TLE8888-1QK

Engine Machine System IC

AEC Qualified

RoHS

1 Overview

Quality Requirement Category: Automotive

Features

- Voltage pre-regulator
- Integrated 5 V regulator
- 2 integrated 5 V trackers
- Standby regulator
- Separate internal supply
- Voltage monitoring
- High speed CAN interface with wake-up by bus
- LIN interface with high speed mode for K-Line operation
- Variable reluctance sensor interface
- Microsecond Channel interface (MSC) with low voltage differential signal (LVDS) inputs pads for low EME
- SPI and direct control inputs for high flexibility
- Main relay driver
- Ignition Key detection with key off delay output
- Wake-up input
- Engine off timer
- 4 low-side power stages especially to drive injectors (R_{on} = 550 mΩ) with enable input
- 3 low-side power stages (R_{on} = 350 mΩ)
- 6 push pull stages for driving on-board MOSFET with drain feedback
- 7 low-side power stages especially to drive relays (R_{on} = 1.5 Ω), one with delayed switch off functionality
- 4 half bridge stages for high flexibility, one with delayed switch off functionality
- 4 push pull stages for driving on- and off- board IGBT with back supply suppression and high voltage capability
- Open-load, short-to-GND and short-to-BAT diagnostic
- Overtemperature and short-to-BAT protection
- Monitoring watchdog module
- AEC Qualified

Overview

Description

The TLE8888-1QK is a U-Chip suitable for automotive engine management systems. It contains the basic functionality to supply the microcontroller and the ECU, establish the communication on- and off- board and drive EMS typical actuators. Furthermore it controls the main relay driver.

Type	Package	Marking
TLE8888-1QK	LQFP-100	TLE8888-1QK
TLE8888QK	LQFP-100	TLE8888QK
TLE8888-2QK	LQFP-100	TLE8888-2QK

Device Variants TLE8888QK and TLE8888-2QK

The device variants TLE8888QK and TLE8888-2QK differ from the main version TLE8888-1QK in the watchdog functionality.

The TLE8888QK has a fixed set of parameter for the watchdog (see datasheet addendum "TLE8888QK - Addendum").

For the TLE8888-2QK the watchdog function is disabled (see datasheet addendum "TLE8888-2QK - Addendum").

Only the main version TLE8888-1QK is described in this datasheet.

For order conditions please contact the nearest Infineon Technologies office.

Abbreviations

Symbol	Explanation
MSC	Microsecond channel
SPI	Serial peripheral interface
LVDS	Low voltage differential signal
EME	Electromagnetic emission
EMI	Electromagnetic interference
LIN	Local interconnect network
HS CAN	High speed controller area network

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3 Pin Configuration

3.1 Pin Assignment
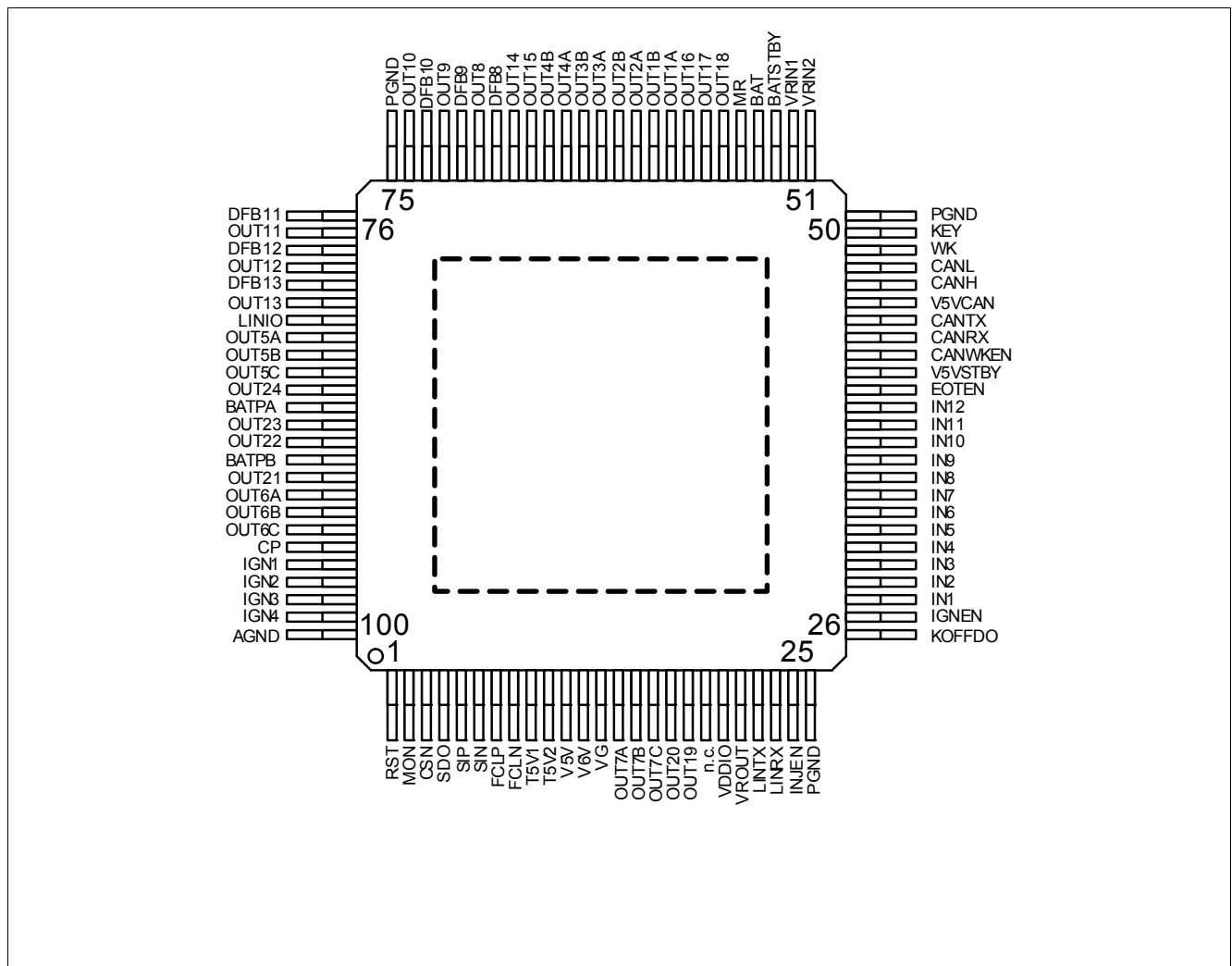
Figure 2 Pin Configuration

3.2 Pin Definitions and Functions

Pin	Symbol	Function	Function
1	*RST*	IN/OUT	**Reset;** Bidirectional pin for reset functions
2	*MON*	IN/OUT	**Monitor;** Bidirectional pin for monitoring functions
3	*CSN*	IN	**MSC/SPI slave chip select;** Single ended chip select for MSC and SPI
4	*SDO*	OUT	**MSC/SPI serial data output;** Output for MSC and SPI
5	*SIP*	IN	**MSC/SPI Data input;** positive data input of LVDS in MSC mode or single ended data input in SPI mode

Pin Configuration

Pin	Symbol	Function	Function
6	*SIN*	IN	**MSC data input or select input;** negative data input of LVDS in MSC mode or select input for SPI mode
7	*FCLP*	IN	MSC/SPI Clock input; positive clock input of LVDS in MSC mode or single ended clock input in SPI mode
8	*FCLN*	IN	**Select input or MSC clock input;** negative clock input of LVDS in MSC mode or select input for single ended mode (SPI or MSC)
9	*T5V1*	OUT	**5 V tracker;** Supply voltage for off- board sensors
10	*T5V2*	OUT	**5 V tracker;** Supply voltage for off- board sensors
11	*V5V*	OUT	**5 V supply;** Supply voltage for main functions of the ECU
12	*V6V*	IN	**Source of external pre-regulator**
13	*VG*	OUT	**Gate of external pre-regulator**
14	*OUT7A*	OUT	**Low-side power stage;** Must be connected to *OUT7B* and *OUT7C* without any parasitic
15	*OUT7B*	OUT	**Low-side power stage;** Must be connected to *OUT7A* and *OUT7C* without any parasitic
16	*OUT7C*	OUT	**Low-side power stage;** Must be connected to *OUT7A* and *OUT7B* without any parasitic
17	*OUT20*	OUT	**Low-side small signal stage;**
18	*OUT19*	OUT	**Low-side small signal stage;**
19	n.c.		leave open or connect to GND
20	*VDDIO*	Supply	**Supply input for logic level inputs and outputs**
21	*VROUT*	OUT	**Output of variable reluctance sensor interface;** Digital output to microcontroller
22	*LINTX*	IN	**Transmit digital input for LIN interface;**
23	*LINRX*	OUT	**Receive digital output for LIN interface;**
24	*INJEN*	IN	**Injector enable input;**
25	*PGND*	GND	**Power ground;** internally connected to cooling tab
26	*KOFFDO*	OUT	**Key off delay output;**
27	*IGNEN*	IN	**Ignition enable input;**
28	*IN1*	IN	**Parallel input;** Input pin for direct control of power stage OUT1,
29	*IN2*	IN	**Parallel input;** Input pin for direct control of power stage OUT2
30	*IN3*	IN	**Parallel input;** Input pin for direct control of power stage OUT3
31	*IN4*	IN	**Parallel input;** Input pin for direct control of power stage OUT4
32	*IN5*	IN	**Parallel input;** Input pin for direct control of push pull state IGN1
33	*IN6*	IN	**Parallel input;** Input pin for direct control of push pull state IGN2
34	*IN7*	IN	**Parallel input;** Input pin for direct control of push pull state IGN3
35	*IN8*	IN	**Parallel input;** Input pin for direct control of push pull state IGN4
36	*IN9*	IN	**Parallel input;** Input pin for direct control of power stages, could be multiplexed to various stages

Pin Configuration

Pin	Symbol	Function	Function
37	*IN10*	IN	**Parallel input;** Input pin for direct control of power stages, could be multiplexed to various stages
38	*IN11*	IN	**Parallel input;** Input pin for direct control of power stages, could be multiplexed to various stages
39	*IN12*	IN	**Parallel input;** Input pin for direct control of power stages, could be multiplexed to various stages
40	*EOTEN*	IN	**Engine off timer enable input;**
41	*V5VSTBY*	OUT	**5 V standby supply;** Supply voltage in sleep mode
42	*CANWKEN*	IN	**Enable input for remote CAN wake-up;**
43	*CANRX*	OUT	**Receive digital output for CAN;**
44	*CANTX*	IN	**Transmit digital input for CAN;**
45	*V5VCAN*	Supply	**5 V supply input for CAN;**
46	*CANH*	IN/OUT	**CAN bus high;**
47	*CANL*	IN/OUT	**CAN bus low;**
48	*WK*	IN	**Wake-up input;** Input signal and supply for MR
49	*KEY*	IN	**Key input;** Input signal and supply for MR
50	*PGND*	GND	**Power ground;** internally connected to cooling tab
51	*VRIN2*	IN	**Differential input of variable reluctance sensor;** Analog input from sensor
52	*VRIN1*	IN	**Differential input of variable reluctance sensor;** Analog input from sensor
53	*BATSTBY*	Supply	**Battery input for standby supply;** Battery supply voltage standby supply regulator
54	*BAT*	Supply	**Battery;** Supply voltage for main functions of the device.
55	*MR*	OUT	**Low-side power stage for main relay;**
56	*OUT18*	OUT	**Low-side power stage;**
57	*OUT17*	OUT	**Low-side power stage;**
58	*OUT16*	OUT	**Low-side power stage;**
59	*OUT1A*	OUT	**Low-side power stage;** Must be connected to *OUT1B* without any parasitic
60	*OUT1B*	OUT	**Low-side power stage;** Must be connected to *OUT1A* without any parasitic
61	*OUT2A*	OUT	**Low-side power stage;** Must be connected to *OUT2B* without any parasitic
62	*OUT2B*	OUT	**Low-side power stage;** Must be connected to *OUT2A* without any parasitic
63	*OUT3A*	OUT	**Low-side power stage;** Must be connected to *OUT3B* without any parasitic
64	*OUT3B*	OUT	**Low-side power stage;** Must be connected to *OUT3A* without any parasitic

Pin Configuration

Pin	Symbol	Function	Function
65	OUT4A	OUT	**Low-side power stage;** Must be connected to OUT4B without any parasitic
66	OUT4B	OUT	**Low-side power stage;** Must be connected to OUT4A without any parasitic
67	OUT15	OUT	**Low-side power stage;**
68	OUT14	OUT	**Low-side power stage;**
69	DFB8	IN	**Drain Feedback;** Related to OUT8
70	OUT8	OUT	**Push pull stage;** To control on- board MOSFET
71	DFB9	IN	**Drain Feedback;** Related to OUT9
72	OUT9	OUT	**Push pull stage;** To control on- board MOSFET
73	DFB10	IN	**Drain Feedback;** Related to OUT10
74	OUT10	OUT	**Push pull stage;** To control on- board MOSFET
75	PGND	GND	**Power ground;** internally connected to cooling tab
76	DFB11	IN	**Drain Feedback;** Related to OUT11
77	OUT11	OUT	**Push pull stage;** To control on- board MOSFET
78	DFB12	IN	**Drain Feedback;** Related to OUT12
79	OUT12	OUT	**Push pull stage;** To control on- board MOSFET
80	DFB13	IN	**Drain Feedback;** Related to OUT13
81	OUT13	OUT	**Push pull stage;** To control on- board MOSFET
82	LINIO	IN/OUT	**BUS for LIN interface;**
83	OUT5A	OUT	**Low-side power stage;** Must be connected to OUT5B and OUT5C without any parasitic
84	OUT5B	OUT	**Low-side power stage;** Must be connected to OUT5A and OUT5C without any parasitic
85	OUT5C	OUT	**Low-side power stage;** Must be connected to OUT5A and OUT5B without any parasitic
86	OUT24	OUT	**Half bridge stage;**
87	BATPA	Supply	**Battery;** Supply voltage for half bridges and the charge pump; must be connected to BATPB without any parasitic
88	OUT23	OUT	**Half bridge stage;**
89	OUT22	OUT	**Half bridge stage;**
90	BATPB	Supply	**Battery;** Supply voltage for half bridges and the charge pump; must be connected to BATPA without any parasitic
91	OUT21	OUT	**Half bridge stage;**
92	OUT6A	OUT	**Low-side power stage;** Must be connected to OUT6B and OUT6C without any parasitic
93	OUT6B	OUT	**Low-side power stage;** Must be connected to OUT6A and OUT6C without any parasitic
94	OUT6C	OUT	**Low-side power stage;** Must be connected to OUT6A and OUT6B without any parasitic
95	CP	OUT	**Charge pump;** add external capacitance to stabilise charge pump voltage

Pin Configuration

Pin	Symbol	Function	Function
96	*IGN1*	OUT	**Push pull stage;** To control on- or off- board IGBT
97	*IGN2*	OUT	**Push pull stage;** To control on- or off- board IGBT
98	*IGN3*	OUT	**Push pull stage;** To control on- or off- board IGBT
99	*IGN4*	OUT	**Push pull stage;** To control on- or off- board IGBT
100	*AGND*	GND	**Signal ground;** internally connected to *PGND* and cooling tab
Cooling tab[1]	*PGND*	GND	**Power ground;** internally connected PGND pins

1) Cooling tab is also called exposed pad

4 General Product Characteristics

General definition:

V_S is the short cut for all battery supplies of the TLE8888-1QK (*BAT*, *BATPA*, *BATPB*, *BATSTBY*) unless otherwise specified

GND is the short cut for all grounds of the TLE8888-1QK (*AGND*, *PGND*) unless otherwise specified.

Table 1   Absolute Maximum Ratings[1]

T_j = -40°C to +150°C, all voltages with respect to GND, positive current flowing into pin, (unless otherwise specified)

Parameter	Symbol	Values			Unit	Note or Test Condition	Number
		Min.	Typ.	Max.			
Voltages							
BATPA, BATPB, OUT8…13, DFB8…13	$V_{BATPA,MR}$, $V_{BATPB,MR}$, $V_{OUT8…13,MR}$, $V_{DFB8…13,MR}$	-0.3	–	40	V	–	P_4.1
CP	$V_{CP,MR}$	-0.3	–	45	V	-0.3 V < V_{CP} - V_{BATPA} < 5 V	P_4.2
OUT1…7, OUT14…20	$V_{OUT1…7,MR}$, $V_{OUT14…20,MR}$	-0.3	–	50	V	OUTn is switched off, clamping is allowed according **Chapter 9.6**	P_4.3
V6V	$V_{V6V,MR}$	-0.3	–	10	V	–	P_4.4
VG	$V_{VG,MR}$	-0.3	–	12	V	V_{VG} - V_{V6V} < 5 V	P_4.5
V5V, V5VSTBY, VDDIO, V5VCAN	$V_{V5V,MR}$, $V_{V5STBY,MR}$, $V_{VDIO,MR}$, $V_{V5VCAN,MR}$	-0.3	–	5.5	V	–	P_4.6
T5V1, T5V2, IGN1…4	$V_{T5V1,MR}$, $V_{T5V2,MR}$, $V_{IGN1…4,MR}$	-1	–	40	V	–	P_4.7
BAT, BATSTBY, KEY, WK, MR	$V_{BAT,MR}$, $V_{KEY,MR}$, $V_{WK,MR}$, $V_{BATSTBY,MR}$, $V_{MR,MR}$,	-16	–	40	V	–	P_4.8

Table 1 Absolute Maximum Ratings[1] (cont'd)

T_j = -40°C to +150°C, all voltages with respect to GND, positive current flowing into pin, (unless otherwise specified)

Parameter	Symbol	Values			Unit	Note or Test Condition	Number
		Min.	Typ.	Max.			
IN1…12, SIP, SIN, FCLP, FCLN, CSN, LINTX, CANTX, IGNEN, INJEN, CANWKEN, EOTEN	$V_{IN1…12,MR}$, $V_{FCLP,MR}$, $V_{FCLN,MR}$, $V_{SIP,MR}$, $V_{SIN,MR}$, $V_{CSN,MR}$, $V_{LINTX,MR}$, $V_{CANTX,MR}$, $V_{IGNEN,MR}$, $V_{INJEN,MR}$, $V_{EOTEN,MR}$, $V_{CANWKEN,MR}$	-0.3	–	5.5	V	–	P_4.9
SDO, RST, VROUT, LINRX, CANRX	$V_{SDO,MR}$, $V_{RST,MR}$, $V_{VROUT,MR}$, $V_{LINRX,MR}$, $V_{CANRX,MR}$	-0.3	–	VDDIO+0.3	V	both conditions must be observed	P_4.31
		-0.3	–	5.5	V		
MON, KOFFDO	$V_{MON,MR}$, $V_{KOFFDO,MR}$	-0.3	–	V5V+0.3	V	both conditions must be observed	P_4.10
		-0.3	–	5.5	V		
VRIN1	$V_{VRIN1,MR}$	-0.3	–	40	V	VRIN2 open	P_4.11
VRIN2	V_{VRIN2_MR}	-0.3	–	40	V	VRIN1 open	P_4.12
LINIO, CANH, CANL	$V_{LINIO,MR}$, $V_{CANH,MR}$, $V_{CANL,MR}$	-40	–	40	V	–	P_4.13
OUT21…24	$V_{OUT21…24,MR}$	-0.3	–	BATPx+0.3	V	–	P_4.14
Currents							
DFB8…13	$I_{DFB8…13,MR}$	-5	–	5	mA	[2]	P_4.15
Common Mode Input Current of VRIN1 and VRIN2	$I_{VRIN,CM,MR}$	-5	–	5	mA	$I_{VRIN,CM,MR} = I_{VRIN1} + I_{VRIN2}$[2]	P_4.16
Common Mode Input Current of VRIN1 and VRIN2, non permanent	$I_{VRIN,CM,MR}$	-15	–	15	mA	$I_{VRIN,CM,MR} = I_{VRIN1} + I_{VRIN2}$[2], maximum duty cycle 60% and maximum on time of 1 ms, 100 h	P_4.34
Differential Current of VRIN1 and VRIN2	$\Delta I_{VRIN,MR}$	-50	–	50	mA	$\Delta I_{VRIN,MR} = (I_{VRIN1} - I_{VRIN2})/2$[2]	P_4.17
PGND	$I_{PGND,MR}$	-25	–	25	A	–	P_4.18
IGN1…4	$I_{IGN1…4,MR}$	-50	–	–	mA	[2]	P_4.19
Temperatures							

General Product Characteristics

Table 1 Absolute Maximum Ratings[1] (cont'd)

T_j = -40°C to +150°C, all voltages with respect to GND, positive current flowing into pin, (unless otherwise specified)

Parameter	Symbol	Values			Unit	Note or Test Condition	Number
		Min.	Typ.	Max.			
Junction Temperature	T_j	-40	–	150	°C	3)	P_4.20
Storage Temperature	T_{stg}	-55	–	150	°C	–	P_4.21
ESD Susceptibility							
ESD Susceptibility	V_{ESDHBM}	-2	–	2	kV	HBM[4]	P_4.22
ESD Susceptibility BAT, BATPA, BATPB, T5V1, T5V2, BATSTBY, KEY, WK, MR, OUT1…7, OUT14…24, DFB8…13, IGN1…4, CANH, CANL, LINIO, VRIN1, VRIN2 to PGND	$V_{ESD,HBM}$	-4	–	4	kV	HBM[4]	P_4.23
ESD Susceptibility	V_{ESDCDM}	-500	–	500	V	CDM[5]	P_4.24
ESD Susceptibility Pin 1, 25, 26, 50, 51, 75, 76, and 100 (corner pins)	$V_{ESD1, 25, 26, 50, 51, 75, 76, 100}$	-750	–	750	V	CDM[5]	P_4.25

1) not subject to production test
2) Current has to be limited when maximum voltages are exceeded
3) according to qualification
4) ESD susceptibility, HBM according to EIA/JESD 22-A114F (1.5k Ω, 100 pF)
5) ESD susceptibility, Charged Device Model "CDM" EIA/JESD22-C101 or ESDA STM5.3.1

Notes

1. *Stresses above the ones listed here may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.*
2. *Integrated protection functions are designed to prevent IC destruction under fault conditions described in the data sheet. Fault conditions are considered as "outside" normal operating range. Protection functions are not designed for continuous repetitive operation.*

Table 2   Functional Range

T_j = -40°C to +150°C, all voltages with respect to GND, positive current flowing into pin, (unless otherwise specified)

Parameter	Symbol	Values			Unit	Note or Test Condition	Number
		Min.	Typ.	Max.			
Supply Voltage - Reduced Operation	$V_{BAT,ro}$	4.5	–	6	V	reduced operation range, main relay and delayed off power stages are on if enabled, remaining functions not working	P_4.26
Supply Voltage - Low Drop Range	$V_{BAT,ld}$	6	–	9	V	low drop operation range, supply regulators working with supply out of the charge pump, standby supply regulator out of operation range	P_4.27
Supply Voltage - Normal Operation range	$V_{BAT,nop}$	9	–	28	V	normal operation range[1]	P_4.28
Supply Voltage - Overvoltage Range	$V_{BAT,ov}$	28	–	40	V	overvoltage, power stages are switched off	P_4.29
Supply Voltage transients[2]	d_{VBAT}/d_t	-1	–	1	V/µs	–	P_4.30

1) overtemperature due to bad R_{thJA} of the ECU or overload can happen
2) not subject to production test, specified by design

Note: Within the functional range the IC operates as described in the circuit description. The electrical characteristics are specified within the conditions given in the related electrical characteristics table.

Table 3   Thermal Resistance

Parameter	Symbol	Values			Unit	Note or Test Condition	Number
		Min.	Typ.	Max.			
Junction to Case[1]	R_{thJC}	–	2.4	–	K/W	–	P_4.32
Junction to Ambient	R_{thJA}	–	–	–	K/W	[2]	P_4.33

1) Not subject to production test, specified by design.
2) EIA/JESD 52_2, FR4, 80 × 80 × 1.5 mm; 35 × Cu, 5 × Sn; 300 mm^2

5 Operation Behavior

The TLE8888-1QK has implemented the whole supply of an ECU. Therefore a complex control logic is implemented to provide several operation states.

In this chapter

• the ramp up and down behavior and

• the status of the TLE8888-1QK during special conditions like 5 V undervoltage

is described. For the description of the monitoring watchdog module see **Chapter 6**.

In **Figure 3** the block diagram with all blocks affecting the status of the device and the ECU are shown. Following blocks are influenced during the different operation states and reset functions:

• Serial Interface MSC/SPI: with the serial interface the setup of the device is done

• Key input detection: start signal from key switch (KL15)

• Wake-up input detection: additional start signal e.g. from external CAN with wake-up by bus function

• Engine off timer: wake-up signal in comparator mode

• Power supply: ECU 5 V supply and 5 V sensor supplies, 5 V standby supply

• Voltage monitoring: supervision of all supplies (BAT, V5V, T5V1, T5V2)

• Main relay driver: controls external main relay to switch battery voltage to an ECU supply pin (see also application setups in **Chapter 17**)

• Power stages and half-bridges control block

• LIN/K-Line: transmission mode depends on operation state of the ECU

• CAN: transmission mode depends on operation state of the ECU, remote wake-up function

• Reset outputs MON and RST

• Monitoring watchdog module: signature watchdog for safety applications

• Operation Mode Control

The operation mode control block consists of:

• ramp up and down sequence control logic

• the reset control logic and

• status output logic.
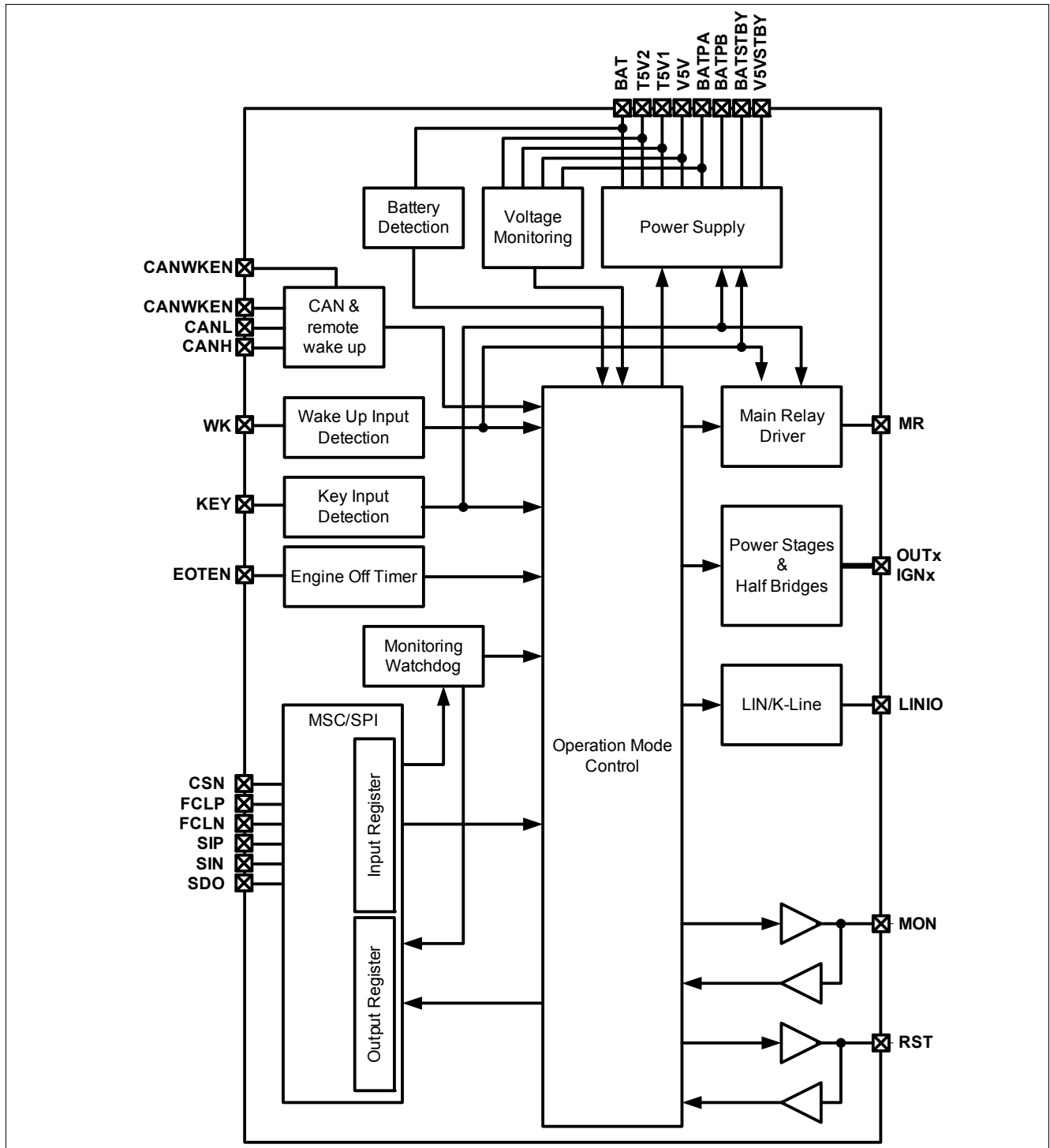
Figure 3   Block diagram operation mode control

5.1   Operation States

In **Figure 4** the state diagram of the whole ramp up and down sequence is shown. There are seven operation states:

- ECU sleep state: *KEY* and *WK* input are "low", no wake-up signals from engine off timer or CAN are active, main relay is off, the whole ECU inclusive TLE8888-1QK is not supplied, 5 V standby supply is working if pin *BATSTBY* is supplied, engine off timer and CAN wake-up circuits are active if enabled and supplied.

Operation Behavior

- Supply ramp up state: *KEY* input or wake[1] are "high" and the supply of the TLE8888-1QK starts working, the voltage of V6V, V5V, T5V1 and T5V2 are ramping up but the voltage levels are below the undervoltage threshold. For wake-up by wake[1] the ramp up of the main supply has to be finished before the ramp up timer overflow. The main relay is switched on depending on the voltage level at the pin *BAT* (see **Chapter 7.2**)

- Normal operation state: *KEY* input or wake are "high" and main relay is switched on depending on the voltage level at the pin *BAT* or the status of bit **MR** in the status register **OpStat0** (see **Chapter 7.2**), the whole ECU is supplied and the status of the different functions and registers is according **Table 5** and **Table 6**.

- Afterrun state: *KEY* is "low" but afterrun enable bit is set and therefore the whole ECU is supplied, the status of the different functions and registers is according **Table 5** and **Table 6** and the microcontroller can execute afterrun routines

- Afterrun reset state: the reset procedure before direct reentry in normal operation is executed if bit **AR** =1 in the configuration register **OpConfig0**

- General power-down state: the supplies of the ECU (*V5V*, *T5V1*, *T5V2*) are disabled and the power-down timer is counting, main relay remains in the switching status and the TLE8888-1QK is supplied to ensure the power-down (V5V drops down to 0 V) of the ECU, *V5VSTBY* is working if *BATSTBY* is supplied, all functions to external are disabled.

- Wake clear state: this state avoids permanent wake-up in failure cases. The wake clear command is executed (function according setting bit **WKCLR** in the command register **Cmd0**). All wake signals which are active after the supply ramp up and the general power-down state are reset.

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1)   description see **Figure 4**, **Chapter 7.2**, **Chapter 7.4** and **Chapter 12.2.4**

Operation Behavior

The diagram contains the following states: wake clear*, Supply Ramp Up, Gerneral Power Down*, ECU Sleep, Afterrun*, Normal Operation*, Afterrun Reset*.

Transitions:
- PDT_OF=1 (Gerneral Power Down* → wake clear*)
- KEY=0 (wake clear* → ECU Sleep)
- KEY=1 (wake clear* → Supply Ramp Up)
- KEY=0 & wake=1 & RT_OF=1 (Supply Ramp Up → wake clear*)
- KEY=0 & wake=0 (Supply Ramp Up → ECU Sleep)
- KEY=1 or wake=1 (ECU Sleep → Supply Ramp Up)
- (KEY=1 or wake=1) & V5VUV=0 (Supply Ramp Up → Normal Operation*)
- PD_OF=1 or SSOT_OF=1 (Afterrun* → Gerneral Power Down*)
- wake=0 & KEY=0 & AE=0 (Afterrun* → ECU Sleep)
- (PD_OF=1 or SSOT_OF=1) & KEY=0 (Normal Operation* → Gerneral Power Down*)
- KEY=0 & wake=0 & AE=0 (Normal Operation* → ECU Sleep)
- KEY=0 & AE=1 (Normal Operation* → Afterrun*)
- AR=0 & KEY=1 (Afterrun* → Normal Operation*)
- AR=1 & KEY=1 (Afterrun* → Afterrun Reset*)
- (Afterrun Reset* → Normal Operation*)

Legend:
KEY	filtered KEY signal
RT_OF	ramp up timer overflow
AE	afterrun enable bit
AR	afterrun reset configuration bit
PDT_OF	power down timer overflow
PD_OF	overflow of minimum one of the three PD counter
POR	internal power on reset
SSOT_OF	secure shut off timer overflow
V5VUV	under voltage of V5V active

0 … function inactive
1 … function active

(e.g. V5VUV=1 → 5V supply is below undervoltage threshold
V5VUV=0 → 5V supply is above undervoltage threshold)

* POR=1:
active internal power on reset forces transition to ECU sleep (wake=0 & KEY=0) or supply ramp up mode (wake=1 or KEY=1) from all states

wake = WKINT or CANWK or EOTWK

wake = 1: one of the signals WKINT, CANWK, EOTWK is „1"
wake = 0: all signals are „0"

Figure 4   Operation state diagram

Operation Behavior

Description of the transitions:

Table 4   Operation State Transitions

Transition	Condition	Description
from all states to ECU sleep state	internal supply voltage < internal por threshold and KEY = 0 and wake[1]=0[2]	internal power on reset is active and reset the whole digital logic, ECU sleep state is entered due to no wake-up signal at KEY or wake
from all states to supply ramp up state	internal supply voltage < internal por threshold and KEY = 1 or wake = 1[2]	internal power on reset is active and reset the whole digital logic, supply ramp up state is entered due to a wake-up signal at KEY or wake
ECU sleep state to supply ramp up state	$KEY > V_{KEY,th}$ or wake = 1	With a "high" voltage at KEY or wake the wake-up of the TLE8888-1QK starts
Supply ramp up state to ECU sleep state	$KEY < V_{KEY,th}$ and wake = 0[2]	The external supply ramp up is not finished but the wake-up signals are low
Supply ramp up state to wake clear state	$KEY < V_{KEY,th}$ and wake = 1[2] and RT_OF = 1	The KEY signal is low and the wake-up signals are active. The ramp up timer has an overflow which indicates a ramp up problem of the external supply (e.g. short to GND). To avoid permanent high current consumption the internal wake signals must be reset to enter the ECU sleep state.
Supply ramp up state to normal operation state	($KEY > V_{KEY,th}$ or wake = 1) and V5V > $V_{uv,V5V}$[2]	normal operation state is entered if the main supply voltage $V5V$ is above the undervoltage threshold, KEY is high or one of the wake-up conditions are active
Normal operation state to afterrun state	$KEY < V_{KEY,th}$ and AE = 1[2]	KEY is "low" and afterrun function is enabled: no changes in the setup of the TLE8888-1QK
Normal operation state to ECU sleep state	AE = 0 and KEY < $V_{KEY,th}$ and wake = 0[2]	normal shut off
Normal operation state to general power-down state	(PD_OF = 1 or SSOT_OF = 1) and KEY < $V_{KEY,th}$ [2]	KEY is low and watchdog error shut off with overflow of the power-down counter or secure shut off due to expired secure shut off timer
Afterrun state to ECU sleep state	AE = 0 and KEY < $V_{KEY,th}$ and wake = 0 [2]	normal shut off in afterrun mode with the reset of the afterrun enable bit AE by the microcontroller
Afterrun state to general power-down state	PD_OF = 1 or SSOT_OF = 1	watchdog error shut off with overflow of the power-down counter or secure shut off due to expired secure shut off timer
Afterrun state to normal operation state	$KEY > V_{KEY,th}$ and AR = 0[2]	reentry of normal operation with KEY on during afterrun operation, no reset is performed (AR = 0)
Afterrun state to afterrun reset state	$KEY > V_{KEY,th}$ and AR = 1[2]	reentry of normal operation with KEY on during afterrun operation with reset (AR = 1)
Afterrun reset state to normal operation state		transition to normal operation with the next active internal clock edge after entry to the afterrun reset state

Operation Behavior

Table 4   Operation State Transitions (cont'd)

Transition	Condition	Description
General power-down state to wake clear state	PDT_OF = 1	with the power-down timer overflow the reset of the internal wake signals must be performed
Wake clear state to ECU sleep state	$KEY < V_{KEY,th}$	after reset of the internal wake signals and KEY is low the ECU sleep state is entered, no unwanted wake-up due to a failure condition will occur
Wake clear state to supply ramp up state	$KEY > V_{KEY,th}$	after reset of the internal wake signals and KEY is high the supply ramp up state is entered, no unwanted wake-up due to a failure condition at the CAN bus and pin WK will occur

1) wake = WKINT or CANWK or EOTWK (see **Chapter 7.2**, **Chapter 7.4** and **Chapter 12.2.4**)
2) including defined filter times

The two states:
- normal operation
- afterrun

are reflected in the bit **OM** of the status register **OpStat0**.

The power-down time is defined with the bits **PDT** of the configuration register **OpConfig0**.

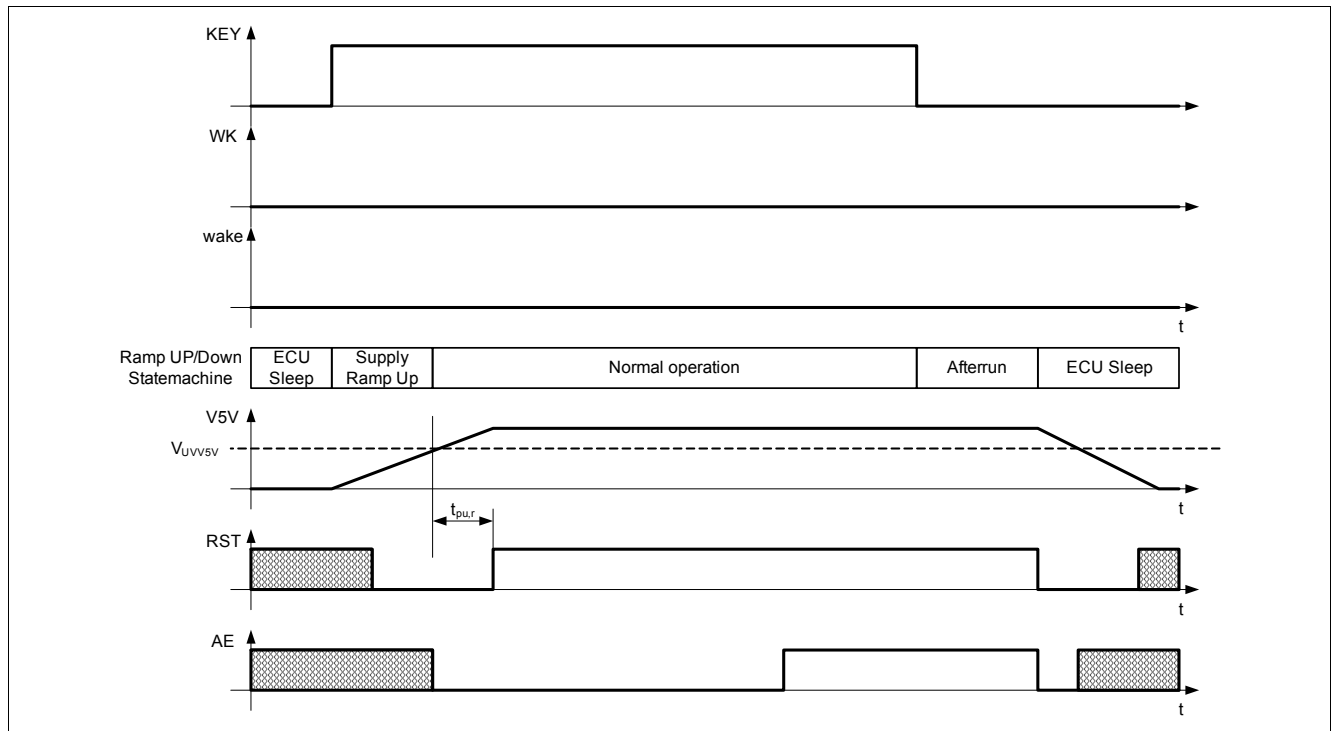In **Figure 5** a sequence with wake-up by KEY and go to sleep with afterrun mode is shown.

Figure 5   Ramp up and down sequence diagram with wake-up by KEY and afterrun mode

5.2   Reset and Operation Modes

Operation Behavior

The TLE8888-1QK provides several supervision functions which lead to some dedicated reset states and special operation modes of the device and the ECU.

There are two bidirectional reset pins MON and RST implemented. For the behavior during reset of the reset pins MON and RST and the other status of the TLE8888-1QK see **Table 5** and **Table 6**.

Following reset functions and special states are implemented:

- Internal power on reset: the internal power on reset detection circuit monitors the voltage level of the internal supply. For an internal supply voltage below the internal power on reset threshold the whole digital logic of the TLE8888-1QK is reset which results in the ECU sleep state or supply ramp up state depending on the state of *KEY* and wake. If the voltage level for operation is high enough the 6 V pre regulator is working. The 5 V supplies are disabled till the internal supply level is over the power on threshold level.

- ECU power on reset: this is the reset at ramp up of the power supplies and the beginning of the operation. The pins *RST* and *MON* are pulled to GND to reset the microcontroller and all devices connected to the pin *MON*. The device is reset to the initial reset status. The reset is released with a voltage at pin *V5V* higher than the **V5V Undervoltage Detection Hysteresis** after **tpu,r**.

- Reset during undervoltage of the 5 V supply V5V: this reset occurs during undervoltage of the 5 V ECU supply. The pins *RST* and *MON* are pulled to GND to reset the microcontroller and all devices connected to the pin *MON*. The delayed switch off function is active regarding the configuration setup. The status of the main relay is according to the status of the wake-up pins *KEY* and *WK* and the voltage level of the supply pin *BAT*.

- State during undervoltage of the 5 V supplies T5V1 and T5V2: with the undervoltage detection of the tracker supplies diagnosis bits are set but there is no effect to the behavior of the device.

- Reset during overvoltage of the 5 V supply V5V: with the overvoltage detection of the 5 V ECU supply all functions of the device which have an effect externally or can lead to overcurrent or overtemperature are disabled (e.g. power stages, LIN/CAN/MSC/SPI communication). The pins *RST* and *MON* are low.

- State during overvoltage of the 5 V supplies T5V1 and T5V2: with the detection of overvoltage of the tracker supplies diagnosis bits are set but there is no effect to the behavior of the device.

- Power stages switch off during overvoltage of the battery supply *BAT*: For voltages at the supply pin *BAT* higher than the overvoltage threshold the power stages are disabled to avoid too high clamping energy during switch off. Damage of the switches is prevented.

- Watchdog reset: If the reset counter is incremented and the reset is enabled (bit **WDREN** = 1) the microcontroller is reset with a "low" at the pin *RST*. The power stages are disabled and the LIN/CAN communication is set to receive only mode.

- Software reset from microcontroller: with the software reset command (command register **CmdSR**) the software reset is activated. The device is reset to the reset status defined in **Table 5** and **Table 6**. The activation of the software reset triggers an increase of the power-down counter by 1.

- Reset with an external forced "low" at *RST*: With a detected "low" at the *RST* pin the TLE8888-1QK is reset to the reset status defined in **Table 5** and **Table 6**.

- Power stages switch off with an external forced "low" at *MON*: With a detected "low" at the *MON* pin the power stages are disabled (**O1E** to **O24E**, **IGN1E** to **IGN4E** are set to "0"). After *MON*=0 event the power stages must be enabled again.

- State with time out of the MSC communication: With the time out of the MSC communication the power stages are disabled (**O1E** to **O24E**, **IGN1E** to **IGN4E** are set to "0"). After the next valid received data frame the power stages must be enabled again.

- Afterrun reset: This reset is executed if the bit **AR** of register **OpConfig0** is 1 and the transition from afterrun state to normal operation is triggered (definition see **Table 6**).

Table 5 Overview Behavior at Reset and Operation Conditions (part 1)

Effect to functions:	Conditions						
	Internal power on reset	**ECU power on reset**	**Undervoltage V5V**	**Undervoltage T5V1, T5V2**	**Overvoltage V5V**[1]	**Overvoltage T5V1, T5V2**	**Overvoltage BAT**
notes	forces state change	only after transition from Supply Ramp Up to Normal Operation state for **$t_{pu,r}$**	timing see **Chapter 8.7** and **Table 7**	timing see **Chapter 8.7**	timing see **Chapter 8.7** and **Table 7**	timing see **Chapter 8.7**	timing see **Chapter 8.7**
V5VSTBY, *V6V*	en.	en.	en.	en.	en.	en.	en.
V5V, *T5V1*, *T5V2*	dis.	en.	en.	en.	en.	en.	en.
MSC/SPI communication	dis.	dis.	dis.	en.	dis.	en.	en.
Main relay	en.[2]	en.[2]	en.[2]	en.[2]	en.[2]	en.[2]	en.[2]
Low-side switches / Half bridges / Push Pull Driver	off/dis./off	off/dis./off	off/dis./off	no change	off/dis./off	no change	off/dis./off
OUT17 and *OUT21* with delayed switch off function	dis.	dis.	delayed switch off activated	en.	delayed switch off activated	en.	dis.
LIN/CAN communication	dis.	rec. only, after release setup acc. bits **CAN**, **LIN**, **CANWE**, **LINWE**[3]	rec. only, after release setup acc. bits **CAN**, **LIN**, **CANWE**, **LINWE**[3]	acc. bits **CAN**, **LIN**, **CANWE**, **LINWE**	dis., after release setup acc. bits **CAN**, **LIN**, **CANWE**, **LINWE**	acc. bits **CAN**, **LIN**, **CANWE**, **LINWE**	acc. bits **CAN**, **LIN**, **CANWE**, **LINWE**
MON (output function)	"low"[4]	"low"	"low"	no effect[5]	"low"	no effect[5]	no effect[5]
RST (output function)	"low"[4]	"low"	"low"	no effect[5]	"low"	no effect[5]	no effect[5]
Watchdog Sequence, Heartbeat Timer[6]	reset	reset	reset	no effect	reset	no effect	no effect

Table 5 **Overview Behavior at Reset and Operation Conditions (part 1)** (cont'd)

Effect to functions:	Conditions						
	Internal power on reset	ECU power on reset	Undervoltage V5V	Undervoltage T5V1, T5V2	Overvoltage V5V[1]	Overvoltage T5V1, T5V2	Overvoltage BAT
WWD Error Counter, FWD pass counter, Total error counter	reset	reset	reset	no effect	reset	no effect	no effect
PD Counter	reset	reset	reset	no effect	reset	no effect	no effect
Reset Counter; SSOT	reset	reset	reset	no effect	reset	no effect	no effect
AR; **CANWE**; **LINWE**; **FWDQUEST**	reset	reset	reset	no effect	reset	no effect	no effect
AE; **WWDConfig0**; **WDConfig0**; watchdog diagnosis bits	reset	reset	reset	no effect	reset	no effect	no effect
Logic and MSC/SPI register bits[7][8]	reset	reset	reset, diagnosis bit is set	diagnosis bits are set	no effect	diagnosis bits are set	diagnosis bit is set
EOTWK, **CANWK**, **WKINT**	no effect	no effect	reset	no effect	no effect	no effect	no effect

1) for voltages greater than the maximum ratings of pin *V5V* behavior is not guaranteed

2) according the definition in **Chapter 7**

3) after release of RST (transition from low to high) there is a time delay of **tdel,r** before configuration is enabled

4) active pull down if supply voltage is high enough

5) pull up of open drain output is active

6) start of watchdog sequence after release of reset

7) valid for all register bits which are not described in **Table 5** or **Table 6**

8) During active delayed switch off mode some register bits related to the power stages are not reset, see **Chapter 9.4**

Table 6   Overview Behavior at Reset and Operation Conditions (part 2)

Effect to functions:	Conditions							
	Watchdog reset	**Safe State**	**SW reset from micro-controller**	**MON switch off (input function)**	**RST reset (input function)**	**MSC time out**	**afterrun reset**	
							no reset AR=0	**reset AR=1**
note	status during reset pulse **top,r**		status during reset pulse **tint,r**	masked by MON output function	masked by RST output function	status till next valid MSC communication		
V5VSTBY, *V6V*	en.	en.	en.	en.	en.	en.	en.	en.
V5V, *T5V1*, *T5V2*	en.	en.	en.	en.	en.	en.	en.	en.
MSC/SPI communication	dis.	en.	en.	en.	dis.	en.	en.	dis.
Main relay	en.[1]	en.	en.[1]	en.[1]	en.[1]	en.[1]	en.[1]	en.[1]
Low-side switches / Half bridges / Push Pull Driver	off/dis./off	off/dis./off	off/dis./off[3]	off/dis./off	off/dis./off	off/dis./off	no change	off/dis./off
OUT17 and *OUT21* with delayed switch off function	no trigger if termination of delayed switch off function	no trigger if termination of delayed switch off function	dis.[3]	delayed switch off activated	delayed switch off activated	delayed switch off activated	en.	dis.

Table 6   Overview Behavior at Reset and Operation Conditions (part 2) (cont'd)

Effect to functions:	Conditions							
	Watchdog reset	Safe State	SW reset from micro-controller	MON switch off (input function)	RST reset (input function)	MSC time out	afterrun reset	
							no reset **AR**=0	reset **AR**=1
LIN/CAN communication	acc. bits **CAN**, **LIN**, **CANWE**, **LINWE**	acc. bits **CAN**, **LIN**, **CANWE**, **LINWE**	acc. bits **CAN**, **LIN**, **CANWE**, **LINWE**	acc. bits **CAN**, **LIN**, **CANWE**, **LINWE**	rec. only, after release setup acc. bits **CAN**, **LIN**, **CANWE**, **LINWE**[2]	acc. bits **CAN**, **LIN**, **CANWE**, **LINWE**	acc. bits **CAN**, **LIN**, **CANWE**, **LINWE**	rec. only, after release setup acc. bits **CAN**, **LIN**, **CANWE**, **LINWE**[2]
MON	"low"	"low"	"low"[3]	forced from outside	"low"	no effect[4]	no effect[4]	"low"
RST	"low"	no effect[4]	no effect[4]	no effect[4]	forced from outside	no effect[4]	no effect[4]	"low"
Watchdog Sequence, Heartbeat Timer[5]	reset	no effect	reset	no effect	reset	no effect	no effect	reset
WWD Error Counter, FWD pass counter, Total error counter	reset	no effect	reset	no effect	reset	no effect	no effect	reset
PD Counter	no effect	no effect	increment +1	no effect	no effect	no effect	no effect	no effect
Reset Counter; SSOT	no effect	no effect	no effect	no effect	no effect	no effect	no effect[6]	no effect[6]
AR; **CANWE**; **LINWE**; **FWDQUEST**	no effect	no effect	no effect	no effect	no effect	no effect	no effect	no effect

Table 6   Overview Behavior at Reset and Operation Conditions (part 2) (cont'd)

Effect to functions:	Conditions							
	Watchdog reset	Safe State	SW reset from micro-controller	MON switch off (input function)	RST reset (input function)	MSC time out	afterrun reset	
							no reset AR=0	reset AR=1
AE; WWDConfig0; WDConfig0; watchdog diagnosis bit	reset	no effect	reset	no effect	reset	no effect	no effect	reset
Logic and MSC/SPI register bits[7)8)]	no effect	no effect	reset	no effect	reset	diagnosis bit is set	no effect	reset
EOTWK, CANWK, WKINT	no effect	no effect	no effect	no effect	no effect	no effect	no effect	no effect

1) according the definition in **Chapter 7**

2)   after release of RST (transition from low to high) there is a time delay of **tdel,r** before configuration is enabled

3) status for time **top,r**

4) pull up of open drain output is active

5) start of watchdog sequence after release of reset

6) SSOT reset due to *KEY* = 1

7) valid for all register bits which are not described in **Table 5** or **Table 6**

8) During active delayed switch off mode some register bits related to the power stages are not reset, see **Chapter 9.4**

Table 7   Reset Time Definition

Reset Function		Reset Time at RST Output	Related Status Bits in Register **OpStat1**
internal power on reset			all registers are reset
ECU power on reset		$t_{pu,r}$	
Undervoltage V5V		$t_{pu,r}$	**V5VUVR**
Overvoltage V5V		$t_{pu,r}$	**V5VOVR**
Watchdog reset		$t_{op,r}$	**WDRES**
RST reset forced from outside		forced from outside	**RSTR**
Software reset from microcontroller		no effect	all registers are reset[1]
Afterrun reset	**AR**="0"	no effect	
	AR="1"	$t_{op,r}$	**ARES**

1) internal reset with $t_{int,r}$ active

After a reset with pin *RST* the configuration of the CAN and LIN bus is delayed by the time **tdel,r** to avoid that undefined microcontroller pins are affecting the buses. During this delay time the configuration bits can be changed by a write access to the register.

5.3 Electrical Characteristics Operation Behavior

Table 8 **Electrical Characteristics: Operation Behavior**

V_S = 13.5 V, V_{VSV} = 5 V, T_j = -40°C to +150°C, all voltages with respect to ground, positive current flowing into pin (unless otherwise specified)

Parameter	Symbol	Values			Unit	Note or Test Condition	Number
		Min.	Typ.	Max.			
Internal power on reset threshold	$V_{por,int,th}$	–	–	2.8	V	of internal supply voltage	P_5.3.1
Supply voltage range for internal supply	$V_{BATP,int}$	4.5	–	–	V	only valid if the charge pump has ramped up before voltage drop, both condition must be fulfilled to ensure no internal power on reset	P_5.3.2
	$V_{V6V,int}$	3.5	–	–	V		
Power-Down Timer							
Power-down time 1	$t_{pd,1}$	–	100	–	ms	–	P_5.3.3
Power-down time 2	$t_{pd,2}$	–	200	–	ms	–	P_5.3.4
Power-down time 3	$t_{pd,3}$	–	300	–	ms	–	P_5.3.5
Power-down time 4	$t_{pd,4}$	–	400	–	ms	–	P_5.3.6
Power-down time accuracy	$t_{pd,a}$	-10	–	+10	%	–	P_5.3.7
Ramp Up timer							
Ramp up time	t_{ru}	185	–	650	ms	–	P_5.3.8
MON In- Output							
Input low level	V_{il}	–	–	0.29*$V5V$	V	–	P_5.3.10
Input high level	V_{ih}	0.7*$V5V$	–	–	V	–	P_5.3.11
Input hysteresis	V_{ihys}	0.1	–	1	V	–	P_5.3.12
Pull up current	I_{imax}	-100	–	–	µA	V_{in} = 0 V, pull up to $V5V$	P_5.3.13
Input de-glitch time for low and high level detection	$t_{i,d}$	0.5	–	3.5	µs	–	P_5.3.14
Output low level operation	V_{ol}	–	–	0.7	V	I_{out} = 2 mA; V_{V5V} = 2.5 V	P_5.3.15
Output current capability	I_{omax}	15[1]	–	–	mA	V_{MON} = 5 V	P_5.3.16
RST In- Output							
Input low level	V_{il}	–	–	0.29*$VDDIO$	V	–	P_5.3.17

Operation Behavior

Table 8   Electrical Characteristics: Operation Behavior (cont'd)

V_S = 13.5 V, V_{VSV} = 5 V, T_j = -40°C to +150°C, all voltages with respect to ground, positive current flowing into pin (unless otherwise specified)

Parameter	Symbol	Values			Unit	Note or Test Condition	Number
		Min.	Typ.	Max.			
Input high level	V_{ih}	0.7*$VDDIO$	–	–	V	–	P_5.3.18
Input hysteresis	V_{ihys}	0.1	–	1	V	–	P_5.3.19
Pull up current	I_{imax}	-100	–	–	µA	V_{in} = 0 V, pull up to $VDDIO$	P_5.3.20
Input de-glitch time for low and high level detection	$t_{i,d}$	0.5	–	3.5	µs	–	P_5.3.21
Output low level operation	V_{ol}	–	–	0.7	V	I_{out} = 2 mA; V_{V5V} = 2.5 V	P_5.3.22
Output current capability	I_{omax}	15[1]	–	–	mA	V_{RST} = 5 V	P_5.3.23
Reset Times							
Power up reset time	$t_{pu,r}$	12	16	20	µs	–	P_5.3.24
Operation reset time	$t_{op,r}$	1	2	4	µs	–	P_5.3.25
Internal reset time	$t_{int,r}$	–	–	1	µs	–	P_5.3.26
Delay time after reset	$t_{del,r}$	6	10	14	µs	–	P_5.3.27

1)   Application must ensure that current into this pin does not exceed this value.

6   Monitoring Watchdog Module (Signature Watchdog)

The watchdog function is intended for a temporal and logical monitoring of the microcontroller's program sequence. In **Figure 6** the block diagram of the monitoring module is drawn. The module has an interface to the MSC/SPI block. The monitoring of the microcontroller is done by the separate check of the timing with the window watchdog and the logical operation check by the functional watchdog. Therefore the microcontroller must send a window watchdog service command for the window watchdog and four response bytes for the functional check. The results of the checks affect the corresponding counter (window watchdog error counter or functional watchdog pass counter). Additionally a total error counter module is implemented which detects the occurrence of watchdog errors (the timing check or the functional is not passed) and changes the status of the total error counter accordingly.
For the independent functional watchdog and the total error counter a heartbeat is implemented to define the increment timing of both functions.
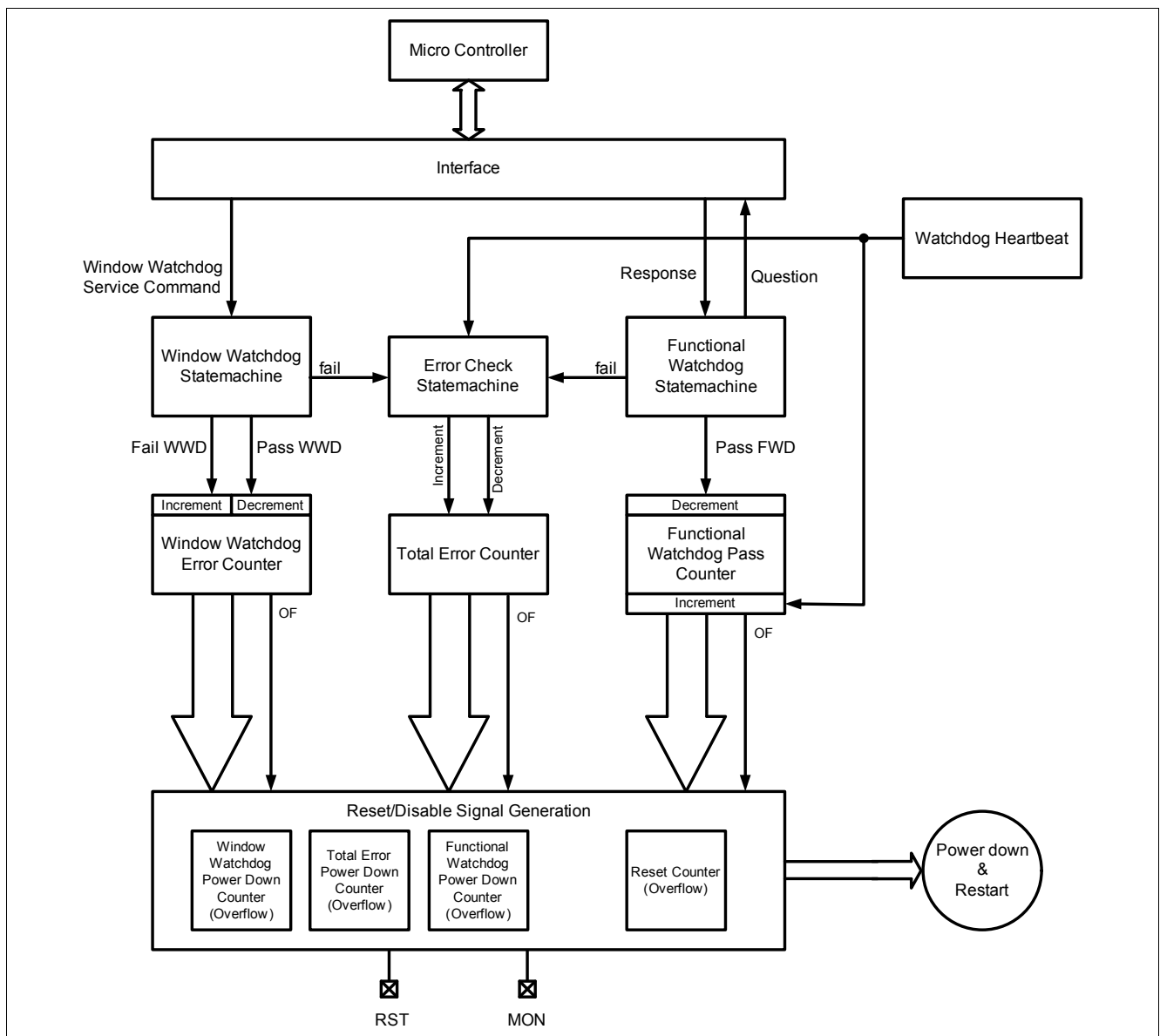
Figure 6   Block diagram of the Monitoring Watchdog Function

Monitoring Watchdog Module (Signature Watchdog)

The status of the counters (window watchdog error counter, functional watchdog pass counter and total error counter) and the corresponding overflow signals are inputs to the watchdog reset, power-down counter and the secure shut off timer. This information is used to affect the operation status of the TLE8888-1QK and the status of the pins *MON* and *RST*.

The software of the microcontroller has to make sure that the program sequence and any safety critical parts of the microcontroller are self tested by performing related routines according to the received questions.

Table 9

Bit Name	Register	Type	Description
General			
WDRES	**OpStat1**	status	reset caused by watchdog (general status bit)
RESC	**WdStat0**	status	reset counter value
SSOTS	**WdStat0**	status	Secure shut off timer start status
WDHBTPRE	**WDHBT0**	status	heartbeat timer pre divider value
WDHBT	**WDHBT1**	status	heartbeat timer value
WDHBTP	**WDConfig0**	configuration	definition of heartbeat period for functional watchdog and total error counter
CANWE	**WDConfig1**	configuration	CAN operation mode during safe state
LINWE	**WDConfig1**	configuration	LIN operation mode during safe state
WDREN	**WDConfig1**	configuration	watchdog reset enable
FWDQG	**WDConfig1**	configuration	Functional watchdog question generation pattern setup
	MSCReadWd0	command	Multi read command for **WdStat0**, **TECStat**, **FWDStat0**, **FWDStat1**, **WdDiag**, **WWDStat**, **WDConfig0** and **WWDConfig0**
	MSCReadWd1	command	Multi read command for **WDHBT0**, **WDHBT1**, **WdStat0** and **WdStat1**
	WDHBTPSyncCmd	command	heartbeat period synchronization command
WDHBTS	**Cmd0**	command	watchdog heartbeat timer sample command
Window Watchdog			
WWDEC	**WWDStat**	status	value of error counter for window watchdog
WWDSCR	**WdStat0**	status	Window watchdog service command received status
WWDPDC	**WdStat0**	status	power-down counter value of window watchdog
WWDECI	**WWDConfig1**	configuration	definition of the increment value of error counter for window watchdog
WWDECD	**WWDConfig1**	configuration	definition of the decrement value of error counter for window watchdog
WWDCWT	**WWDConfig0**	configuration	closed window time
WWDOWT	**WWDConfig0**	configuration	open window time
	WWDServiceCmd	command	window watchdog service command
WWDSCE	**WdDiag**	diagnosis	window watchdog service command too early
WWDTO	**WdDiag**	diagnosis	window watchdog time out

Monitoring Watchdog Module (Signature Watchdog)

Table 9 (cont'd)

Bit Name	Register	Type	Description
WWDRES	**WdDiag**	diagnosis	reset caused by window watchdog
Functional Watchdog			
FWDQUEST	**FWDStat1**	status	question definition
FWDRESPC	**FWDStat1**	status	response counter
FWDPC	**FWDStat0**	status	pass counter value of functional watchdog
FWDPDC	**WdStat1**	status	power-down counter value of functional watchdog
FWDPCI	**FWDConfig**	configuration	definition of the increment value of pass counter for functional watchdog
FWDPCD	**FWDConfig**	configuration	definition of the decrement value of pass counter for functional watchdog
FWDKQ	**WDConfig1**	configuration	Keep question function set up
	FWDRespCmd	command	response write command
	FWDRespSyncCmd	command	response write command with heartbeat synchronization at received response byte 0
FWDREA	**WdDiag**	diagnosis	response error of actual question
FWDREL	**WdDiag**	diagnosis	response error of last answer
FWDRES	**WdDiag**	diagnosis	reset caused by functional watchdog
Total Error Counter			
TEC	**TECStat**	status	total error counter value
TECPDC	**WdStat1**	status	power-down counter value of total error counter part
TECI	**TECConfig**	configuration	definition of the increment value of total error counter
TECD	**TECConfig**	configuration	definition of the decrement value of total error counter
TECRES	**WdDiag**	diagnosis	reset caused by total error counter

6.1 Window Watchdog

For the timing check the microcontroller has to send periodically the window watchdog service command **WWDServiceCmd**. The window watchdog is triggered correctly if the command is received inside the open window of the window watchdog sequence. The check result is used to change the value of the window watchdog error counter. If the check is passed the counter will be decremented and for errors it will be incremented. Additionally a write access to configuration register **WWDConfig0** causes also an incrementation of the window watchdog error counter. The incrementation of the window watchdog error counter (error is occurred) is an input for the total error counter (**Chapter 6.3**). In **Figure 7** the state machine of the window watchdog is shown.

The values for incrementation or decrementation can be set in the configuration register **WWDConfig1**. The window watchdog error counter is a 6 bit counter. The influence of the counter values to the operation behavior is shown in **Table 11** and **Table 12**.

The window watchdog sequence for the timing check consists of a closed window followed by an open window (see **Figure 8**). A watchdog sequence starts with:

- the release of a reset of the monitoring module (see **Table 5** and **Table 6** in **Chapter 5.2**)

- a window watchdog service command

Monitoring Watchdog Module (Signature Watchdog)

- a write to the window time configuration register **WWDConfig0**

- a timer overflow of the watchdog timer

In **Figure 8** the two parts of one watchdog sequence are shown. After the power on reset it is running in an endless loop with the defined time for the open and closed window. It is only stopped at active reset signals or outside normal operating conditions **Table 5** and **Table 6** in **Chapter 5.2**.

The timing of the window watchdog sequence can be set with a write command to the configuration register **WWDConfig0** or directly with the data bits of the **WWDServiceCmd**. With a write access to the configuration register **WWDConfig0** the watchdog window sequence is started and the window watchdog error counter is incremented.

The check is passed if the command is received inside the open window. A command send too early or a missing command leads to an error. In the diagnosis register **WdDiag** the bit **WWDSCE** signalizes a window watchdog service command received too early and the bit **WWDTO** signalizes a time out (no window watchdog service command received before end of open window) of the last sequence. The diagnosis information is not cleared with the read out.

The bit **WWDSCR** in the status register **WdStat0** signalizes a received window watchdog service command at the last watchdog sequence. The reset of this bit is done with a readout of the bit or with the window watchdog time-out.
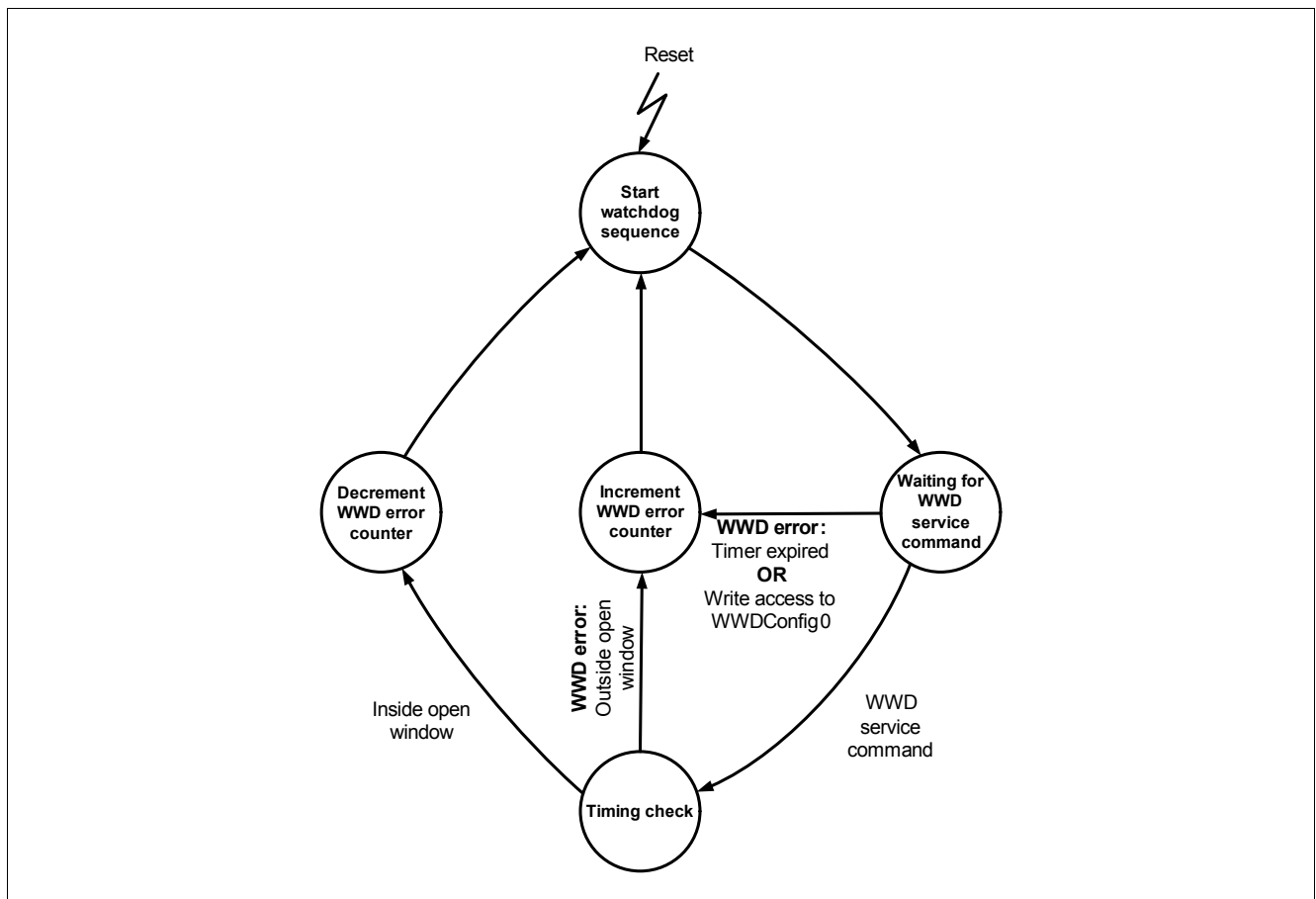
Figure 7   State Diagram of the Window Watchdog Module
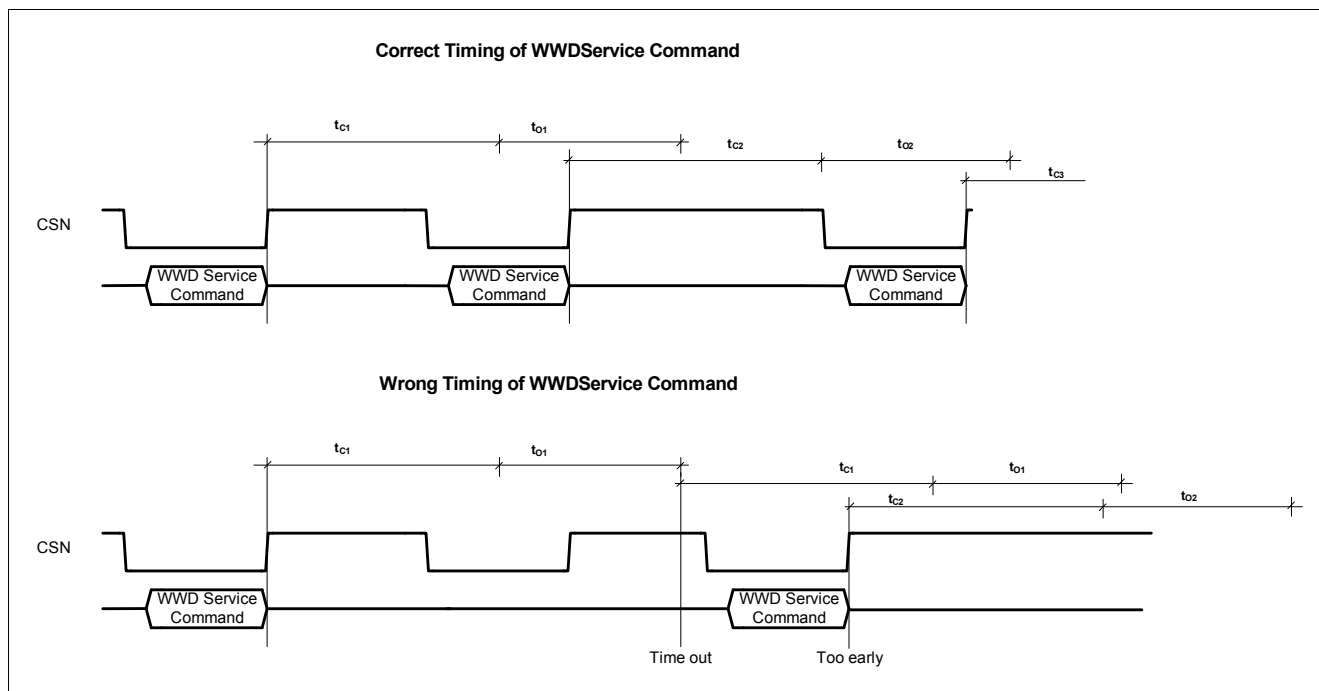
Figure 8   Watchdog Sequence Timing

6.2   Functional Watchdog

For the functional check the microcontroller has to send with the commands **FWDRespCmd** (functional watchdog response command) or **FWDRespSyncCmd** (functional watchdog response and synchronisation command) the right four response bytes to the actual question defined by the TLE8888-1QK. The response bytes are checked for correctness.

A pass of the check triggers a decrement of the functional watchdog pass counter. A functional watchdog error (FWD error) is not affecting the functional watchdog pass counter but it is used for the total error counter as an input signal (see **Chapter 6.3**). A FWD error is defined as:

- received response byte 0 with **FWDRespCmd** and minimum one of the response bytes are wrong
- received response byte 0 with **FWDRespSyncCmd** and minimum one of the response bytes are wrong
- the watchdog heartbeat timer period synchronisation command **WDHBTPSyncCmd** is received

In the diagnosis register **WdDiag** the bit **FWDREA** signalizes an error of the received response bytes to the actual question and the bit **FWDREL** signalizes an error of the response bytes of the last answer. With a read out the diagnosis bits are not cleared.

To detect that the functional check is missing a heartbeat is implemented. With an heartbeat event the functional watchdog pass counter is incremented. An heartbeat event occurs:

- with expiring of the heartbeat period timer or
- with receiving the watchdog heartbeat period synchronisation command **WDHBTPSyncCmd** (response counter is also reset) or
- with receiving the functional watchdog response and synchronisation command **FWDRespSyncCmd** if response byte 0 is received

The heartbeat period can be set by a write access to the configuration register **WDConfig0** or by the watchdog heartbeat period synchronisation command **WDHBTPSyncCmd**. If the data is $000\ 0000_B$ the value of the

heartbeat period is not changed.
Behavior of the heartbeat period in case of changing the period time:

- **WDHBTPSyncCmd**: the response counter and the heartbeat timer are reset and a heartbeat event is triggered, the new value of the period is executed with next period.

- write access to the configuration register **WDConfig0**: the new value of the period is effective after the write command. If the new value is lower than the actual heartbeat timer value then the heartbeat event is immediately triggered otherwise the actual period length is immediately changed to the new value.

The functional watchdog pass counter is a six bit counter (see status register **FWDStat0**). The values for incrementation or decrementation can be set in the configuration register **FWDConfig**. The influence of the counter values to the operation behavior is shown in **Table 11** and **Table 12**.

In **Figure 9** the state machine of the functional watchdog is shown. There are two possible principles available to serve the function watchdog:

- unsynchronized heartbeat and use of functional watchdog response command **FWDRespCmd** and write access to the configuration register **WDConfig0** to change the heartbeat period time or

- heartbeat is started with receiving the functional watchdog response and synchronisation command **FWDRespSyncCmd** and use of the watchdog heartbeat period synchronisation command **WDHBTPSyncCmd** for changing the heartbeat period

The commands can be used in all possible combinations without restrictions. Using **FWDRespCmd** has the advantage that with fast correct responses the decrement of the functional watchdog pass counter can be speed up.

The bit **FWDKQ** in the configuration register **WDConfig1** is used to enable the keep question function for the functional watchdog. If the bit is set in case of a passed functional check the next functional check procedure is done with the same question if minimum one of the bits **WWDSCE** or **WWDTO** is set (window watchdog error).
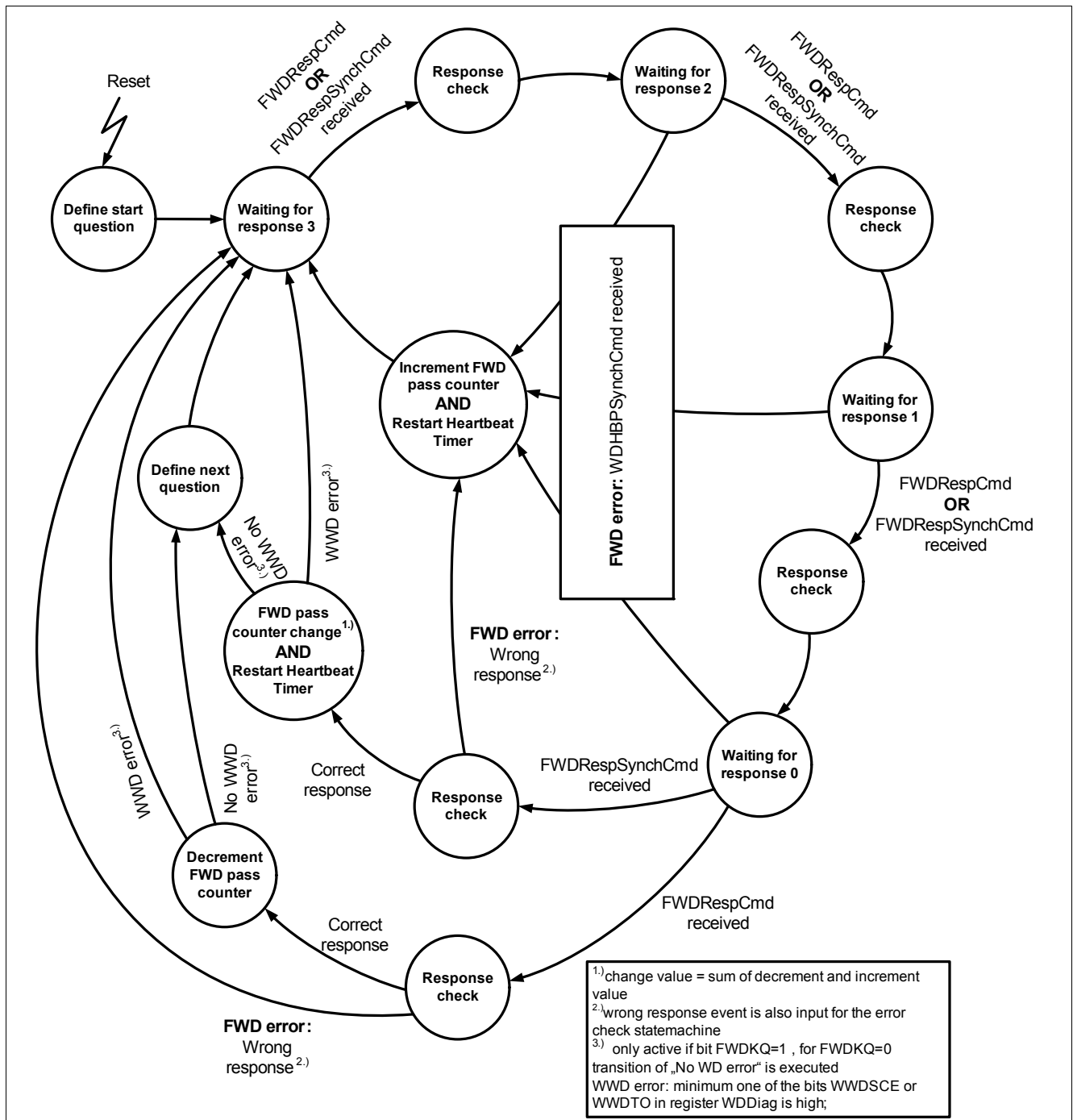
Figure 9   Functional Watchdog State diagram

6.2.1   Question and Response Definition

The bits **FWDQUEST** in the watchdog status register **FWDStat1** represent the actual valid question.
The reset value is 0000_B and it will be changed regarding the definition of the state machine for the monitoring module (see **Figure 7**). The expected response is shown in **Table 10**. The answer of the microcontroller is done by a write access to the command registers **FWDRespCmd** or **FWDRespSyncCmd**.
The actual value of the bits **FWDRESPC** in the watchdog status register **FWDStat1** defines the interpretation of the 8 bit content of these commands as RESP3 to RESP0 (definition see **FWDRESPC**).

The definition of the next question is done with a pseudo random algorithm. With the bit **FWDQG** in the configuration register **WDConfig1** the generation algorithm for the questions is defined. There are two settings:

- question pattern length 16: 16 question repeated every 16th watchdog sequence with a minimum hamming distance of 3
- question pattern length 256: every 256 question the order of the 16 questions is repeated, minimum hamming distance is 1

Table 10   Questions and related Response

QUEST[3:0]	RESP3	RESP2	RESP1	RESP0
0	FF	0F	F0	00
1	B0	40	BF	4F
2	E9	19	E6	16
3	A6	56	A9	59
4	75	85	7A	8A
5	3A	CA	35	C5
6	63	93	6C	9C
7	2C	DC	23	D3
8	D2	22	DD	2D
9	9D	6D	92	62
A	C4	34	CB	3B
B	8B	7B	84	74
C	58	A8	57	A7
D	17	E7	18	E8
E	4E	BE	41	B1
F	01	F1	0E	FE

6.3   Total Error Counter Module

The total error module is used to count the errors of the window watchdog and the functional watchdog. In **Figure 10** the error check state machine is shown. If a watchdog error of the functional or the window watchdog occurs the state machine enters the state "error occurred" and with the next heartbeat event (definition see **Chapter 6.2**) the total error counter is incremented.

The counter is also incremented if a functional watchdog error or at the same time a window watchdog error occurs by using the **FWDRespSyncCmd**. With the **WDHBTPSyncCmd** always an increment of the total error counter is done. A decrement of the total error counter is only possible by using the **FWDRespSyncCmd** and no errors are occurred.

The decrement and increment value of the total error counter can be set with the configuration register **TECConfig**. The status of the total error counter is available in the status register **TECStat**.
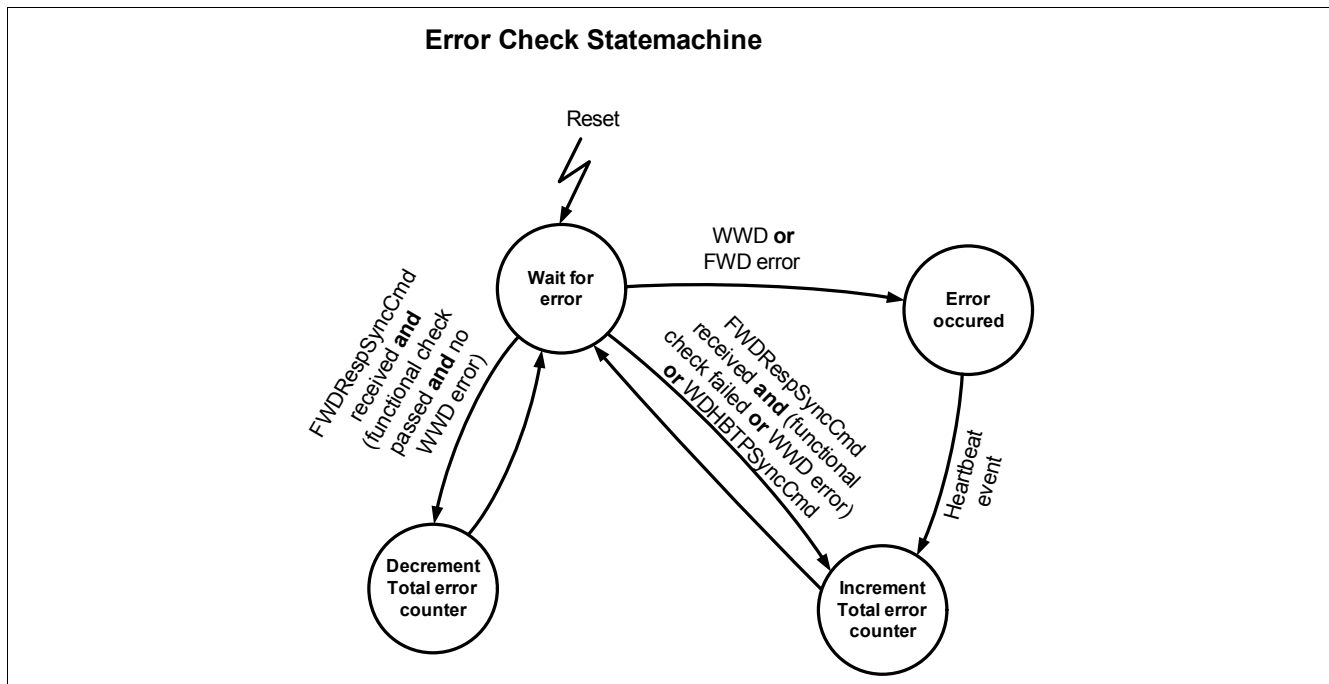
Figure 10   State diagram of the Error check State machine for the Total Error Counter Module

6.4   Watchdog Reset Counter

The watchdog reset counter is a three bit counter (bits **RESC** in **WdStat0**) and is triggered by an overflow of one of the three counters of the monitoring functions (see **Figure 11**). The reset counter can only be incremented by 1. Each time the watchdog reset counter changes the value a watchdog reset occurs depending on the status of watchdog reset enable bit **WDREN** in the configuration register **WDConfig1**. The counter stops counting if **WDREN** = "0" or at full scale. There are no further resets if full scale is reached. The behavior at the different reset conditions is defined in **Chapter 5.2 Table 5** and **Table 6**.

6.5   Power-Down Counter

There are three power-down counters with three bits implemented. The window watchdog power-down counter (bits **WWDPDC** in status register **WdStat0**) is triggered by an overflow of the window watchdog error counter, the functional watchdog power-down counter (bits **FWDPDC** in status register **WdStat1**) is triggered by an overflow of the functional watchdog pass counter and the total error power-down counter (bits **TECPDC** in status register **WdStat1**) is triggered by an overflow of the total error counter (see **Figure 11**).

If a trigger occurs the dedicated power-down counter is incremented by 1. Additionally all three power-down counters are incremented by 1 if a software reset occurs. The power-down counters are reset if the ready state is reached (see **Table 11** and **Table 12**).

With an overflow of minimum one of the three power-down counters a power-down of the TLE8888-1QK is performed if *KEY* is "low" (see **Chapter 5.1**). This function can not be disabled. The behavior at the different reset conditions is defined in **Chapter 5.2 Table 5** and **Table 6**.

6.6   Secure Shut Off Timer

The secure shut off timer (SSOT) is reset with *KEY* = 1 and the timer starts with an overflow of one of the three counters of the monitoring functions (see **Figure 11**) if it is enabled with *KEY* = 0. If the timer is expired after the **Secure shut off time** a power-down of the TLE8888-1QK is performed (see **Chapter 5.1**).The behavior at the different reset conditions is defined in **Chapter 5.2 Table 5** and **Table 6**.

6.7 Operation State Definition and Reset Generation

The values of the three counter of the monitoring module are affecting the operation state of the TLE8888-1QK. There are three states defined:

- the safe state: this is the reset state. The bits **O1E** to **O24E** and **IGN1E** to **IGN4E** in the configuration register **OEConfig0** to **OEConfig3** are set to "0" to ensure that all actuators are switched off.

- ready state: the device can be operated without restrictions.

- watchdog reset: a reset is performed according the definition in **Table 5** and **Table 6**.

The definition of the three states is shown in **Table 11**. The states are affecting the status of the pins *MON* and *RST*, the power-down counter, the secure shut off timer and the reset counter (definition see **Table 12**).

Table 11   Definition of Reset, Safe and Ready State

Safe State	$WWDEC>32_D$ **OR** $FWDPC >32_D$ **OR** $TEC>32_D$
Ready State	$WWDEC<33_D$ **AND** $FWDPC<33_D$ **AND** $TEC<33_D$
Watchdog Reset	WWDEC overflow **OR** FWDPC overflow **OR** TEC overflow (for all counters $>63_D$)

Table 12   System Reaction to the watchdog status

	Ready State	Safe State	Watchdog Reset
RST	1	1	0[1]
MON	1	0	0
Power stages	no influence of normal operation	disabled	disabled
O1E to **O24E**, **IGN1E** to **IGN4E**	X	0	0
WWD error counter FWD pass counter Total error counter	no effect	no effect	reset[1]
Reset counter	no effect	no effect	increment by 1
Window watchdog power-down counter Total error power-down counter Functional watchdog power-down	reset	no effect	increment by 1 regarding the overflow source
Secure shut off timer	no effect	no effect	start of timer with the first overflow if *KEY* = 0

1) occurs for the defined reset time if watchdog reset is enabled

Monitoring Watchdog Module (Signature Watchdog)
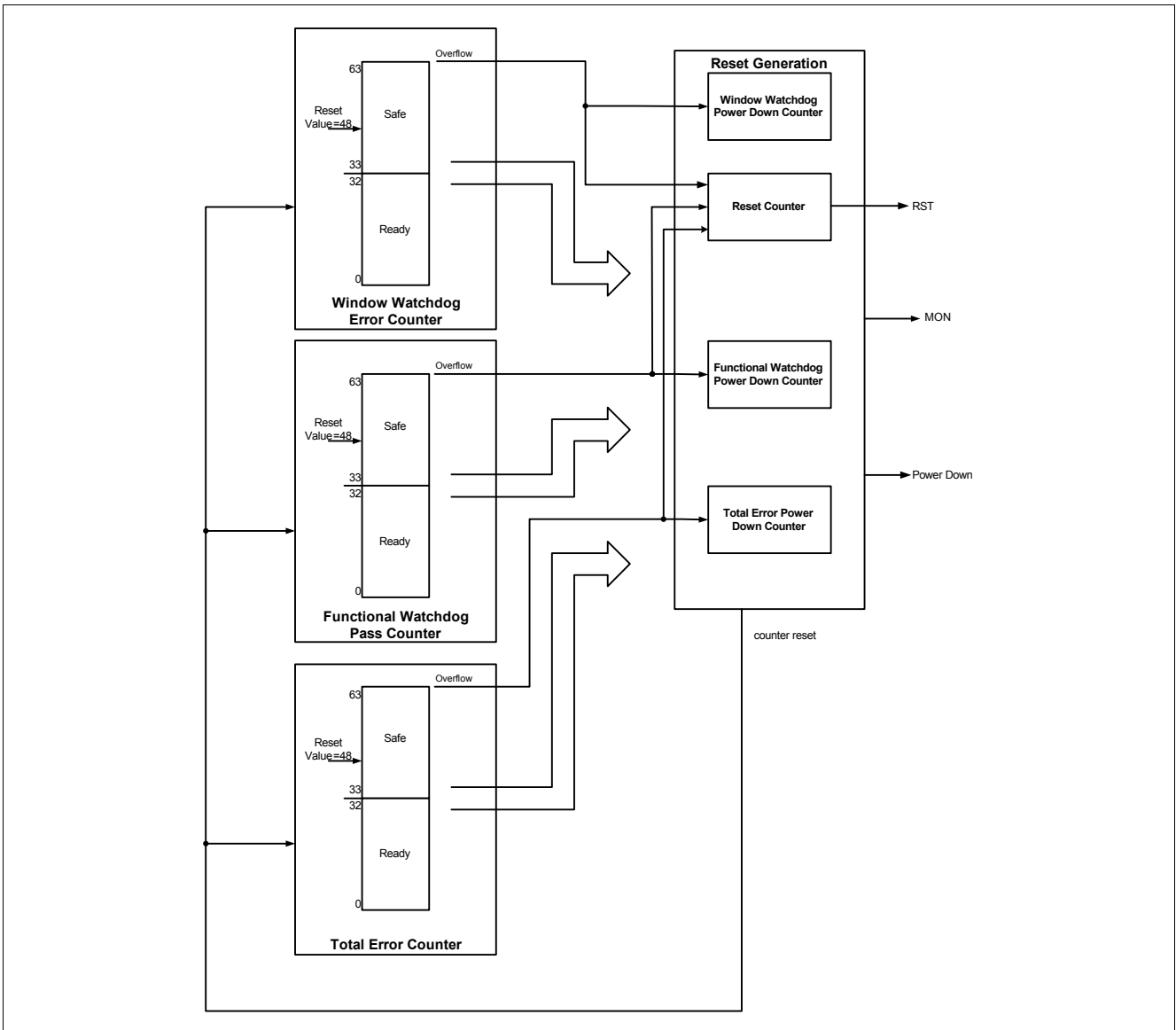
Figure 11   Block diagram of the Reset Generation

Behavior of the WWD error counter, the FWD pass counters and the total error counter in case of over and underflow:

The counters are designed to keep the same value:

• at incrementation if the new counter value is higher than the full scale value of the counter and

• at decrementation if the new counter value is lower than zero.

In **Figure 12** an example is shown.
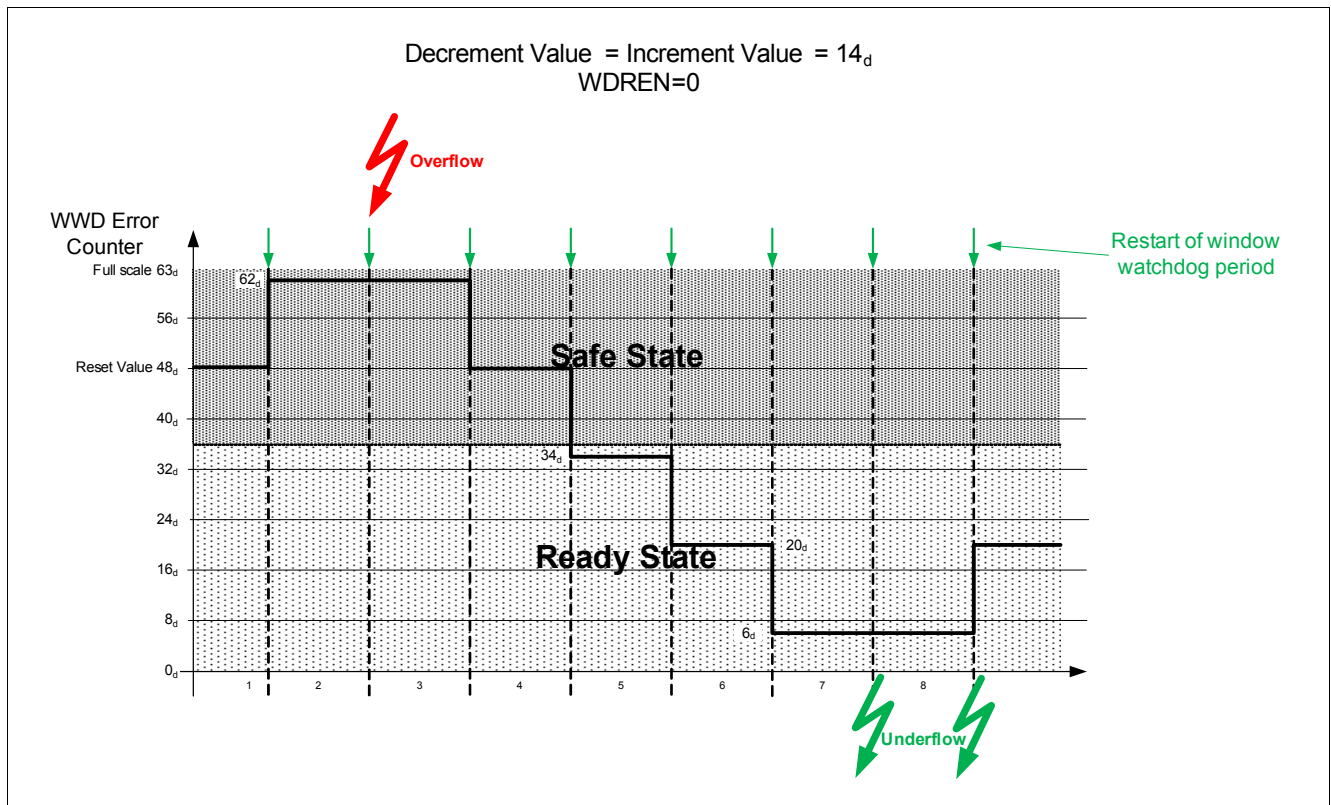
Figure 12   Example of WWD error counter behavior with decrement and increment value of 14d

6.8   Synchronisation of Window Watchdog Sequence and Heartbeat

In **Figure 13** the relation between the heartbeat clock generation, the total error counter and the window watchdog sequence generation is shown. The window watchdog sequence generation and the heartbeat period generation have the same clock base with the accuracy of **tw,a**.

The value of the pre-divider and the heartbeat timer can be read out with the status registers **WDHBT0** and **WDHBT1**. This can be used to measure the actual internal clock frequency. Therefore the value of the pre-divider and the heartbeat period counter must be sampled by sending a **Cmd0** command with an activated **WDHBTS** bit. With this command the value of the two registers are stored in the related status registers and the readout can be done.

With two sampled values the microcontroller can correct the time information by the value of the actual frequency of the TLE8888-1QK. With such a correction of the microcontroller timing check it is possible to use smaller open window times to improve the performance of the timing check. Additional it is possible to use this information for synchronization purpose for the check of the monitoring function of the TLE8888-1QK inside the microcontroller.

Monitoring Watchdog Module (Signature Watchdog)
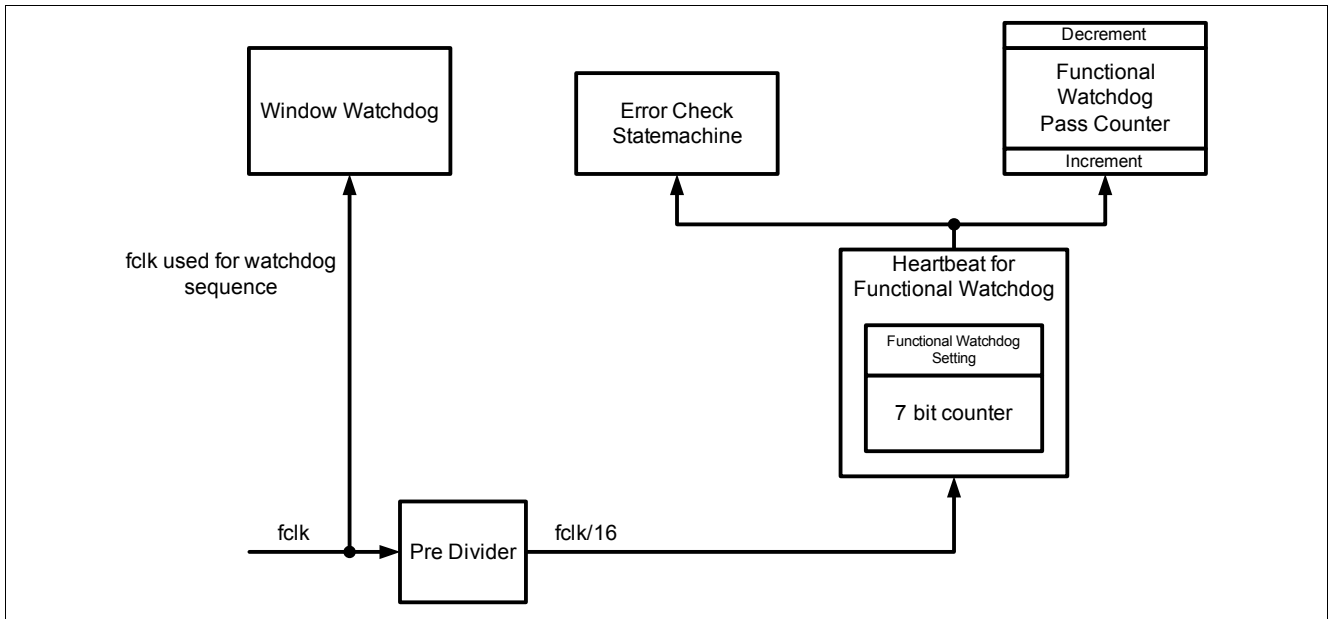
Figure 13   Clock Generation for the Watchdog Module

6.9 Electrical Characteristics Monitoring Watchdog Module

Table 13 Electrical Characteristics: Monitoring Watchdog Module

V_S = 13.5 V, V_{VSV} = 5 V, T_j = -40°C to +150°C, all voltages with respect to ground, positive current flowing into pin (unless otherwise specified)

Parameter	Symbol	Values			Unit	Note or Test Condition	Number
		Min.	Typ.	Max.			
Window watchdog closed window time	$t_{WWD,ct}$	1.6	–	100.8	ms	63 values	P_6.8.1
Window watchdog closed window time step	$t_{WWD,ct}$	–	1.6	–	ms	–	P_6.8.2
Window watchdog open window time 1	$t_{WWD,ot1}$	–	3.2	–	ms		P_6.9.1
Window watchdog open window time 2	$t_{WWD,ot2}$	–	6.4	–	ms		P_6.9.2
Window watchdog open window time 3	$t_{WWD,ot3}$	–	9.6	–	ms		P_6.9.3
Window watchdog open window time 4	$t_{WWD,ot4}$	–	12.8	–	ms	–	P_6.8.3
Clock frequency accuracy for window watchdog sequence and heartbeat	$t_{w,a}$	-5	–	+5	%	–	P_6.8.4
Heartbeat time period	$t_{HBT,pt}$	1.6	–	203.2	ms	127 values	P_6.9.4
Secure shut off time	t_{SSOT}	18	20	22	min	–	P_6.8.5

7 Wake-Up Detection and Main Relay Driver

The TLE8888-1QK integrates a complex wake-up functionality with two wake-up pins (*KEY* and *WK*), engine off timer, CAN wake-up and the main relay driver. There are several possibilities to initiate the start up of the device:

- a positive voltage at the pin *KEY* or at the pin *WK*
- a dominant pulse at the CAN inputs *CANH* and *CANL* for the wake-up time (description see **Chapter 12**)
- after expiration of the defined time of the engine off timer in comparator mode

With minimum one valid wake-up signal the pre regulator and the main supply start the ramping up due to voltage at the battery supply pin *BAT* and the drain of the external MOSFET of the pre regulator. The switch on of the main relay depends on the wake-up signal and the voltage level at the pin *BAT*. For a wake signal from the pin *KEY* the main relay is always switched on. For the other cases the main relay is only switched on if the voltage of the pin *BAT* is below the detection threshold.

With the bit **WKCLR** in the command register **Cmd0** the internal status of the detection at pin *WK*, engine off timer and CAN wake-up are reset (description see **Chapter 7.2**, **Chapter 7.4** and **Chapter 12.2.4**). The supply for the engine off timer and the CAN wake receiver is *V5VSTBY*.
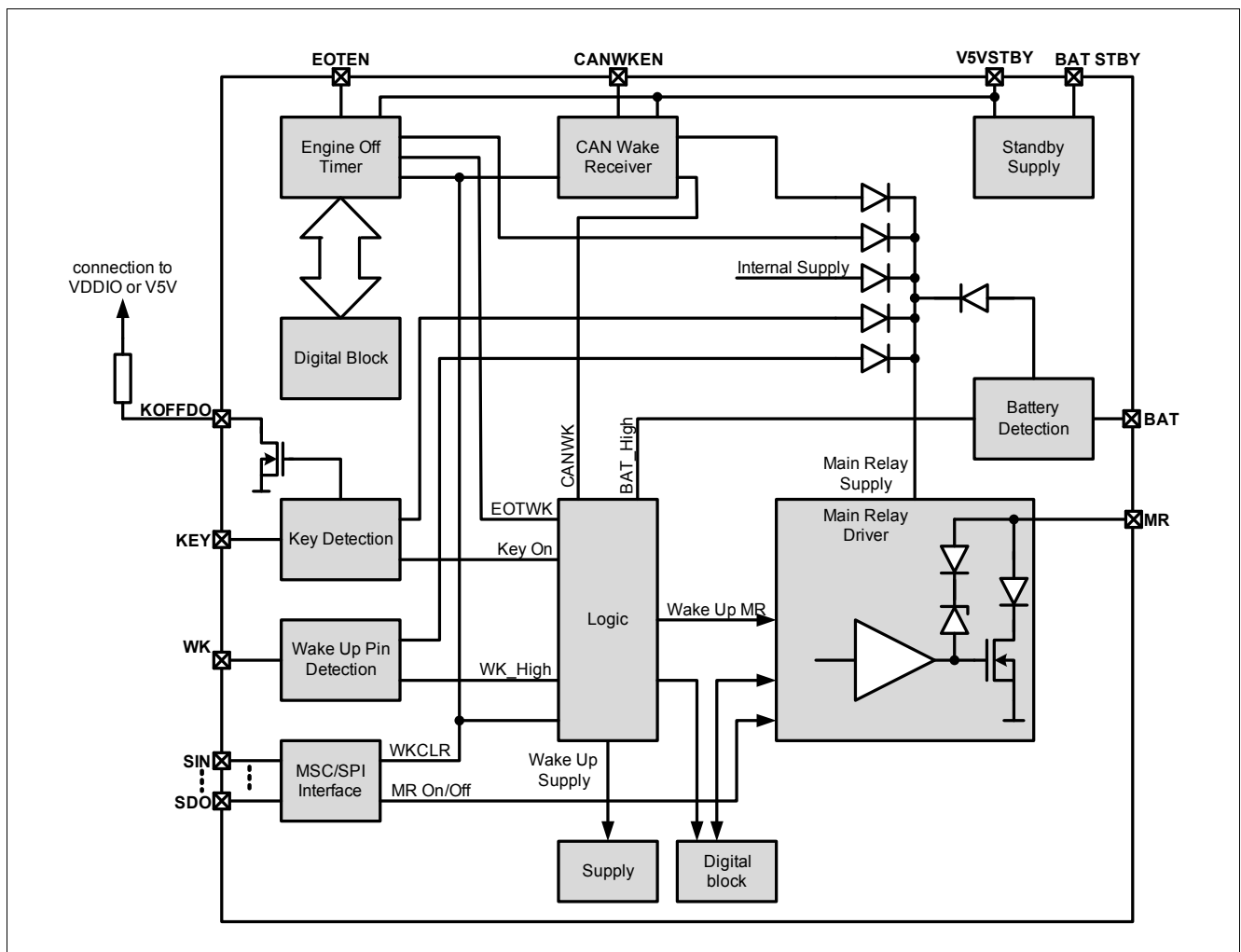
Figure 14   Block Diagram of the Key Detection, Wake-up Detection and Main Relay Driver

Table 14   Switching Behavior of Main Relay at Start Up (Transition ECU Sleep to Supply Ramp Up Mode)

KEY = 0, *WK* = EOTWK = CANWK= 0	-	*MR* is switched off	Supply is off
KEY = 1, *WK* = EOTWK = CANWK= X	-	*MR* is switched on	Supply is switched on
KEY = 0, *WK* or EOTWK or CANWK = 1	$BAT < V_{BAT,th}$	*MR* is switched on	
KEY = 0, *WK* or EOTWK or CANWK= 1	$BAT > V_{BAT,th}$	*MR* is switched off	

7.1   Wake-up Detection by Pin *KEY* and Key Off Delay

The input pin *KEY* is implemented to detect the status of the key switch in the car. With a high signal the start up of the TLE8888-1QK is initiated. During start up the implemented circuitry provides also the supply for switching the main relay. A deglitch filter is implemented to be robust against disturbances (see **Figure 16**). After ramp up the supply of the main relay is provided by the internal supply. To provide a direct access from the *KEY* signal to actuators a key off delay function is implemented.
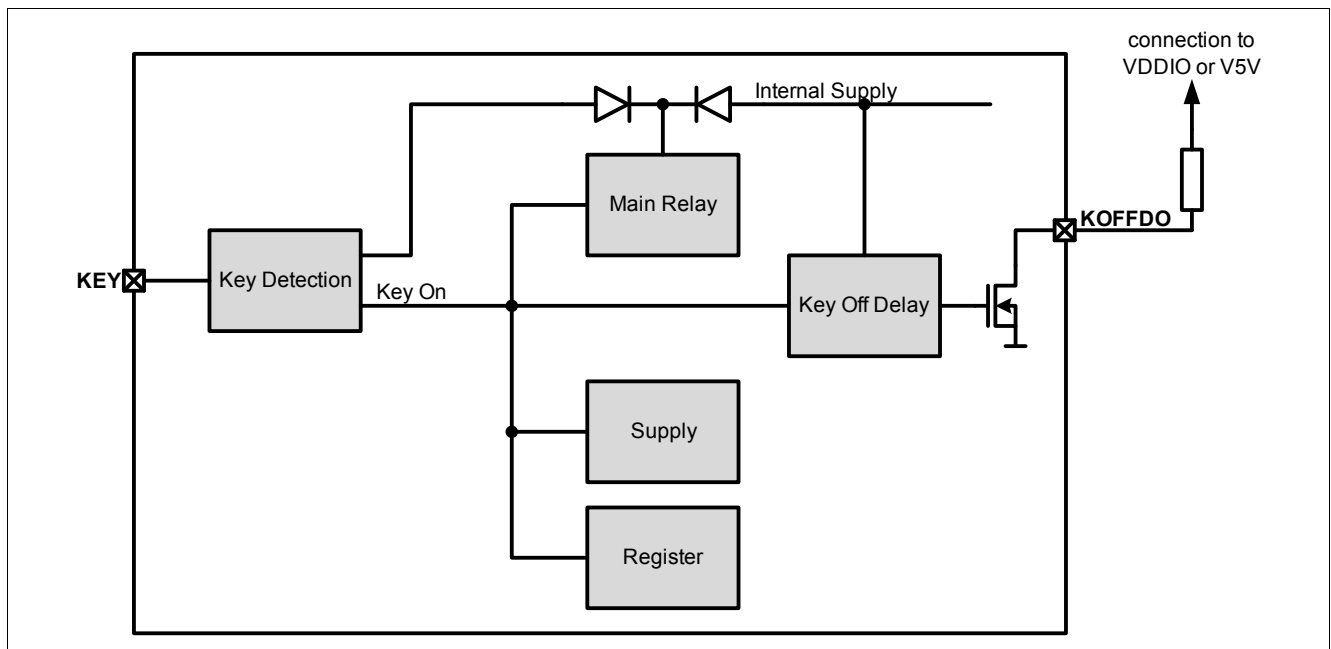
Figure 15   Block Diagram of the Key Detection

In **Figure 16** the effect of the filter time is shown. The status of the pin *KEY* including the filter time is reflected in bit **KEY** in the status register **OpStat0**.
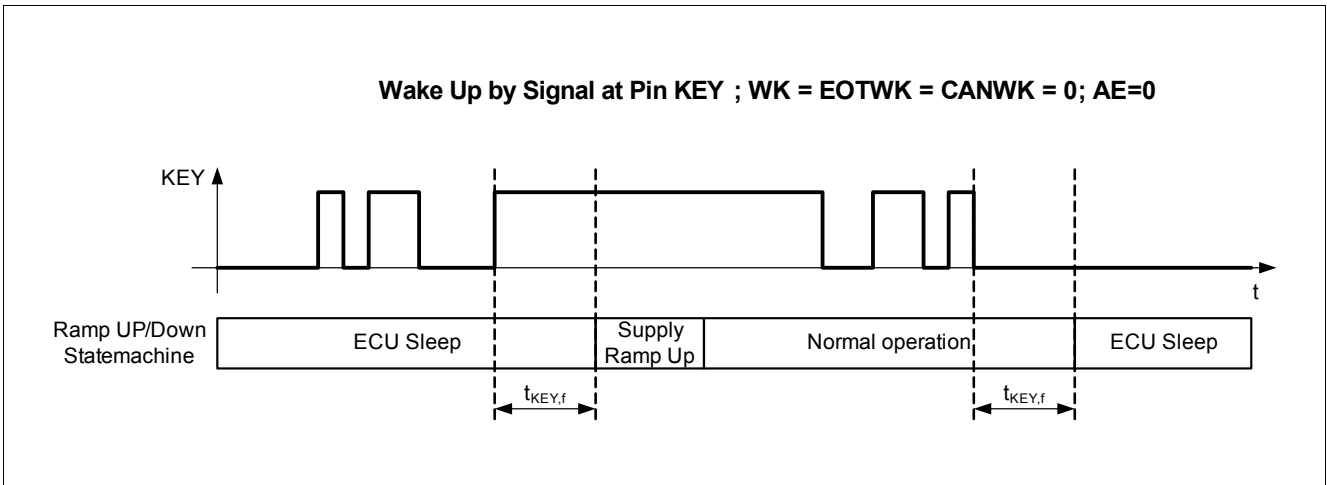
Figure 16   Function of Key detection filter time

The key off delay function provides the *KEY* signal at the open drain output *KOFFDO*. The positive edge is delayed by the **Key Detection Filter Time** and the negative edge by the **Key Off Delay Time 1** to **Key Off Delay Time 4** (according setup of the bits **KOD** in register **OpConfig0**) if the supply is available.
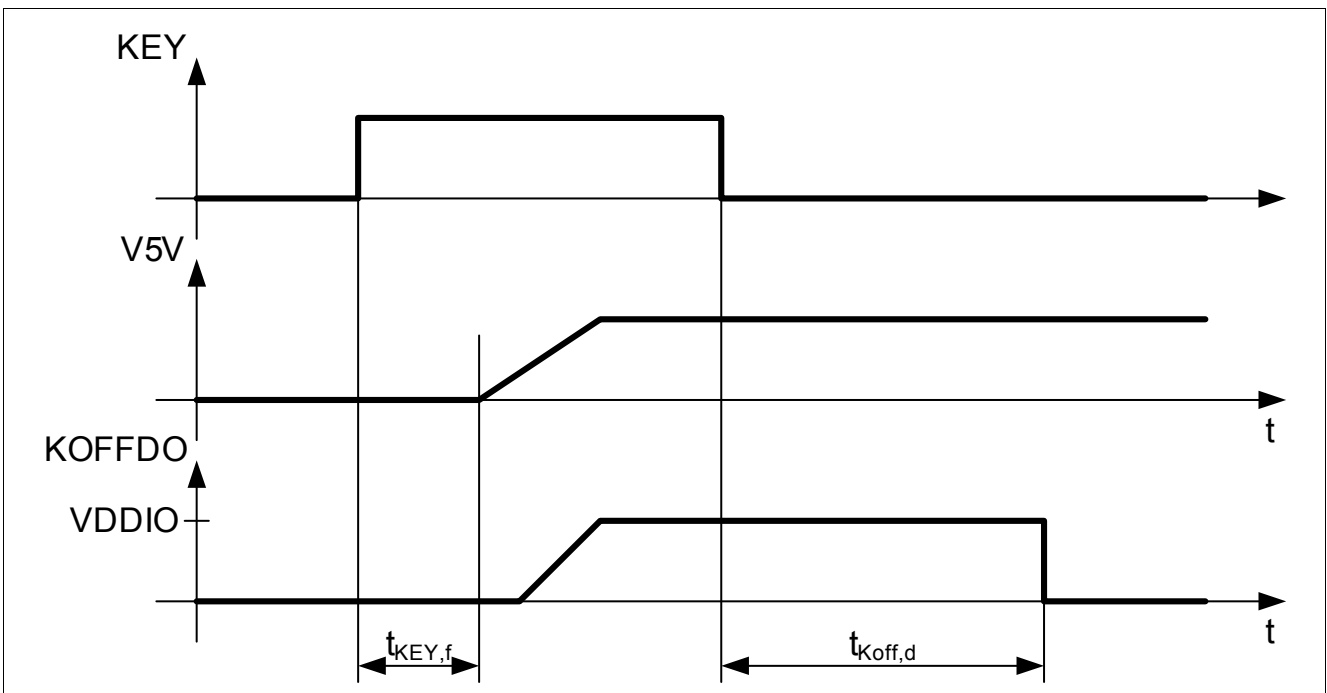
Figure 17   Timing Diagram of the Key Off Delay

7.2   Wake-up Detection by Pin *WK*

The pin *WK* is used e.g. for an external CAN device with wake-up function on the ECU. With a high signal the start up of the TLE8888-1QK is initiated. During ramp up the supply for the main relay circuit is provided by the active wake-up pin *WK*. After ramp up the supply of the main relay circuit is provided by the internal supply. In **Figure 18** the block diagram of the wake-up detection by pin *WK* is shown.
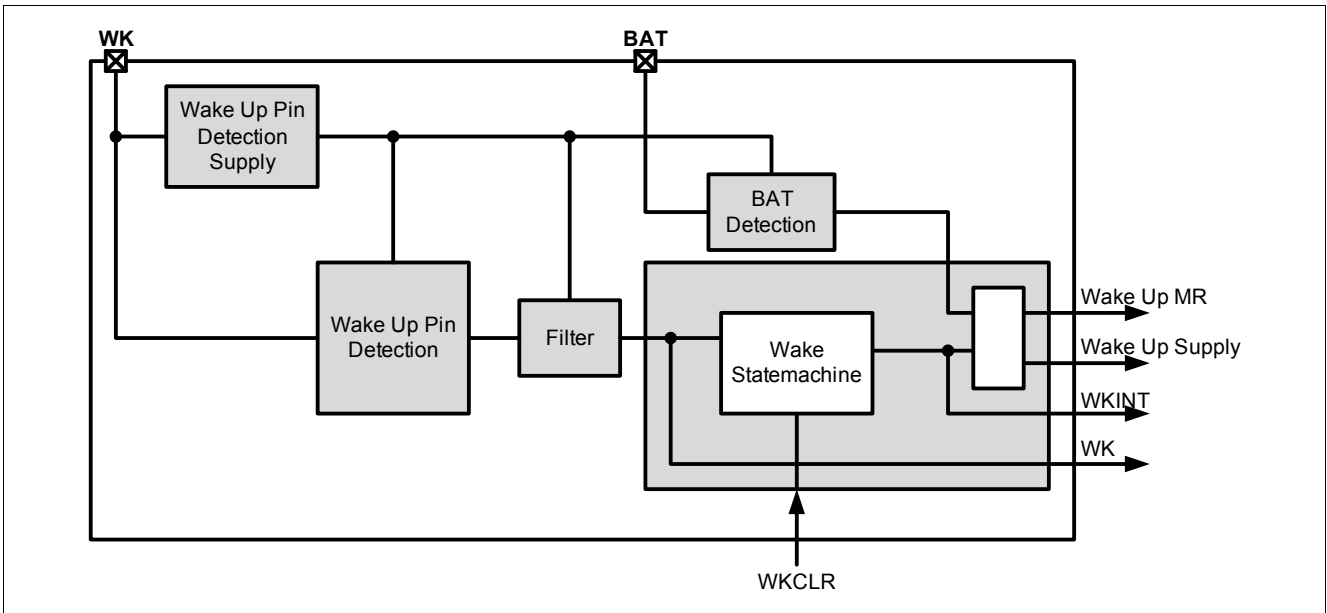
Figure 18   Block Diagram of the Wake-up Detection

For wake-up by pin *WK* special functions are implemented.

- main relay is switched on depending on the voltage level at pin *BAT* (see **Table 14**)
- power-down procedure in case of a permanent WK = "1" and a blocked micro-controller (see description in **Chapter 5.1 Operation States**)
- wake clear bit **WKCLR** in the command register **Cmd0** to clear the internal wake-up signal in case of permanent WK = "1" signal
- deglitch filter of $t_{WK,f}$ for positive and negative edge at pin *WK*

In **Figure 19** the effect of the filter time is shown. The status of the pin *WK* including the filter time is reflected in bit **WK** in the status register **OpStat0**.
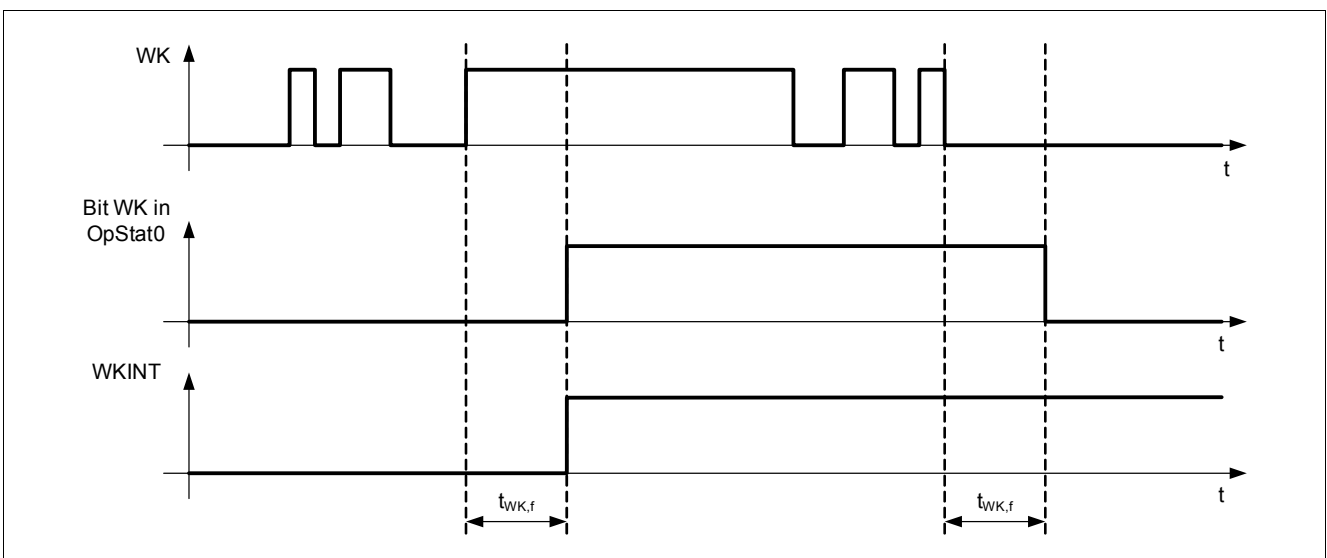
Figure 19   Function of WK detection filter time

To realize the power-down procedure an internal wake-up signal WKINT is used (status see bit **WKINT** in the status register **OpStat0**). In **Figure 20** the state diagram of the internal wake signal generation is shown. With

a positive edge at pin *WK* the internal signal WKINT is set to "1" and a wake-up is triggered. With a wake-up clear command (set bit **WKCLR** to "1" in command register **Cmd0**) WKINT is reset (see **Figure 22**). The next wake-up by pin *WK* is only detected with a positive edge at pin *WK*. A permanent high level at pin *WK* doesn't lead to permanent wake-up situation. Details of the operation behavior see **Chapter 5.1 Operation States**.
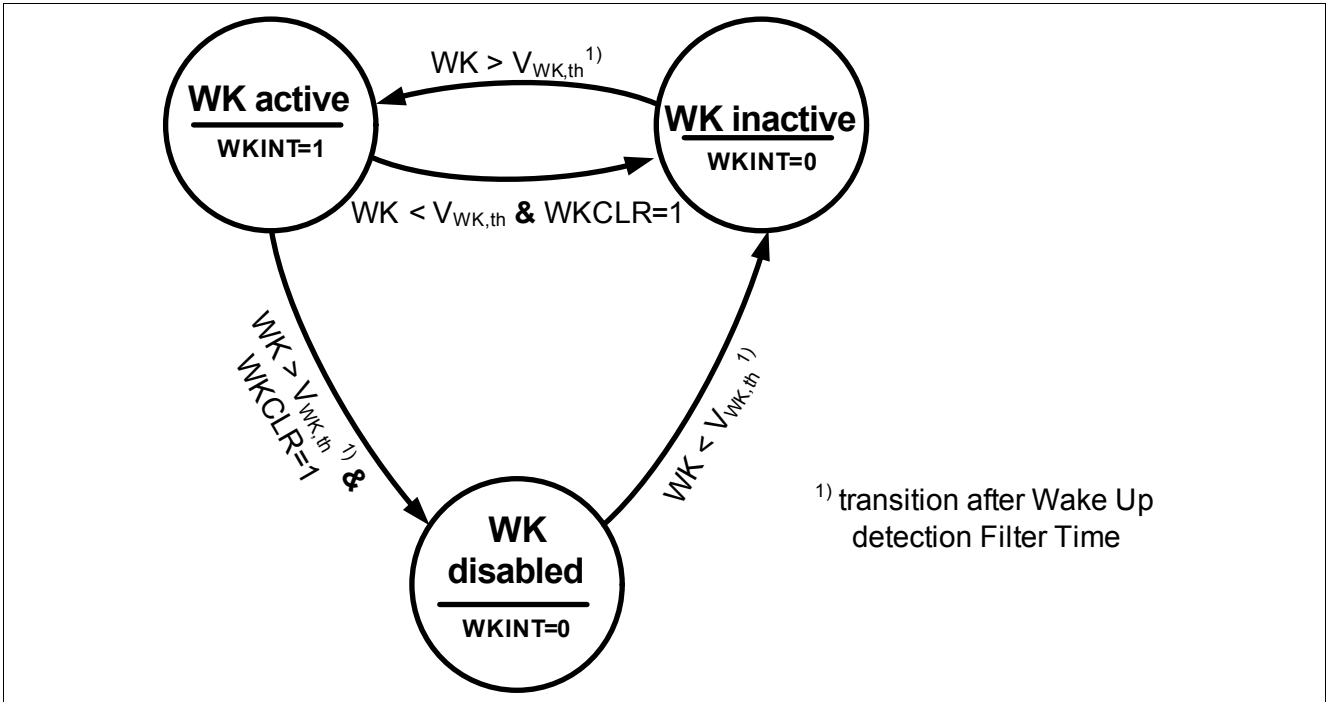
Figure 20   State Diagram of the Wake State Machine for Internal Wake Signal

At the beginning of the functional diagram of **Figure 21** a normal wake-up sequence with a wake signal of the pin *WK* is shown. In the second part of the diagram the signal of pin *WK* stick at high (e.g. short to battery) and the microcontroller must send a wake clear command (bit **WKCLR** = 1 in command register **Cmd0**) for entering the ECU sleep mode. With a low at pin *WK* the wake state machine is set to the state "WK inactive" and a wake-up by pin *WK* is enabled.
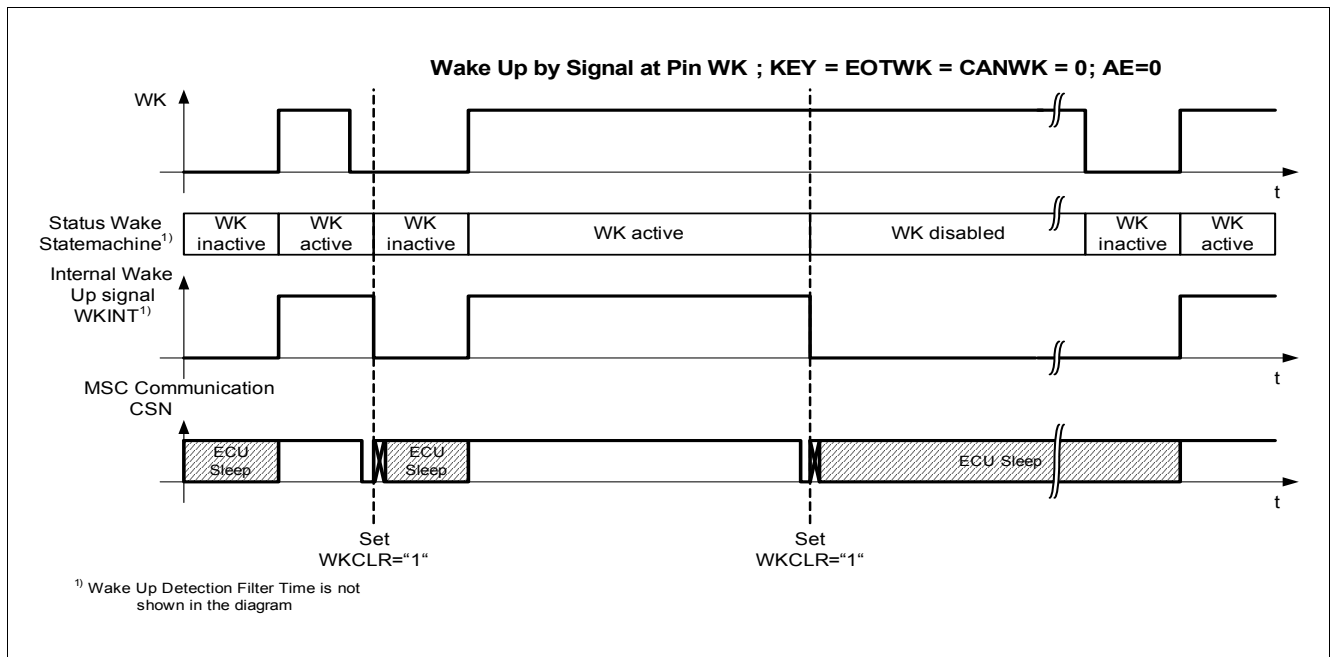
Figure 21   Functional Diagram for Internal Wake Signal
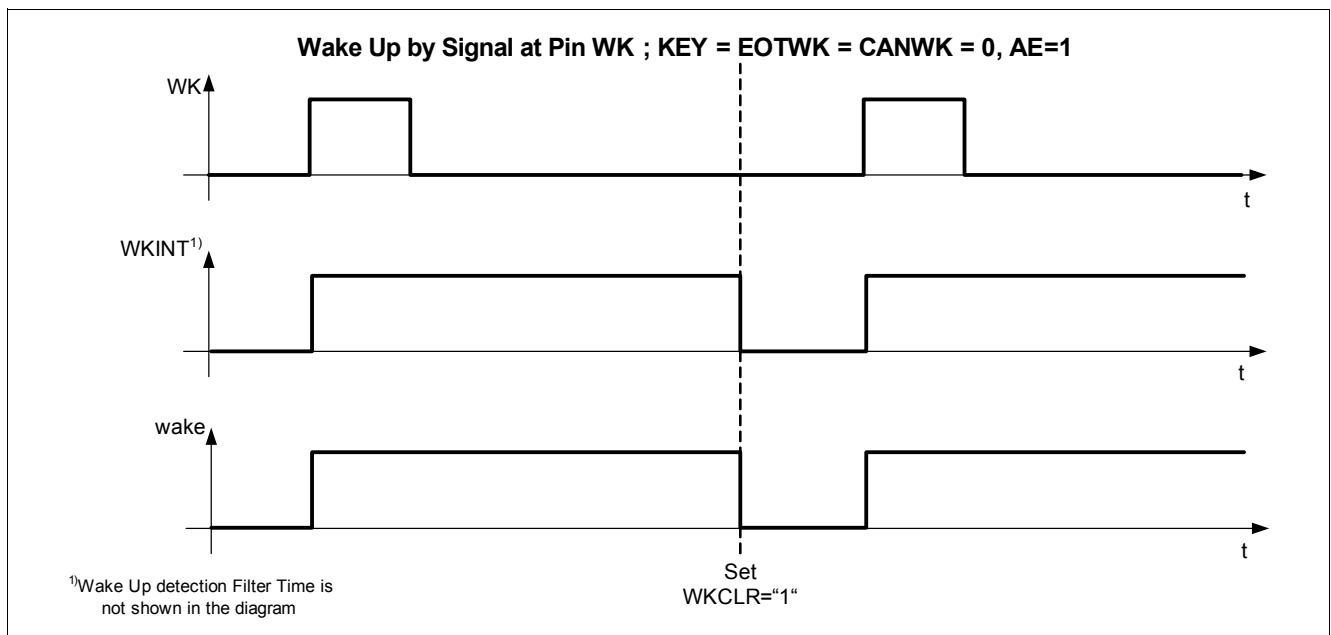
Figure 22   Functional Diagram of Detection of Two Internal Wake Signals

7.3   Main Relay Driver

The main relay driver is designed to switch on the main relay of engine management applications. It integrates a reverse protected low-side switch with active clamping freewheeling. The output is protected against overload with an overtemperature detection and an overcurrent protection circuit. At low battery voltage (*V5V* main supply is below undervoltage detection threshold e.g. during cranking) the main relay stays on. The on resistance is related to the supply voltage at pin *BAT* and is defined down to 4.5 V.

The main relay is automatically switched on with a wake-up signal according to **Table 14**. The main relay is normally switched off automatically according the power-down procedure defined in **Chapter 5**.

With write access to the command bit **MRON** of the command register **Cmd0** the main relay can be switched

additionally by MSC/SPI control according to the status of *KEY*, *WK*, EOTWK and CANWK (see **Table 15**). The status of the main relay is available in the status register **OpStat0** bit **MR**.

Table 15   Effect of MSC/SPI Write Command Bit MRON

KEY = 0, *WK* = EOTWK = CANWK = X	*MR* is switched according to write command
KEY = 1, *WK* = EOTWK = CANWK = X	*MR* is always switched on

The main relay driver is protected against overcurrent and overtemperature. In the case of overcurrent and/or overtemperature the output is switched off and is switched on again after release of the failure condition. This leads to a repetitive switching. A minimum off time **tMR,off** is implemented to ensure no destruction due to repetitive switching.

7.4   Engine Off Timer

The engine off timer is integrated to measure the time in ECU sleep mode. Additionally the comparator mode is implemented to wake-up the TLE8888-1QK after a defined time. It is internally supplied out of the standby supply pin *V5VSTBY*. With the pin *EOTEN* the function is enabled with a connection to *V5VSTBY* and disabled with a connection to *AGND*. It consists of an oscillator optimized for low current operation, a counter and a comparator. The counter counts up to 36 hours and if the counter value reaches the comparator threshold an internal wake-up signal is generated. The activation of the comparator mode is done with a definition of a comparator threshold greater than 0000H in configuration registers **EOTConfig0** and **EOTConfig1**. There are two operation modes implemented:

- Counter Mode: only counter is working, no wake-up with comparator threshold
- Comparator Mode: counter operation like counter mode, additional wake-up with comparator threshold

In comparator mode the internal EOTWK flag is set if the counter is equal to compare value in the configuration registers **EOTConfig0** and **EOTConfig1**. The reset of the EOTWK flag is done with the bit **WKCLR** in the command register **Cmd0** if the counter value is not equal to the compare value.
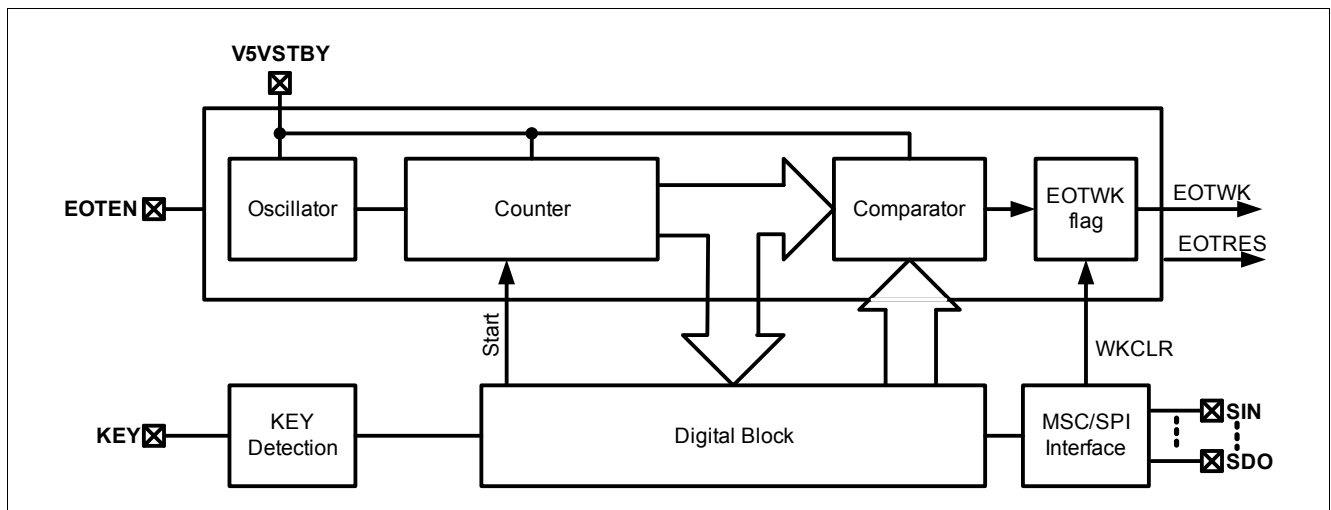
Figure 23   Block Diagram Engine Off Timer

The start of the counter can be configured with the bit **EOTCONF** in the configuration register **OpConfig0** to

- start by *KEY* signal (reset value) and
- start by MSC command

Wake-Up Detection and Main Relay Driver

With the falling edge of the *KEY* signal or with the execution of the MSC command the counter is reset and starts counting (see **Figure 24**). The start command is performed with setting the bit **EOTS** to "1" in the command register **Cmd0**.

The status bit **EOTRES** (register **OpStat1**) is implemented to highlight that a standby reset has happened. With the start of the counter this bit is reset. Therefore the status of this bit must be readout before the start of the engine off timer.

The 24 bits of the counter are available in the status register **EOTStat0**, **EOTStat1** and **EOTStat2**. For easier access to the engine off timer status the multiple read command **MSCReadDiag0EOT** is implemented.

After wake-up the counter doesn't stop counting. A readout of the counter value doesn't stop counting. With this behavior it is possible to measure the counting time with the microcontroller (see **Figure 25**).

With a read out of two counter values in a defined time a correction factor can be calculated (difference of counter values divided by the time between the two read outs). With this measurement of the correction factor only the variation caused by the temperature of the timer are effective. The absolute variations are corrected by the correction factor. There are no restrictions for the measurement time but due to the resolution of the counter a minimum measurement time *Δt* of 1 s is recommended.

After power-up of the engine off timer circuit with a supply ramp up at pin *V5VSTBY* the counter value and the comparator threshold are reset to the reset value. Additionally the bit **EOTRES** in the status register **OpStat1** is set to "1".

Any other resets like ECU power on reset have no impact to the engine off timer counter. The compare configuration register **EOTConfig0** and **EOTConfig1** are cleared with an ECU power on reset.

The counter stops counting at full scale. If a standby supply reset occurs the counter stops counting and is reset to "0".
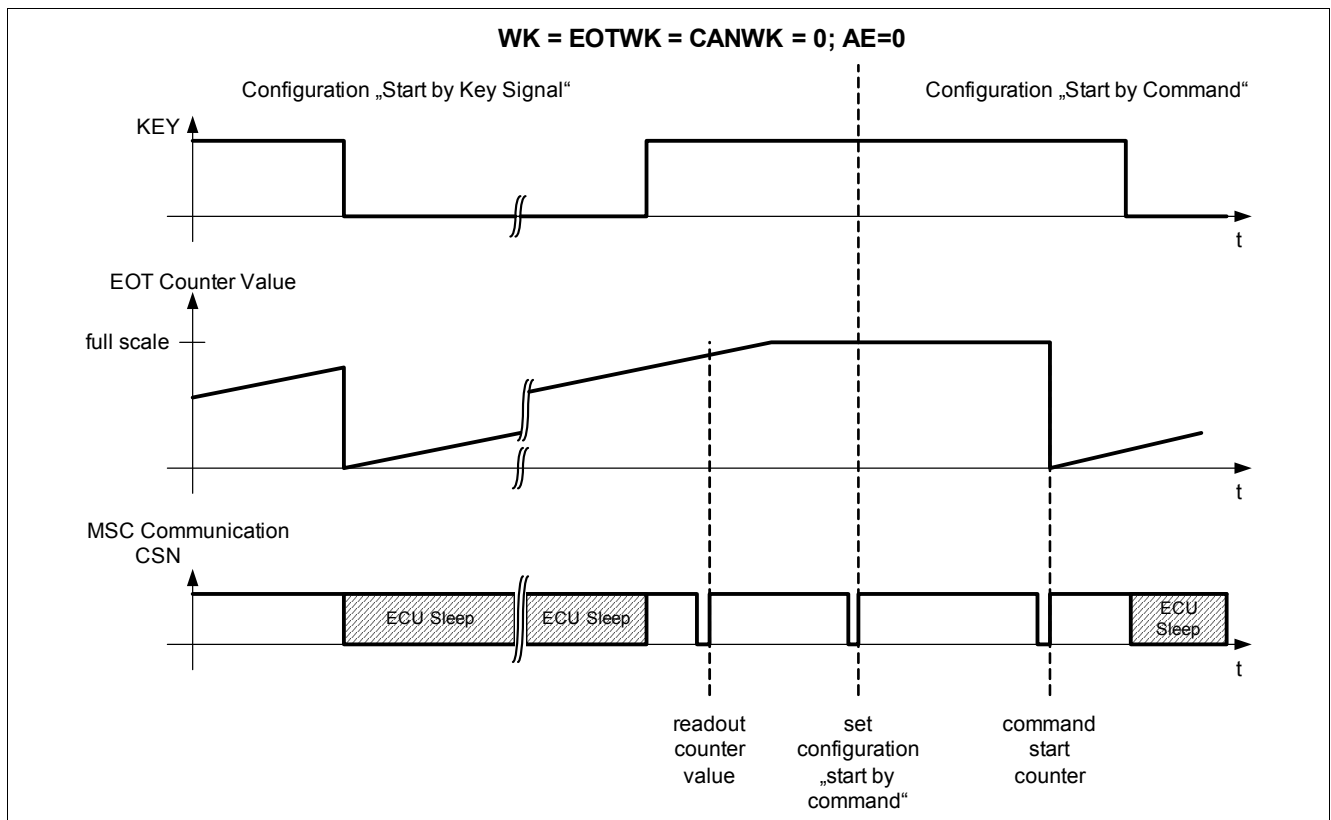
Figure 24 Function Diagram Engine Off Timer Counter Mode
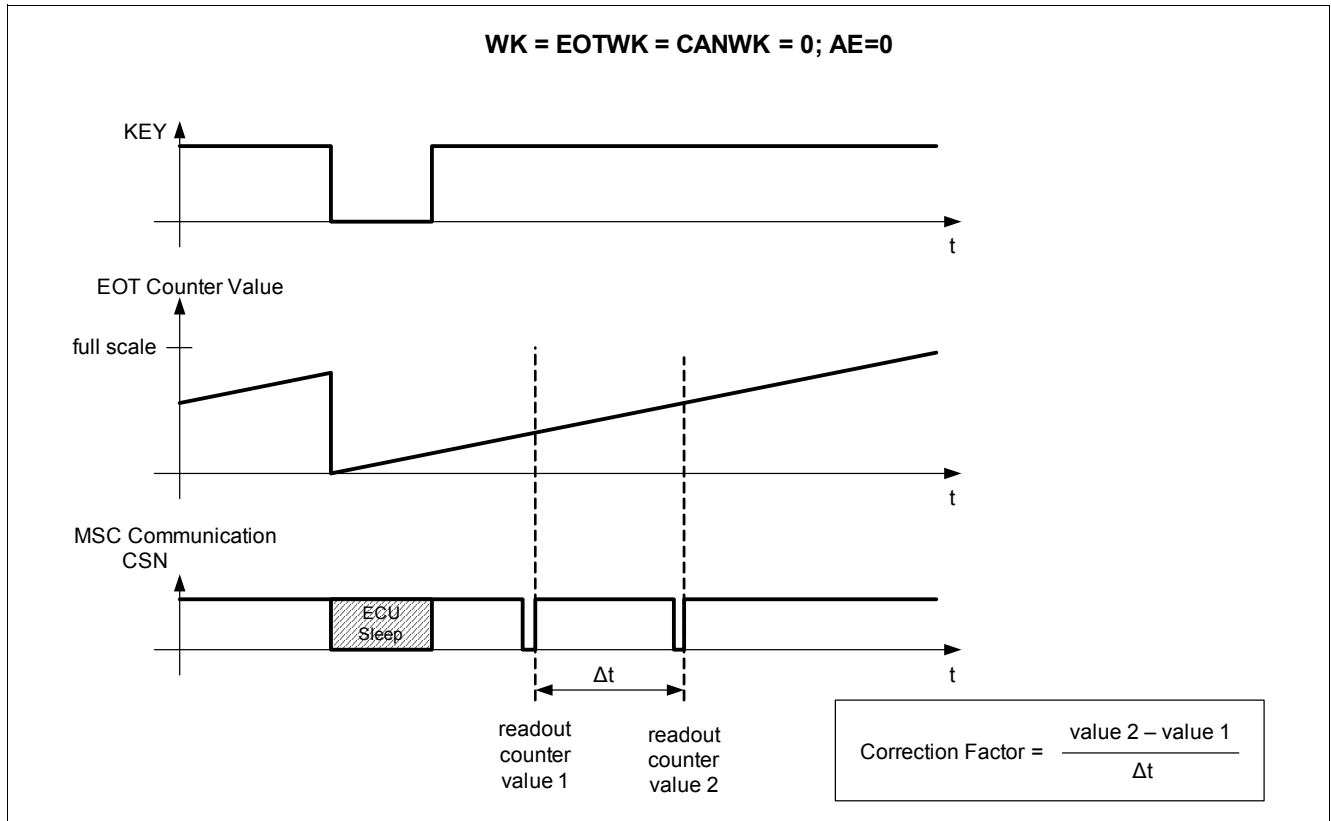
Figure 25   Function Diagram Engine Off Timer Correction Factor Measurement

In comparator mode there is no difference in the behavior of the counter as described above. Additionally a comparator threshold different to 0000H for wake-up is defined in the configuration register **EOTConfig0** and **EOTConfig1**. The comparator mode is enabled with a threshold value different to 0000_H. If the counter value is equal to the comparator threshold the internal wake-up signal EOTWK (status see bit **EOTWK** in the status register **OpStat0**) of the TLE8888-1QK is active (see **Figure 26**).

With a wake-up clear command (set bit **WKCLR** to "1" in command register **Cmd0**) the internal EOTWK signal is reset.

Table 16   Counter Definition

EOTC[23:0]		
000000_H	reset value	
000001_H to $FFFFFF_H$	1/128 s to 131071 s = 36 h + 24 min + 31 s	time resolution 1/128 s

Table 17   Comparator Threshold Definition

EOTTH[15:0]		
0000_H	reset value	comparator mode disabled
0001_H to $FFFF_H$	2 s to 131070 s = 36 h + 24 min + 30 s	comparator mode enabled, time resolution 2 s
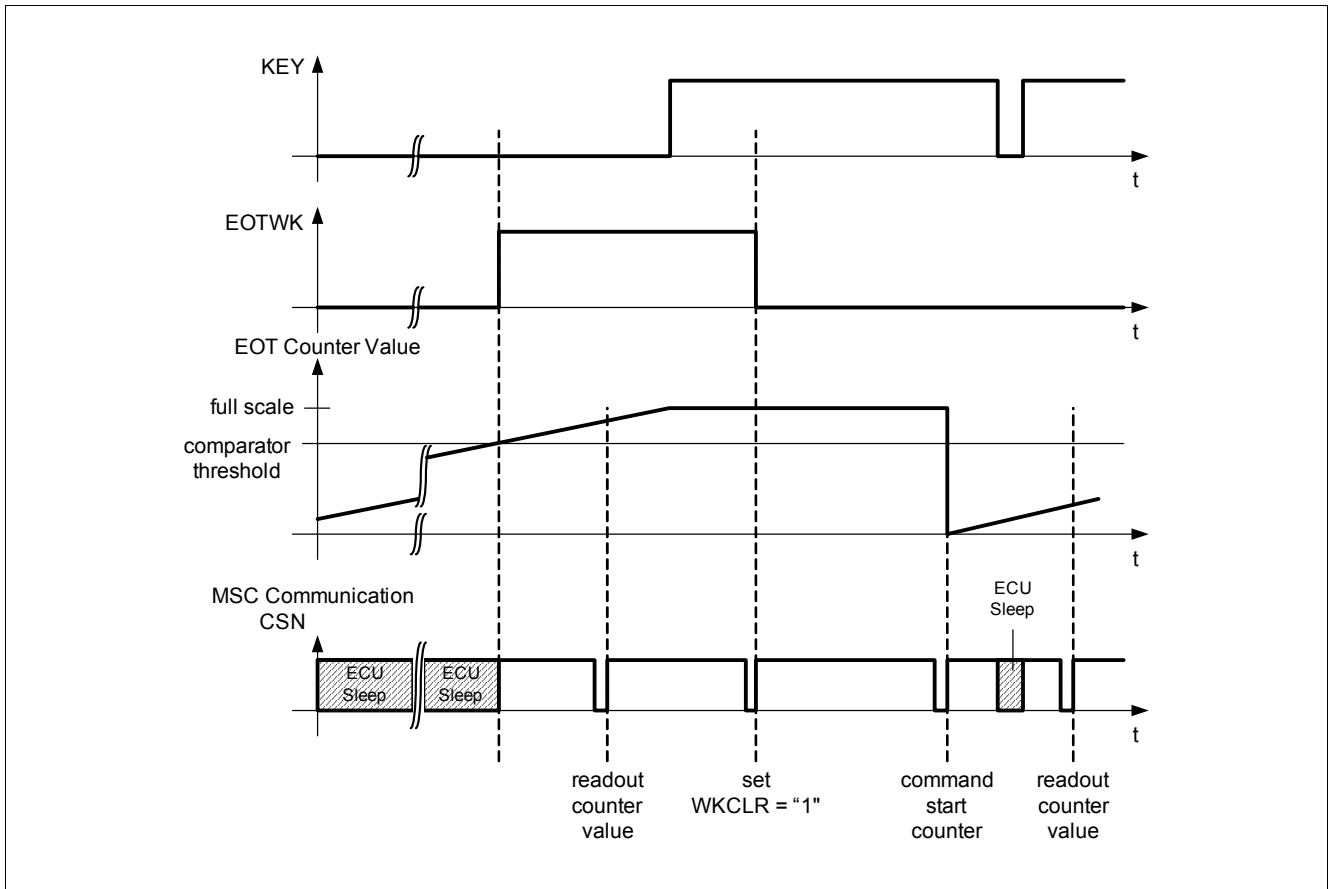
Figure 26   Function Diagram Engine Off Timer Comparator Mode

7.5 Electrical Characteristics Key Detection, Wake-up Detection and Main Relay Driver

Table 18 Electrical Characteristics Key Detection

V_S = 13.5 V, V_{VSV} = 5 V, T_j = -40°C to +150°C, all voltages with respect to GND, positive current flowing into pin, (unless otherwise specified)

Parameter	Symbol	Values			Unit	Note or Test Condition	Number
		Min.	Typ.	Max.			
Key On Detection Threshold	$V_{KEY,th}$	3.6	–	4.5	V	rising edge	P_7.5.1
Key On Detection Hysteresis	$V_{KEY,h}$	140	250	400	mV	–	P_7.5.2
Input Current during wake-up	I_{KEY}	–	–	0.55	mA	V_{KEY} = 5 V[1]	P_7.5.3
Input Current after wake-up	I_{KEY}	–	–	0.7	mA	V_{KEY} = V_{BAT} = 4.5 V	P_7.5.31
Key Detection Filter Time	$t_{KEY,f}$	7.5	16	24	ms	V_{KEY} = 5 V	P_7.5.4
Key Off Delay Time 1	$t_{KEYoff,d,1}$	100	–	200	ms	–	P_7.5.5
Key Off Delay Time 2	$t_{KEYoff,d,2}$	200	–	400	ms	–	P_7.5.6
Key Off Delay Time 3	$t_{KEYoff,d,3}$	400	–	800	ms	–	P_7.5.7
Key Off Delay Time 4	$t_{KEYoff,d,4}$	800	–	1600	ms	–	P_7.5.8
Output *KOFFDO*							
Output Current Capability	I_{KOFFDO}	15[2]	–	–	mA	V_{KOFFDO} = 5 V	P_7.5.9
KOFFDO Output Low Level	$V_{KOFFDO,low}$	–	–	0.4	V	I_{KOFFDO} < 1 mA	P_7.5.30

1) not subject to production test, specified for design
2) Application must ensure that current into this pin does not exceed this value.

Table 19 Electrical Characteristics Wake-up Detection

V_S = 13.5 V, V_{VSV} = 5 V, T_j = -40°C to +150°C, all voltages with respect to GND, positive current flowing into pin, (unless otherwise specified)

Parameter	Symbol	Values			Unit	Note or Test Condition	Number
		Min.	Typ.	Max.			
Wake-up Detection Threshold	$V_{WK,th}$	3.6	–	4.5	V	rising edge	P_7.5.10
Wake-up Detection Hysteresis	$V_{WK,h}$	140	250	400	mV	–	P_7.5.11
Input Current during Wake-up	I_{WK}	–	–	0.55	mA	V_{WK} = 5 V[1]	P_7.5.12
Wake-up Detection Filter Time	$t_{WK,f}$	1	2	3.5	ms	V_{WK} = 5 V	P_7.5.13
Battery Detection Threshold	$V_{Bat,th}$	3.5	–	5	V	V_{WK} = 5 V	P_7.5.14

1) not subject to production test, specified by design

Table 20   Electrical Characteristics Main Relay Driver

V_S = 13.5 V, V_{VSV} = 5 V, T_j = -40°C to +150°C, all voltages with respect to GND, positive current flowing into pin, (unless otherwise specified)

Parameter	Symbol	Values			Unit	Note or Test Condition	Number
		Min.	Typ.	Max.			
MR Operation Current	I_{MR}	–	–	0.8	A	–	P_7.5.15
MR Overcurrent Limitation	$I_{MR,oc}$	0.8	–	1.5	A	–	P_7.5.16
MR On Voltage	V_{MR}	–	–	1.35	V	I_{MR} = 0.3 A	P_7.5.17
MR switch off time in failure case	$t_{MR,off}$	16	27	–	ms	in case of overcurrent and/or over-temperature	P_7.5.32
MR On Voltage at Low Battery Voltage, low temperature	$V_{MR,l,LT}$	–	–	1.1	V	I_{MR} = 0.1 A, V_{BAT} = 4.5 V (decreasing) T_J < 25°C	P_7.5.18
MR On Voltage at Low Battery Voltage, high temperature	$V_{MR,l,HT}$	–	–	1.05	V	I_{MR} = 0.1 A, V_{BAT} = 4.5 V (decreasing) T_J > 25°C	P_7.5.19
MR Clamping Voltage	$V_{MR,cl}$	40	–	60	V	I_{MR} = 0.2 A	P_7.5.20
MR Clamping Energy[1]	$E_{MR,cl}$	–	–	6.5	mJ	I_{MR} < 0.3 A, T_j = 150°C, 40*106 cycles	P_7.5.21
MR leakage current in off mode, positive voltage	$I_{MR.leak,pos}$	–	–	5	µA	V_{MR} = 13.5 V, V_{KEY} = 0 V and V_{WK} = 0 V	P_7.5.22
MR leakage current in off mode, negative voltage	$I_{MR.leak,neg}$	-100	–	–	µA	V_{MR} = -13.5 V, V_{KEY} = 0 V and V_{WK} = 0 V	P_7.5.23

1) not subject to production test

Table 21   Electrical Characteristics Engine Off Timer

V_S = 13.5 V, V_{VSV} = 5 V, T_j = -40°C to +150°C, all voltages with respect to GND, positive current flowing into pin, (unless otherwise specified)

Parameter	Symbol	Values			Unit	Note or Test Condition	Number
		Min.	Typ.	Max.			
Oscillator Accuracy	$\Delta f_{osc,a}$	-30	–	+30	%	$V_{V5VSTBY}$ = 5 V	P_7.5.24
Oscillator Frequency Variation over Temperature	$\Delta f_{osc,T}$	-5	–	+5	%	$V_{V5VSTBY}$ = 5 V, T_j = -40°C to 85°C, one single device	P_7.5.25
Counter Resolution	$C_{EOT,r}$	–	1/128	–	s	–	P_7.5.26

Table 21 **Electrical Characteristics Engine Off Timer** (cont'd)

V_S = 13.5 V, V_{VSV} = 5 V, T_j = -40°C to +150°C, all voltages with respect to GND, positive current flowing into pin, (unless otherwise specified)

Parameter	Symbol	Values			Unit	Note or Test Condition	Number
		Min.	Typ.	Max.			
Counter Full Scale	$C_{EOT,fs}$	–	–	24	bit	–	P_7.5.27
		–	131071	–	s	–	
Additional current consumption at pin *BATSTBY* for enabled engine off timer function	I_{EOTSUP}	–	–	10	µA	$V_{V5VSTBY}$ = 5 V and no wake-up	P_7.5.28
Additional current consumption at pin *BATSTBY* for enabled engine off timer function and wake-up[1]	$I_{EOTSUP,w}$	–	–	450	µA	$V_{V5VSTBY}$ = 5 V and wake-up	P_7.5.29

1) not subject to production test, specified by design

8 Power Supply

The power supply unit generates the internal supply (including supply for CAN and pre-drivers, voltage reference and current biasing), the main supply voltage for the ECU (*V5V*) and sensor supplies for off- board sensors (*T5V1* and *T5V2*). All supplies start working by the wake-up signal generated by the key and wake-up detection (see **Chapter 7.2** for details).

A linear pre-regulator with an external logic level power MOSFET is implemented to keep the power dissipation of the TLE8888-1QK low. The precise voltage supplies for the ECU and the sensor supplies are integrated inclusive the power transistor. All supplies with low drop functionality (main supply *V5V*, pre-regulator, sensor supplies *T5V1*/*T5V2*) are using an integrated charge pump to provide low drop behavior at low battery voltages.
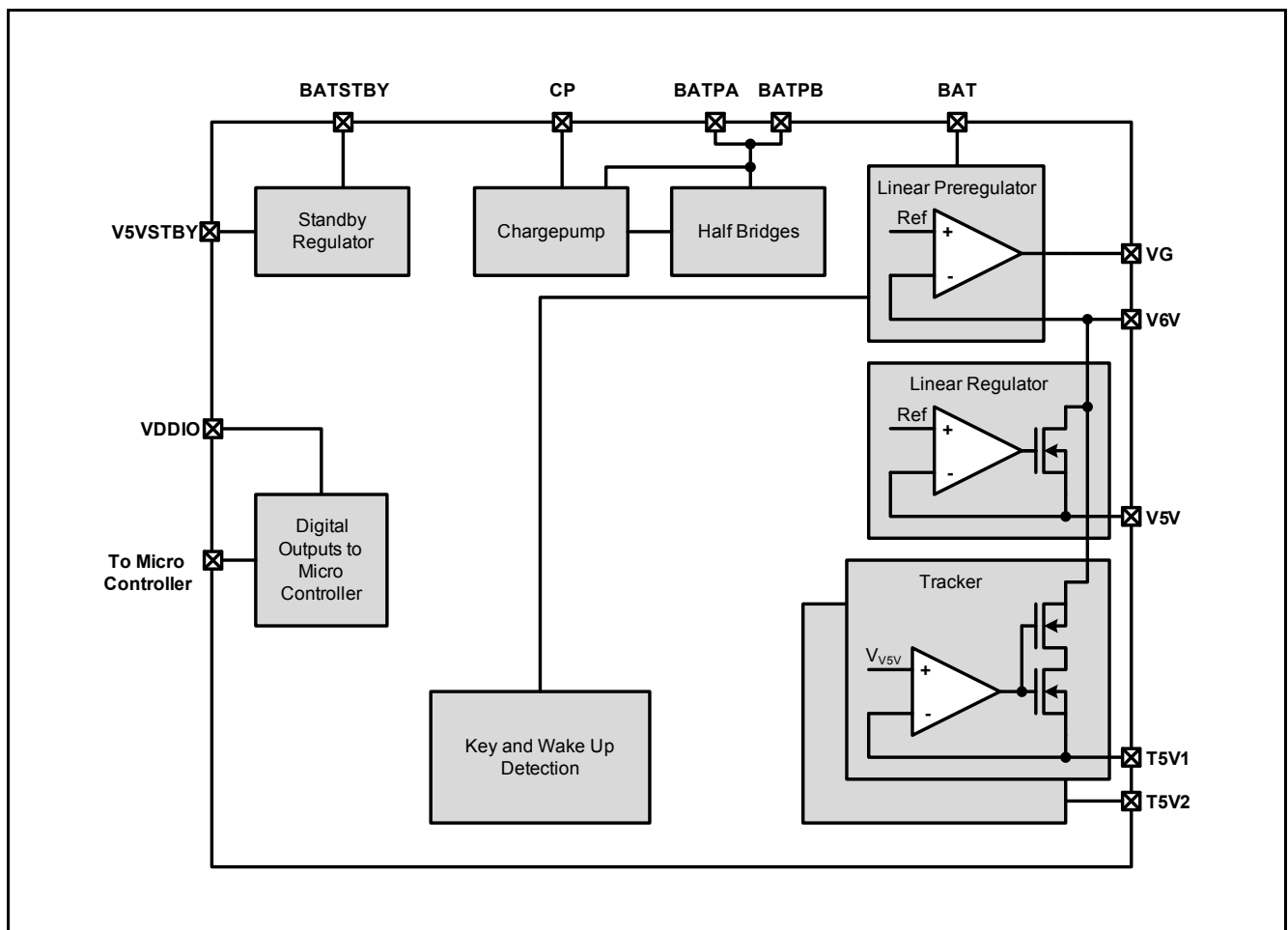
Figure 27   Block diagram of the power supply

8.1 Pre-Regulator

The pre-regulator uses an external logic level power MOSFET and regulates the voltage at pin *V6V*. The voltage at the pin is also the input voltage for the main supply of the ECU (*V5V*), the sensor supplies (*T5V1*, *T5V2*) and the internal supply. The circuit is designed for low drop operation.

It's not allowed to load the external MOSFET with anything else than *V6V*. The function of the pre-regulator is guaranteed with the MOSFET IPD30N06S2L-23 of Infineon.

8.2 5 V Main Supply

The 5 V main supply is designed to supply the ECU including microcontroller and e.g. other power chips. Out of *V6V* a high accurate voltage is provided at the pin *V5V*. The pin and the circuit is protected against overload and short circuit. For stabilization and ripple reduction an external buffer capacitor is required. For low drop operation of the regulator the pins *BATPA* and *BATPB* must be supplied.

8.3 Sensor Supply

There are two sensor supplies integrated providing an output voltage based on *V5V* as reference. Out of *V6V* a high accurate voltage is provided at the pins *T5V1* and *T5V2*. The pins and the circuits are protected against overload, short circuit and reverse supply back to *V6V*. For stabilization and ripple reduction external buffer capacitors are required. For low drop operation of the regulator the pins *BATPA* and *BATPB* must be supplied.

8.4 IO Supply

The TLE8888-1QK provides an IO supply pin *VDDIO* for 3.3 V and 5 V microcontroller interfaces. This pin is used for the supply of the output driver and defines the output level of all logical interface pins.

8.5 Standby Supply

The TLE8888-1QK integrates a standby supply which is supplied by the pin *BATSTBY* and provides a 5 V output supply at pin *V5VSTBY*. It is not allowed to connect this pin to any other supply.

8.6 Charge Pump

There is a charge pump integrated to supply the half bridges out of *BATPA* and *BATPB*. A capacitor has to be connected on the PCB (between *CP* and *BATPA*/*BATPB*) to buffer the voltage and reduce the ripple. It's not allowed to apply any external load to the pin *CP*.

8.7 Voltage Monitoring

The TLE8888-1QK provides voltage monitoring of the main ECU supply *V5V*, the sensor supplies *T5V1* and *T5V2* and the battery voltage. In **Chapter 5.2** the effect to the status of theTLE8888-1QK is described. All detection thresholds are implemented with a hysteresis and a filter time to suppress disturbances.
The status of the over- and undervoltage detection of *BAT*, *T5V1* and *T5V2* are available in the diagnosis resister **Diag0** and the bits **BATOV**, **T1UV**, **T1OV**, **T2UV** and **T2OV**.
Under- and overvoltage of *V5V* leads to a reset of the microcontroller (see **Table 5** in **Chapter 5.2**). After release of the reset the cause of the reset is available in the status register **OpStat1** (bits **V5VUVR** and **V5VOVR**).

8.8 Electrical Characteristics Power Supply

Table 22 Electrical Characteristics Power Supply

V_S = 13.5 V, V_{VSV} = 5 V, T_j = -40°C to +150°C, all voltages with respect to GND, positive current flowing into pin, (unless otherwise specified)

Parameter	Symbol	Values			Unit	Note or Test Condition	Number
		Min.	Typ.	Max.			
current consumption at pins *BATPA*, *BATPB*, *BAT* and *V6V*	$I_{BAT,sum}$	–	–	50	mA	static, all "off", no PWM and MSC/SPI communication	P_8.8.1
Pre-Regulator							
Pre-Driver Output Voltage *V6V*	V_{V6V}	5.5	6	6.5	V	with respect to *AGND*, with external MOS FET IPD30N06S2L-23	P_8.8.2
Gate Output Voltage *VG*	DV_{VG}	4	–	7.5	V	V_{V6V} = 5.5 V; DV_{VG} = V_{VG} - V_{V6V}	P_8.8.3
Gate Output Voltage *VG* at low Supply	D$V_{VG,l}$	1.7	–	–	V	V_{BATPx} = 4.5 V, I_{VG} = 1 µA; DV_{VG} = V_{VG} - V_{V6V}	P_8.8.4
Buffer Capacitor at *V6V*[1]	C_{V6V}	1	20	1000	µF	[2] [3]	P_8.8.37
ESR of Buffer Capacitance at *V6V*[1]	ESR_{V6V}	0.01		2	Ω	for C_{V6V} < 15 µF, f_{ESR} = 10 kHz	P_8.8.38
ESR of Buffer Capacitance at *V6V*[1]	ESR_{V6V}	0.5		2	Ω	for *15 µF < C_{V6V} < 20 µF*, f_{ESR} = 10 kHz	P_8.8.39
ESR of Buffer Capacitance at *V6V*[1]	ESR_{V6V}	1		2	Ω	for *20 µF < C_{V6V} < 1000 µF*, f_{ESR} = 10 kHz	P_8.8.40
Buffer Capacitor at *VG*[1]	C_{VG}	–	4.7	15	nF	[2][3]	P_8.8.41
ESR of Buffer Capacitance at *VG*[1]	ESR_{VG}	–	–	1	Ω	f_{ESR} = 10 kHz	P_8.8.42
5 V Main Supply *V5V*							
Output Voltage *V5V*	V_{V5V}	4.9	–	5.1	V	-5 mA < I_{V5V} < -500 mA, with respect to *AGND*	P_8.8.5
Voltage Drop *V6V*-*V5V* at low Supply	$V_{V5V,d}$	–	–	0.6	V	I_{V5V} = - 500 mA; V_{BAT} = V_{BATPx} = V_{KEY} = V_{V6V} = 4.5 V	P_8.8.6
Voltage Drop *V6V*-*V5V* at low Supply and low temperature	$V_{V5V,d,CT}$	–	–	0.45	V	T_j = -40°C; I_{V5V} = -500 mA; V_{BAT} = V_{BATPx} = V_{KEY} = V_{V6V} = 4.5 V[1]	P_8.8.7
Current Limitation	$I_{V5V,lim}$	-1200	–	-500	mA	–	P_8.8.8

Power Supply

Table 22 Electrical Characteristics Power Supply (cont'd)

V_S = 13.5 V, V_{VSV} = 5 V, T_j = -40°C to +150°C, all voltages with respect to GND, positive current flowing into pin, (unless otherwise specified)

Parameter	Symbol	Values			Unit	Note or Test Condition	Number
		Min.	Typ.	Max.			
Buffer Capacitor at $V5V$[1]	C_{V5V}	0.1	10	220	µF	[2][3]	P_8.8.9
ESR of Buffer Capacitance at $V5V$[1]	ESR_{V5V}	0.01		2	Ω	for C_{V5V} < 10 µF, f_{ESR} = 10 kHz	P_8.8.43
ESR of Buffer Capacitance at $V5V$[1]	ESR_{V5V}	0.1		2	Ω	for $10\,µF < C_{V5V}$ < 47 µF, f_{ESR} = 10 kHz	P_8.8.44
ESR of Buffer Capacitance at $V5V$[1]	ESR_{V5V}	0.5		2	Ω	for $47\,µF < C_{V5V}$ < 220 µF, f_{ESR} = 10 kHz	P_8.8.45
Sensor Supplies $T5V1$ and $T5V2$							
Output voltage tracking accuracy	DV_{T5Vx}	-10	–	10	mV	$DV_{T5Vx} = V_{V5V} - V_{T5Vx}$, 4 V < V_{V5V} < 5.1 V, V_{V6V} > 5.5 V, $V_{IGNx} \geq 0$ V	P_8.8.10
Current Limitation	$I_{T5Vx,lim}$	-300	–	-100	mA		P_8.8.11
Buffer Capacitor at $T5V1$ and $T5V2$[1]	C_{T5Vx}	–	–	400	nF		P_8.8.12
IO Supply $VDDIO$							
IO Supply Voltage Range	V_{VDDIO}	3	–	5.5	V	–	P_8.8.13
Current Consumption at pin $VDDIO$	I_{DDIO}	–	–	2	mA	V_{VDDIO} = 5 V, INx = 0 V, CSN = LINTX = CANTX = 5 V, MON and RST open[1]	P_8.8.14
Standby Supply $V5VSTBY$							
Output Voltage $V5VSTBY$	$V_{V5VSTBY}$	4.75	–	5.25	V	-10 µA < $I_{V5VSTBY}$ < -15 mA	P_8.8.15
Total Standby Current Consumption at pins $BATSTBY$, BAT, $V6V$ and MR	I_{STBY}	–	–	120	µA	ECU sleep mode, T_j = 25°C, $I_{V5VSTBY}$ = 0 mA, $V_{BATSTBY} = V_{BAT} = V_{MR}$ = 13.5 V, $EOTEN = CANWK$ EN = 0 V	P_8.8.16
Buffer Capacitor at $V5VSTBY$[1]	$C_{V5VSTBY}$	27	100	270	nF	[2][3]	P_8.8.46
ESR of Buffer Capacitance at $V5VSTBY$[1]	$ESR_{V5VSTBY}$	0.01	–	1	Ω		P_8.8.47
Charge Pump							

Power Supply

Table 22   Electrical Characteristics Power Supply (cont'd)

V_S = 13.5 V, V_{VSV} = 5 V, T_j = -40°C to +150°C, all voltages with respect to GND, positive current flowing into pin, (unless otherwise specified)

Parameter	Symbol	Values			Unit	Note or Test Condition	Number
		Min.	Typ.	Max.			
Charge pump Output Voltage	DV_{CP}	4	5	7	V	DV_{CP} = V_{CP} - V_{BAT} no external load currents	P_8.8.17
Charge pump Output Voltage at low supply	DV_{CP}	3.5	–	–	V	V_{BAT} = 4.5 V after start up, DV_{CP} = V_{CP} - V_{BATPx}	P_8.8.18
Buffer Capacitor at CP[1)	C_{CP}	–	4.7	–	nF		P_8.8.19
Voltage Monitoring							
$V5V$ Undervoltage Detection Threshold, decreasing	$V_{UV,V5V,dec}$	4.45	–	4.7	V	V_{V5V} decreasing	P_8.8.20
$V5V$ Undervoltage Detection Threshold, increasing	$V_{UV,V5V,inc}$	4.45	–	4.8	V	V_{V5V} increasing	P_8.8.21
$V5V$ Undervoltage Detection Hysteresis	$V_{Hys,UV,V5V}$	10	50	–	mV	–	P_8.8.22
$V5V$ Undervoltage Filter Time	$t_{f,UV,V5V}$	5	10	15	µs	–	P_8.8.23
$T5V1$ and $T5V2$ Undervoltage Detection Threshold	$V_{UV,T5Vx,dec}$	4.45	–	4.7	V	V_{T5Vx} decreasing	P_8.8.24
$T5V1$ and $T5V2$ Undervoltage Detection Threshold	$V_{UV,T5Vx,inc}$	4.45	–	4.8	V	V_{T5Vx} increasing	P_8.8.25
$T5V1$ and $T5V2$ Undervoltage Detection Hysteresis	$V_{Hys,UV,T5Vx}$	10	50	–	mV	–	P_8.8.26
$T5V1$ and $T5V2$ Undervoltage Filter Time	$t_{f,UV,T5Vx}$	5	10	15	µs	–	P_8.8.27
$V5V$ Overvoltage Detection Threshold	$V_{OV,V5V}$	5.2	–	5.6	V	V_{V5V} increasing	P_8.8.28
$V5V$ Overvoltage Detection Hysteresis	$V_{Hys,OV,V5V}$	10	–	100	mV	–	P_8.8.29
$V5V$ Overvoltage Filter Time	$t_{f,OV,V5V}$	5	10	15	µs	–	P_8.8.30
$T5V1$ and $T5V2$ Overvoltage Detection Threshold	$V_{OV,T5Vx}$	5.2	–	5.6	V	V_{T5Vx} increasing	P_8.8.31
$T5V1$ and $T5V2$ Overvoltage Detection Hysteresis	$V_{Hys,OV,T5Vx}$	10	–	100	mV	–	P_8.8.32
$T5V1$ and $T5V2$ Overvoltage Filter Time	$t_{f,OV,T5Vx}$	5	10	15	µs	–	P_8.8.33
BAT Overvoltage Detection Threshold	$V_{OV,BAT}$	28	–	30.4	V	V_{BAT} increasing	P_8.8.34

Power Supply

Table 22 **Electrical Characteristics Power Supply** (cont'd)

V_S = 13.5 V, V_{VSV} = 5 V, T_j = -40°C to +150°C, all voltages with respect to GND, positive current flowing into pin, (unless otherwise specified)

Parameter	Symbol	Values			Unit	Note or Test Condition	Number
		Min.	Typ.	Max.			
BAT Overvoltage Detection Hysteresis	$V_{Hys,BAT}$	50	–	500	mV	–	P_8.8.35
BAT Overvoltage Filter Time	$t_{f,OV,BAT}$	5	10	15	µs	–	P_8.8.36

1) not subject to production test, specified by design

2) Defined minimum value is needed for regulator stability. Application might need higher value than minimum.

3) additionally in parallel a capacitance up to 0.1*C_{VxV} and low ESR is allowed

9 Power Stages

In the TLE8888-1QK there are 14 low-side power stages, 4 half bridges, 4 push-pull outputs for on board and external ignition driver and 6 push-pull outputs for on board MOSFETs implemented. The 14 low-side power stages are designed for various inductive and resistive loads, 4 stages to drive especially injectors, 3 with a higher operating current to drive e.g. O2-heaters and 7 stages to drive relays.

For the injector output stages (*OUT1* to *OUT4*) the common enable input *INJEN* and for the ignition outputs the common enable input *IGNEN* are implemented. The half bridges can be used with high or low-side load, with active or passive freewheeling or in full bridge configuration.
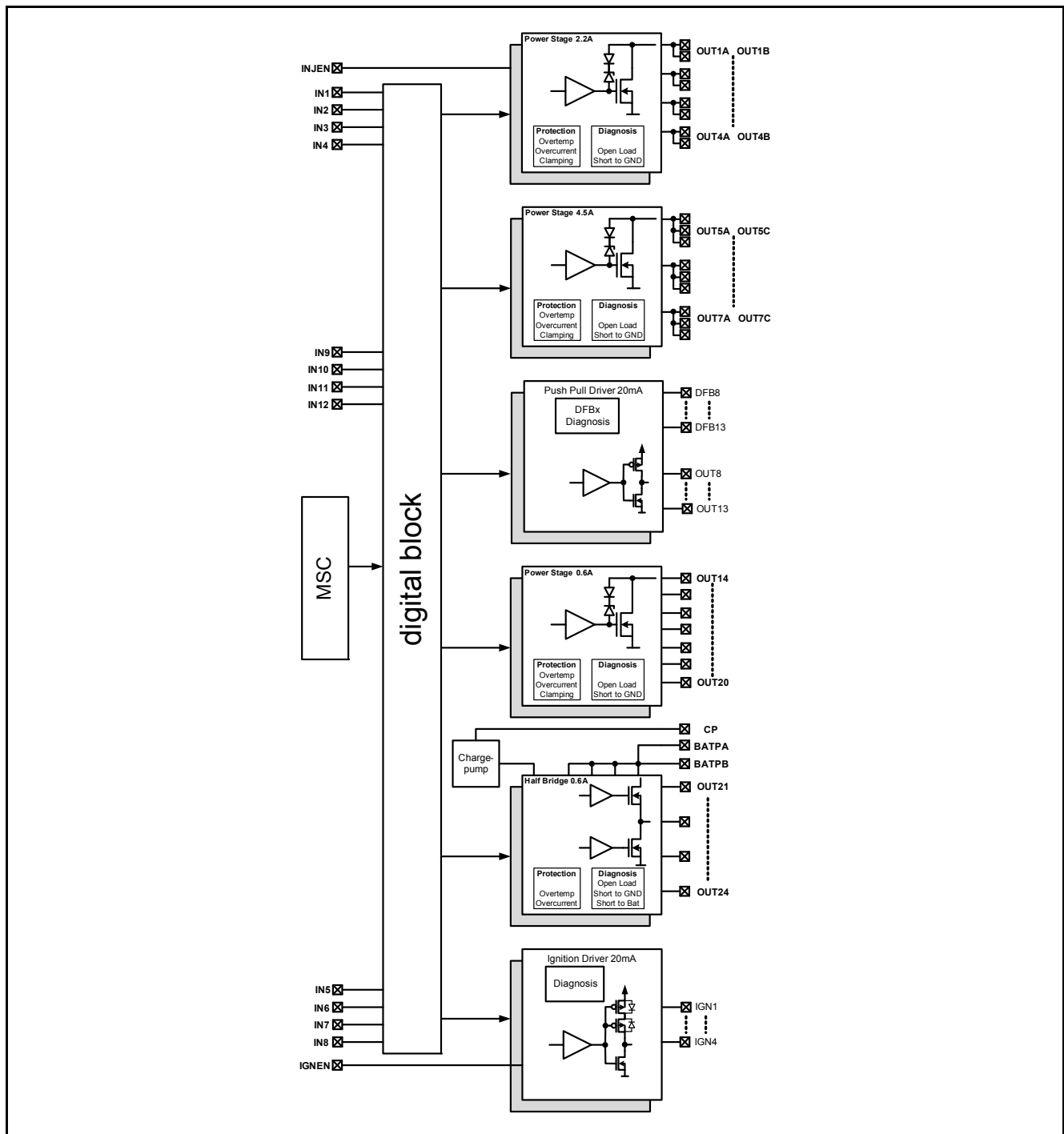
Figure 28   Block Diagram of the Power stages

Table 23   Overview Power Stages

	Type	maximum operation current	Ron	active clamping	Diagnosis in on	Diagnosis in off
OUT1 to *OUT4*	Low-side switch	**2.2** A	**550** mW	yes	overcurrent (short to battery) overtemperature	open load short to GND overtemperature
OUT5 to *OUT7*	Low-side switch	**4.5** A	**350** mW	yes	overcurrent (short to battery) overtemperature	open load short to GND overtemperature
OUT8 to *OUT13*	5 V push pull output	**20**/-**20** mA	–	no	at pin DFBx: short to battery at pin OUTx: overvoltage	at pin DFBx: open load short to GND at pin OUTx: overvoltage
OUT14 to *OUT20*	Low-side switch	**0.6** A	**1.5** W	yes	overcurrent (short to battery) overtemperature	open load short to GND overtemperature
OUT21 to *OUT24*	Half bridge	**0.6** A	**2.4** W	no	overcurrent (short to battery/short to GND) overtemperature	open load short to battery/short to GND overtemperature
IGN1 to *IGN4*	5 V push pull output	**20**/-**20** mA	–	no	short to battery short to GND open load	short to battery

9.1   Power Stage Control

The output stages will be controlled either by the MSC/SPI data frame or command frame and the control register **Cont0** to **Cont3** (see **Chapter 14.1.5**) or the direct drive inputs *IN1* to *IN12*. The configuration which control mode is active is done in the configuration register **DDConfig0** to **DDConfig3** (see **Chapter 14.1.4**).
A "1" in the control register/data frame bit or a "high" at the direct drive inputs switches on the corresponding output.
In **Table 24** the assignment of the direct drive inputs to the output stages is shown. The set up is valid for MSC and SPI operation.

The status of the power stages is also affected by the operation state and conditions of the TLE8888-1QK and is described in **Chapter 5**. All power stages are switched off if a micro channel time out occurs. Description of the effect to the control of the power stages see **Chapter 13.1.1**, **Downstream Supervisory Functions**.

Table 24   Direct Drive Input Assignment to Output Stages

Input	Output	Note
IN1 to *IN4*	*OUT1* to *OUT4*	configuration for direct drive: bits **O1DD** to **O4DD** of the configuration register **DDConfig0** fix assignment of the inputs to the outputs
IN5 to *IN8*	*IGN1* to *IGN4*	configuration for direct drive: bits **IGN1DD** to **IGN4DD** of the configuration register **DDConfig3** fix assignment of the inputs to the outputs
IN9 to *IN12*	*OUT5* to *OUT24*	configuration for direct drive: bits **O5DD** to **O24DD** of the configuration registers **DDConfig0** to **DDConfig2** assignment of input pins: configuration register **InConfig0** to **InConfig3** only 4 of this output stages can be switched directly

All direct drive inputs have implemented a pull down current source to define the input voltage.
For a multiple assignment of two direct drive inputs for one output stage (wrong configuration) the output is switched off independent of the status of the direct drive inputs.

9.2   Power Stages Enable

To enable the power stages a central output enable bit **OE** is defined. The status of the bit is shown in the status register **OpStat1** and can be set with the command register **CmdOE**. Additional a dedicated output enable bit for each output is defined (see register **OEConfig0** to **OEConfig3**) to avoid uncontrolled repetitive switching in failure case. These enable bits are reset by the protection function of each channel and block switch on of the channels. The bits could not be set if a protection function is active.
With setting the central enable bit to "1" all dedicated output enable bits are set to "1" (if no protection function is active) and all channels are enabled and can be controlled according their configuration.
With setting the central enable bit to "0" all dedicated output enable bits are set to "0" and all channels are disabled.
For the injector channels *OUT1* to *OUT4* the common enable input *INJEN* must be set to "high" and for the ignition outputs *IGN1* to *IGN4* the common enable input *IGNEN* must be set to "high" to enable the channels.

Procedure to switch on after failure condition occurred:

- Read out of diagnosis bits
- Second read out to verify that the failure conditions are not remaining
- Set of the dedicated output enable bit of the affected channel if the diagnosis bit is not active anymore
- Switch on of the channel

Switch off during battery overvoltage:

To protect the power stages against high energy during freewheeling they are switched off for battery voltages greater than the "**BAT Overvoltage Detection Threshold**" (see **Table 22** in **Chapter 8.8**).

9.3 Power Stages Configuration

The power stages can be configured according the configuration bits in the configuration registers **OutConfig0** to **OutConfig5**, **BriConfig0**, **BriConfig1** and **IGNConfig**. The direct drive input configuration is described in **Table 24**.

Table 25   Configuration Overview Power Stages

	Configuration	Configuration Register
OUT1 to *OUT4*	overcurrent: current limitation or switch off diagnosis in off: pull down current activated/deactivated	**OutConfig0**
OUT5 to *OUT7*	overcurrent: current limitation or switch off diagnosis in off: pull down current activated/deactivated	**OutConfig1**
OUT8 to *OUT13*	at pin DFBx: diagnosis in off: pull down current activated/deactivated diagnosis in on: short to battery detection thresholds	**OutConfig2** and **OutConfig3** bits 0 to 3
OUT14 to *OUT20*	mode set up: delayed switch off mode for *OUT17* overcurrent: current limitation or switch off diagnosis in off: pull down current activated/deactivated (*OUT14* to *OUT17*) pull up and down current activated/deactivated (*OUT18* to *OUT20*)	**OutConfig3** bits 4 and 5, **OutConfig4**, **OutConfig5**
OUT21 to *OUT24*	mode set up: active or passive freewheeling high- or low-side switch mode half or full bridge mode delayed switch off mode for *OUT21*	**BriConfig0** and **BriConfig1**
IGN1 to *IGN4*	open load in activation/deactivation open load current setting open load detection time	**IGNConfig**

9.4 Special Function "Delayed Switch Off" for *OUT17* and *OUT21*

A special set up for the control behavior of *OUT17* and *OUT21* is implemented. With the delayed switch off functionality the outputs are suited to drive loads (e.g. starter relay) which must be on during very low battery voltages even if the microcontroller is in reset e.g. due to undervoltage. In this operation conditions all other power stages are normally switched off.

With the bits **O17D** in the configuration register **OutConfig4** and **O21D** in the configuration register **BriConfig1** both outputs can be configured to:

• normal control mode according description in **Chapter 9.1**

• delayed switch off mode

For delayed switch off mode *OUT17* and *OUT21* must be configured as controlled by MSC/SPI (bits **O17DD**/**O21DD** in configuration register **DDConfig2** are set to "0")

Delayed switch off mode for *OUT21* is only allowed in high- or low-side switch configuration. Fullbridge configuration is not allowed.

The delayed switch off mode keeps the two outputs on for the time **ton,del** after an trigger event. With the trigger events in normal control mode the outputs are switched off.

In delayed switch off mode the delayed switch off timer starts with following trigger events:

The channel must be on before a trigger event, switch on of all channels during the delayed switch off mode is not possible

- undervoltage of the main supply *V5V* is detected
- or overvoltage of the main supply *V5V* is detected
- or the MSC time out occurs
- or an active signal ("0") at pin *MON*
- or an active signal ("0") at pin *RST*

With the bit **RDOT** in the command register **Cmd0** the delayed switch off timer is restarted and the on time is increased.

The delayed off mode is terminated with following events:

- overflow of delayed off timer
- O17/O21 are switched off with command **CmdOE**, set control register bits **O17ON**/**O21ON** or the configuration register bits **O17E**/**O21E** to "0"
- **O17D**/**O21D** are set to "0"
- Ready State is active and no trigger event is active

The outputs are switched off immediately if an internal power on reset occurs. According to the definition in **Chapter 5.1** if the conditions for a state change to ECU sleep mode are fulfilled the delayed off is terminated and the transition is executed.

Normally the related register bits of *OUT17* and *OUT21* are reset during undervoltage of the main supply *V5V* or an active signal ("0") at pin *RST* (definition see **Table 5** and **Table 6** in **Chapter 5.2**). In delayed switch off configuration following register bits are not reset:

- **OE** in status register **OpStat1**
- **O17E**, **O21E** in configuration register **OEConfig2**
- **O17D**, **O17OL**, **O17OC** in configuration register **OutConfig4**
- **O21F**, **O21M** in configuration register **BriConfig0**
- **O21D** in configuration register **BriConfig1**

For illustration in **Figure 29** and **Figure 30** two examples for the delayed switch off mode for are shown.

Power Stages
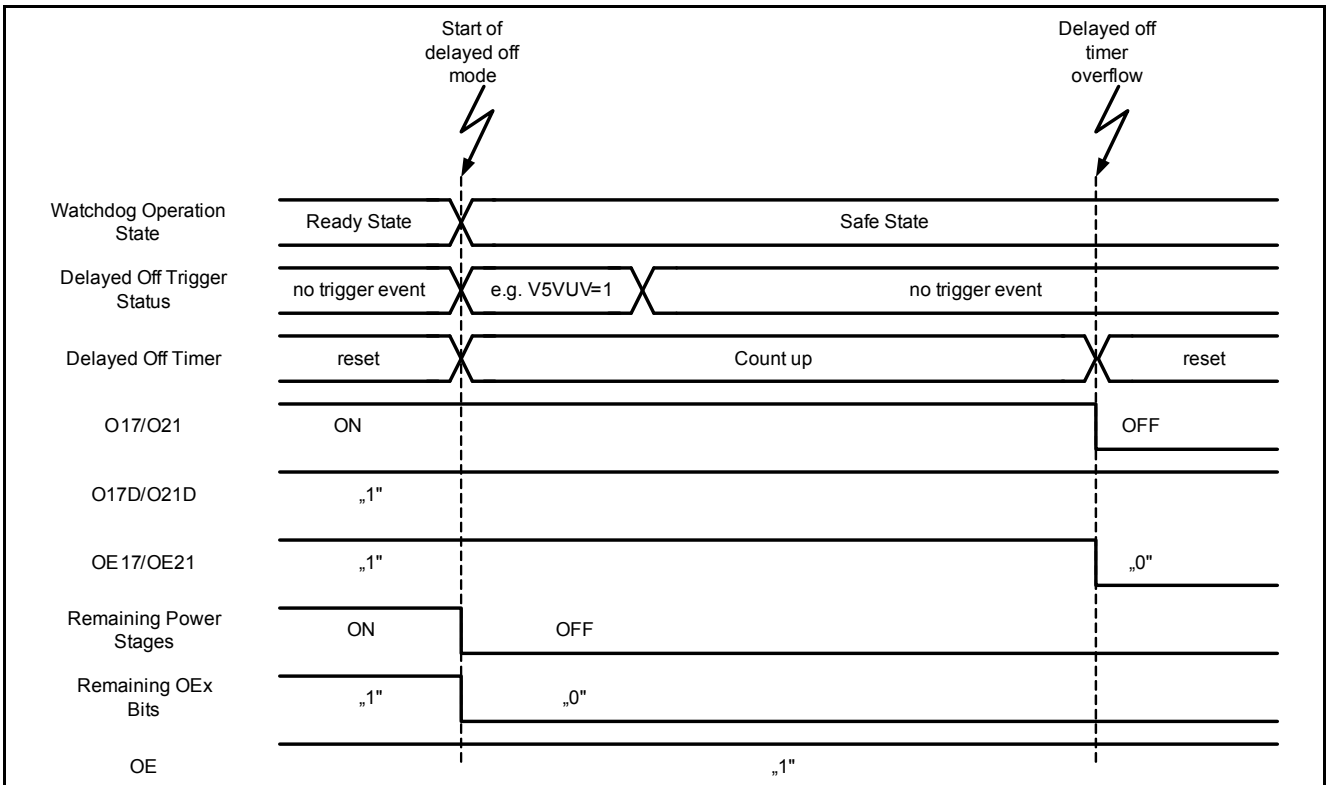
Figure 29   Example for Delayed Off Behavior: Overflow of Delayed Off Timer
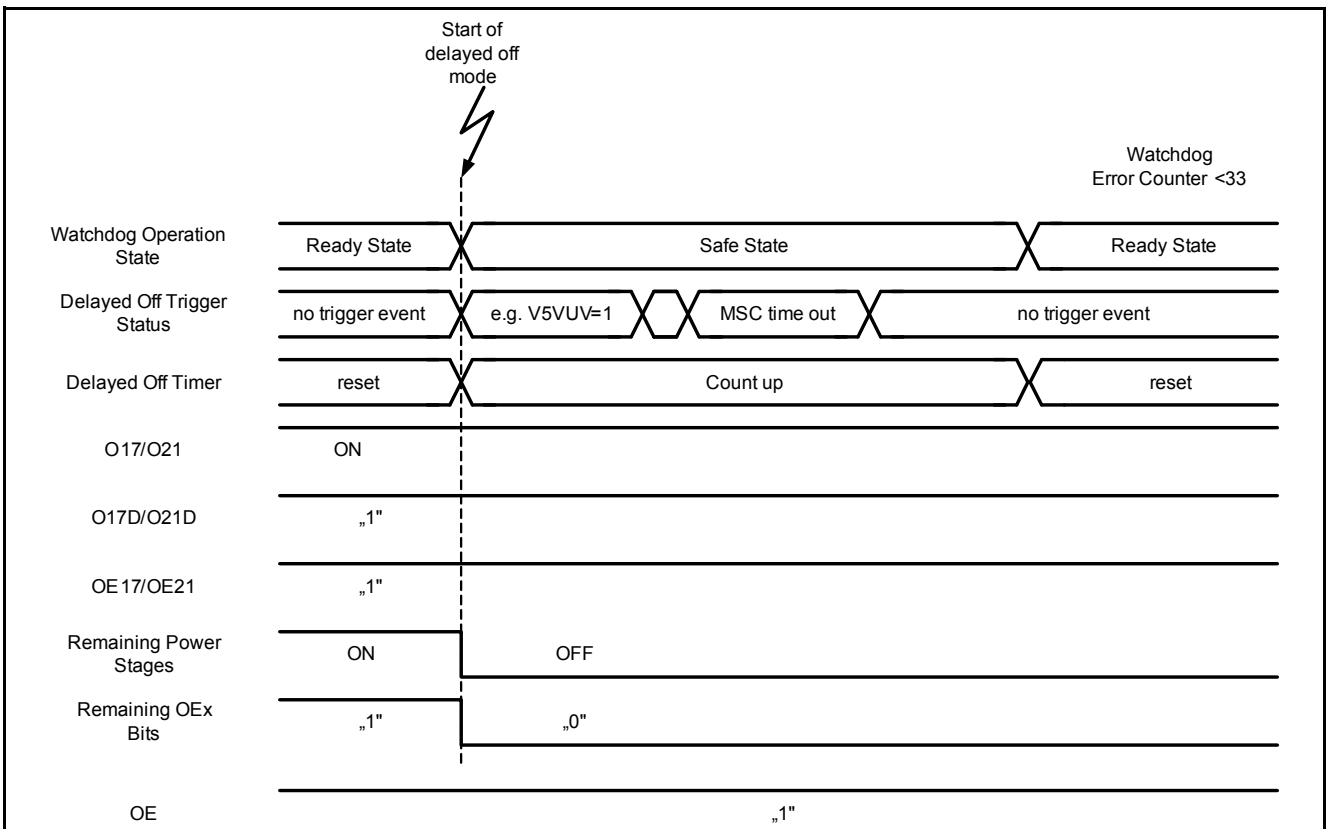
Figure 30   Example for Delayed Off Behavior: Stop of Delayed Off Timer with Ready State

9.5 Electrical Characteristics Direct Drive Inputs

Table 26 Electrical Characteristics Direct Drive Inputs

V_S = 13.5 V, V_{VSV} = 5 V, T_j = -40°C to +150°C, all voltages with respect to GND, positive current flowing into pin, (unless otherwise specified)

Parameter	Symbol	Values			Unit	Note or Test Condition	Number
		Min.	Typ.	Max.			
Direct Drive Inputs *IN1* to *IN12*							
Low Level Input Voltage	$V_{IN,l}$	-0.3	–	0.9	V	–	P_9.5.1
High Level Input Voltage	$V_{IN,h}$	2	–	V_{VDDIO}	V	–	P_9.5.2
Input Voltage Hysteresis	$V_{IN,hys}$	50	200	–	mV	–	P_9.5.3
Pull Down Current	$I_{IN,pd}$	25	–	100	µA	$V_{IN} = V_{VDDIO}$	P_9.5.4
Pull Down Current	$I_{IN,pd}$	2.4	–	–	µA	V_{IN} = 0.6 V	P_9.5.5
Delayed Switch Off for *OUT17* and *OUT21*							
Switch On Time in Delayed Switch Off Mode	$t_{on,del}$	400	–	800	ms	–	P_9.5.6
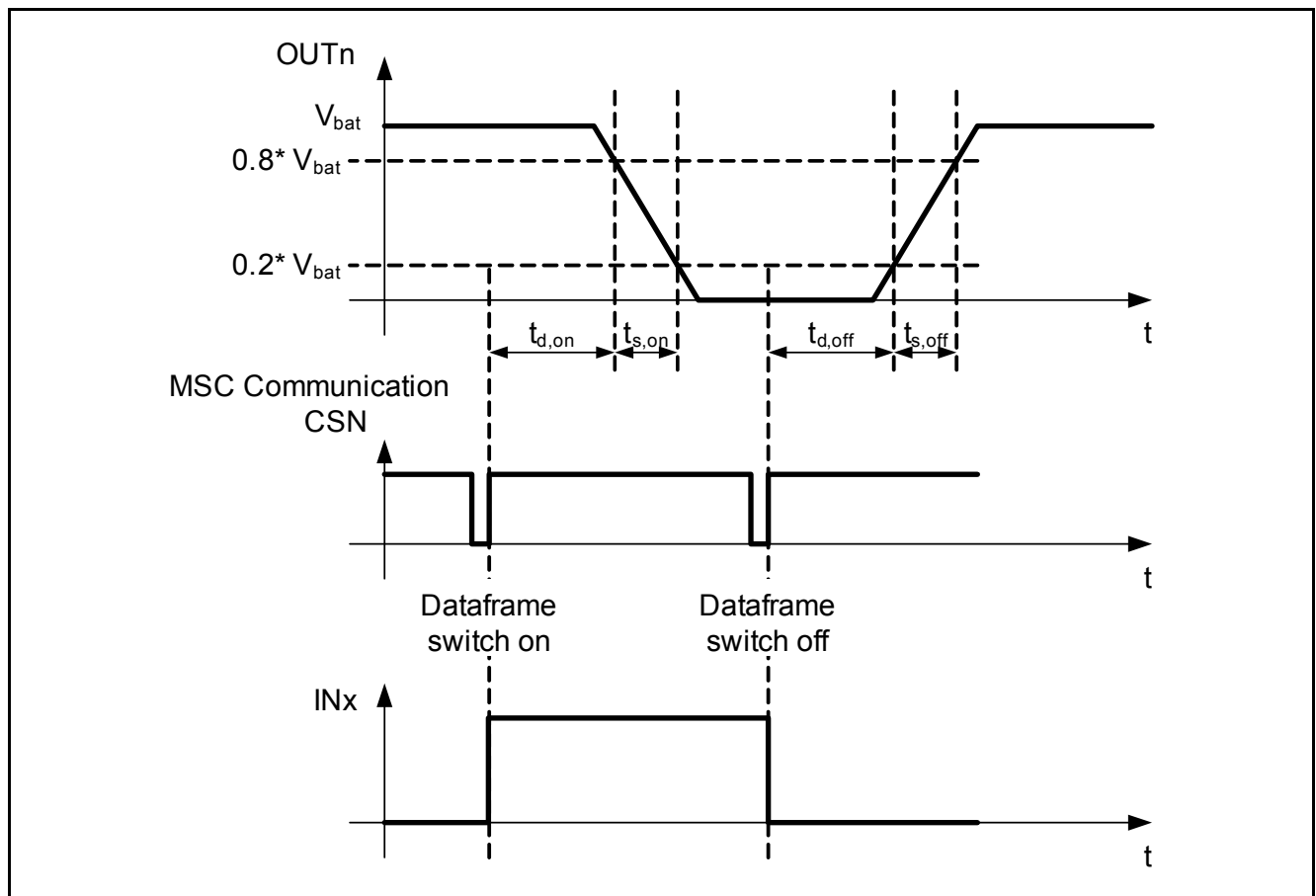
Figure 31 Switching Behavior

9.6 Low-Side Switches *OUT1* to *OUT7* and *OUT14* to *OUT20*

The low-side switches are designed to withstand repetitive clamping events which occurs in automotive applications. The outputs are fully protected and various diagnosis functions are implemented.

They are controlled and enabled like all power stages according the description in **Chapter 9.1** and **Chapter 9.2**. To enable the low-side switches *OUT1* to *OUT4* additionally the enable pin *INJEN* must be "high".

The outputs are fully protected against overcurrent and overtemperature and various diagnosis functions are implemented. For the description of the diagnosis function see **Chapter 9.6.2**.

All power stages are switched off if a micro channel time out occurs. Description of the effect to the control of the power stages see **Chapter 13.1.1**, **Downstream Supervisory Functions**.

9.6.1 Protection of *OUT1* to *OUT7* and *OUT14* to *OUT20*

The outputs are fully protected against overcurrent and overtemperature.

The current protection of the power stages *OUT1* to *OUT7* and *OUT14* to *OUT20* can be configured to current limitation or switch off in case of overcurrent (configuration register **OutConfig0**, **OutConfig1**, **OutConfig3** to **OutConfig5** bits **O1OC** to **O7OC** and **O14OC** to **O20OC**).In failure case (e.g. short to battery) the output current of the low-side switches are always limited and an overcurrent condition is detected if the overcurrent signal is valid longer than the"**Overcurrent Detection Filter Time**". With the detection the corresponding diagnosis bits are set according the priority shown in **Table 27** and for switch off configuration additionally the output is switched off.

To cover all failure conditions the overtemperature protection is implemented. Especially for the overcurrent limitation configuration the overtemperature is the only protection function against overload. After exceeding the temperature threshold the outputs are switched off till the temperature is decreased by the "**Overtemperature Hysteresis**".

For the procedure to switch on an affected channel after failure condition see **Chapter 9.2**.

9.6.2 Diagnosis of *OUT1* to *OUT7* and *OUT14* to *OUT20*

For the low-side outputs various diagnosis function are implemented. For short to battery in on diagnosis the protection function overcurrent and overtemperature are used to set the diagnosis information and for open load and short to GND (SCG) in off a special circuit is implemented.

To detect the open load/short to GND a push pull circuits is active which leads to the function of the voltage and currents of the outputs shown in **Figure 32**. With the defined detection threshold the load condition can be detected.

With the off signal of the output stage the open load/short to GND detection circuit is enabled. To suppress disturbances the output of the detection circuit is stored in the diagnosis register **OutDiag0** to **OutDiag4** after the "**Diagnosis Filter Time for open load and short to GND in off**" $t_{\text{diag,f}}$ and according the priority shown in **Table 27**. With the readout of the diagnosis register the content is updated to the actual diagnosis.

For the outputs *OUT1* to *OUT7* and *OUT14* to *OUT17* the diagnosis pull down current of the open load/short to GND in off detection could be switched off (see configuration register **OutConfig1** to **OutConfig4**). With deactivated pull down current open load in off detection is not active and the diagnosis information 10B will never occur and is deactivated. With deactivated pull down current the short to GND detection is active.

For the outputs *OUT18* to *OUT20* the diagnosis pull up and down currents could be switched off (bits **O18OL** and **O20OL** in configuration register **OutConfig5**). In this case no diagnosis information in off is active and the bits O18DIAG1, O19DIAG1 and O20DIAG1 are "0".

In **Figure 32** the behavior open load/short to GND in off detection of the output current as a function of the output voltage is shown.
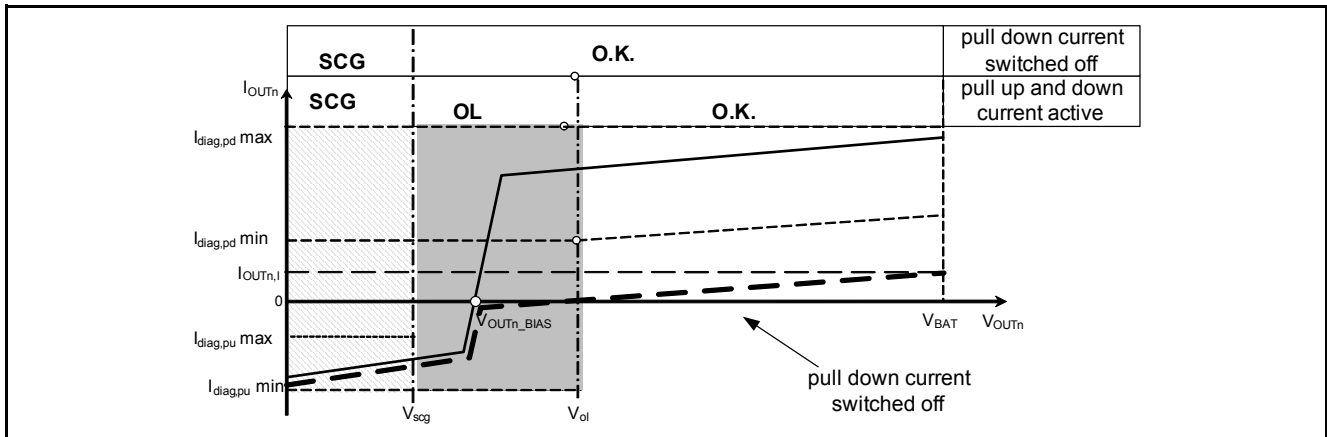
Figure 32   Output behavior with active diagnosis in off

Table 27   Description of Diagnosis Information

OnDIAG[1:0]	Priority (1 = highest priority)	Description
00	4	no failure
01	1	short circuit to battery (overcurrent) or overtemperature
10	2	open load in off[1] [2]
11	3	short circuit to ground in off[2]

1)   no open load in off detection with deactivated pull down current

2)   no open load and short to GND in off signalization for *OUT18* to *OUT20* if pull up and down currents are switched off

9.6.3   Electrical Characteristics Low-Side Switches *OUT1* to *OUT7* and *OUT14* to *OUT20*

Table 28   Electrical Characteristics Low-Side Switches *OUT1* to *OUT7* and *OUT14* to *OUT20*

V_S = 13.5 V, V_{VSV} = 5 V, T_j = -40°C to +150°C, all voltages with respect to GND, positive current flowing into pin, (unless otherwise specified)

Parameter	Symbol	Values			Unit	Note or Test Condition	Number
		Min.	Typ.	Max.			
OUT1…4, n = 1 to 4							
Operation Current	I_{OUTn}	–	–	2.2	A		P_9.6.1
Limitation Current in Overcurrent condition	$I_{OUTn,lim}$	2.2	–	4	A		P_9.6.2
Overcurrent Detection Filter Time	$t_{oc,f}$	40	–	70	µs		P_9.6.3
On Resistance	$R_{OUTn,on}$		–	550	mΩ	I_{OUTn} = 2.2 A	P_9.6.4
Clamping Voltage	$V_{OUTn,cv}$	50	–	60	V	I_{OUTn} = 0.2 A	P_9.6.5
Repetitive Clamping Energy	$E_{OUTn,cl}$	–	–	4	mJ	I_{OUTn} < 1.4 A, T_j = 125°C, 648*106 cycles[1]	P_9.6.6

Table 28   Electrical Characteristics Low-Side Switches *OUT1* to *OUT7* and *OUT14* to *OUT20* (cont'd)

V_S = 13.5 V, V_{VSV} = 5 V, T_j = -40°C to +150°C, all voltages with respect to GND, positive current flowing into pin, (unless otherwise specified)

Parameter	Symbol	Values			Unit	Note or Test Condition	Number
		Min.	Typ.	Max.			
Leakage Current 1	$I_{OUTn,l,1}$	–	–	5	µA	V_{OUTn} = 13.5 V, V_{BAT} = 0 V, T_j = 60°C[1)2)]	P_9.6.7
Leakage Current 2	$I_{OUTn,l,2}$	–	–	10	µA	V_{OUTn} = 28 V, V_{BAT} = 0 V, T_j = 60°C[1)2)]	P_9.6.8
Leakage Current 3	$I_{OUTn,l,3}$	–	–	20	µA	V_{OUTn} < 28 V, V_{BAT} = 0 V, T_j = 150°C[2)]	P_9.6.9
Turn On Delay Time	$t_{d,on}$	1	–	7	µs	V_{OUTn} = 13.5 V, I_{OUTn} = 2.2 A, resistive load[3)]	P_9.6.10
Turn Off Delay Time	$t_{d,off}$	1	–	8	µs	V_{OUTn} = 13.5 V, I_{OUTn} = 2.2 A, resistive load[3)]	P_9.6.11
Switch On Time	$t_{s,on}$	1.8	–	7	µs	V_{OUTn} = 13.5 V, I_{OUTn} = 2.2 A, resistive load[3)]	P_9.6.12
Switch Off Time	$t_{s,off}$	1.8	–	7	µs	V_{OUTn} = 13.5 V, I_{OUTn} = 2.2 A, resistive load[3)]	P_9.6.13
OUT5…7, n = 5 to 7							
Operation Current	I_{OUTn}	–	–	4.5	A		P_9.6.14
Limitation Current in Overcurrent condition	$I_{OUTn,lim}$	4.5	–	8	A		P_9.6.15
Overcurrent Detection Filter Time	$t_{oc,f}$	40	–	70	µs		P_9.6.16
On Resistance	$R_{OUTn,on}$		–	350	mΩ	I_{OUTn} = 3 A	P_9.6.17
Clamping Voltage	$V_{OUTn,cv}$	50	–	60	V	I_{OUTn} = 0.2 A	P_9.6.18
Repetitive Clamping Energy	$E_{OUTn,cl}$	–	–	22	mJ	I_{OUTn} < 1.05 A, T_j = 125°C, 1*109 cycles[1)]	P_9.6.19
Leakage Current 1	$I_{OUTn,l,1}$	–	–	5	µA	V_{OUTn} = 13.5 V, V_{BAT} = 0 V, T_j = 60°C[1)2)]	P_9.6.20
Leakage Current 2	$I_{OUTn,l,2}$	–	–	10	µA	V_{OUTn} = 28 V, V_{BAT} = 0 V, T_j = 60°C[1)2)]	P_9.6.21
Leakage Current 3	$I_{OUTn,l,3}$	–	–	30	µA	V_{OUTn} < 28 V, V_{BAT} = 0 V, T_j = 150°C[2)]	P_9.6.22

Table 28   Electrical Characteristics Low-Side Switches *OUT1* to *OUT7* and *OUT14* to *OUT20* (cont'd)

V_S = 13.5 V, V_{VSV} = 5 V, T_j = -40°C to +150°C, all voltages with respect to GND, positive current flowing into pin, (unless otherwise specified)

Parameter	Symbol	Values			Unit	Note or Test Condition	Number
		Min.	Typ.	Max.			
Turn On Delay Time	$t_{d,on}$	1	–	7	µs	V_{OUTn} = 13.5 V, I_{OUTn} = 2.2 A, resistive load[3]	P_9.6.23
Turn Off Delay Time	$t_{d,off}$	1	–	7	µs	V_{OUTn} = 13.5 V, I_{OUTn} = 2.2 A, resistive load[3]	P_9.6.24
Switch On Time	$t_{s,on}$	1.4	–	7	µs	V_{OUTn} = 13.5 V, I_{OUTn} = 2.2 A, resistive load[3]	P_9.6.25
Switch Off Time	$t_{s,off}$	1.4	–	7	µs	V_{OUTn} = 13.5 V, I_{OUTn} = 2.2 A, resistive load[3]	P_9.6.26
OUT14…20, n = 14 to 20							
Operation Current	I_{OUTn}	–	–	0.6	A		P_9.6.27
Limitation Current in Overcurrent condition	$I_{OUTn,lim}$	0.6	–	1.5	A		P_9.6.28
Overcurrent Detection Filter Time	$t_{oc,f}$	40	–	70	µs		P_9.6.29
On Resistance	$R_{OUTn,on}$		–	1.5	Ω	I_{OUTn} = 0.6 A	P_9.6.30
OUT17 On Resistance at Low Battery Voltage	$R_{OUT17,on,l}$		–	1.7	Ω	I_{OUTn} = 0.1 A, V_{BATPx} = 4.5 V	P_9.6.31
Clamping Voltage	$V_{OUTn,cv}$	50	–	60	V	I_{OUTn} = 0.2 A	P_9.6.32
Repetitive Clamping Energy	$E_{OUTn,cl}$	–	–	6.5	mJ	I_{OUTn} < 0.3 A, T_j = 125°C, 40*106 cycles[1]	P_9.6.33
Leakage Current 1	$I_{OUTn,l,1}$	–	–	5	µA	V_{OUTn} = 13.5 V, V_{BAT} = 0 V, T_j = 60°C[1,2]	P_9.6.34
Leakage Current 2	$I_{OUTn,l,2}$	–	–	15	µA	V_{OUTn} = 28 V, V_{BAT} = 0 V, T_j = 60°C[1,2]	P_9.6.35
Leakage Current 3	$I_{OUTn,l,3}$	–	–	35	µA	V_{OUTn}=28V, V_{BAT}=0V, T_j=150°C[2]	P_9.6.36
Turn On Delay Time	$t_{d,on}$	1	–	7	µs	V_{OUTn} = 13.5 V, I_{OUTn} = 0.3 A, resistive load[3]	P_9.6.37
Turn Off Delay Time	$t_{d,off}$	1	–	7	µs	V_{OUTn} = 13.5 V, I_{OUTn} = 0.3 A, resistive load[3]	P_9.6.38

Table 28   Electrical Characteristics Low-Side Switches *OUT1* to *OUT7* and *OUT14* to *OUT20* (cont'd)

V_S = 13.5 V, V_{VSV} = 5 V, T_j = -40°C to +150°C, all voltages with respect to GND, positive current flowing into pin, (unless otherwise specified)

Parameter	Symbol	Values			Unit	Note or Test Condition	Number
		Min.	Typ.	Max.			
Switch On Time	$t_{s,on}$	1.1	–	5.6	µs	V_{OUTn} = 13.5 V, I_{OUTn} = 0.3 A, resistive load[3]	P_9.6.39
Switch Off Time	$t_{s,off}$	1.1	–	5.6	µs	V_{OUTn} = 13.5 V, I_{OUTn} = 0.3 A, resistive load[3]	P_9.6.40
Delayed Off Time after trigger event for *OUT17*	$t_{off,del}$	400	–	800	ms		P_9.6.41
Diagnosis OUT1 to 7 and OUT14 to 20							
Overtemperature Switch Off Threshold	$T_{OUTn,ot}$	150	–	200	°C	[1]	P_9.6.42
Overtemperature Hysteresis	$T_{OUTn,ot,hys}$	–	10	–	°C	[1]	P_9.6.43
Open Load in Off Detection Threshold	V_{ol}	$V5V$-0.15	$V5V$	$V5V$+0.15	V		P_9.6.44
Short to GND in Off Detection Threshold	V_{scg}	$0.6*V5V$-0.15	$0.6*V5V$	$0.6*V5V$+0.15	V		P_9.6.45
Diagnosis Pull Up Current	$I_{diag,pu}$	-270	–	-150	µA	V_{OUTn} = 0 V, V_{IGNx} ≥ 0 V	P_9.6.46
Diagnosis Pull Down Current	$I_{diag,pd}$	280	–	500	µA	V_{ol} < V_{OUTn} < V_{BAT}, V_{IGNx} ≥ 0 V	P_9.6.47
Diagnosis Filter Time for open load and short to GND in off	$t_{diag,f}$	60	–	135	µs		P_9.6.48
Direct Drive Inputs *INJEN*							
Low Level Input Voltage	$V_{IN,l}$	-0.3	–	0.9	V		P_9.6.49
High Level Input Voltage	$V_{IN,h}$	2	–	V_{VDDIO}	V		P_9.6.50
Input Voltage Hysteresis	$V_{IN,hys}$	50	200	–	mV		P_9.6.51
Pull Down Current	$I_{IN,pd}$	25	–	100	µA	V_{IN} = V_{VDDIO}	P_9.6.52
Pull Down Current	$I_{IN,pd}$	2.4	–	–	µA	V_{IN} = 0.6 V	P_9.6.53

1) Parameter is not subject of production test, specified by design

2) additionally diagnosis currents are active in operation mode; exception *OUT18* to *OUT20* in diagnosis current switch off configuration

3) see **Figure 31**

9.7 Half Bridges *OUT21* to *OUT24*

The TLE8888-1QK integrates 4 half bridges which can be used as half bridge, full bridge, low-side power stage or high-side power stage. They are fully protected against overload and overtemperature and diagnosis fits to the chosen setup of the load. For the description of the diagnosis function see **Chapter 9.7.2**.
They are controlled and enabled like all power stages according the description in **Chapter 9.1** and **Chapter 9.2**. In **Table 29** the effect of **O21E** to **O24E** and **O21ON** to **O24ON** to the high-side and low-side switch of the half bridge is shown.

The half bridges can be configured via MSC/SPI for high- or low-side loads (setup see **Figure 33**) and for passive or active freewheeling (freewheeling is done with bulk diode or actively with switching on the freewheeling path). In **Table 29** the configuration is shown. With the bits **O21M** to **O24M** of the configuration register **BriConfig0** the switching mode is defined. With this configuration the low or the high-side transistor is defined to switch on the load. For low-side switch mode the load is connected to the battery, for high-side switch mode the load is connected to GND (see **Figure 33**). With the bits **O21F** to **O24F** of the configuration register **BriConfig0** the freewheeling behavior is defined. The freewheeling is done for low-side switch mode with the high-side transistors. For passive freewheeling the bulk diode is used and the freewheeling transistor is always off. For the active freewheeling mode the freewheeling transistor is on during an off signal. This is the so called half bridge mode. The alternate switching of the high-side and low-side switch is done with a break before make phase. The definition of the switching mode is important for the correct diagnosis in off (see **Chapter 9.7.2**). The bits **FB1E** and **FB2E** (full bridge enable) are only used for the diagnosis in off for full bridge set up. **FB1E** = "1" is used for loads connected between *OUT21* and *OUT22*. **FB2E** = "1" is used for loads connected between *OUT23* and *OUT24*. The diagnosis in off setup is changed to the special situation of full bridge mode. The setting with **O21M** to **O24M** and **O21F** to **O24F** are valid.

Note: for full bridge set up the same set up for the two half bridges is recommended!

Table 29 Configuration of the Half Bridge

OnM [1]	OnF[1]	OnE[1]	OnON = 1[1]	OnON = 0[1]	Description
0	0	0	high-side =off low-side = off	high-side =off low-side = off	low-side switch mode and passive freewheeling at high-side:[2] both switches are disabled
0	0	1	high-side =off low-side = on	high-side =off low-side = off	low-side switch mode and passive freewheeling at high-side:[2] high-side switch always off, bulk diode of high-side switch is used for passive freewheeling
0	1	0	high-side =off low-side = off	high-side =off low-side= off	low-side switch mode and active freewheeling at high-side:[2] both switches are disabled
0	1	1	high-side =off low-side = on	high-side =on low-side= off	low-side switch mode and active freewheeling at high-side:[2] high-side switch on during freewheeling
1	0	0	high-side =off low-side= off	high-side =off low-side= off	high-side switch mode and passive freewheeling at low-side:[2] both switches are disabled

Table 29   Configuration of the Half Bridge (cont'd)

OnM [1]	OnF [1]	OnE [1]	OnON = 1 [1]	OnON = 0 [1]	Description
1	0	1	high-side =on low-side= off	high-side =off low-side= off	high-side switch mode and passive freewheeling at low-side:[2] low-side switch always off, bulk diode of low-side switch is used for passive freewheeling
1	1	0	high-side =off low-side= off	high-side =off low-side= off	high-side switch mode and active freewheeling at low-side:[2] both switches are disabled
1	1	1	high-side =on low-side= off	high-side =off low-side= on	high-side switch mode and active freewheeling at low-side:[2] low-side switch on during freewheeling

1) n=21 to 24 for the selected half bridge channel
2) setup definition see **Figure 33**
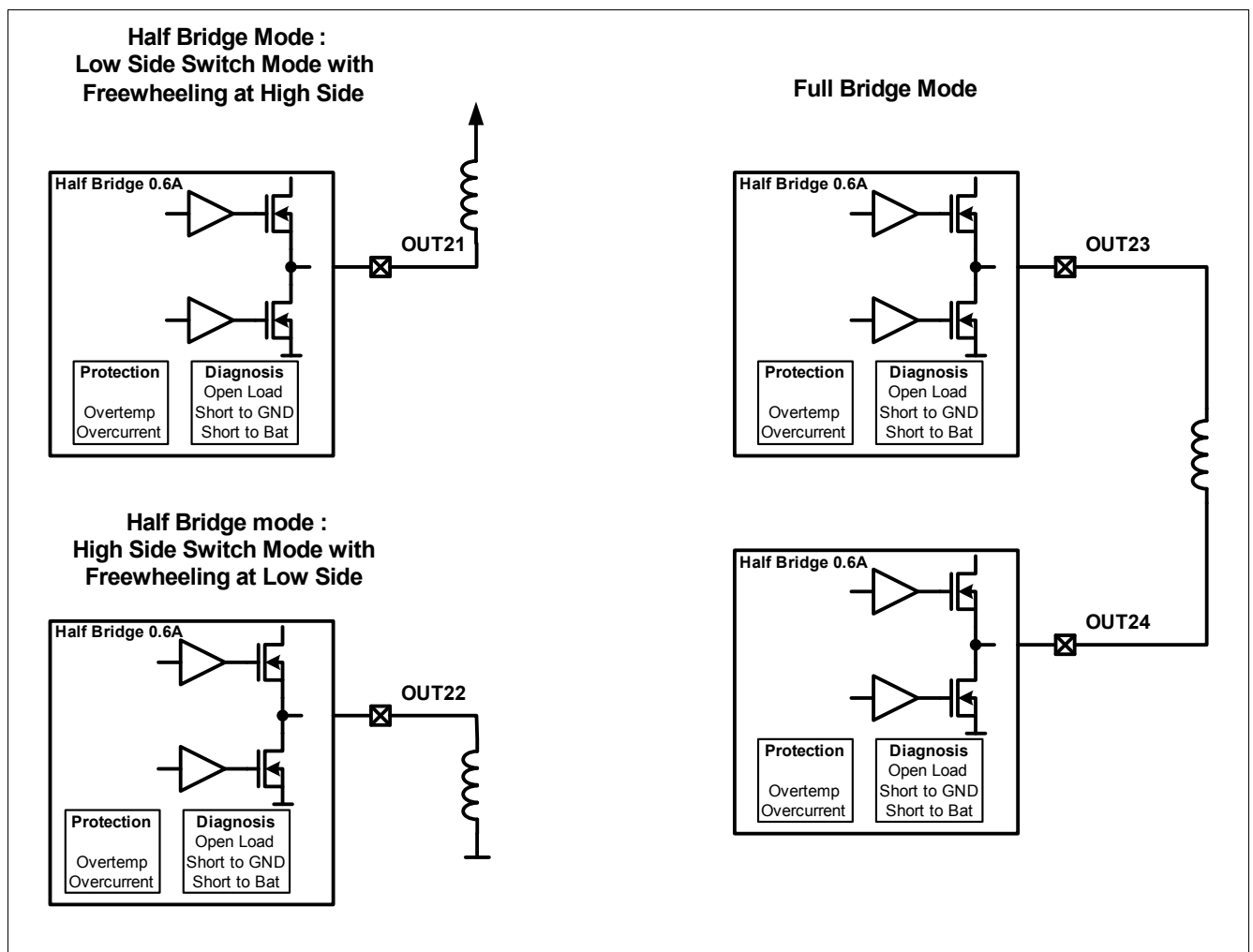
Figure 33   Load setups for half and full bridge mode

9.7.1 Protection of Half Bridges *OUT21* to *OUT24*

The half bridge outputs are fully protected against overcurrent and overtemperature.
In failure case (e.g. short to GND) the affected transistor is switched off after the "**Overcurrent Switch Off Filter Time**" and the diagnosis bit is set. The half bridge output is high ohmic (tristate).
To cover all failure conditions the overtemperature protection is implemented. After exceeding the temperature threshold the half bridge outputs are switched off till the temperature is decreased by the "**Overtemperature Hysteresis**".
For the procedure to switch on an affected channel after failure condition see **Chapter 9.2**.

9.7.2 Diagnosis of Half Bridges *OUT21* to *OUT24*

For the half bridge outputs various diagnosis function are implemented. For short to battery and short to GND in on diagnosis the protection function overcurrent is used (diagnosis bits **O21OC** to **O24OC** in diagnosis register **BriDiag1**). Overtemperature is signalized with the diagnosis bits **B1OT** and **B2OT** in diagnosis register **BriDiag1**. For open load and short to GND (SCG) in off a special circuit is implemented. The diagnosis bits **O21DIA** to **O24DIA** in diagnosis register **BriDiag0** are set according the setup of the channels and according the priority shown in **Table 30**.
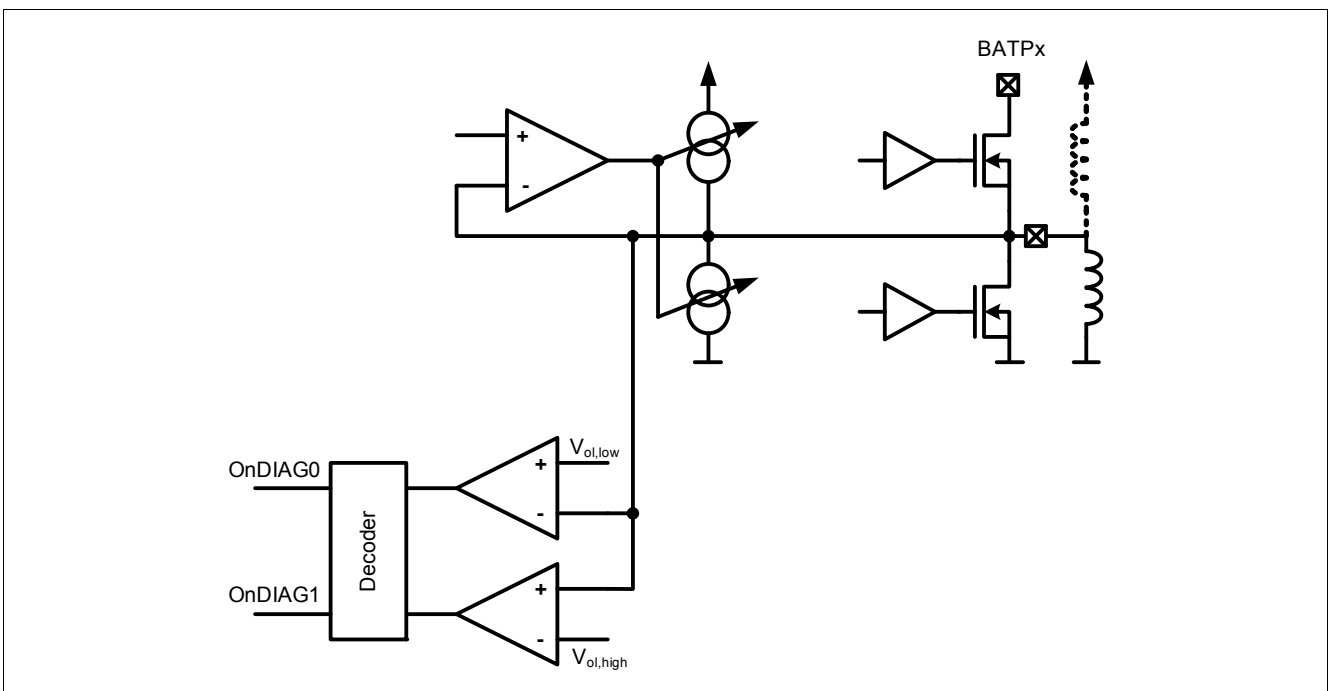
**Figure 34   Open Load and Short to GND/Battery Detection Circuit for Half Bridge Configuration (Low-
or High-Side Load)**
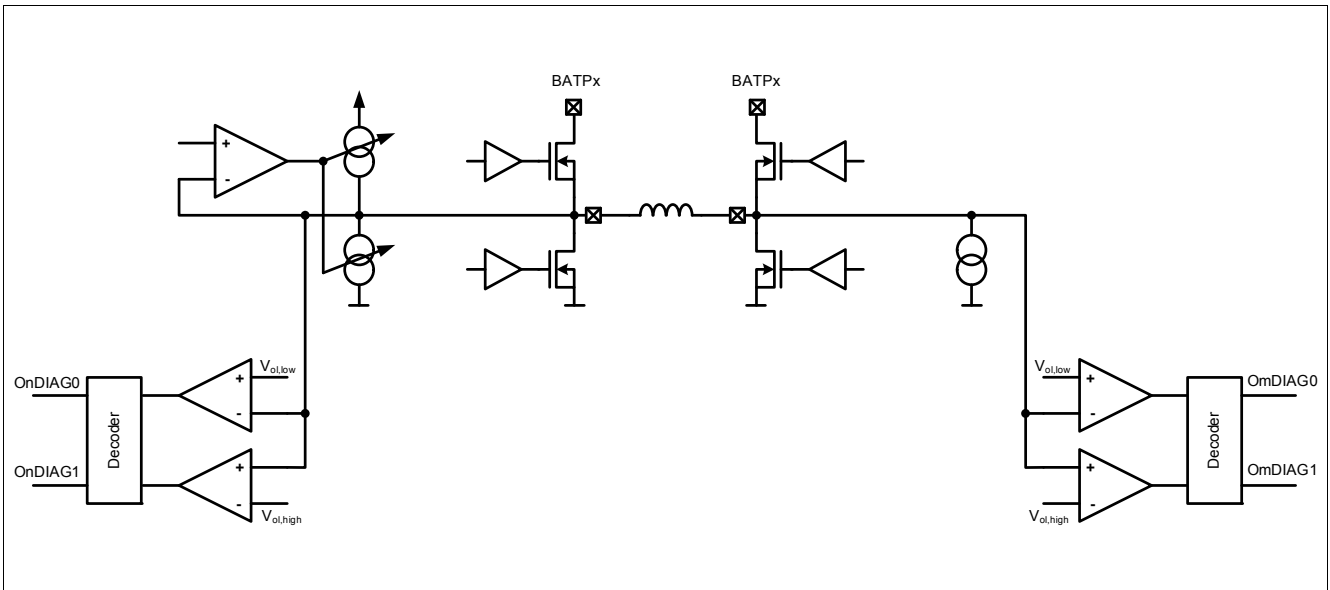
Figure 35   Open Load and Short to GND/Battery Detection Circuit for Full Bridge Configuration

In **Figure 36** and **Figure 37** the behavior of the output current as a function of the output voltage in the different configurations are shown.

The detection in off for open load is the same for both settings but for the short detection there is a difference for low-side and high-side switch mode.

• Hig-side switch mode: short to battery detection in off
• Low-side switch mode: short to GND detection in off
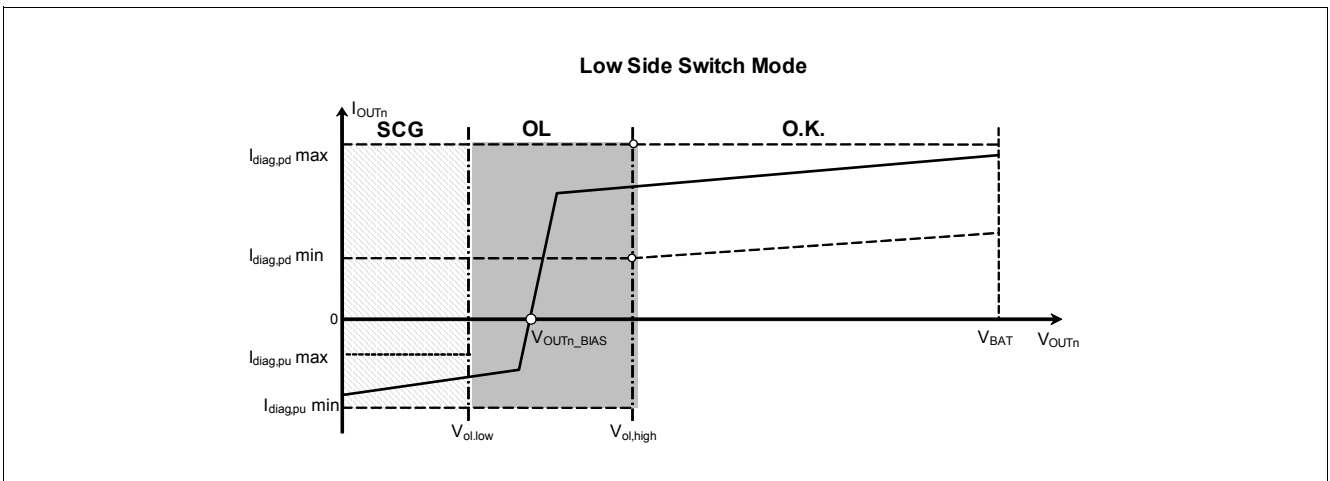
Figure 36   Output Behavior in Off for Low-Side Switch Configuration with Open Load and Short to GND Detection
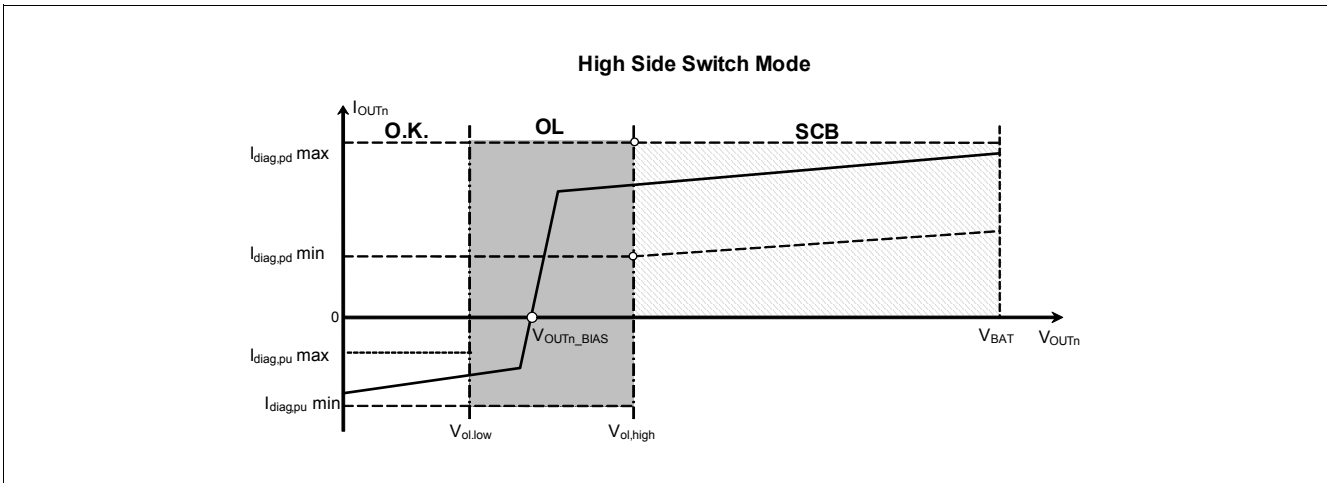
Figure 37   Output Behavior in Off for High-Side Switch Configuration with Open Load and Short to Battery Detection
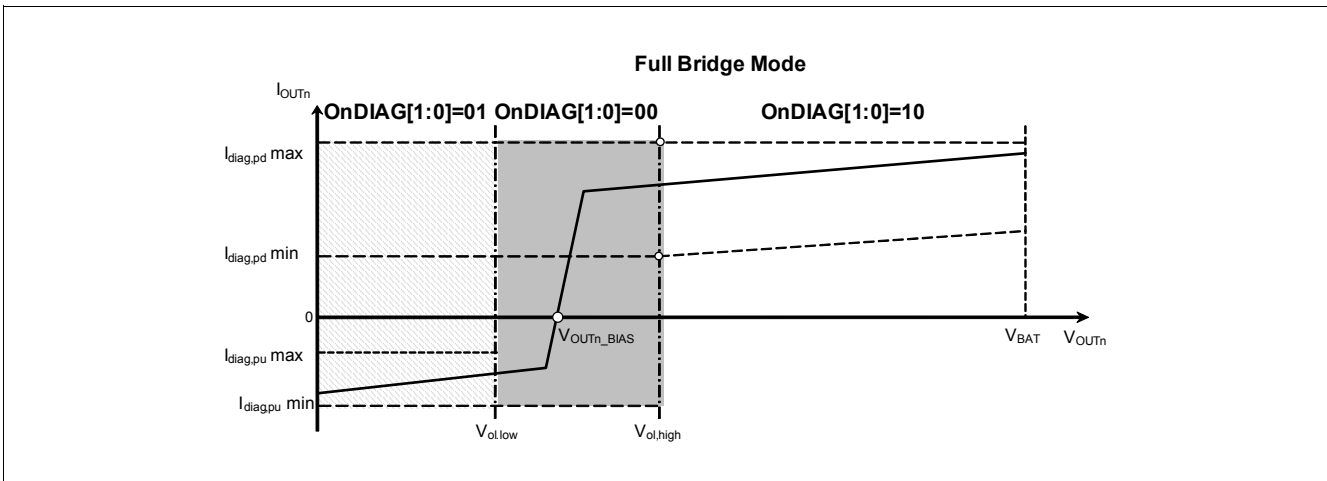
Figure 38   Output Behavior in Off for Full Bridge Mode Configuration

The detection is active if the high-side and the low-side switch are off and the diagnosis activation timer $t_{br,diag,act}$ starts counting. For activation of the open load in off detection in active freewheeling configuration the half bridge must be disabled by setting the bits **O21E** to **O24E** of configuration register **OEConfig2** to "low", for passive freewheeling a normal off signal (*IN9* to *IN12* or **O21ON** to **O24ON** in control register **Cont2** is set to "low") is sufficient. For full bridge mode both half bridges must be off or disabled regarding the setting of the half bridge. After the **Bridge Diagnosis Activation Time** $t_{br,diag,act}$ the output of the detection circuit is stored in the diagnosis register **BriDiag0** according the priority shown in **Table 30**. After activation of the open load in off detection a filter time $t_{br,diag,f}$ to suppress disturbances is implemented. The diagnosis register bits are set after the specified filter times. With the readout of the diagnosis register the content is updated to the actual diagnosis.

In **Table 30** the definition of the diagnosis bits for single switch usage is defined, in **Table 31** the definition for full bridge mode.

Note: especially for full bridge mode it is recommended to read out the diagnosis register twice due to transition states and possible misleading diagnosis register entries

Table 30 Description of Diagnosis Information Single Switch Usage

OnDIAG[1:0][1]	Priority (1 = highest priority)	High-Side Switch Mode	Low-Side Switch Mode
00	3	no failure	no failure
01	2	open load in off	n.a.
10	2	n.a.	open load in off
11	1	short circuit to battery in off	short circuit to ground in off

1) n from 21 to 24

Note: *For high-side switch mode (low-side load) after start up there will be a short to ground detection before the output is configured to high-side load and the diagnosis bits are set to "11". This detection is not right and it is recommended to read out the diagnosis registers twice after start up to avoid wrong diagnosis information.*

Table 31 Description of Diagnosis Information in Full Bridge Mode

OnDIAG[1:0][1]	OmDIAG[1:0][1]	Full Bridge Mode
00	00	no failure
Single Failure		
00	01	open load in off (or double fault open load and short to GND at *OUT22* /*OUT24*)
10	10	short circuit to battery in off
01	01	short circuit to ground in off (or double fault open load and short to GND at *OUT21* /*OUT23*
Double Failure		
00	10	open load and short circuit to bat at *OUT22* /*OUT24* in off
01	10	short circuit to ground at *OUT21* /*OUT23* and short circuit to battery at *OUT22* /*OUT24* in off
10	01	short circuit to battery at *OUT21* /*OUT23* and short circuit to ground or open load at *OUT22* /*OUT24* in off
Remaining Combinations		
10	00	not existing or transition states after switch off
xx	11	
11	xx	
01	00	

1) n = 21 and m=22 or n=23 and m=24

9.7.3 Electrical Characteristics Half Bridges

Table 32 Electrical Characteristics Half Bridges

V_S = 13.5 V, V_{VSV} = 5 V, T_j = -40°C to +150°C, all voltages with respect to GND, positive current flowing into pin, (unless otherwise specified)

Parameter	Symbol	Values			Unit	Note or Test Condition	Number
		Min.	Typ.	Max.			
OUT21…24, n = 21 to 24							
Operation Current	I_{OUTn}	–	–	0.6	A		P_9.1
Overcurrent Switch Off Threshold	$I_{OUTn,oc}$	0.6	–	1.5	A		P_9.2
Overcurrent Switch Off Filter Time	$t_{oc,f}$	0.5	–	2	µs		P_9.3
On Resistance	$R_{OUTn,on}$		–	2.4	Ω	I_{OUTn} = 0.3 A	P_9.4
OUT21 On Resistance at Low Battery Voltage, low temperature	$R_{OUT21,on,l,LT}$		–	2.4	Ω	I_{OUTn} = 0.1 A, V_{BAT} = 4.5 V T_j < 100°C	P_9.5
OUT21 On Resistance at Low Battery Voltage, high temperature	$R_{OUT21,on,l,HT}$		–	2.6	Ω	I_{OUTn} = 0.1 A, V_{BAT} = 4.5 V T_j > 100°C	P_9.6
Leakage Current, low-side	$I_{OUTn,l,low}$	–	–	20[1]	µA	V_{OUTn} = 13.5 V	P_9.7
Leakage Current, high-side	$I_{OUTn,l,high}$	-20[1]	–	–	µA	V_{OUTn} = 0 V	P_9.8
Turn On Delay Time[2]	$t_{d,on}$	–	–	10	µs	I_{OUTn} = 0.3 A, resistive load	P_9.9
Turn Off Delay Time[2]	$t_{d,off}$	0.1	–	10	µs	I_{OUTn} = 0.3 A, resistive load	P_9.10
Switch On Time[2]	$t_{s,on}$	0.9	–	2.5	µs	I_{OUTn} = 0.3 A, resistive load	P_9.11
Switch Off Time[2]	$t_{s,off}$	0.9	–	2.5	µs	I_{OUTn} = 0.3 A, resistive load	P_9.12
Diagnosis OUT21 to 24							
Overtemperature Switch Off Threshold	$T_{OUTn,ot}$	150	–	200	°C	[3]	P_9.13
Overtemperature Hysteresis	$T_{OUTn,ot,hys}$	–	10	–	°C	[3]	P_9.14
Open Load in Off Detection Threshold High Limit	$V_{ol,high}$	0.9*$V5V$ -0.2	0.9*$V5V$	0.9*$V5V$ +0.2	V		P_9.15
Open Load in Off Detection Threshold Low Limit	$V_{ol,low}$	0.5*$V5V$ -0.2	0.5*$V5V$	0.5*$V5V$ +0.2	V		P_9.16
Diagnosis Pull Up Current	$I_{diag,pu}$	-980	–	-220	µA		P_9.17
Diagnosis Pull Down Current	$I_{diag,pd}$	150	–	300	µA		P_9.18
Bridge Diagnosis Activation Time	$t_{br,diag,act}$	60	–	135	µs		P_9.19
Bridge Diagnosis Filter Time	$t_{br,diag,f}$	0.5	–	2	µs		P_9.20

1) In operation leakage current covered by open load current

2) see **Figure 31** for timing definition

3) not subject to production test, specified by design

9.8 Push Pull Stages *OUT8* to *OUT13* and *DFB8* to *DFB13*

These 5 V push pull stages are designed for driving on-board MOSFETs. The outputs are fully protected and various diagnosis functions are implemented.

They are controlled and enabled like all power stages according the description in **Chapter 9.1** and **Chapter 9.2**. In off ("0" in control register or "low" at the configured direct drive input pin) the low-side transistor of the push/pull stage is on and forces a "low voltage level at the pin.

9.8.1 Protection of *OUT8* to *OUT13*

There are functions implemented to detect short to battery at the external MOSFET and to protect the driver outputs.

For the short to battery detection feedback pins *DFB8* to *DFB13* are implemented to sense the voltage at the drain of the external MOSFET. The short to battery detection in on is done by comparing the voltage level of the drain feedback pins with the short to bat detection threshold.

A short is detected after the "**Short to Battery Detection Filter Time**". In case of short to battery the output is switched off and the corresponding diagnosis bits in the diagnosis register **OutDiag1** to **OutDiag3** are set according the priority shown in **Table 33**. There are four different thresholds, "**Short to Battery Detection Threshold in On 1**" to "**Short to Battery Detection Threshold in On 4**", implemented so that the detection threshold can be adapted to the used MOSFET. The diagnosis of the push pull stages can be set in three groups. The configuration is done with the bits **PP0D** to **PP2D** in the configuration register **OutConfig2** and **OutConfig3**.

The protection of the driver output pins is done by comparing the output voltage on the pins *OUT8* to *OUT13* with the "**Overvoltage Detection Threshold**". An overvoltage (e.g. short to battery) is detected after the "**Overvoltage Diagnosis Filter Time**" and the corresponding diagnosis bits in the diagnosis register **PPOVDiag** is set. In case of overvoltage high and low-side transistors of the push pull driver are switched off (high ohmic state).

9.8.2 Diagnosis of *OUT8* to *OUT13*

For the push pull stages *OUT8* to *OUT13* various diagnosis functions for the external MOSFETs are implemented. The open load, short to ground in off and short to battery in on detection is done via the drain feedback *DFB8* to *DFB13*. The diagnosis pull down current of the open load/short to ground in off detection can be switched off (see configuration register **OutConfig2**). With deactivated pull down current open load in off detection is not active and the diagnosis information of OnDIAG[1:0] = 10B will never occur. With deactivated pull down current the short to ground detection is active.

In **Figure 39** the behavior of the output current as a function of the output voltage is shown.
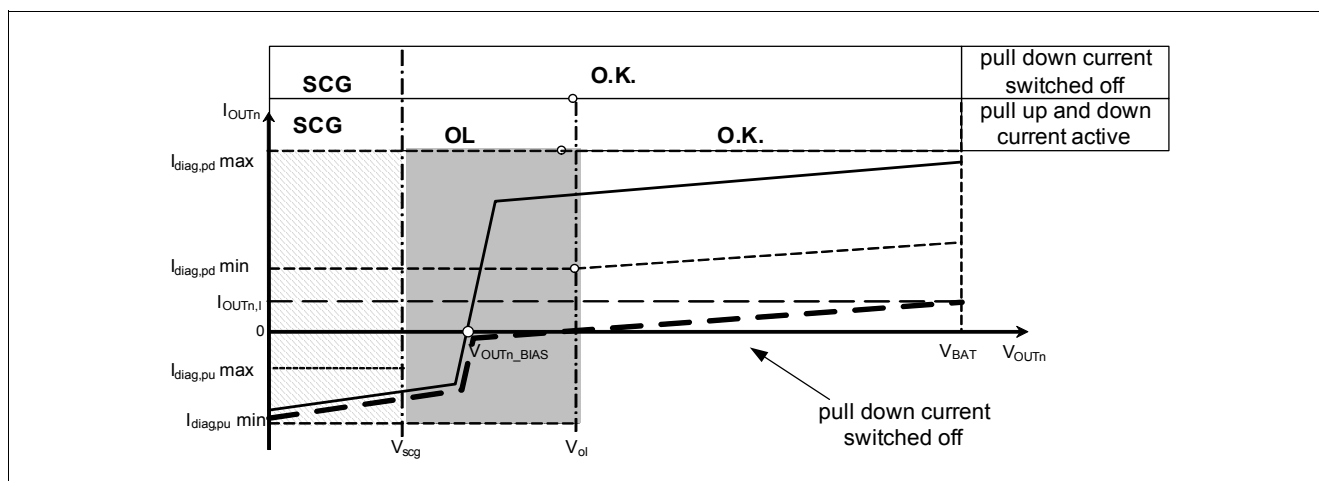
Figure 39   Output behavior in off with open load and short to GND detection of *DFB8* to *DFB13*

Whenever the push pull stages are off the open load/short to GND detection circuit is enabled. To suppress disturbances the output of the detection circuit is stored in the diagnosis register **OutDiag1** to **OutDiag3** after the **Diagnosis Filter Time for Open Load and Short to GND in Off Detection** $t_{diag,f}$ and according the priority shown in **Table 33**. With the readout of the diagnosis register the content is updated to the actual diagnosis.

Table 33   Description of Diagnosis Information (*DFB8* to *DFB13*)

OnDIAG[1:0]	Priority (1 = highest priority)	Description
00	4	no failure
01	1	short circuit to battery
10	2	open load in off[1]
11	3	short circuit to ground in off

1)   no open load in off detection with deactivated pull down current

9.9   Electrical Characteristics Push Pull Stages *OUT8* to *OUT13*

Table 34   Electrical Characteristics Push Pull Stages *OUT8* to *OUT13*

Stages on or off, V_S = 13.5 V, V_{VSV} = 5 V, T_j = -40°C to +150°C, all voltages with respect to GND, positive current flowing into pin, (unless otherwise specified)

Parameter	Symbol	Values			Unit	Note or Test Condition	Number
		Min.	Typ.	Max.			
OUT8…13, n = 8 to 13							
High Level Output Voltage	$V_{OUTn,h}$	4	–	5.5	V	I_{OUTn} = -5 mA	P_9.8.1
Low Level Output Voltage	$V_{OUTn,l}$	–	–	0.6	V	I_{OUTn} = 5 mA	P_9.8.2
Pull up current	$I_{OUTn,pu}$	–	–	-20	mA	V_{OUTn} = 0 V, OUTn on	P_9.8.3
Pull down current	$I_{OUTn,pd}$	20	–	–	mA	V_{OUTn} = 5 V, OUTn off	P_9.8.4

Table 34   Electrical Characteristics Push Pull Stages *OUT8* to *OUT13* (cont'd)

Stages on or off, V_S = 13.5 V, V_{VSV} = 5 V, T_j = -40°C to +150°C, all voltages with respect to GND, positive current flowing into pin, (unless otherwise specified)

Parameter	Symbol	Values			Unit	Note or Test Condition	Number
		Min.	Typ.	Max.			
Overvoltage Detection Threshold	$V_{OUTn,ov,th}$	5.5	–	7.7	V		P_9.8.5
Overvoltage Diagnosis Filter Time	$t_{OUTn,ov,f}$	5	–	10	µs		P_9.8.6
Diagnosis *DFB8* to *DFB13*							
Short to Battery Detection Threshold in On 1	$V_{DFBn,sb,1}$	90	125	150	mV	referred to *PGND*	P_9.8.7
Short to Battery Detection Threshold in On 2	$V_{DFBn,sb,2}$	180	225	250	mV	referred to *PGND*	P_9.8.8
Short to Battery Detection Threshold in On 3	$V_{DFBn,sb,3}$	350	400	450	mV	referred to *PGND*	P_9.8.9
Short to Battery Detection Threshold in On 4	$V_{DFBn,sb,4}$	0.7	0.8	0.9	V	referred to *PGND*	P_9.8.10
Short to Battery Detection Filter Time	$V_{DFBn,sb,fl}$	10	–	15	µs		P_9.8.11
Open Load in Off Detection Threshold	V_{ol}	*V5V*-0.2	*V5V*	*V5V*+0.2	V		P_9.8.12
Short to GND in Off Detection Threshold	V_{scg}	0.5*V5V-0.2	0.5*V5V	0.5*V5V+0.2	V		P_9.8.13
Diagnosis Pull Down Current in Off	$I_{diag,pd}$	220	–	600	µA	V_{DFBn} = 13.5 V	P_9.8.14
Diagnosis Pull Up Current in Off	$I_{diag,pu}$	-300	–	-100	µA	V_{DFBn} = 0 V	P_9.8.15
Diagnosis Filter Time for Open Load and Short to GND in Off Detection	$t_{diag,f,off}$	60	–	135	µs		P_9.8.16
Pull Down Current in On	$I_{diag,pd,on}$	–	–	1.8	µA	V_{DFBn} = 5 V	P_9.8.17

9.10   Push Pull Stages *IGN1* to *IGN4*

The *IGN1* to *IGN4* are 5 V push pull stages for on- and off-board ignition power stages (e.g. with IGBTs, darlington transistors). For off board ignition power stages the outputs *IGN1* to *IGN4* are equipped with a back supply suppression (in case of a short circuit from *IGN1* to *IGN4* to battery there is no parasitic current flow back to 5 V).

They are controlled and enabled like all power stages according the description in **Chapter 9.1** and **Chapter 9.2**. Additionally a "high" at the pin *IGNEN* is needed to enable the outputs. In off ("0" in control register or "low" at the configured direct drive input pin or *IGNEN* is "low") the low-side transistor of the push/pull stage is on and forces a "low voltage level at the pin.
The outputs are fully protected and various diagnosis functions are implemented.

9.10.1   Protection of *IGN1* to *IGN4*

The protection of the outputs is done by detecting short to battery and short to ground. This is done by comparing the output voltage level with the "**Short to Battery Detection Threshold** and **Short to Ground**

Detection Threshold". To suppress disturbances the output signal of the short to GND and short to battery detection circuit is stored in the diagnosis register **IgnDiag** after the "**Diagnosis Filter Time for Short to GND and Battery Detection**" $t_{\text{diag,f,sc}}$ and according the priority shown in **Table 35**.

During detected short to GND the output is switched off (low-side transistor of push/pull stage is on), during detected short to battery the output is high ohmic (tristate).

The short to battery detection is always active. The short to ground detection is enabled with the on signal of the output stage.

Additionally an overtemperature protection is implemented. There is one common sensor for *IGN1* and *IGN2* and one for *IGN3* and *IGN4*.

9.10.2   Diagnosis of *IGN1* to *IGN4*

An open load detection during the switch on phase is implemented and can be enabled with the bit **IOLA** in the configuration register **IGNConfig**. In **Figure 40** the detection principle is shown. When the open load detection in on is enabled, first the output is pulled up by a defined current, which is set by the bits **IOLI** in the configuration register **IGNConfig**.

The output voltage, which is passed to the detection circuit, is filtered ("**Diagnosis Filter Time for Open Load Detection**") to suppress disturbances. After the open load time ("**Open Load Time 1**" to "**Open Load Time 4**"selected in configuration register **IGNConfig** bits **IOLT**) the filtered output is compared with the **Open Load Detection Threshold Vol**. The diagnosis register **IgnDiag** is set if the filtered output is higher than the **Open Load Detection Threshold** and the output is fully switched on.

The failures are stored in the diagnosis register according the priority shown in **Table 35** with "1" is the highest priority. With the readout of the diagnosis register **IgnDiag** the content is updated to the actual diagnosis.

Table 35   Description of Diagnosis Information (*IGN1* to *IGN4*)

IGNnDIAG[1:0]	Priority (1 = highest priority)	Description
00	4	no failure
01	1	short circuit to battery or overtemperature
10	2	open load
11	3	short circuit to ground in on
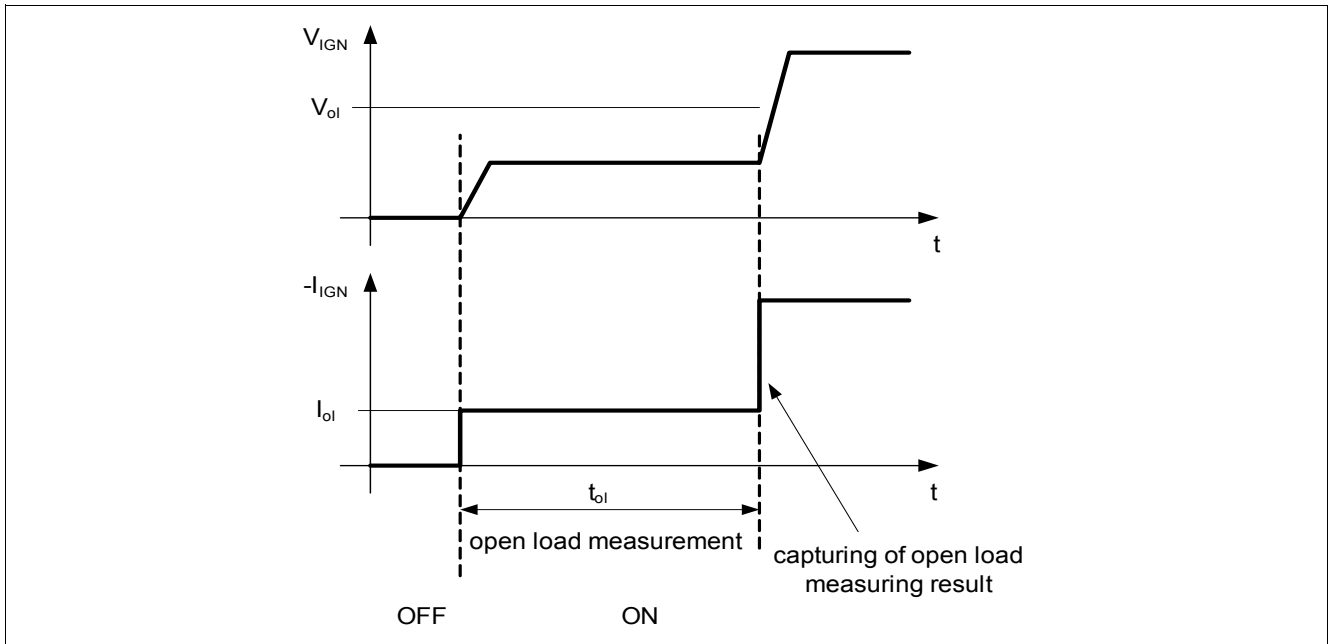
Figure 40   Ignition Output Open Load Detection

9.11   Electrical Characteristics Push Pull Stages *IGN1* to *IGN4*

Table 36   Electrical Characteristics Push Pull Stages

Stages on or off, V_S = 13.5 V, V_{VSV} = 5 V, T_j = -40°C to +150°C, all voltages with respect to GND, positive current flowing into pin, (unless otherwise specified)

Parameter	Symbol	Values			Unit	Note or Test Condition	Number
		Min.	Typ.	Max.			
IGN1…4, n = 1 to 4							
High Level Output Voltage	$V_{IGNn,h}$	4.35	–	–	V	I_{IGNn} = -15 mA,	P_9.9.1
Low Level Output Voltage	$V_{IGNn,l}$	–	–	0.6	V	I_{IGNn} = 5 mA	P_9.9.2
Pull up current	$I_{IGNn,pu}$	–	–	-20	mA	V_{IGNn} = 0 V, IGNn on	P_9.9.3
Pull down current	$I_{IGNn,pd}$	20	–	–	mA	V_{IGNn} = 5 V, IGNn off	P_9.9.4
Leakage current	I_{L_IGNn}	–	–	120	µA	V_{IGNn} = 13.5 V	P_9.9.5
Leakage current to *V5V*	$I_{L\_IGNn,V5V}$	–	–	1	µA	V_{IGNn} = 13.5 V	P_9.9.26
Overtemperature Switch Off Threshold	$T_{IGNx,ot}$	150	–	200	°C	[1]	P_9.9.6
Overtemperature Hysteresis	$T_{IGNx,ot,hys}$		10		°C	[1]	P_9.9.7
Diagnosis *IGN1* to *IGN4*							
Short to Battery Detection Threshold	$V_{IGNn,scb}$	6.4	–	7.5	V		P_9.9.8
Short to Ground Detection Threshold	V_{scg}	1.6	–	2.3	V		P_9.9.9
Diagnosis Filter Time for Short to GND and Battery Detection	$t_{diag,f,sc}$	5	–	10	µs		P_9.9.10

Table 36   Electrical Characteristics Push Pull Stages (cont'd)

Stages on or off, V_S = 13.5 V, V_{VSV} = 5 V, T_j = -40°C to +150°C, all voltages with respect to GND, positive current flowing into pin, (unless otherwise specified)

Parameter	Symbol	Values			Unit	Note or Test Condition	Number
		Min.	Typ.	Max.			
Open Load Detection Threshold	V_{ol}	4	–	4.5	V		P_9.9.11
Open Load Switch On Current 1	$I_{olf,1}$	-120	-100	-40	µA		P_9.9.12
Open Load Switch On Current 2	$I_{olf,2}$	-500	-400	-300	µA		P_9.9.13
Open Load Switch On Current 3	$I_{olf,3}$	-1.2	-1	-0.4	mA		P_9.9.14
Open Load Switch On Current 4	$I_{olf,4}$	-5	-4	-2.5	mA		P_9.9.15
Open Load Time 1	$t_{ol,1}$	50	60	70	µs		P_9.9.16
Open Load Time 2	$t_{ol,2}$	210	250	290	µs		P_9.9.17
Open Load Time 3	$t_{ol,3}$	450	510	570	µs		P_9.9.18
Open Load Time 4	$t_{ol,4}$	690	775	860	µs		P_9.9.19
Diagnosis Filter Time for Open Load Detection	$t_{diag,f,olf}$	6	10	14	µs		P_9.9.20
Direct Drive Inputs *IGNEN*							
Low Level Input Voltage	$V_{IN,l}$	-0.3	–	0.9	V		P_9.9.21
High Level Input Voltage	$V_{IN,h}$	2	–	V_{VDDIO}	V		P_9.9.22
Input Voltage Hysteresis	$V_{IN,hys}$	50	200	–	mV		P_9.9.23
Pull Down Current	$I_{IN,pd}$	25	–	100	µA	$V_{IN} = V_{VDDIO}$	P_9.9.24
Pull Down Current	$I_{IN,pd}$	2.4	–	–	µA	V_{IN} = 0.6 V	P_9.9.25

1) Parameter is not subject of production test, specified by design

10 VR and Hall Sensor Interface

The variable reluctance (VR) sensor interface converts an output signal of a VR sensor into a push-pull logic level signal suited for microcontroller input ports. To achieve the best accuracy for the positive and the negative edge of the *VROUT* signal the switching point is the zero crossing. For robustness against disturbances the next zero crossing is enabled only if a signal peak (minimum or maximum of the signal) is detected. The amplitude of the VR sensor signal is limited by an internal clamping circuit to avoid damage of the device due to overvoltage caused by the VR sensor signal.

There are three operation modes for VR sensor applications and one Hall sensor mode implemented. The manuel VR sensor mode with static setup of the detection parameter under control of the microcontroller via MSC/SPI and an auto mode with an adaptive algorithm to ensure best detection performance. The semi auto mode is less accurate then the auto mode.

The diagnosis VR sensor interface setup could be done by measuring the voltage between the two input pins during diagnosis mode. Additionally three diagnosis bits for short to battery, short to GND and open load (directly at the pins) are available.
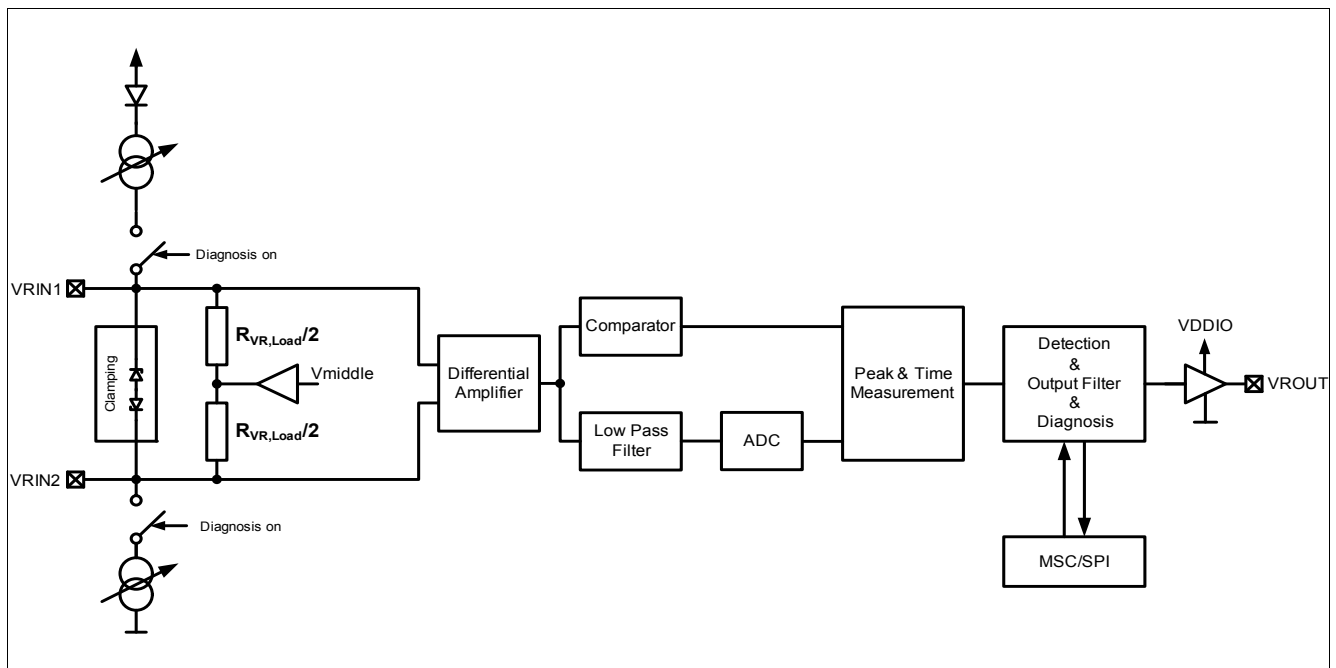
Figure 41   VR Sensor Interface Block diagram

10.1 Signal Detection

The signal detection for Hall sensor mode is a comparator with the switching threshold **VVRIN1,th, hall** and the hysteresis **VVRIN1,hys, hall**. The detection of the VR signal consist of the zero crossing detection, peak detection and the output filter. At the input there is a clamping circuit between the pins *VRIN1* and *VRIN2* suited to clamp the maximum current of VR sensors.

The zero crossing detection ensures that the influence of the input signal slope is eliminated for both edges. To avoid disturbances due to the floating input signal a middle voltage is applied with the integrated load resistance. The clamping circuit between the pins *VRIN1* and *VRIN2* clamps the input voltage in both direction to protect the input structures. The clamping is suited for VR sensors with a maximum output current of **ΔIVR,clamp** (see **Table 37**).

The peak detection is done by measuring the voltage difference by the analog to digital converter and the detection of the slope of the input signal. If the gradient of the slope changes the sign the next zero crossing detection is enabled. The detection of the sign is done by comparing the absolute value of the signal with the

peak detection threshold (**VVR,peak,min,1** to **VVR,peak,min,4** according setup). A sign change is only valid if the absolute value of the signal is larger than peak detection threshold (**VVR,peak,min,1** to **VVR,peak,min,4** according setup) for a time longer than the peak detection time **tVR,peak,min,1** to **tVR,peak,min,2** according setup (see **Figure 42**).
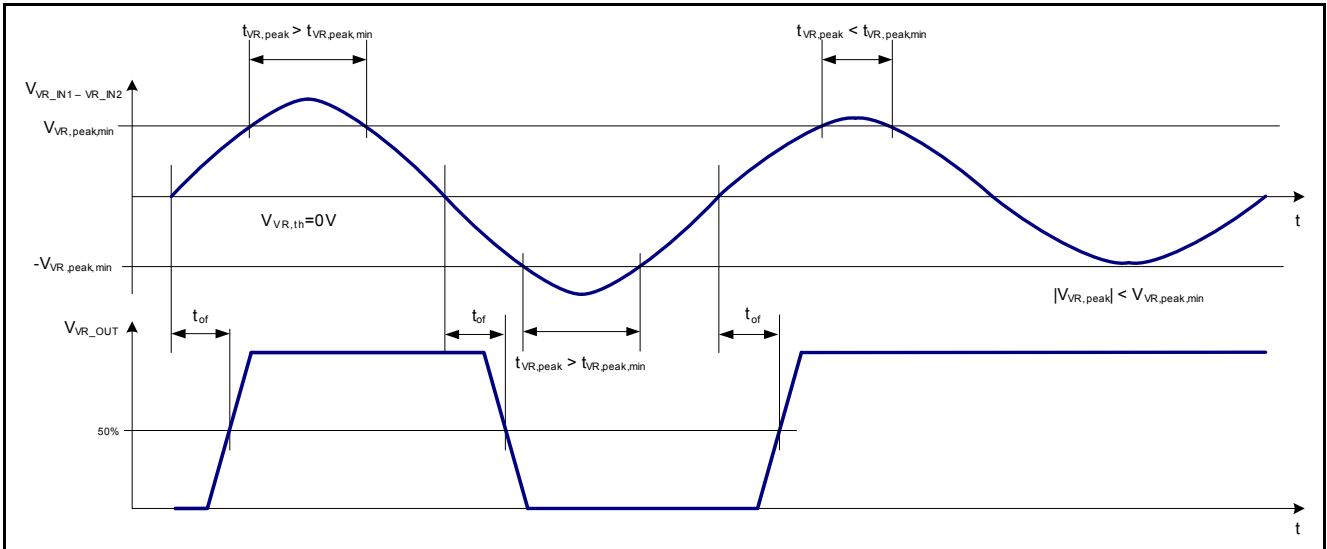
Figure 42   Timing Characteristics of the VR Sensor Interface

The output filter is implemented for all operation modes to suppress disturbances with high frequencies. The function is shown in **Figure 43**. The output signal *VROUT* is filtered with the time **tof,1**. The output signal of the internal zero crossing detection must be stable for a time longer than **tof,1**.
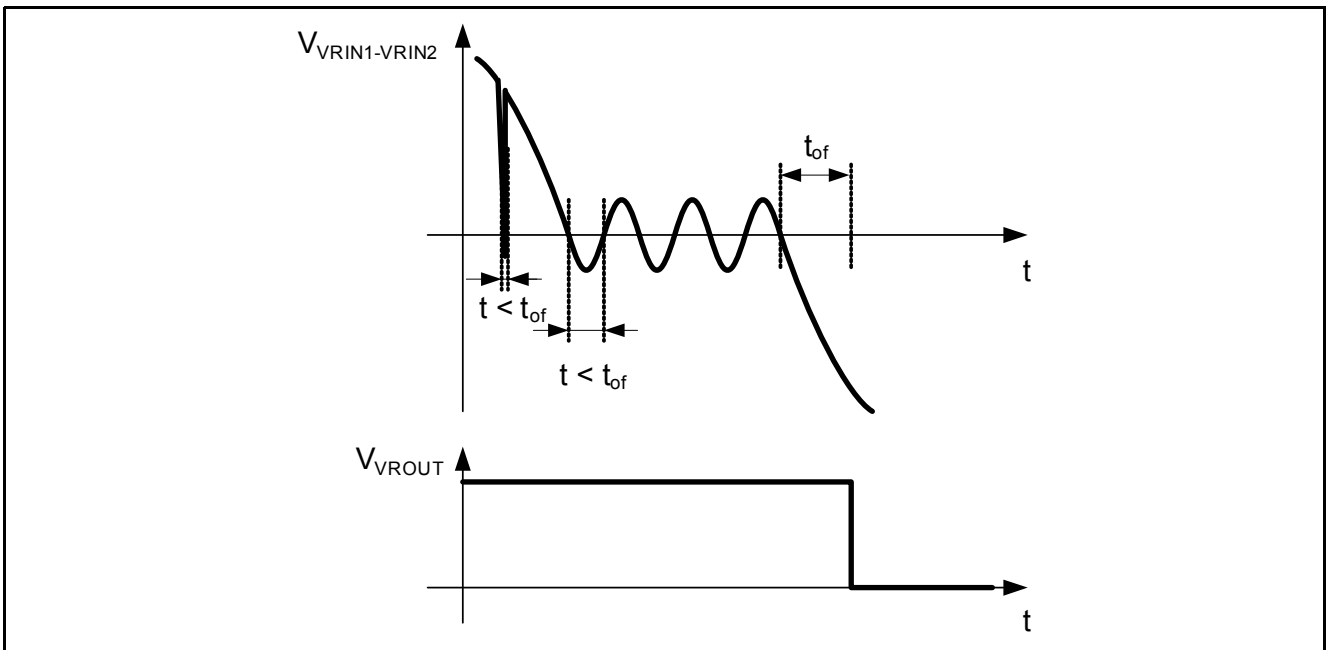
Figure 43   Output Filter Behavior

Following parameters could be set by MSC/SPI communication:

- peak detection threshold **VVR,peak,min,1** to **VVR,peak,min,4** with the bits **VRSPV** in the configuration register **VRSConfig0**

- peak detection time **tVR,peak,min,1** to **tVR,peak,min,2** with the bit **VRSPT** in the configuration register **VRSConfig0**
- output filter time **tof,1** to **tof,4** with the bits **VRSF** in the configuration register **VRSConfig0**

10.2 Detection Modes

The TLE8888-1QK integrates four detection modes:

- auto detection mode for VR sensor signals
- manual detection mode for VR sensor signals
- semi auto detection mode for VR sensor signals
- detection mode for Hall sensor signals

To select the various detection modes the bits **VRSM** in the configuration register **VRSConfig1** must be set.

Auto detection mode for VR sensor signals: In the auto detection mode an algorithm is setting all parameters to the optimal values to achieve the best detection behavior. The peak detection time is set due to the actual speed value, the peak detection threshold is set due to the level of the previous peaks. The output filter time (**tof,1** to **tof,4**) is set by the microcontroller independently to increase the robustness against short disturbances at the inputs. Write access to the registers bits of **VRSPT** and **VRSPV** are ignored in auto detection mode.

Semi auto detection mode for VR sensor signals: The algorithm of the semi auto mode is based on less number of measurement information as the auto detection mode. This leads to a simpler implementation of the detection algorithm. The output filter time (**tof,1** to **tof,4**) is set by the microcontroller independently to increase the robustness against short disturbances at the inputs. Write access to the registers bits of **VRSPT** and **VRSPV** are ignored in semi auto detection mode.

Manual detection mode for VR sensor signals: In the manual detection mode the microcontroller has the full control of all parameters of the detection and the algorithm of the auto detection modes are disabled. The settings are done via the MSC/SPI interface.

Detection mode for Hall sensor signals: For the Hall sensor mode the pin *VRIN2* is forced internally to the switching threshold **VVRIN1,th, hall**. The detection principle is a comparator with hysteresis. Write access to the registers bits of **VRSPT** and **VRSPV** are ignored in the detection mode for Hall sensor signals. The diagnosis is disabled. With this set up the number of external devices is reduced (see **Chapter 17.2**).

Note: Switching between the different configurations must be avoided with active signals at the inputs VRIN1 and VRIN2.

10.3 Diagnosis for VR Sensor Signal Detection Modes

The TLE8888-1QK integrates three different diagnosis modes for the VR sensor interface:

- short to GND/short to battery diagnosis mode: detection of short to GND or short to battery directly at pins *VRIN1* and *VRIN2*
- open load diagnosis mode: detection of open load directly at pins *VRIN1* and *VRIN2*
- ADC measurement mode: measurement of the voltage between the pins *VRIN1* and *VRIN2*

The modes are defined in the configuration register **VRSConfig1** with the bits **VRSDIAGM**.

The diagnosis of the VR sensor is done by activating the diagnosis mode with the bits **VRSDIAGM** in the configuration register **VRSConfig1** and starting diagnosis measurement with the bit **VDIAGS** in the command register **Cmd0**. With the activation of the VRS diagnosis mode at *VRIN1* a pull up current source to the internal supply and at *VRIN2* a pull down current source is applied (current configuration with bits **VRSI_SC** for short to GND/short to battery diagnosis mode, **VRSI_OL** for open load diagnosis mode and **VRSI_ADC** for ADC

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measurement mode in the configuration registers **VRSConfig1** and **VRSConfig2**).To avoid bad influence of the time constants of the external circuitry the timing of the measurement is controlled by the microcontroller. The sequence is shown in **Figure 44**.

The end of the diagnosis procedure triggered by the start command is signalized by the correspondent data valid bits **VRSDV_SC** (short to GND and short to battery diagnosis mode), **VRSDV_OL** (open load diagnosis mode) in diagnosis register **VRSDiag0** and **VRSDV_ADC** (ADC measurement mode) in the diagnosis register **VRSDiag1**.

For the detection thresholds see parameter **Short to GND detection threshold**, **Short to battery detection threshold** and **Open load detection threshold**. The output of the ADC measurement is defined by the parameter **ADC measurement gain** and **ADC measurement offset**.

The result of the diagnosis is available in the diagnosis register **VRSDiag0** with the bits **VRSG** (short to GND detection), **VRSB** (short to battery detection) and **VRSOL** (open load detection directly at the pins). The digital value of the ADC measurement is available in the register **VRSDiag1** with the bits **VRSD**. This ADC value can be used by the microcontroller to define additional error detection conditions different to the defined short to GND, short to battery and open load thresholds.

The data valid bits are reset with start of the corresponding diagnosis or with the readout of the register.

Note: In detection mode for Hall sensor signals the diagnosis is deactivated and the values of ***VRSDIAGM*** and ***VRSI_SC***in the register ***VRSConfig1***,***VRSI_ADC*** and ***VRSI_OL*** in register ***VRSConfig2*** and the start command ***VDIAGS*** in the register ***Cmd0*** are ignored*.
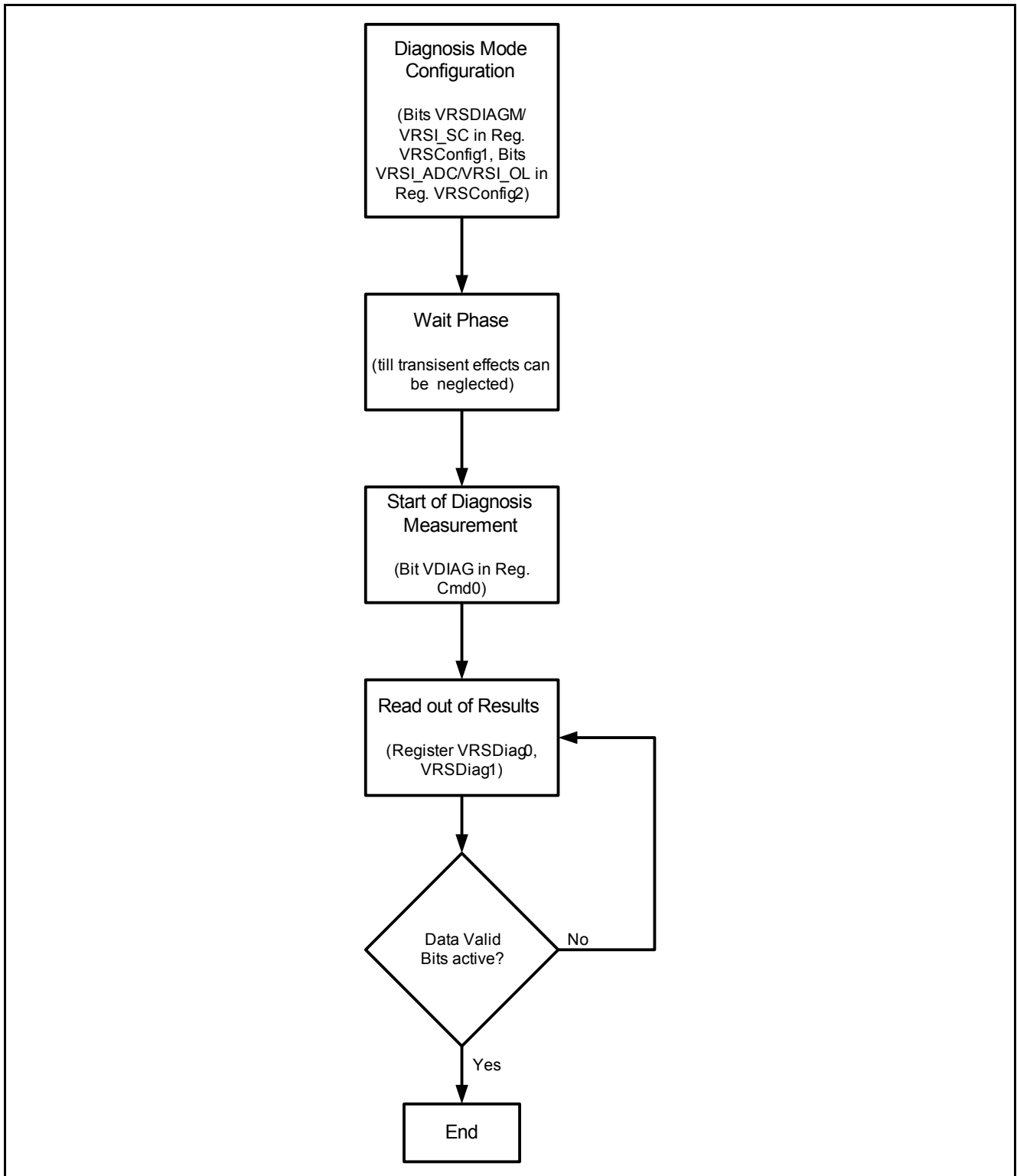
Figure 44   VRS Flow Chart

For the measurement the internal circuits are changed. In **Figure 45**, **Figure 46** and **Figure 47** the block diagram of the different setups are shown.
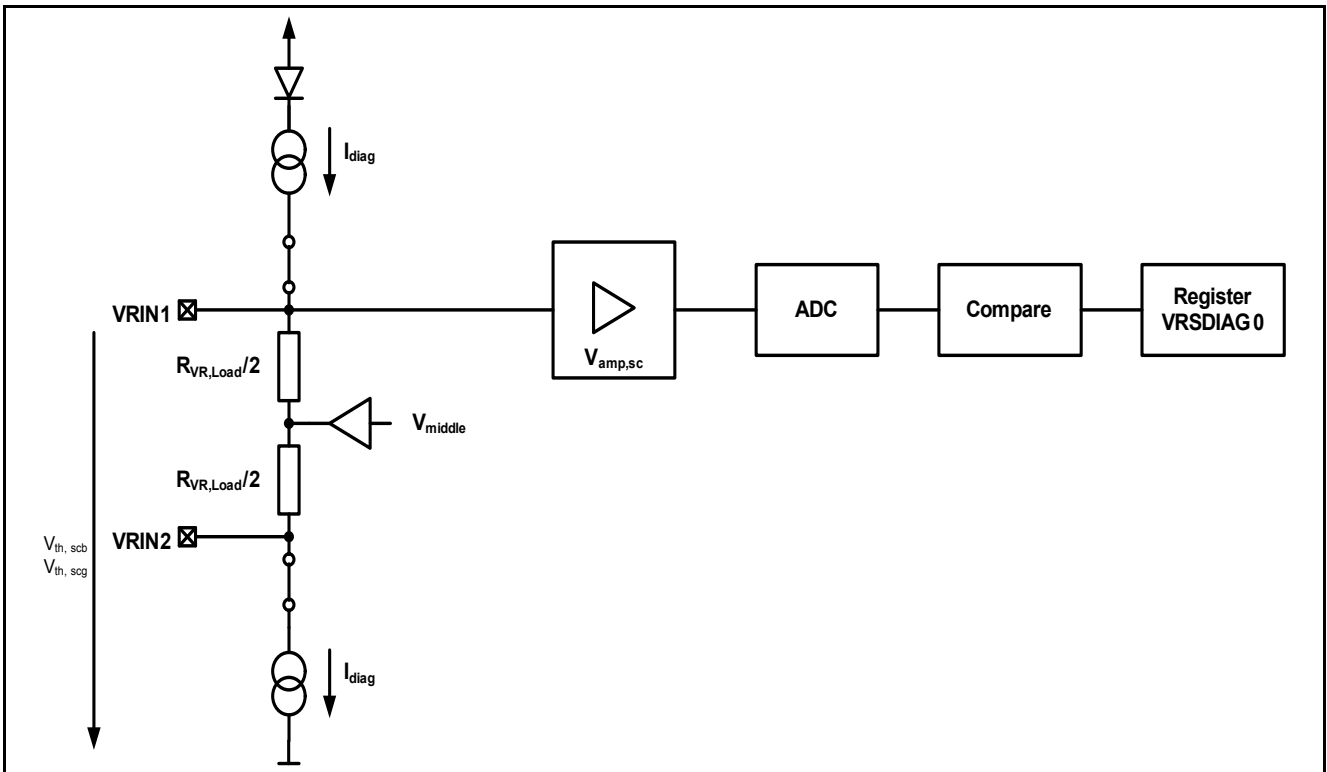
Figure 45   VRS Diagnosis Block Diagram for Short to GND and Short to Battery Measurement
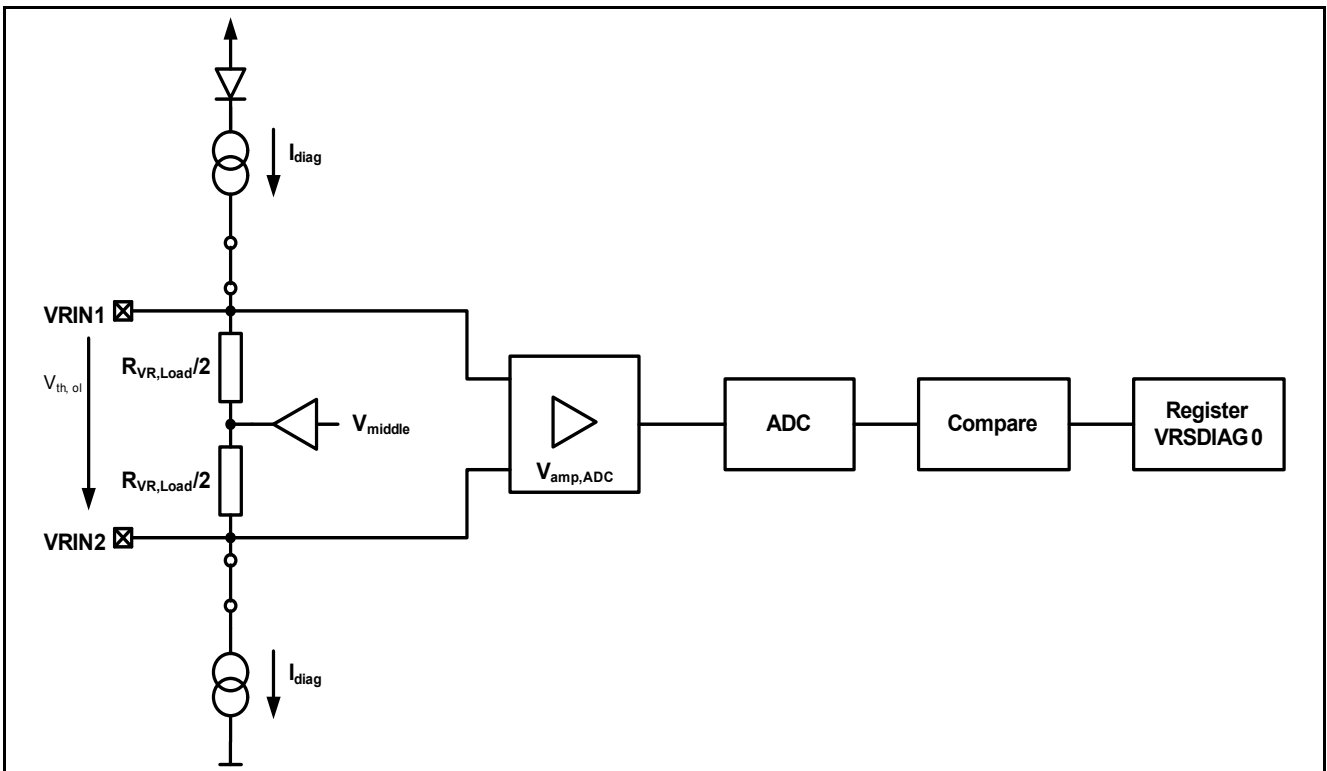
Figure 46   VRS Diagnosis Block Diagram for Open Load Measurement
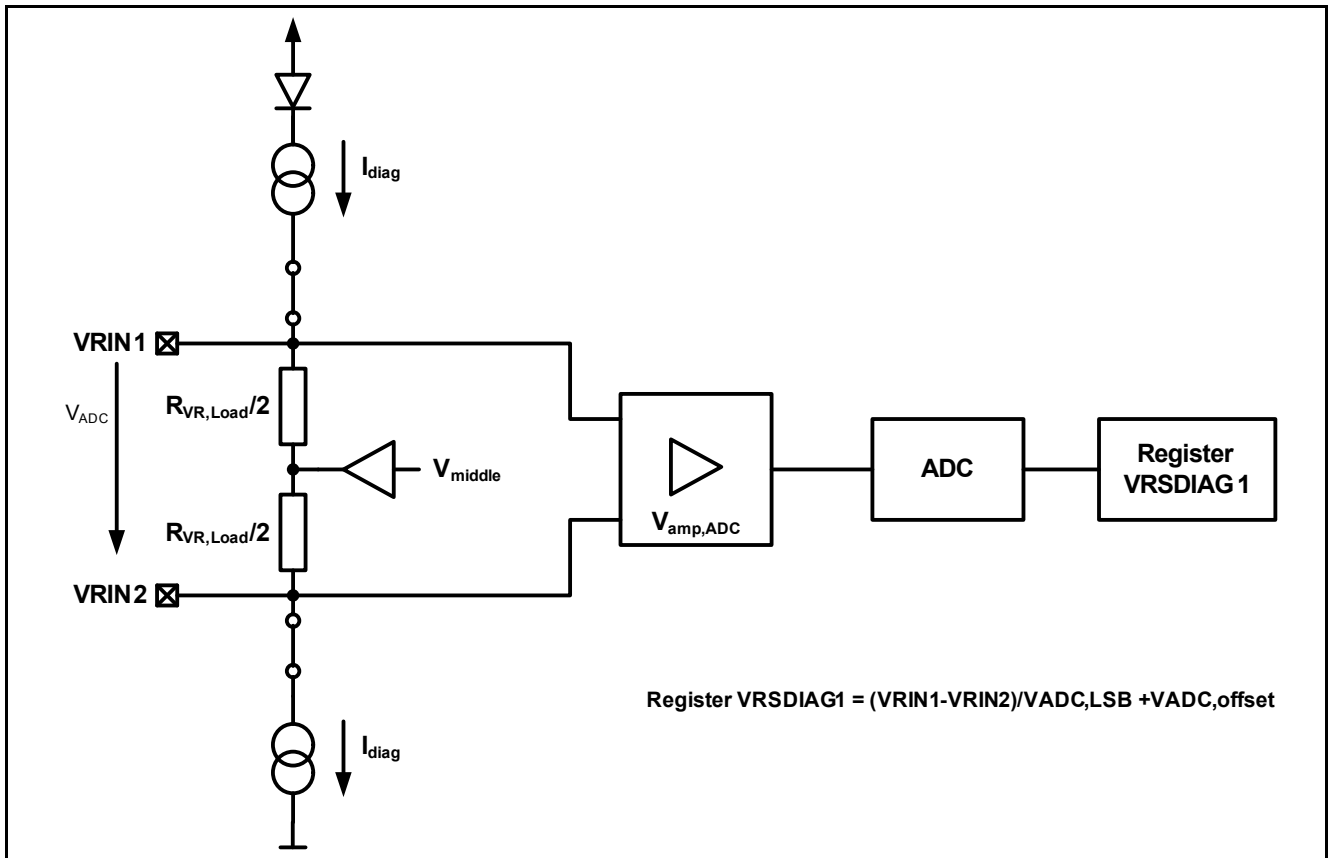
Figure 47   VRS Diagnosis Block Diagram for ADC Measurement

10.4 Electrical Characteristics VR Sensor Interface

Table 37   Electrical Characteristics: VR Sensor Interface

V_S = 13.5 V, V_{VSV} = 5 V, T_j = -40°C to +150°C, all voltages with respect to ground, positive current flowing into pin (unless otherwise specified)

Parameter	Symbol	Values			Unit	Note or Test Condition	Number
		Min.	Typ.	Max.			
Input Characteristics:							
VR Sensor Interface Detection Threshold	$V_{VR,th}$	-30	0	30	mV		P_10.4.1
minimum amplitude for peak detection 1	$V_{VR,peak,min,1}$	–	50	–	mV	reset value	P_10.4.2
minimum amplitude for peak detection 2	$V_{VR,peak,min,2}$	–	150	–	mV		P_10.4.3
minimum amplitude for peak detection 3	$V_{VR,peak,min,3}$	–	350	–	mV		P_10.4.4
minimum amplitude for peak detection 4	$V_{VR,peak,min,4}$	–	550	–	mV		P_10.4.5
minimum time for peak detection 1	$t_{VR,peak,min,1}$	–	10	–	µs	reset value 1 kHz sinusoidal signal	P_10.4.6
minimum time for peak detection 2	$t_{VR,peak,min,2}$	–	250	–	µs	1 kHz sinusoidal signal	P_10.4.7
VR Sensor Interface Load Resistance	$R_{VR,Load}$	50	75	110	kΩ		P_10.4.9
VR Sensor Interface Input Clamping Current	$\Delta I_{VR,clamp}$	–	–	50	mA	$\Delta I_{VR,clamp} = (I_{VRIN1} - I_{VRIN2})/2$	P_10.4.18
VR Sensor Interface Input Clamping Voltage	$\Delta V_{VR,clamp}$	2	–	3	V	$\Delta V_{VR,clamp} = \|V_{VRIN1} - V_{VRIN"}\|$, $I_{VR,calmp}$ = 50 mA	P_10.4.19
Switching threshold voltage at pin *VRIN1* for Hall Sensor Mode	$V_{VRIN1,th,\,hall}$	0.9	–	2	V	no load at pin *VRIN2*[1]	P_10.4.20
Switching hysteresis pin *VRIN1* for Hall Sensor Mode	$V_{VRIN1,hys,\,hall}$	0.35	0.5	–	V	no load at pin *VRIN2*	P_10.4.10
Middle voltage level normal mode	V_{middle}	1.9	2.25	2.5	V		P_10.4.11
VRS Diagnosis:							
Middle voltage level diagnosis mode	V_{middle}	0.9	1.3	1.65	V		P_10.4.12
Diagnosis measurement time	t_{conv}	–	7	8	µs		P_10.4.13

Table 37   Electrical Characteristics: VR Sensor Interface (cont'd)

V_S = 13.5 V, V_{VSV} = 5 V, T_j = -40°C to +150°C, all voltages with respect to ground, positive current flowing into pin (unless otherwise specified)

Parameter	Symbol	Values			Unit	Note or Test Condition	Number
		Min.	Typ.	Max.			
Diagnosis current accuracy	$I_{diag, acc}$	-30%	–	+30%		*VRIN1 = VRIN2 = V_{middle}*; typ. values see register **VRSConfig1** and **VRSConfig2**	P_10.4.14
Short to GND detection threshold	$V_{th,scg}$	0.8	–	1.1	V		P_10.4.15
Short to battery detection threshold	$V_{th,scb}$	2.8	–	3.3	V		P_10.4.16
Open load detection threshold	$V_{th,ol}$	0.9	–	1.2	V		P_10.4.17
ADC measurement input range	$V_{ADC,r}$	-1.5	–	1.5	V		P_10.4.8
ADC measurement gain	$V_{ADC,LSB}$	–	49	–	mV	valid from 6_d to 70_d	P_10.4.31
ADC measurement offset	$V_{ADC,offset}$	–	37_d	–			P_10.4.32
Output Characteristics:							
Low Level Output Voltage - Low Output Current	$V_{VR\_OUT,L,l}$	–	–	0.4	V	I_{VR_OUT} = 100 µA	P_10.4.21
Low Level Output Voltage - High Output Current	$V_{VR\_OUT,L,h}$	–	–	1.5	V	I_{VR_OUT} = 1 mA	P_10.4.22
High Level Output Voltage - Low Output Current	$V_{VR\_OUT,H,l}$	VDDIO-0.4	–	–	V	I_{VR_OUT} = -100 µA	P_10.4.23
High Level Output Voltage - High Output Current	$V_{VR\_OUT,H,h}$	VDDIO-1.5	–	–	V	I_{VR_OUT} = -1 mA	P_10.4.24
Transfer Characteristics:							
Output Filter Time 1	$t_{of,1}$	1	2	3	µs	reset value	P_10.4.25
Output Filter Time 2	$t_{of,2}$	5	6	7.5	µs		P_10.4.26
Output Filter Time 3	$t_{of,3}$	9.5	11	13	µs		P_10.4.27
Output Filter Time 4	$t_{of,4}$	19	21	23	µs		P_10.4.28

1)   external circuitry for hall mode see **Chapter 17.2**

11 Local Interconnect Network (LIN)

The LIN interface is designed for in-vehicle networks using data transmission up to 20 kbit/s. The implementation of the physical layer is according to LIN specification revision 2.1 for slave nodes and is compatible with lower versions like revision 2.0 and 1.3[1]. *LINTX* is the transmit-data input from the microcontroller, *LINIO* is the bidirectional LIN bus signal and *LINRX* is the receive-data output to the microcontroller. The transmitted data stream at *LINTX* is converted to the LIN bus signal at *LINIO*. *LINRX* reflects the received data at *LINIO* with a logic signal suited for 3.3 V and 5 V microcontroller interfaces.

The detection thresholds at LINIO are related to the power supply *BATPA*[2].

The LIN interface of the TLE8888-1QK is compatible to the physical layer definition of the K-Line (ISO 9141) standard. For K-Line operation no additional settings are necessary.

A flash mode for high speed operation can be selected with the communication interface (MSC or SPI). There is no bus wake-up function implemented.
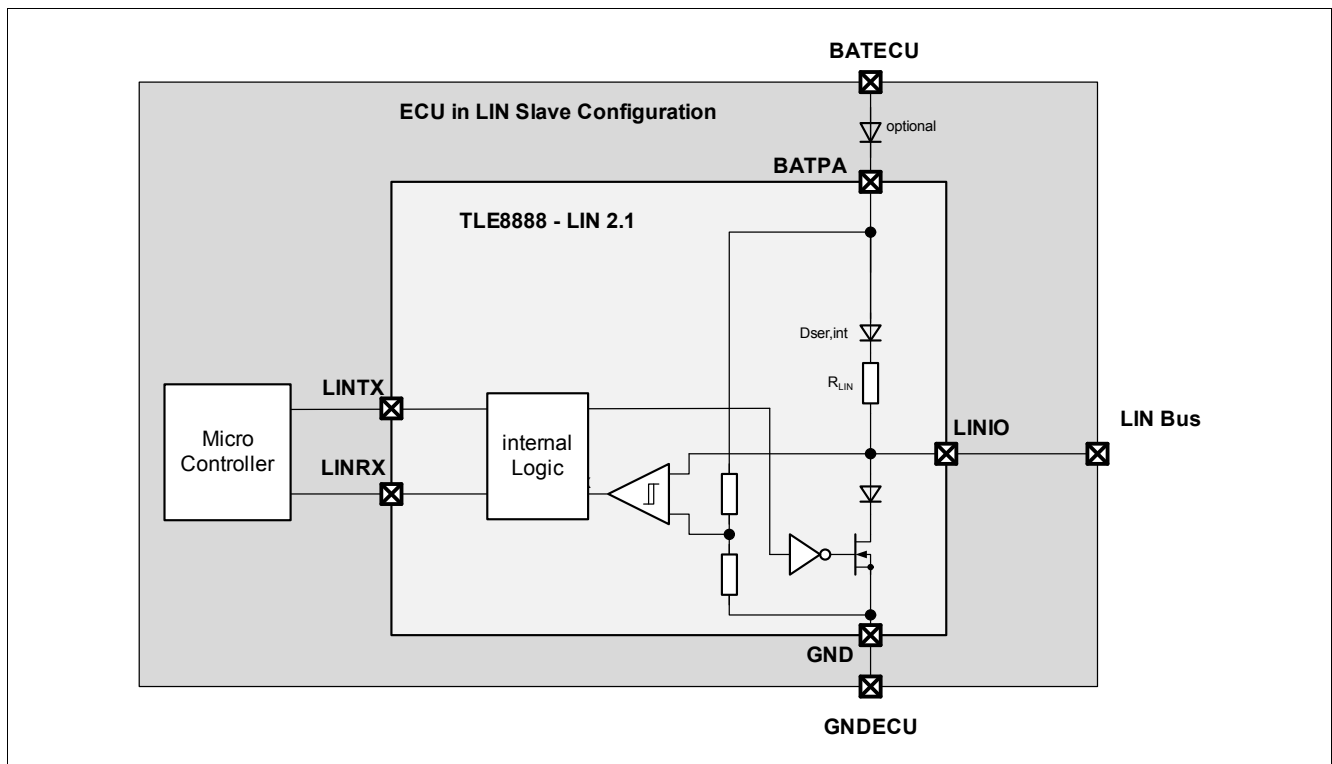
Figure 48   Local Interconnect Network (LIN) Slave Node

The LIN interface in the TLE8888-1QK is implemented according the requirements of the standard for slave nodes. For master setup an external pull up resistor (typ. 1 kΩ, see definition in LIN specification) and a diode must be connected to *LINIO* and *BATPA* on the ECU (see **Figure 49**).

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1) see LIN specification revision 2.1 chapter 6.2

2) *BATPA* is identical to the internal supply voltage VSUP defined in LIN specification revision 2.1
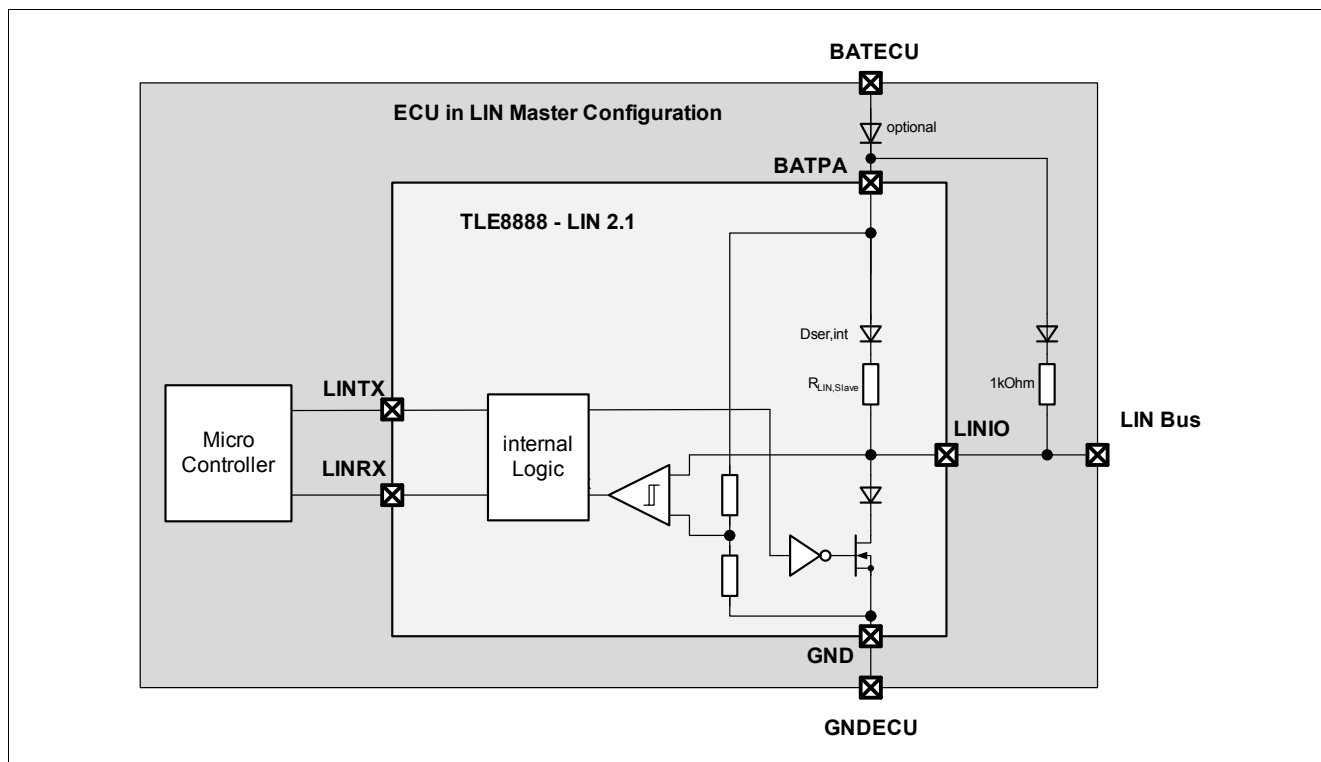
Figure 49   Local Interconnect Network (LIN) Master Node

11.1   Operation Modes

The interface can be configured for three operation modes:

- LIN/K-Line Mode: operation according LIN specification revision 2.1 with a maximum speed of 20 kbit/s and K-Line standard ISO 9141
- Receive Only Mode: transmission of data is disabled
- Flash Mode: operation up to 115 kbit/s is possible, slope control and current limitation are deactivated

The selection of the modes is done with setting the bits **LIN** in the register **ComConfig1** via communication interface (MSC or SPI). The operation mode after power on reset is defined by reset value of the register.

11.2   Failure Modes in LIN/K-Line Operation

In the LIN specification a special behavior of the interface is required for some failure conditions. This behavior is also active if a K-Line node is used.

11.2.1   Performance in Non Operation Supply Voltage Range

For supply voltages out of operation range the interface may still operate, but communication is not guaranteed. For *LINTX* = 'high' (recessive) the interface shall not drive *LINIO* to dominant state and if *LINIO* is in recessive state the *LINRX* output shall provide a 'high' (recessive).

11.2.2   Loss of Supply Voltage and GND Connection

During loss of supply voltage or GND connection the interface shall not interfere with the communication of other LIN nodes. Upon return of connection, normal operation shall resume without any intervention on the LIN bus line (pin *LINIO*).

11.2.3 Bus Wiring Short to Battery or GND

The LIN interface is protected against short to battery or short to GND. Upon remove of the fault, normal operation shall resume without any intervention on the LIN bus line (pin *LINIO*).

11.2.4 TX Time Out

The TX time out function is implemented to prevent the bus line from being blocked by a permanent 'low' at the pin *LINTX* caused by an error at the ECU or the microcontroller. If the *LINTX* signal is 'low' (dominant) for $t > t_{timeout}$ the transmission of the *LINTX* signal to the bus is deactivated and the LIN output stage is disabled.

The transmission is reactivated, after a rising edge at *LINTX* was detected. The implemented time out feature requires a minimum data rate of 1600 bit/s.

The time out function can be disabled with the configuration bit **LINTOE** in the configuration register **ComConfig1**.

11.2.5 Overtemperature Protection

The LIN bus output *LINIO* is protected against overload with an overtemperature protection. In case of overtemperature the output transistor is switched off and the diagnosis bit **LINOT** in the diagnosis register **ComDiag** is set. The configuration register is not changed.

11.3 Electrical Characteristics LIN

Table 38 Electrical Characteristics: LIN

V_S = 13.5 V, V_{VSV} = 5 V, T_j = -40°C to +150°C, all voltages with respect to ground, positive current flowing into pin (unless otherwise specified)

Parameter	Symbol	Values			Unit	Note or Test Condition	Number
		Min.	Typ.	Max.			
Supply voltage range for normal operation	$V_{BATPA,LIN}$	7	–	18	V	acc. Param 10 LIN Spec. Rev. 2.1	P_11.3.1
Limitation Current at LINIO for driver dominant state	$I_{LINIO,lim}$	40	–	200	mA	acc. Param 12 LIN Spec. Rev. 2.1	P_11.3.2
Leakage Current at LINIO for bus dominant state and driver off	$I_{LINIO,leak,dom}$	-1	–	–	mA	acc. Param 13 LIN Spec. Rev. 2.1 V_{LINIO} = 0 V V_{BAT} = 12 V	P_11.3.3
Leakage Current at LINIO for bus recessive state	$I_{LINIO,leak,rec}$	–	–	20	µA	acc. Param 14 LIN Spec. Rev. 2.1 $V_{LINIO} > V_{BAT}$	P_11.3.4
Current at LINIO during GND loss	I_{LINIO,no_GND}	-1	–	1	mA	acc. Param 15 LIN Spec. Rev. 2.1 $GND = V_S$ $0\,V < V_{LINIO} < 18\,V$ V_{BAT} = 12 V	P_11.3.5
Current at LINIO during power supply loss	I_{LINIO,no_Sup}	–	–	20	µA	acc. Param 16 LIN Spec. Rev. 2.1 $GND = V_S = 0\,V$ $0\,V < V_{LINIO} < 18\,V$	P_11.3.6
Receiver Dominant State	$V_{LINIO,dom}$	–	–	$0.4*V_{B\ ATPA}$	V	acc. Param 17 LIN Spec. Rev. 2.1	P_11.3.7
Receiver Recessive State	$V_{LINIO,rec}$	$0.6*V_{B\ ATPA}$	–	–	V	acc. Param 18 LIN Spec. Rev. 2.1	P_11.3.8
Receiver switching threshold center voltage	$V_{LINIO,cnt}$	$0.475*V_{BATPA}$	–	$0.525*V_{BATPA}$	V	acc. Param 19 LIN Spec. Rev. 2.1 $V_{LINIO,cnt} = (V_{th,dom} + V_{th,rec})/2$	P_11.3.9
Hysteresis of switching threshold	V_{Hys}	–	–	$0.175*V_{BATPA}$	V	acc. Param 20 LIN Spec. Rev. 2.1 $V_{Hys} = V_{th,rec} - V_{th,dom}$	P_11.3.10
Voltage drop at internal serial diode $D_{ser,int}$	V_D	0.4	–	1	V	acc. Param 21 LIN Spec. Rev. 2.1	P_11.3.11
Resistance of internal slave resistor Rslave	$R_{LIN,Slave}$	20	–	60	kΩ	acc. Param 26 LIN Spec. Rev. 2.1	P_11.3.12

Table 38   Electrical Characteristics: LIN (cont'd)

V_S = 13.5 V, V_{VSV} = 5 V, T_j = -40°C to +150°C, all voltages with respect to ground, positive current flowing into pin (unless otherwise specified)

Parameter	Symbol	Values			Unit	Note or Test Condition	Number
		Min.	Typ.	Max.			
Duty cycle 1	D_1	0.396	–	–	–	acc. Param 27 LIN Spec. Rev. 2.1	P_11.3.13
Duty cycle 2	D_2	–	–	0.581	–	acc. Param 28 LIN Spec. Rev. 2.1	P_11.3.14
Duty cycle 3	D_3	0.417	–	–	–	acc. Param 29 LIN Spec. Rev. 2.1	P_11.3.15
Duty cycle 4	D_4	–	–	0.59	–	acc. Param 30 LIN Spec. Rev. 2.1	P_11.3.16
Propagation delay of receiver rising edge	$t_{rx,pd,r}$	–	–	6	µs	acc. Param 31 LIN Spec. Rev. 2.1	P_11.3.17
Propagation delay of receiver falling edge	$t_{rx,pd,f}$	–	–	6	µs	acc. Param 31 LIN Spec. Rev. 2.1	P_11.3.18
Propagation delay symmetry of receiver	$t_{rx,pd,sym}$	-2	–	2	µs	acc. Param 32 LIN Spec. Rev. 2.1	P_11.3.19
TX Dominant Time Out Time	$t_{timeout}$	6	12	20	ms	min. data rate of 1600bit/s required	P_11.3.20
Bus Recessive Output Voltage	$V_{BUS,rec}$	0.8*V_{BATPA}	–	–	V		P_11.3.21
Bus Dominant Output Voltage	$V_{BUS,do}$	–	–	1.4	V	V_{BATPA} = 7 V R_{pu} = 500 Ω	P_11.3.22
Bus Dominant Output Voltage	$V_{BUS,do}$	–	–	2.2	V	V_{BATPA} = 18 V R_{pu} = 500 Ω	P_11.3.23
LINIO Input Capacitance	C_{LINIO}	–	15	25	pF	[1]	P_11.3.24
Overtemperature Switch Off Threshold	$T_{LIN,ot}$	150	–	200		[1]	P_11.3.25
Overtemperature Hysteresis	$T_{LIN,ot,hys}$	–	10	–		[1]	P_11.3.26
LINRX Output Characteristics							
Low Level Output Voltage - Low Output Current	$V_{LINRX,L,l}$	–	–	0.4	V	I_{LINRX} = 100 µA	P_11.3.27
Low Level Output Voltage - High Output Current	$V_{LINRX,L,h}$	–	–	1.5	V	I_{VR_OUT} = 1 mA	P_11.3.28
High Level Output Voltage - Low Output Current	$V_{LINRX,H,l}$	VDDIO-0.4	–	–	V	I_{LINRX} = -100 µA	P_11.3.29
High Level Output Voltage - High Output Current	$V_{LINRX,H,h}$	VDDIO-1.5	–	–	V	I_{LINRX} = -1 mA	P_11.3.30
LINTX Input Characteristics							
Low Level Input Voltage	$V_{LINTX,l}$	-0.3	–	0.9	V		P_11.3.31

Table 38   Electrical Characteristics: LIN (cont'd)

V_S = 13.5 V, V_{VSV} = 5 V, T_j = -40°C to +150°C, all voltages with respect to ground, positive current flowing into pin (unless otherwise specified)

Parameter	Symbol	Values			Unit	Note or Test Condition	Number
		Min.	Typ.	Max.			
High Level Input Voltage	$V_{LINTX,h}$	2	–	V_{VDDIO}	V		P_11.3.32
Input Voltage Hysteresis	$V_{IN,hys}$	50	200	–	mV		P_11.3.33
Pull Up Current	$I_{LINTX,pu}$	-100	–	-25	μA	V_{LINTX} = 0 V	P_11.3.34
Pull Up Current	$I_{LINTX,pu}$	–	–	-2.4	μA	V_{LINTX} = $VDDIO$-0.6 V	P_11.3.35

1)   Not subject to production test, specified by design
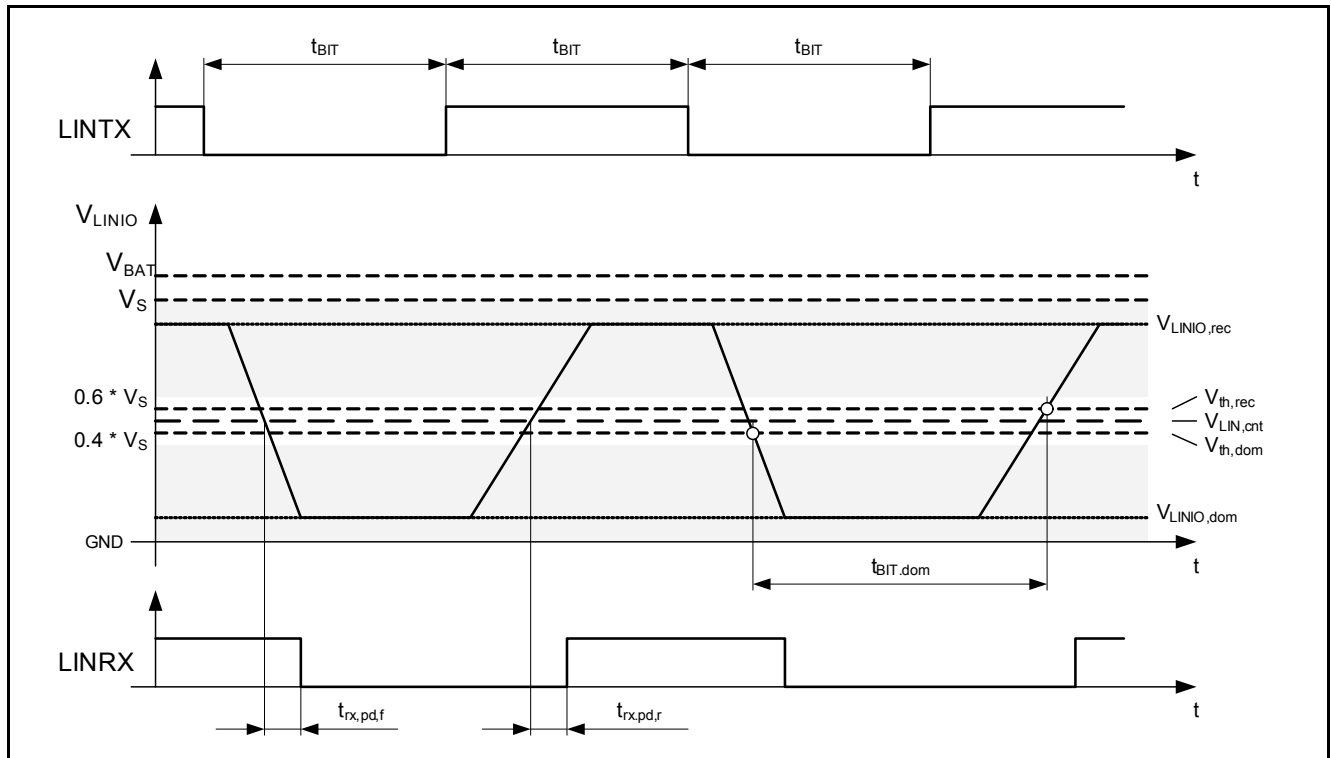
Figure 50   Timing Diagram of the LIN Interface

12   High Speed Controller Area Network (CAN) Transceiver

The Controller Area Network (CAN) is a serial bus system that connects microcontroller, sensors and actuators for real-time control applications.

The integrated CAN interface provides the physical layer of the CAN according to ISO 11898. It is suitable for high speed differential data transmission and reception. It works as an interface between the CAN protocol controller and the physical bus lines.

Remote wake-up function with a dominant signal at the bus lines is implemented.

12.1   Functional Description

The high speed CAN is a two wire differential network which allows data transmission rates up to 1Mbit/s. The input *CANTX* and the output *CANRX* are connected to the microcontroller of the ECU. As shown in **Figure 51**, the CAN has a receive unit and a output driver stage, allowing the transceiver to send data to the bus line and monitor data from the bus lines at the same time. It converts the serial data stream available at the transmit data input CANTX into a differential output signal at *CANH* and *CANL*. The receiver stage monitors *CANH* and *CANL* and converts the differential voltage to a serial data stream at *CANRX*.

The supply of the CAN transceiver is done out of *V5VCAN*, the wake receiver is supplied out of *V5VSTBY*. The pin *V5VCAN* must be connected directly to the 5 V supply pin *V5V*. In order to optimize EMC performance a ceramic capacitor **CV5VCAN** should be connected to the pins *V5VCAN* and *PGND* (pin **50**).
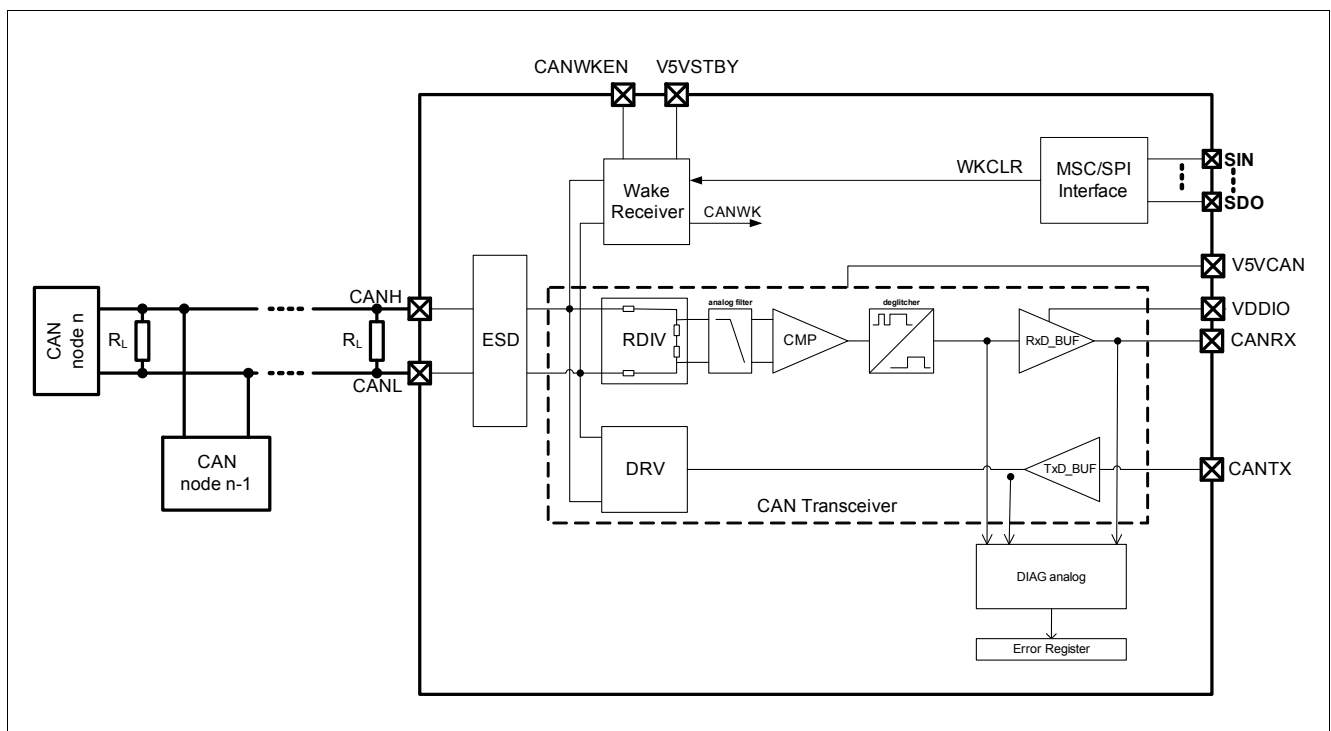
Figure 51   High speed CAN topology

12.2   Operation Modes

Four different operation modes are available. Regardless of the supply status the CAN interface does not disturb the communication on the bus line.

12.2.1   Normal Operation Mode

In normal operation mode the CAN transceiver sends the serial data stream available at the pin *CANTX* to the CAN bus while at the same time the data available at the CAN bus is monitored at the *CANRX* pin. In normal operation mode all functions are active:

- The driver output is active and drives data from the *CANTX* pin to the CAN bus.
- The receiver unit is active and provides the data from the CAN bus to the *CANRX* pin.
- The failure detection is active.

12.2.2   Receive Only Mode

In the receive only mode the CAN transceiver can still receive data from the bus, but the driver output stage is disabled and therefore no data can be sent to the CAN bus. All other functions are active:

- The driver output is disabled and data which is available at the *CANTX* pin will be blocked and not communicated to the CAN bus.
- The receiver unit is active and provides the data from the CAN bus to the *CANRX* pin.
- The failure detection is active.

12.2.3   Power-Down Mode

If the TLE8888-1QK is not supplied the bus communication is not allowed to be disturbed. Therefore the resistors of the receiver unit are switched off and the bus input pins CANH and CANL are high resistive.

12.2.4   Remote Wake-Up

The wake receiver is internally supplied from the standby supply pin *V5VSTBY*. The wake-up function is enabled by an external connection of the pin *CANWKEN* to the standby supply pin *V5VSTBY*. The wake function is disabled by an external connection to *AGND* and the current consumption of the wake-up circuit is reduced to leakage currents only.

In "ECU Sleep" state a dominant signal at *CANH* and *CANL* for longer than the **CAN Wake-up filter time** preceded by a recessive signal causes an internal wake-up and the internal wake signal **CANWK** is set. With a wake clear command (set bit **WKCLR** to "1" in command register **Cmd0**) CANWK is reset (status see bit **CANWK** in the status register **OpStat0**). The next wake-up is only detected with a transition from recessive to dominant. With this implementation of the wake-up procedure, bus line dominant clamping does not lead to permanent wake-up.

In **Figure 52**, **Figure 53** and **Figure 54** the behavior is shown.
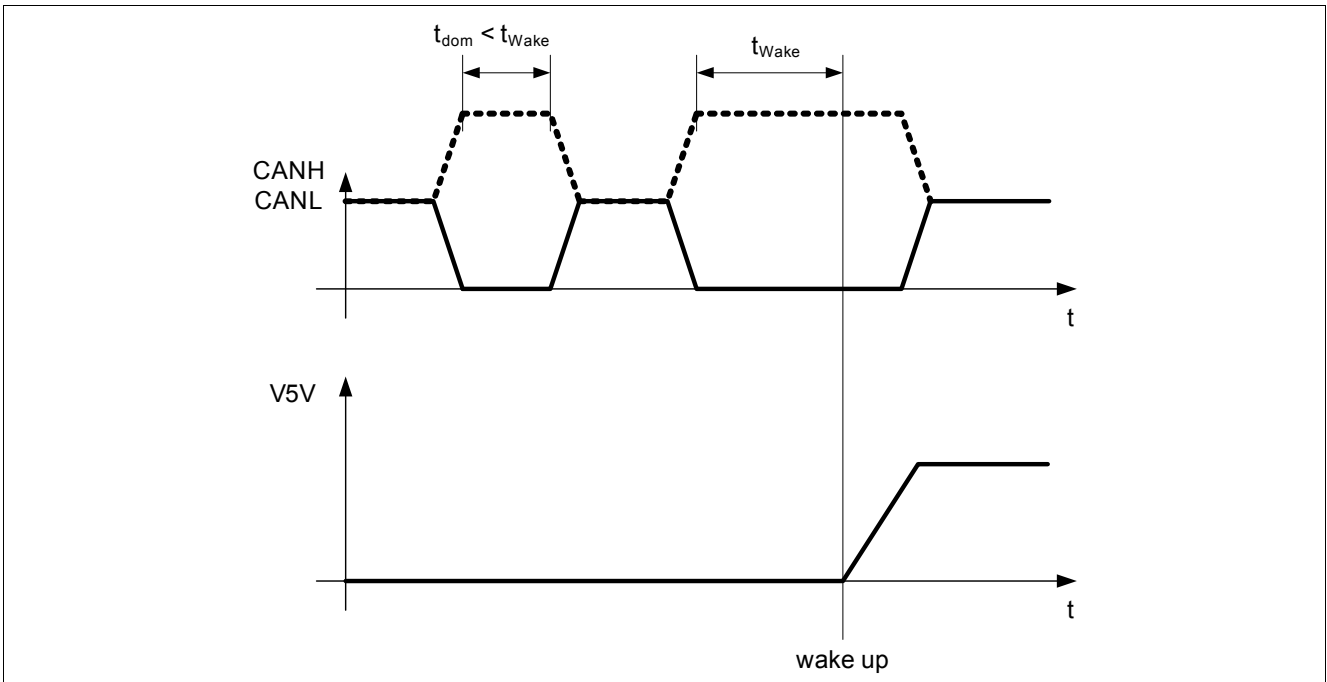
Figure 52   CAN Remote Wake-up
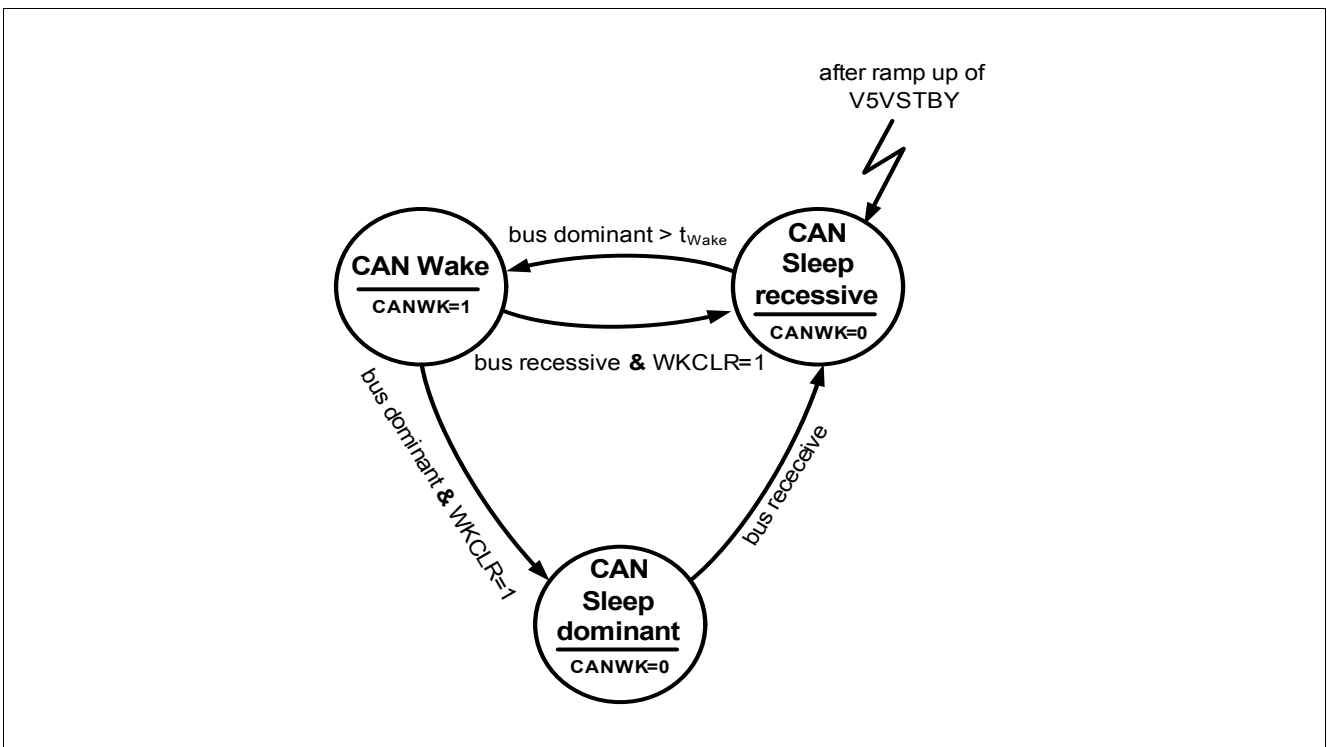
Figure 53   CAN Wake-up State machine
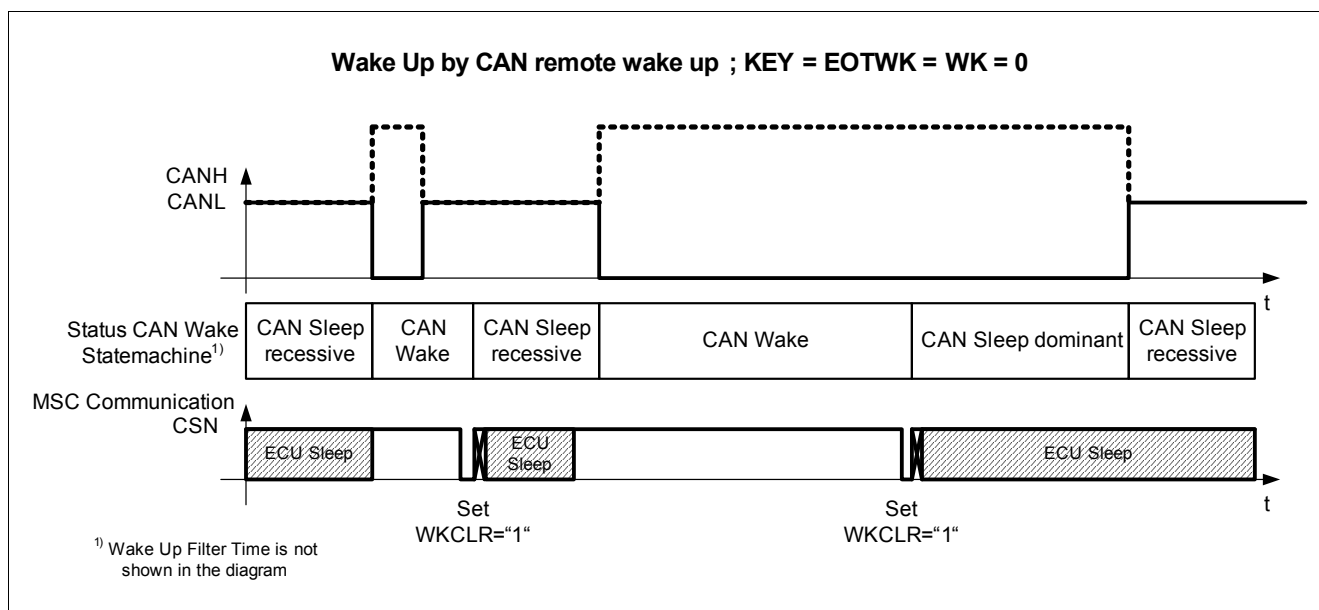
Figure 54   State Transitions at CAN Remote Wake-up

12.3   Diagnostic Functions

The CAN transceiver has an implemented diagnostic unit. Bus failures and local failures can be detected.

12.3.1   CAN Bus Failure Detection

In normal operation the CAN transceiver can detect following bus failure:

• Bus line dominant clamping (bit **CANBDC** in diagnosis register **ComDiag**)

Following bus failures can't be detected (outputs are protected):

• CANH shorted to GND
• CANL shorted to GND
• CANH shorted to low voltage supply
• CANL shorted to low voltage supply
• CANH shorted to V_{Bat}
• CANL shorted to V_{Bat}
• CANH open
• CANL open
• CANH shorted to CANL

12.3.2   Local Failure Detection

In normal operation the CAN transceiver can detect following local failures:

• CAN TX dominant time-out (bit **CANTXTO** in diagnosis register **ComDiag**)
• Overtemperature (bit **CANOT** in diagnosis register **ComDiag**)

In case of failure detection only the corresponding diagnosis register bits are changed. No change in the configuration occurs.

12.4 Electrical Characteristics CAN Transceiver

Table 39 Electrical Characteristics: CAN Transceiver

V_S = 13.5 V, V_{VSV} = 5 V, T_j = -40°C to +150°C, all voltages with respect to ground, positive current flowing into pin (unless otherwise specified)

Parameter	Symbol	Values			Unit	Note or Test Condition	Number
		Min.	Typ.	Max.			
CANH voltage, recessive state	$V_{CANH,rec}$	2	2.5	3	V	no load	P_12.4.1
CANL voltage, recessive state	$V_{CANL,rec}$	2	2.5	3	V	no load	P_12.4.2
CANH voltage, dominant state	$V_{CANH,dom}$	2.75	3.5	4.5	V		P_12.4.3
CANL voltage, dominant state	$V_{CANL,dom}$	0.5	1.5	2.25	V		P_12.4.4
Differential output bus voltage, dominant state	$V_{diff,out,dom}$	1.5	2	3	V	4.75 V < V_{V5VCAN} < 5.25 V	P_12.4.5
Common mode bus voltage, dominant and recessive state	V_{CM}	-12	–	12	V	4.75 V < V_{V5VCAN} < 5.25 V	P_12.4.6
External Termination resistor	R_L	100	120	130	Ω		P_12.4.7
Differential input voltage, recessive state	$V_{diff,n,rec}$	-1	–	0.5	V		P_12.4.8
Differential input voltage, dominant state	$V_{diff,in,dom}$	0.9	–	5	V		P_12.4.9
Differential receiver hysteresis	$V_{diff,hys}$	20	100	–	mV		P_12.4.10
Common mode input resistance	R_{in}	5	–	50	kΩ		P_12.4.11
Bit time	t_B	1	–	–	µs		P_12.4.12
Propagation delay time CANTX to CANRX recessive to dominant	$t_{pd,rec,dom}$	–	–	255	ns		P_12.4.13
Propagation delay time CANTX to CANRX dominant to recessive	$t_{pd,dom,rec}$	–	–	255	ns		P_12.4.14
Propagation delay time CANTX to CANH/CANL recessive to dominant	$t_{pd,out,dom}$	–	–	140	ns	T_j = 25°C;[1] $C_{CANH/CANL}$ < 10 pF	P_12.4.15
Propagation delay time CANTX to CANH/CANL dominant to recessive	$t_{pd,out,rec}$	–	–	140	ns	T_j = 25°C[1]; $C_{CANH/CANL}$ < 10 pF	P_12.4.16

High Speed Controller Area Network (CAN) Transceiver

Table 39   Electrical Characteristics: CAN Transceiver (cont'd)

V_S = 13.5 V, V_{VSV} = 5 V, T_j = -40°C to +150°C, all voltages with respect to ground, positive current flowing into pin (unless otherwise specified)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Note or Test Condition	Number
Bus line dominant clamping detection time	$t_{bus,cl,dom}$	4	–	7	ms		P_12.4.17
CANTX dominant detection time	$t_{CANTX,cl,dom}$	4	–	7	ms		P_12.4.18
V5VCAN buffer capacitance[1]	C_{V5VCAN}		2	–	µF	recommended for optimized EMC performance	P_12.4.19
Overtemperature Switch Off Threshold	$T_{CAN,ot}$	150	–	200	°C	[1]	P_12.4.20
Overtemperature Hysteresis	$T_{CAN,ot,hys}$	–	10	–	°C	[1]	P_12.4.21
CANRX Output Characteristics							
Low Level Output Voltage - Low Output Current	$V_{CANRX,L,l}$	–	–	0.4	V	I_{CANRX} = 100 µA	P_12.4.22
Low Level Output Voltage - High Output Current	$V_{CANRX,L,h}$	–	–	1.5	V	I_{CANRX} = 1 mA	P_12.4.23
High Level Output Voltage - Low Output Current	$V_{CANRX,H,l}$	VDDIO-0.4	–	–	V	I_{CANRX} = -100 µA	P_12.4.24
High Level Output Voltage - High Output Current	$V_{CANRX,H,h}$	VDDIO-1.5	–	–	V	I_{CANRX} = -1 mA	P_12.4.25
CANTX Input Characteristics							
Low level input voltage	$V_{CANTX,l}$	-0.3	–	1	V		P_12.4.26
High level input voltage	$V_{CANTX,h}$	2	–	V_{V5VCAN}	V		P_12.4.27
Input voltage hysteresis	$V_{CANTX,hys}$	50	200	–	mV		P_12.4.28
Pull up current	$I_{CANTX,pu}$	-100	–	-25	µA	V_{CANTX} = 0 V	P_12.4.29
Wake Receiver							
Differential input voltage, recessive state, low power mode	$V_{diff,rec,lp}$	-1	–	0.4	V	4.75V < $V_{V5VSTBY}$ < 5.25 V	P_12.4.30
Differential input voltage, dominant state, low power mode	$V_{diff,dom,lp}$	1.15	–	5	V	4.75 V < $V_{V5VSTBY}$ < 5.25 V	P_12.4.31
Common mode bus voltage, low power mode	$V_{CM,lp}$	-12	–	12	V	4.75 V < $V_{V5VSTBY}$ < 5.25 V	P_12.4.32
CAN Wake-up filter time	$t_{wake,CAN}$	0.75	–	5	µs	4.75 V < $V_{V5VSTBY}$ < 5.25 V	P_12.4.33
Additional current consumption in low power mode at pin *BATSTBY*	I_{CANWK}	–	–	35	µA	0 V ≤ V_{CANH} ≤ 5 V, 0 V ≤ V_{CANL} ≤ 5 V	P_12.4.34

1) Not subject to production test, specified by design

13 Microsecond Channel MSC

The bidirectional microsecond channel (MSC) is a serial interface which is especially optimized to connect peripheral devices via serial link to microcontroller. The serial communication link is built up by a fast synchronous downstream channel from microcontroller to the device and an asynchronous upstream channel (referenced to downstream clock). The downstream interface can be "low voltage differential" (*FCLN*, *FCLP*, *SIN*, *SIP*, *CSN*) or "single ended" (*FCLP*, *SIP*, *CSN*).

Via MSC, the microcontroller controls the outputs and logic of the device including the diagnosis and monitoring module. Read data is requested by microcontroller via downstream communication and returned by the device via MSC upstream channel.

Multiple "power devices" with MSC for downstream operation are possible. The device is selected by *CSN*.

The MSC logic is internally supplied and referenced to *AGND*.

The behavior of the MSC interface during reset is described in **Table 5** and **Table 6** in **Chapter 5.2**.
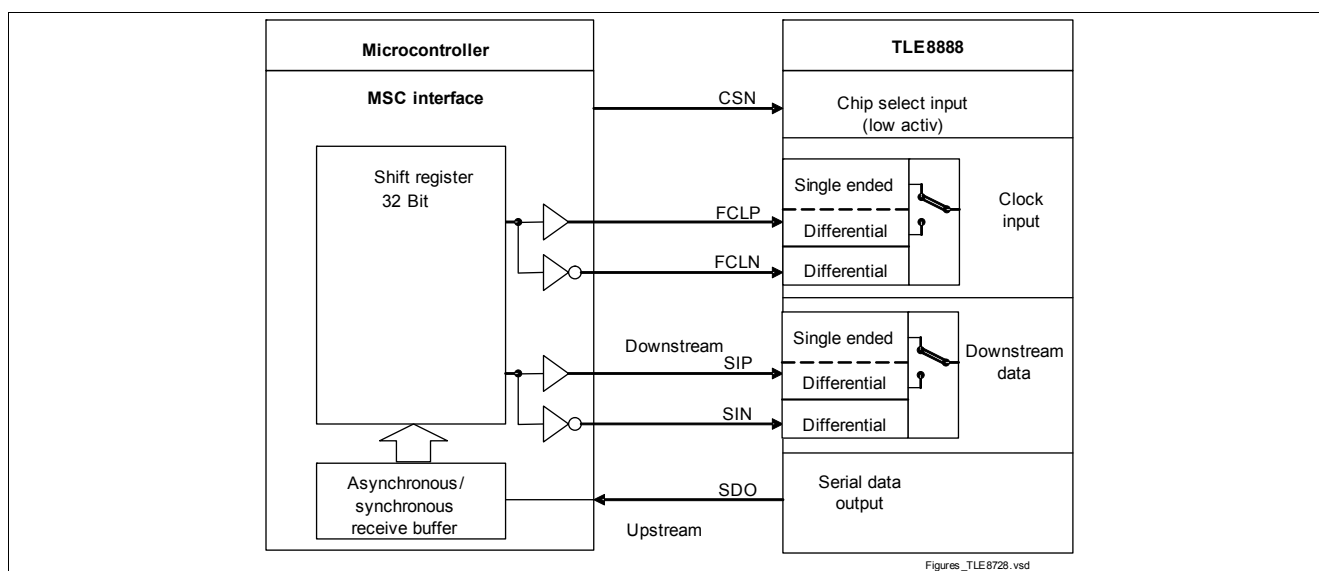
Figure 55   MSC Interface (not tested, overview only)

13.1 Downstream Communication

Downstream frames are synchronous serial frames with clock and data line.

The physical interface for downstream communication can be "low voltage differential" or "single ended" type. Both interface types are using individual pins (*FCLN*, *FCLP*, *SIN* and *SIP*) and common pins (*CSN* and *SDO*). For single ended interface *FCLN* and *SIN* have to be connected to *VDDIO*. For low voltage differential interface both input voltage levels must be within the defined input voltage range.

The frames and the behavior of the communication are the same in differential and single ended mode. Differential inputs for downstream data are *SIP* and *SIN*; the differential input signal *SIP – SIN* is the same logical signal as *SIP* alone in single ended mode and SI will be used in the description for both types of communication. The clock pins are *FCLP* and *FCLN*, the differential clock *FCLP – FCLN* is the same logical signal as *FCLP* in single ended mode and CLK will be used in the description for both types of communication.

There is one input *CSN* for chip select, and one output *SDO* for upstream data. The device is always the slave in this communication link.

The *CSN* signal enables receiver circuits automatically during a downstream frame transmission.

Two types of downstream frames are defined:

- Command frames (selection bit = "1")
- Data frames (selection bit = "0")

The device MSC uses non inverting polarity for SI and CLK: SI changes its state with the rising edge of CLK and is sampled with the falling edge; a logic '1' is a 'high level' on SI, and a logic '0' is a 'low level' on SI. Data at SI is latched by the device on the falling edge of CLK.

The *CSN* input is active low during the active phases of command or data frames. An active enable signal validates the SI input signal. Outside the active phase (*CSN* line is at high level) data at SI is ignored.

It is possible to drive multiple "power devices" with shared CLK and SI lines and individual *CSN* signal.

Command frames and data frames may be sent in any sequence (with a passive phase of at least 2 CLK-cycles after each frame).

Table 40   Execution of commands

Event on MSC downstream	upstream busy	upstream idle
valid read command frame	ignored	executed
valid write command frame	executed[1]	executed
valid data frame	accepted	accepted
invalid command	ignored	ignored
invalid data frame	ignored	ignored

1) only after **tprep,sr** or **tprep,mr**, see also **Chapter 13.2**

The serial clock CLK must be active (toggling) during upstream communication even when no command frame or data frame is transmitted.

The clock period of CLK is defined as t_{FCL}, maximum downstream clock rate is f_{FCLmax}.

The active phase of a downstream frame starts with the falling edge of the signal on *CSN* and ends with the rising edge. *CSN* changes its state with the rising edge of clock CLK.

This figure shows SIP and SIN function but is also valid for FCLP and FCLN
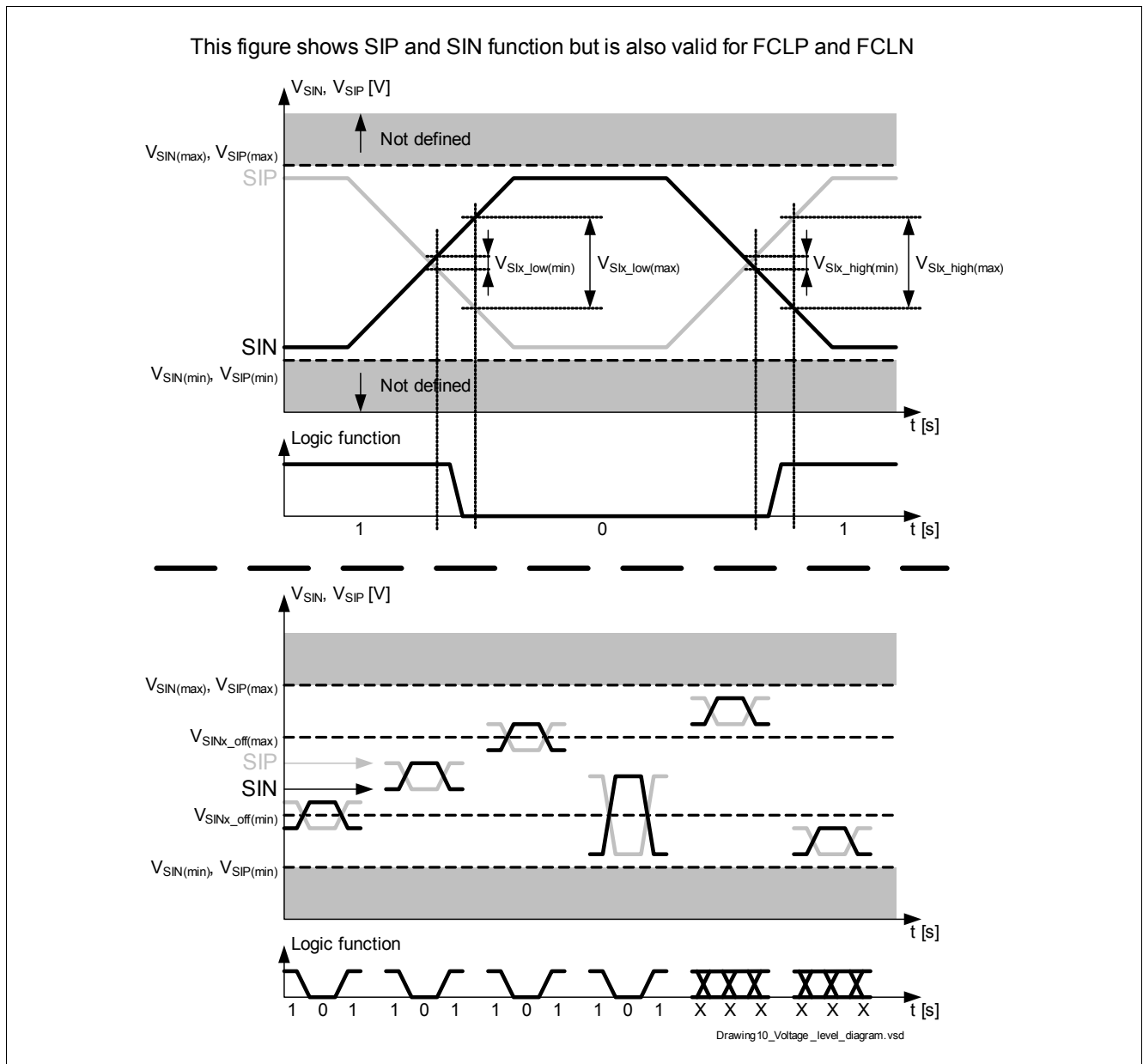
Figure 56   Voltage level diagram

13.1.1   Downstream Supervisory Functions

A command- or data frame is interpreted as valid, if it has the correct number of CLK pulses (a frame has a length of 17 clock pulses). Clock pulses are counted at the falling edge of the signal.

There is no parity check.

If TLE8888-1QK receives no valid data frame for t > t_{MSC_mon}, the device switches off the output stages (all output stage control bits are set to "0"), the bits **O1E** to **O24E** in the configuration registers **OEConfig0** to **OEConfig3** are set to "0" and the MSC time out failure bit in the register **ComDiag** is set to "1". The MSC time out failure bit is reset by a readout of the register **ComDiag** and all output stages remain off. For switching on the stages the bits **O1E** to **O24E** in the configuration registers **OEConfig0** to **OEConfig3** must be set to "1" and the control bits must be set. Outputs which are configured to be driven directly with the direct drive inputs are switched according the input level of the pins *IN1* to *IN12* after set of the bits **O1E** to **O24E**.

13.1.2 Command Frame

A command frame always starts with a high level bit (command selection bit). The number of command bits of the active phase of a command frame is fixed to 16. A command is executed only if the number of transmitted bits of an active command frame is equal to 17.

The length of the command frame's passive phase t_{CPP} must be a minimum of 2 * t_{FCL} (2 clock pulses).

Alternatively the passive phase can consist in $t_{CPP} = t_{FCL}$ (1 clock pulse) followed by a frame of wrong length (4…8 bits, with or without *CSN* active low) and a second $t_{CPP} = t_{FCL}$ (1 clock pulse).
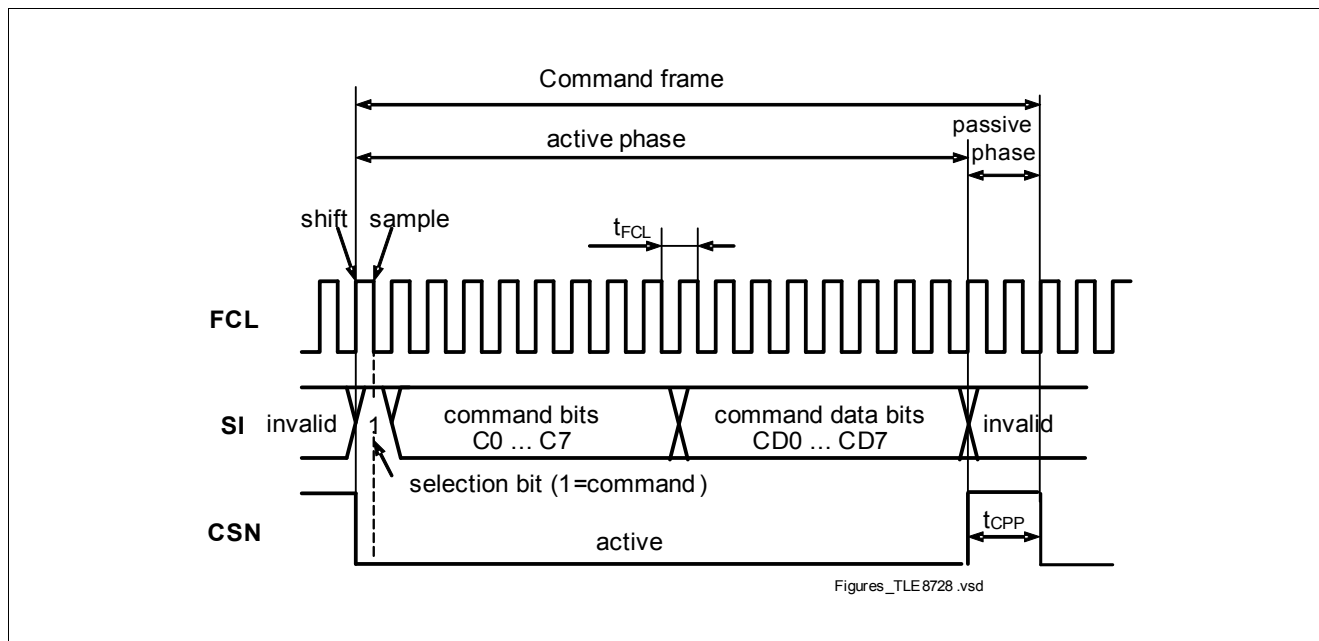
Figure 57   MSC command frame

Content of a command frame (LSB transmitted first)

Table 41   Command frame

Bit #	Description
0 (first bit)	= '1': command selection bit
1…8	Command [C0…C7]
9…16	Data for the command [CD0…CD7]

The least significant (LSB) bit of a command is transmitted first

13.1.3 Data Frame

A data frame always starts with a low level bit (data selection bit). The number of the data bits of the active phase of a data frame is fixed to 28 bit.

A data frame is accepted if the actual length is the expected length 29.

MSC Monitoring t_{MSC_mon} is re triggered by any data frame with correct length (no other error detection mechanism is implemented).

The length of the data frame's passive phase t_{DPP} must be a minimum of 2 * t_{FCL} (2 clock pulses).
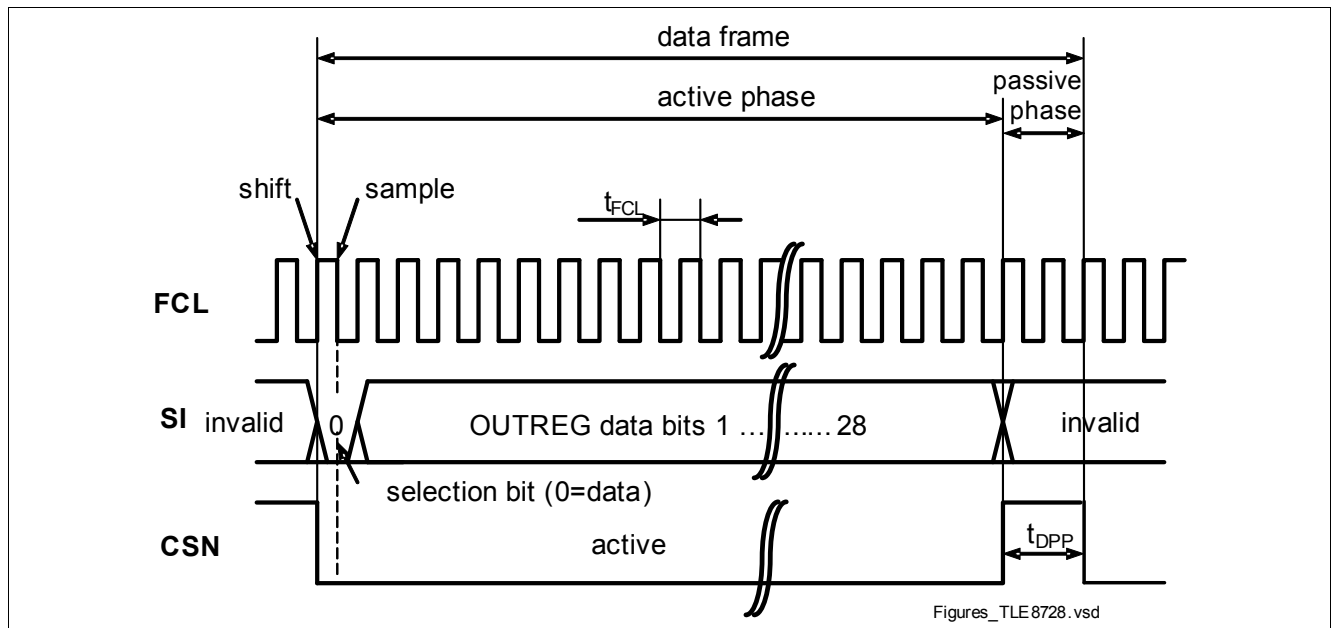
Figure 58   MSC data frame

Table 42   Data frame

OUTREG Bit	Description
0 (first bit)	= '0': data selection bit
1	**O14ON**[1]
2	**O11ON**[1]
3	**O24ON**[1]
4	**O13ON**[1]
5	**IGN1ON**[1]
6	**IGN2ON**[1]
7	**O5ON**[1]
8	**O1ON**[1]
9	**O15ON**[1]
10	**IGN3ON**[1]
11	**O2ON**[1]
12	**O22ON**[1]
13	**O9ON**[1]
14	**O23ON**[1]
15	**O19ON**[1]
16	**O16ON**[1]
17	**O18ON**[1]
18	**O20ON**[1]
19	**O8ON**[1]
20	**O4ON**[1]
21	**O17ON**[1]

Table 42   Data frame (cont'd)

OUTREG Bit	Description
22	**O10ON**[1]
23	**O21ON**[1]
24	**O7ON**[1]
25	**O6ON**[1]
26	**O3ON**[1]
27	**IGN4ON**[1]
28	**O12ON**[1]

1)   Definition see **Chapter 14.1.5**.

There is no parity bit in the data frame.

The data is stored in the control register **Cont0** to **Cont3**.

13.2   Upstream Communication

The serial data output *SDO* is the synchronous serial data signal of the upstream channel and is always single ended. The polarity is 'non inverting polarity'– i.e. a low level bit at *SDO* is stored in the microcontroller as a logic '0', and a high level bit at *SDO* is stored in the microcontroller as a logic '1'. The frequency for *SDO* is derived from CLK by an internal divider and can be configured via MSC.

The output of *SDO* can be configured as an open drain or an push pull output. The set is done with the bit **MSCO** in the configuration register **ComConfig0**. The full range of up stream frequency divider settings in the configuration register **ComConfig0** bits **MSCF** is valid for the push pull output configuration.
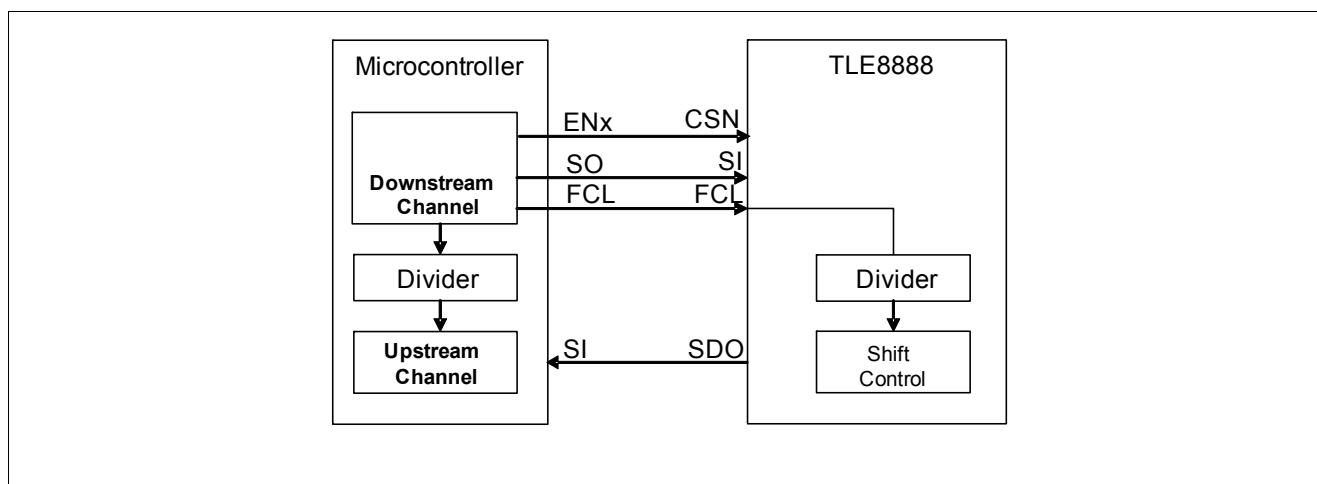
Figure 59   MSC upstream communication (not tested, overview only, Single Ended)

The data frame could be defined with 12 and 16 bit according the setting of **MSCUF** in the configuration register **ComConfig0**. In **Figure 60** the formats are shown. The address bits A2 and A3 are used for the selection of the upstream data register in the microcontroller.

Definition of Address Bits A0 to A3 in 16 Bit Upstream Mode:

*   Fixed A0 to A3 Value:
    The value of the address bits A0 to A3 is fixed according the definition of **MSCA** in the configuration register **ComConfig1** at the rising edge of *CSN* of the read command. For read out with multiple read out commands the value of A0 to A3 does not change.

Microsecond Channel MSC

- Multiple Read Command Mode:
  This mode is especially for the multiple read commands and the configuration of the microcontroller in UD3 interrupt mode. A2 and A3 are used in this mode to define the upstream data register (UD0 -UD3) and a number of n times 4 of upstream frames. A0 is defined as read overflow and A1 is defined as read busy.

Table 43   Definition of A0 in Multiple Read Command Mode for 16 Bit Upstream Format

A0	Description
0	No read command is ignored
1	A read command was sent during upstream communication. This read command was ignored and this is signalized with A0 = 1

Table 44   Definition of A1 in Multiple Read Command Mode for 16 Bit Upstream Format

A1	Description
0	last upstream frame; after finish of this frame next transmitted read command will be executed
1	Upstream activities required by an multiple read commands are ongoing
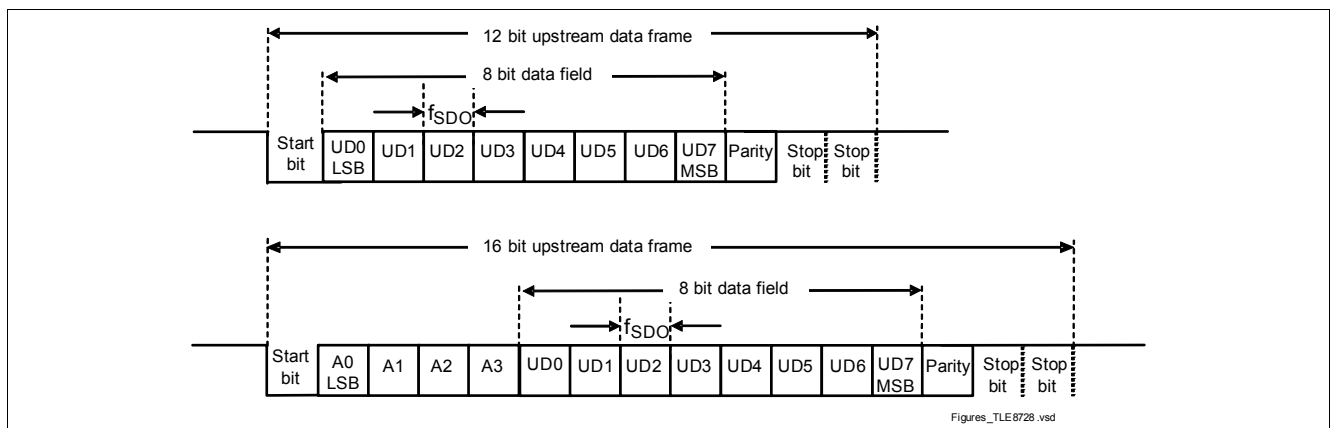
Figure 60   MSC upstream frame
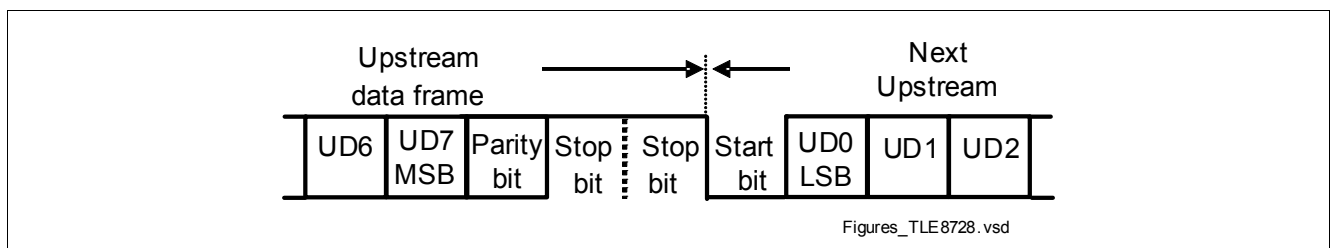
Figure 61   MSC upstream communication flow

Table 45   12 Bit Upstream Frame

Bit	description
0	start bit, always '0'
1-8	upstream data bits UD0…7

Table 45   12 Bit Upstream Frame (cont'd)

Bit	description
9	parity bit (The parity bit is set in order to achieve an even number of '1' in Bits UD0…7+Parity)
10, 11	stop bits, always '1'

Table 46   16 Bit Upstream Frame

Bit	description
0	start bit, always '0'
1-4	address bits A0…3
5-12	upstream data bits UD0…7
9	parity bit (The parity bit is set in order to achieve an even number of '1' in Bits UD0…7+Parity)
10, 11	stop bits, always '1'

Transmission of the registers via upstream starts within t_{MSC_RSP} after read command has been received. During an ongoing upstream communication the device will ignore further read commands until the upstream data transfer is finished. A new read command is accepted if the rising edge *CSN* arrives after the last stop bit has been sent. Data frames are executed independently of ongoing read requests. Write commands are ignored during **MSC upstream preparation time for single read command tprep,sr** or **MSC upstream preparation time for multi read command tprep,mr** (see **Figure 62**). After that time the write commands are executed also during ongoing upstream communication. If the write command is changing the register which is in transmission, the old register content will be sent. With setting the command bit **MSCUPS** in the command register **Cmd0** the running upstream transmission is stopped and all remaining read request of a multiple read command are cleared.
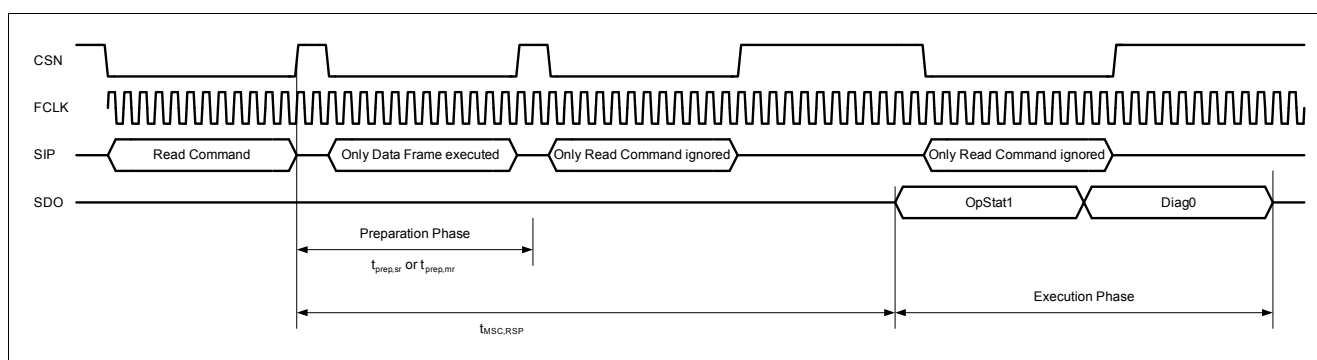
Figure 62   Example MSC upstream and active downstream communication

13.3 Timing Characteristics
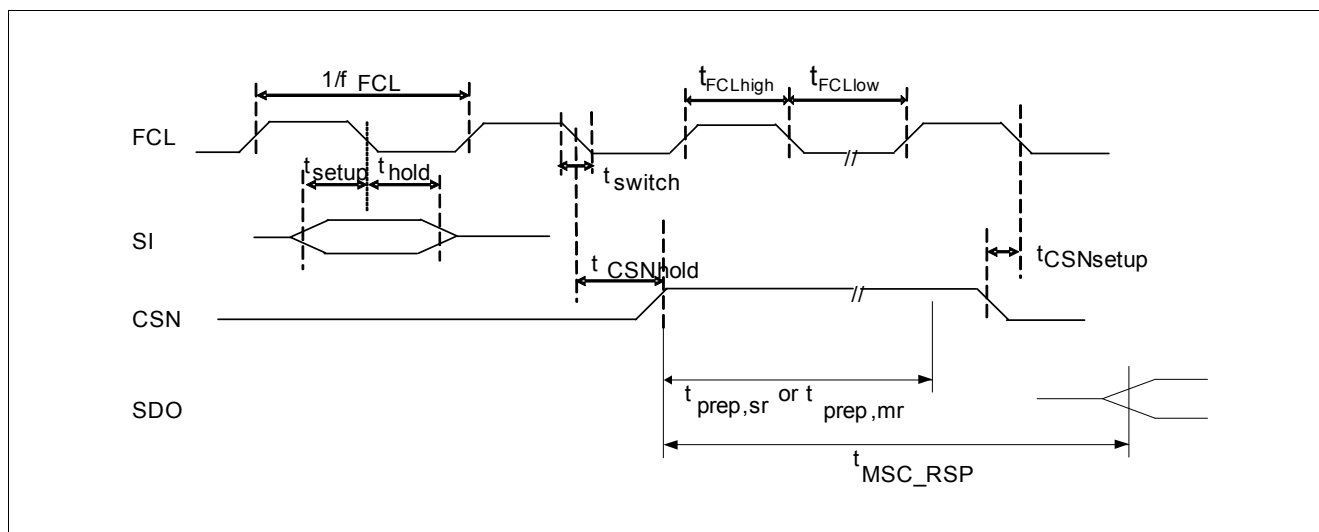
Figure 63   MSC timing

The downstream clock within the device must be active during an upstream data frame transmission (i.e. each answer to a READ command).

The upstream response time t_{MSC_RSP} describes the time between end of read command (rising edge of *CSN*) to beginning of up-stream communication (falling edge of start bit).

13.4 Electrical Characteristics

Table 47   Electrical Characteristics: Microsecond Channel

V_S = 13.5 V, V_{VSV} = 5 V, T_j = -40°C to +150°C, all voltages with respect to ground, positive current flowing into pin (unless otherwise specified)

Parameter	Symbol	Values			Unit	Note or Test Condition	Number
		Min.	Typ.	Max.			
Pin *CSN*							
Input comparator low level	V_{CSN_low}	-0.3	–	0.8			P_13.4.1
Input comparator high level	V_{CSN_high}	1.6	–	5.5	V	–	P_13.4.2
Input comparator hysteresis	V_{CSN_hys}	0.1	–	0.5	V	–	P_13.4.3
Input capacitance[1]	C_{CSN}			12	pF	–	P_13.4.4
Input current Internal pull up current source to *VDDIO*	I_{CSN}	-25	–	-3	µA	0 V < V_{CSN} < 2 V	P_13.4.5
Pins *FCLP, FCLN* MSC Differential Mode							
Input voltage range	V_{FCLP}, V_{FCLN}	0.8	–	1.6	V	–	P_13.4.6

Table 47 Electrical Characteristics: Microsecond Channel (cont'd)

V_S = 13.5 V, V_{VSV} = 5 V, T_j = -40°C to +150°C, all voltages with respect to ground, positive current flowing into pin (unless otherwise specified)

Parameter	Symbol	Values			Unit	Note or Test Condition	Number
		Min.	Typ.	Max.			
Differential input high detection level, $V_{FCLx\_high} = V_{FCLP} - V_{FCLN}$	V_{FCLx_high}	–	–	125	mV	–	P_13.4.7
Differential input low detection level, $V_{FCLx\_low} = V_{FCLP} - V_{FCLN}$	V_{FCLx_low}	-125	–	–	mV	–	P_13.4.8
Differential input hysteresis	$V_{FCLx,hys}$	50		200	mV		P_13.4.53
Input voltage offset, $V_{FCLx\_off} = 0.5 * (V_{FCLP} + V_{FCLN})$	V_{FCLx_off}	1.05	–	1.4	V	–	P_13.4.9
Differential capacitance between; FCLP and FCLN	C_{FCLx}	–	–	8	pF	[1]	P_13.4.10
Input pull down current	I_{FCLN}	3	–	25	µA	1 V < V_{FCLx} < V_{VDDIO}	P_13.4.12

Pins *FCLP* Single Ended Mode

Parameter	Symbol	Min.	Typ.	Max.	Unit	Note or Test Condition	Number
Input comparator low level	V_{FLCP_low}	-0.3	–	0.8			P_13.4.13
Input comparator high level	V_{FLCP_high}	1.6	–	5.5	V	–	P_13.4.14
Input comparator hysteresis	V_{FLCP_hys}	0.1	–	0.5	V	–	P_13.4.15
Input capacitance	C_{FLCP}			12	pF	[1]	P_13.4.16
Input pull down current	I_{FLCP}	3	–	25	µA	1 V < V_{FCLP} < V_{VDDIO}	P_13.4.17

Clock Frequency

Parameter	Symbol	Min.	Typ.	Max.	Unit	Note or Test Condition	Number
FCLP, *FCLN* frequency	f_{FCLx}	–	–	23	MHz		P_13.4.18
FCL frequency single ended mode	f_{FCL}	–	–	12.5	MHz		P_13.4.19

Pins *SIP*, *SIN* MSC Differential Mode

Parameter	Symbol	Min.	Typ.	Max.	Unit	Note or Test Condition	Number
Input voltage range	V_{SIP}, V_{SIN}	0.8	–	1.6	V	–	P_13.4.20
Differential input high detection level, $V_{SIx\_high} = V_{SIP} - V_{NSI}$	V_{SIx_high}	–	–	125	mV	–	P_13.4.21
Differential input low detection level, $V_{SIx\_low} = V_{SIP} - V_{SIN}$	V_{SIx_low}	-125	–	–	mV	–	P_13.4.22
Differential input hysteresis	$V_{SIx,hys}$	50		200	mV		P_13.4.54
Input voltage offset, $V_{SIx\_Off} = 0.5 * (V_{SIP} + V_{SIN})$	V_{SIx_Off}	1.05	–	1.4	V	–	P_13.4.23
Differential capacitance between SIP and SIN	C_{SIx}	–	–	8	pF	[1]	P_13.4.24

Table 47   Electrical Characteristics: Microsecond Channel (cont'd)

V_S = 13.5 V, V_{VSV} = 5 V, T_j = -40°C to +150°C, all voltages with respect to ground, positive current flowing into pin (unless otherwise specified)

Parameter	Symbol	Values			Unit	Note or Test Condition	Number
		Min.	Typ.	Max.			
Input pull down current	I_{SIN}	3	–	25	µA	1 V < V_{SIx} < V_{VDDIO}	P_13.4.26
Pin *SIP* Single Ended Mode							
Input comparator low level	V_{SIP_low}	-0.3	–	0.8			P_13.4.27
Input comparator high level	V_{SIP_high}	1.6	–	5.5	V	–	P_13.4.28
Input comparator hysteresis	V_{SIP_hys}	0.1	–	0.5	V	–	P_13.4.29
Input capacitance	C_{SIP}			12	pF	[1]	P_13.4.30
Input pull down current	I_{SIP}	3	–	25	µA	1 V < V_{SIP} < V_{VDDIO}	P_13.4.31
Pin *SDO* open drain set up							
SDO output low level	$V_{SDO\_low;}$	–	–	0.8	V	I_{SDO} < 4 mA;	P_13.4.32
	V_{SDO_low}	–	–	0.4	V	I_{SDO} < 1 mA	P_13.4.33
SDO passive output high voltage	$V_{SDO\_high,p}$	V_{DDIO} – 1.5	V_{DDIO}	–	V	no load	P_13.4.34
Output current capability	I_{SDO_max}	15[2]	–	–	mA	V_{SDO} = 5 V and V_{VDDIO} = 5 V	P_13.4.35
SDO pull-up current source	I_{SDO_high}	-50	–	-10	µA	0 V < V_{SDO} < 2 V, SDO in tristate, pull up to *VDDIO*	P_13.4.36
SDO (high level = inactive) pin capacity	C_{SDO}	–	–	10	pF	measured with bias voltage of 1 V[1]	P_13.4.37
SDO frequency; maximum upstream frequency with external pull-up	f_{SDO}	500	–	–	kHz	2.2 kΩ and C_L = 15 pF[1]	P_13.4.38
Pin *SDO* push pull set up							
SDO output low level	$V_{SDO\_low;}$	–	–	0.8	V	I_{SDO} < 4 mA;	P_13.4.39
	V_{SDO_low}	–	–	0.4	V	I_{SDO} < 1 mA	P_13.4.40
SDO active output high voltage	$V_{SDO\_high,a}$	V_{DDIO} – 0.4	–	–	V	I_{SDO} = 100 µA	P_13.4.41
Timing Characteristics[3]							
Data hold time	t_{hold}	10	–	–	ns	–	P_13.4.42
Data Setup time	t_{setup}	10	–	–	ns	–	P_13.4.43
Switching time	t_{switch}	–	–	3	ns	[1]	P_13.4.44
FCL low time	t_{FCLlow}	13	–	–	ns	–	P_13.4.45
FCL high time	$t_{FCLhigh}$	13	–	–	ns	–	P_13.4.46

Table 47   Electrical Characteristics: Microsecond Channel (cont'd)

V_S = 13.5 V, V_{VSV} = 5 V, T_j = -40°C to +150°C, all voltages with respect to ground, positive current flowing into pin (unless otherwise specified)

Parameter	Symbol	Values			Unit	Note or Test Condition	Number
		Min.	Typ.	Max.			
CSN setup time	$t_{CSNsetup}$	10	–	–	ns	–	P_13.4.47
CSN hold time	$t_{CSNhold}$	10	–	–	ns	–	P_13.4.48
MSC data time-out monitoring	t_{MSC_mon}	60	–	135	µs	–	P_13.4.49
MSC upstream preparation time for single read command	$t_{prep,sr}$	–	–	0.9 + 4*t_{FCL}	µs		P_13.4.11
MSC upstream preparation time for multi read command	$t_{prep,mr}$	–	–	1.8 + 4*t_{FCL}	µs		P_13.4.25
MSC upstream response time; up-stream divider independent	t_{MSC_RSP}	–	–	100	µs		P_13.4.50
Required idle time after command	t_{CPP}	2/f_{FCL} (2 clock pulses)	–	–	s	–	P_13.4.51
Required idle time after data frame	t_{DPP}	2/f_{FCL} (2 clock pulses)	–	–	s	–	P_13.4.52

1) not subject to production test, specified by design

2) Application must ensure that current into this pin does not exceed this value.

3) See **Figure 57**, **Figure 58** and **Figure 63**

14 Register and Commands

In **Chapter 14.1** to **Chapter 14.1.5** detailed descriptions and definitions of the registers and commands are shown. General definition for all registers and commands are described below.

Offset Address

The offset address used for the register address is mapped to the command bits from C1 to C7. In **Figure 64** an example is shown. Maximum allowed address is $7F_H$.
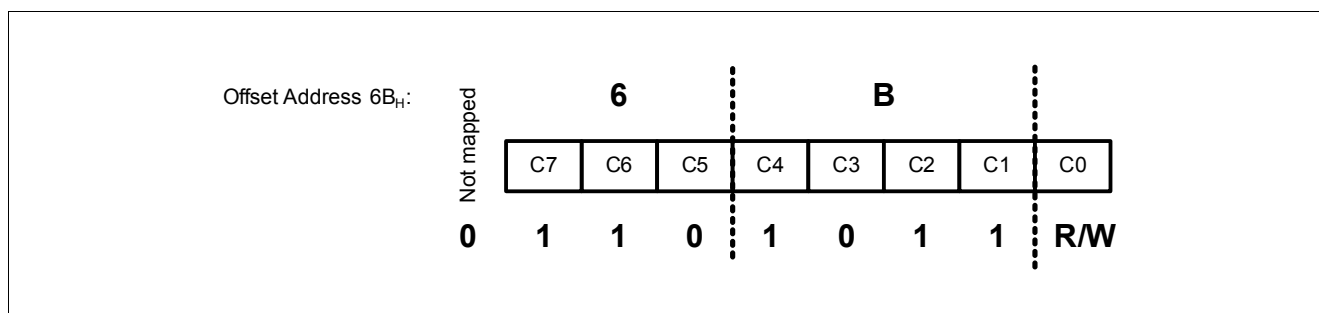
Figure 64   Mapping Offset Address to the Command Bits

Read Access

A read access to a register is done by sending a "0" for the bit C0 of the command frame of the MSC or the SPI frame. All register bits are updated constantly. With the positive edge of *CSN* of a valid read command the internal register information is loaded into the output shift register. The communication via *SDO* to the microcontroller is according the serial interface mode MSC or SPI. Therefore the read information is related to the time of the positive edge of *CSN*.

Write Access

A write access to a register is done by sending a "1" for the bit C0 of the command frame of the MSC or the SPI frame or with the data frame of the MSC communication. With the positive edge of *CSN* of a valid write access for read/write register the bits are set and for command registers the defined function is executed (e.g. multiple read command).

Command Register

These registers are write only registers. Following functions are executed:

• Main relay switching with bits **MRON** and **MRSE** in command register **Cmd0**: In all states where a serial communication with the TLE8888-1QK is allowed the main relay can be switched. This is done by enabling the command with a "1" for **MRSE** and a "0" for switch off or a "1" for switch on for **MRON**. Switch off of the main relay leads for an application with supply of the ECU over the main relay path to a power-down.

• VRS diagnosis start with bit **VDIAGS** in command register **Cmd0**: With a "1" the VRS diagnosis is started. A "0" leads to no action.

• Stop of a MSC upstream communication with bit **MSCUPS** in command register **Cmd0**: With a "1" the upstream communication is stopped immediately. This leads during an upstream to invalid communication. This command is implemented to stop especially multiple read communication. A "0" leads to no action. For SPI mode this command has no effect.

• Start of the engine off timer with bit **EOTS** in command register **Cmd0**: With a "1" the engine off timer is started if the configuration is set accordingly. A "0" leads to no action.

Register and Commands

- Restart of the delayed off timer with bit **RDOT** in command register **Cmd0**: With a "1" the delayed off timer is reset and started again. A "0" leads to no action.

- Wake-up signal clear with bit **WKCLR** in command register **Cmd0**: With a "1" all internal wake-up signals (WKINT, CANWK, EOTWK) are reset. A "0" leads to no action.

- Response write command **FWDRespCmd** and **FWDRespSyncCmd**: With the write access to these registers the 8 bit response byte is sent to the TLE8888-1QK. The interpretation of the sent response byte is done according the description in **Chapter 6**.

- Multiple read command **MSCReadWd0** to **MSCReadWd1**: Multiple read commands are only allowed for MSC setup of the serial interface. The number of read register is defined by a "1" in the data bits of the command. The chosen register is sent in the order MSB down to LSB (see **Figure 65**).
  In SPI setup a multiple read command is an invalid communication.
  During a multi read upstream read commands are ignored, write commands are allowed. To stop an upstream operation use the command **MSCUPS**.

- Software reset command **CmdSR**: With the execution of this command the software reset of the TLE8888-1QK is performed according **Table 6** in **Chapter 5**.

- Central output enable command **CmdOE**: With the execution of this command the central output enable bit is set or reset. For the description of the functionality see **Chapter 9.2**. The status of the central enable bit is available in register **OpStat1**.

- Lock command **CmdLOCK**: With the execution of this command the lock bit is set or reset.This bit is used to lock some configuration registers (see **Table 49**) to avoid a change of these register e.g. during operation. The status of the lock bit is available in register **OpStat1**.
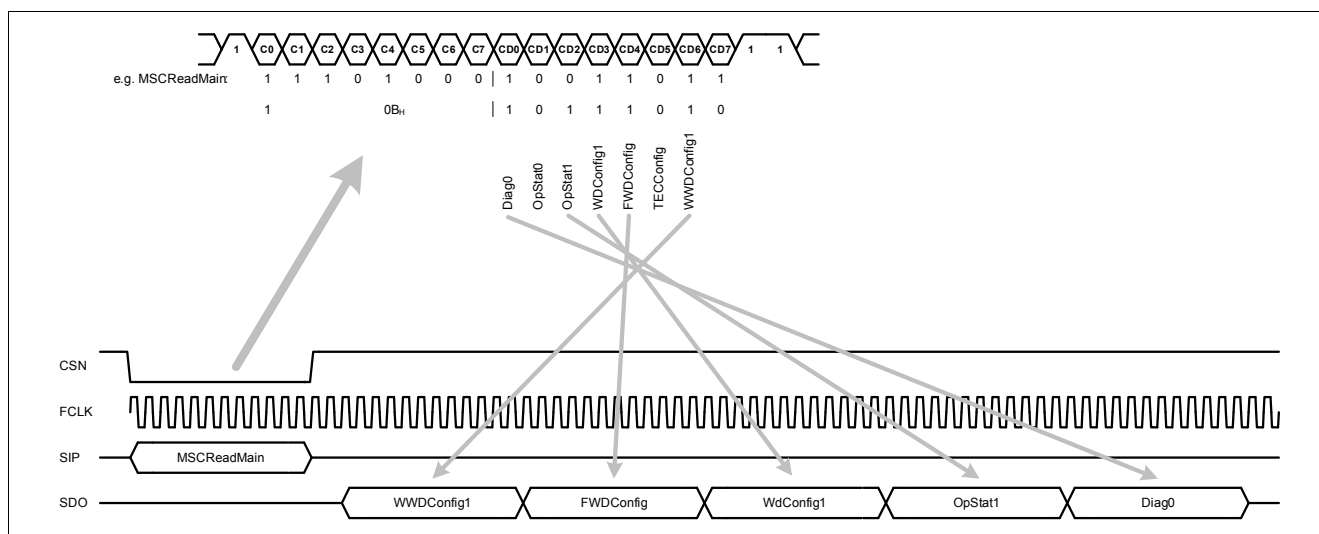
Figure 65   Example of a Multi read Command

Diagnosis Register

The diagnosis register bits are set according the asynchronous detection circuits. The reset of the diagnosis bits is done with the read out of the registers if the failure condition is not detected anymore.

Central Overtemperature Bit COT in Diagnosis Register Diag0

The central overtemperature bit is an OR combination of all overtemperature detection signals which leads to active diagnosis bits. With at least one active overtemperature diagnosis the central overtemperature bit is "1", with no active overtemperature diagnosis this bit is "0". All other diagnosis signals doesn't change the status of the central overtemperature bit.

Central Failure Bit CF in Diagnosis Register Diag0

The central failure bit is an OR combination of diagnosis bits (see **Table 48**). If one or more of these diagnosis bits are active then the central failure bit is "1". If all are inactive the central failure bit is "0". The overtemperature diagnosis doesn't change the status of the central failure bit.

Table 48   Overview of Diagnosis Registers an Bits affecting the Central Failure Bit

Register	Offset	Bit(s)	Note
ComDiag	024$_H$	MSCTO, COMFE, CANBDC, CANTXTO	
OutDiag0 to OutDiag4	026$_H$ to 029$_H$	all bits	central failure bit not set if only overtemperature is detected
PPOVDiag	02A$_H$	all bits	
BriDiag0	02B$_H$	all bits	
BriDiag1	02C$_H$	only overcurrent bits	
IgnDiag	02D$_H$	all bits	
WdDiag	02E$_H$	WWDTO, WWDSCE, FWDREL, FWDREA	

Engine Off Timer Register EOTStat0 to EOTStat2, EOTConfig0 and EOTConfig1

These register are located in the standby block and are supplied by the standby supply. They are not reset with the power on reset of the digital block.

Registers affected by the Lock Bit

Table 49   Overview of Register affected by the Lock Bit

Register	Offset
OutConfig0	040$_H$
OutConfig1	041$_H$
OutConfig2	042$_H$
OutConfig3	043$_H$
OutConfig4	044$_H$
OutConfig5	045$_H$
BriConfig0	046$_H$
BriConfig1	047$_H$
IGNConfig	048$_H$
VRSConfig1	04A$_H$
VRSConfig2	04B$_H$
OpConfig0	04E$_H$
ComConfig0	04F$_H$
ComConfig1	050$_H$

Table 49   Overview of Register affected by the Lock Bit (cont'd)

Register	Offset
EOTConfig0	051_H
EOTConfig1	052_H
InConfig0	053_H
InConfig1	054_H
InConfig2	055_H
InConfig3	056_H
DDConfig0	057_H
DDConfig1	058_H
DDConfig2	059_H
DDConfig3	$05A_H$
WDConfig1	064_H

14.1 Register Table

Table 50 Register Overview

Register Short Name	Register Long Name	Offset Address	Reset Value
Cmd0		001_H	00_H
MSCReadWd0		003_H	00_H
MSCReadDiag0EOT		004_H	00_H
MSCReadDiag1		005_H	00_H
MSCReadCont		006_H	00_H
MSCReadConfig0		007_H	00_H
MSCReadConfig1		008_H	00_H
MSCReadConfig2		009_H	00_H
MSCReadOEConfig		$00A_H$	00_H
MSCReadMain		$00B_H$	00_H
MSCReadWd1		$00C_H$	00_H
WWDServiceCmd		015_H	00_H
FWDRespCmd		016_H	00_H
FWDRespSyncCmd		017_H	00_H
WDHBTPSyncCmd		018_H	00_H
CmdSR		$01A_H$	00_H
CmdOE		$01C_H$	00_H
CmdLOCK		$01E_H$	00_H
Diag0		020_H	00_H
Diag1		021_H	00_H
VRSDiag0		022_H	00_H
VRSDiag1		023_H	00_H
ComDiag		024_H	00_H
OutDiag0		025_H	00_H
OutDiag1		026_H	00_H
OutDiag2		027_H	00_H
OutDiag3		028_H	00_H
OutDiag4		029_H	00_H
PPOVDiag		$02A_H$	00_H
BriDiag0		$02B_H$	00_H
BriDiag1		$02C_H$	00_H
IgnDiag		$02D_H$	00_H
WdDiag		$02E_H$	00_H
EOTStat0		031_H	00_H

Table 50   Register Overview (cont'd)

Register Short Name	Register Long Name	Offset Address	Reset Value
EOTStat1		032$_H$	00$_H$
EOTStat2		033$_H$	00$_H$
OpStat0		034$_H$	00$_H$
OpStat1		035$_H$	00$_H$
WWDStat		036$_H$	30$_H$
FWDStat0		037$_H$	30$_H$
FWDStat1		038$_H$	30$_H$
TECStat		039$_H$	30$_H$
WdStat0		03A$_H$	00$_H$
WdStat1		03B$_H$	00$_H$
WDHBT0		03C$_H$	00$_H$
WDHBT1		03D$_H$	00$_H$
OutConfig0		040$_H$	FF$_H$
OutConfig1		041$_H$	3F$_H$
OutConfig2		042$_H$	3F$_H$
OutConfig3		043$_H$	30$_H$
OutConfig4		044$_H$	3F$_H$
OutConfig5		045$_H$	3F$_H$
BriConfig0		046$_H$	00$_H$
BriConfig1		047$_H$	00$_H$
IGNConfig		048$_H$	00$_H$
VRSConfig0		049$_H$	00$_H$
VRSConfig1		04A$_H$	00$_H$
VRSConfig2		04B$_H$	00$_H$
OpConfig0		04E$_H$	09$_H$
ComConfig0		04F$_H$	A4$_H$
ComConfig1		050$_H$	0D$_H$
EOTConfig0		051$_H$	00$_H$
EOTConfig1		052$_H$	00$_H$
InConfig0		053$_H$	00$_H$
InConfig1		054$_H$	00$_H$
InConfig2		055$_H$	00$_H$
InConfig3		056$_H$	00$_H$
DDConfig0		057$_H$	00$_H$
DDConfig1		058$_H$	00$_H$
DDConfig2		059$_H$	00$_H$
DDConfig3		05A$_H$	00$_H$
OEConfig0		05B$_H$	00$_H$

Table 50   Register Overview (cont'd)

Register Short Name	Register Long Name	Offset Address	Reset Value
OEConfig1		$05C_H$	00_H
OEConfig2		$05D_H$	00_H
OEConfig3		$05E_H$	00_H
WWDConfig0		$05F_H$	FF_H
WWDConfig1		060_H	77_H
FWDConfig		061_H	$F7_H$
TECConfig		062_H	77_H
WDConfig0		063_H	47_H
WDConfig1		064_H	03_H
Cont0		$07B_H$	00_H
Cont1		$07C_H$	00_H
Cont2		$07D_H$	00_H
Cont3		$07E_H$	00_H

The registers are addressed wordwise.

14.1.1   Command Register

Cmd0	Offset	Reset Value
	001_H	00_H

7	6	5	4	3	2	1	0
WKCLR	RDOT	EOTS	MSCUPS	WDHBTS	VDIAGS	MRON	MRSE
w	w	w	w	w	w	w	w
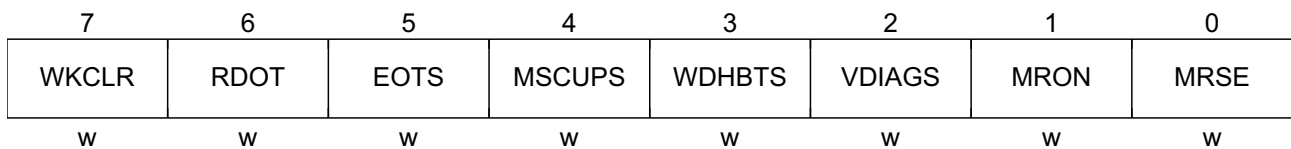
Field	Bits	Type	Description
WKCLR	7	w	**Wake-up Signal Clear Command:** 0_B , no action 1_B , initiated clear of internal wake signals Reset: 0_B

Field	Bits	Type	Description
RDOT	6	w	**Restart Delayed off Timer Command:** 0_B , no action 1_B , delayed off timer is restarted Reset: 0_B
EOTS	5	w	**Engine Off Timer Start Command:** 0_B , no action 1_B , start counter Reset: 0_B
MSCUPS	4	w	**MSC Upstream Stop Bit Command:** 0_B , no influence to upstream transmission 1_B , upstream communication is stopped Reset: 0_B
WDHBTS	3	w	**Watchdog Heartbeat Timer Sample Command:** 0_B , no action 1_B , Watchdog Heartbeat Timer sampled (WDHBT0 and WDHBT1) Reset: 0_B
VDIAGS	2	w	**VRS Diagnosis Measurement Start Command:** 0_B , no measurement 1_B , start of VRS diagnosis measurement Reset: 0_B
MRON	1	w	**Main Relay On Command (active if MRSE = 1):** 0_B , initiated main relay is switched off 1_B , initiated main relay is switched on Reset: 0_B
MRSE	0	w	**Main Relay Switching Enable:** 0_B , main relay switching by bit MRON not enabled 1_B , main relay switching enabled: value of MRON executed Reset: 0_B

MSCReadWd0			**Offset** 003_H			**Reset Value** 00_H	

7	6	5	4	3	2	1	0
WWDCONFIG0	WDCONFIG0	WWDSTAT	WDDIAG	FWDSTAT1	FWDSTAT0	TECSTAT	WDSTAT0
w	w	w	w	w	w	w	w

Field	Bits	Type	Description
WWDCONFIG0	7	w	**Read Status Register WWDConfig0** 0_B , no action 1_B , multi read operation executed (order MSB to LSB) Reset: 0_B
WDCONFIG0	6	w	**Read Status Register WDConfig0** 0_B , no action 1_B , multi read operation executed (order MSB to LSB) Reset: 0_B
WWDSTAT	5	w	**Read Status Register WWDStat** 0_B , no action 1_B , multi read operation executed (order MSB to LSB) Reset: 0_B
WDDIAG	4	w	**Read Configuration Register WdDiag** 0_B , no action 1_B , multi read operation executed (order MSB to LSB) Reset: 0_B
FWDSTAT1	3	w	**Read Configuration Register FWDStat1** 0_B , no action 1_B , multi read operation executed (order MSB to LSB) Reset: 0_B
FWDSTAT0	2	w	**Read Diagnosis Register FWDStat0** 0_B , no action 1_B , multi read operation executed (order MSB to LSB) Reset: 0_B
TECSTAT	1	w	**Read Diagnosis Register TECStat** 0_B , no action 1_B , multi read operation executed (order MSB to LSB) Reset: 0_B
WDSTAT0	0	w	**Read Status Register WdStat0** 0_B , no action 1_B , multi read operation executed (order MSB to LSB) Reset: 0_B

MSCReadDiag0EOT   **Offset**   **Reset Value**
004_H 00_H

7	6	5	4	3	2	1	0
PPOVDIAG	DIAG1	EOTSTAT2	EOTSTAT1	EOTSTAT0	COMDIAG	VRSDIAG1	VRSDIAG0
w	w	w	w	w	w	w	w

Field	Bits	Type	Description
PPOVDIAG	7	w	**Read Diagnosis Register PPOVDiag** 0_B , no action 1_B , multi read operation executed (order MSB to LSB) Reset: 0_B
DIAG1	6	w	**Read Diagnosis Register Diag1** 0_B , no action 1_B , multi read operation executed (order MSB to LSB) Reset: 0_B
EOTSTAT2	5	w	**Read Status Register EOTStat2** 0_B , no action 1_B , multi read operation executed (order MSB to LSB) Reset: 0_B
EOTSTAT1	4	w	**Read Status Register EOTStat1** 0_B , no action 1_B , multi read operation executed (order MSB to LSB) Reset: 0_B
EOTSTAT0	3	w	**Read Status Register EOTStat0** 0_B , no action 1_B , multi read operation executed (order MSB to LSB) Reset: 0_B
COMDIAG	2	w	**Read Diagnosis Register ComDiag** 0_B , no action 1_B , multi read operation executed (order MSB to LSB) Reset: 0_B
VRSDIAG1	1	w	**Read Diagnosis Register VRSDiag1** 0_B , no action 1_B , multi read operation executed (order MSB to LSB) Reset: 0_B
VRSDIAG0	0	w	**Read Diagnosis Register VRSDiag0** 0_B , no action 1_B , multi read operation executed (order MSB to LSB) Reset: 0_B

MSCReadDiag1　　　　　　　　　　**Offset**　　　　　　　　　　**Reset Value**

　　　　　　　　　　　　　　　　　　005_H　　　　　　　　　　　　**00_H**

7	6	5	4	3	2	1	0
IGNDIAG	BRIDIAG 1	BRIDIAG 0	OUTDIAG 4	OUTDIAG 3	OUTDIAG 2	OUTDIAG 1	OUTDIAG 0
w	w	w	w	w	w	w	w

Field	Bits	Type	Description
IGNDIAG	7	w	**Read Diagnosis Register IgnDiag** 0_B , no action 1_B , multi read operation executed (order MSB to LSB) Reset: 0_B
BRIDIAG1	6	w	**Read Diagnosis Register BriDiag1** 0_B , no action 1_B , multi read operation executed (order MSB to LSB) Reset: 0_B
BRIDIAG0	5	w	**Read Diagnosis Register BriDiag0** 0_B , no action 1_B , multi read operation executed (order MSB to LSB) Reset: 0_B
OUTDIAG4	4	w	**Read Diagnosis Register OutDiag4** 0_B , no action 1_B , multi read operation executed (order MSB to LSB) Reset: 0_B
OUTDIAG3	3	w	**Read Diagnosis Register OutDiag3** 0_B , no action 1_B , multi read operation executed (order MSB to LSB) Reset: 0_B
OUTDIAG2	2	w	**Read Diagnosis Register OutDiag2** 0_B , no action 1_B , multi read operation executed (order MSB to LSB) Reset: 0_B
OUTDIAG1	1	w	**Read Diagnosis Register OutDiag1** 0_B , no action 1_B , multi read operation executed (order MSB to LSB) Reset: 0_B
OUTDIAG0	0	w	**Read Diagnosis Register OutDiag0** 0_B , no action 1_B , multi read operation executed (order MSB to LSB) Reset: 0_B

MSCReadCont   **Offset**   **Reset Value**
                                   006_H   **00_H**

7	6	5	4	3	2	1	0
		RES		CONT3	CONT2	CONT1	CONT0
				w	w	w	w
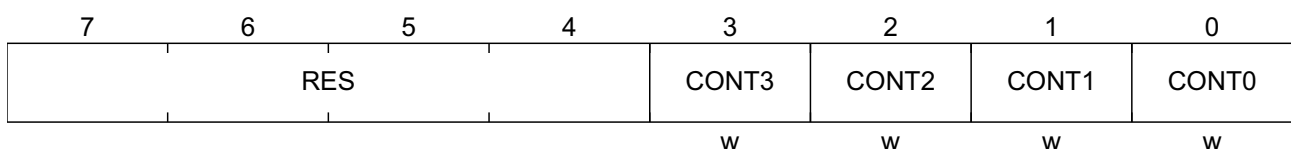
Field	Bits	Type	Description
CONT3	3	w	**Read Control Register Cont3** 0_B , no action 1_B , multi read operation executed (order MSB to LSB) Reset: 0_B
CONT2	2	w	**Read Control Register Cont2** 0_B , no action 1_B , multi read operation executed (order MSB to LSB) Reset: 0_B
CONT1	1	w	**Read Control Register Cont1** 0_B , no action 1_B , multi read operation executed (order MSB to LSB) Reset: 0_B
CONT0	0	w	**Read Control Register Cont0** 0_B , no action 1_B , multi read operation executed (order MSB to LSB) Reset: 0_B

MSCReadConfig0   **Offset**   **Reset Value**

                            007_H 00_H

7	6	5	4	3	2	1	0
BRICONF IG1	BRICONF IG0	OUTCONF IG5	OUTCONF IG4	OUTCONF IG3	OUTCONF IG2	OUTCONF IG1	OUTCONF IG0
w	w	w	w	w	w	w	w
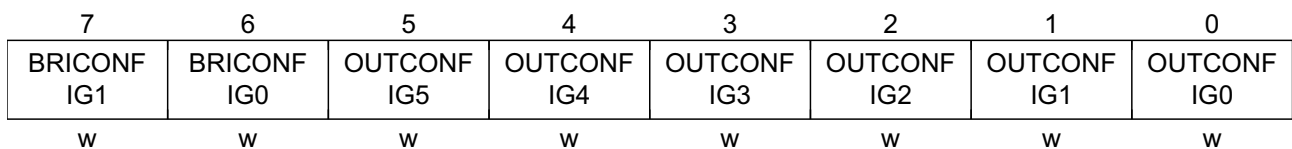
Field	Bits	Type	Description
BRICONFIG1	7	w	**Read Configuration Register BriConfig1** 0_B , no action 1_B , multi read operation executed (order MSB to LSB) Reset: 0_B
BRICONFIG0	6	w	**Read Configuration Register BriConfig0** 0_B , no action 1_B , multi read operation executed (order MSB to LSB) Reset: 0_B
OUTCONFIG5	5	w	**Read Configuration Register OutConfig5** 0_B , no action 1_B , multi read operation executed (order MSB to LSB) Reset: 0_B

Field	Bits	Type	Description
OUTCONFIG4	4	w	**Read Configuration Register OutConfig4** 0_B , no action 1_B , multi read operation executed (order MSB to LSB) Reset: 0_B
OUTCONFIG3	3	w	**Read Configuration Register OutConfig3** 0_B , no action 1_B , multi read operation executed (order MSB to LSB) Reset: 0_B
OUTCONFIG2	2	w	**Read Configuration Register OutConfig2** 0_B , no action 1_B , multi read operation executed (order MSB to LSB) Reset: 0_B
OUTCONFIG1	1	w	**Read Configuration Register OutConfig1** 0_B , no action 1_B , multi read operation executed (order MSB to LSB) Reset: 0_B
OUTCONFIG0	0	w	**Read Configuration Register OutConfig0** 0_B , no action 1_B , multi read operation executed (order MSB to LSB) Reset: 0_B

MSCReadConfig1 **Offset** **Reset Value**

008_H **00_H**

7	6	5	4	3	2	1	0
EOTCONF IG1	EOTCONF IG0	VRSCONF IG1	VRSCONF IG0	OPCONFI G0	COMCONF IG1	COMCONF IG0	IGNCONF IG
w	w	w	w	w	w	w	w

Field	Bits	Type	Description
EOTCONFIG1	7	w	**Read Configuration Register EOTConfig1** 0_B , no action 1_B , multi read operation executed (order MSB to LSB) Reset: 0_B
EOTCONFIG0	6	w	**Read Configuration Register EOTConfig0** 0_B , no action 1_B , multi read operation executed (order MSB to LSB) Reset: 0_B

Field	Bits	Type	Description
VRSCONFIG1	5	w	**Read Configuration Register VRSConfig1** 0_B , no action 1_B , multi read operation executed (order MSB to LSB) Reset: 0_B
VRSCONFIG0	4	w	**Read Configuration Register VRSConfig0** 0_B , no action 1_B , multi read operation executed (order MSB to LSB) Reset: 0_B
OPCONFIG0	3	w	**Read Configuration Register OpConfig0** 0_B , no action 1_B , multi read operation executed (order MSB to LSB) Reset: 0_B
COMCONFIG1	2	w	**Read Configuration Register ComConfig1** 0_B , no action 1_B , multi read operation executed (order MSB to LSB) Reset: 0_B
COMCONFIG0	1	w	**Read Configuration Register ComConfig0** 0_B , no action 1_B , multi read operation executed (order MSB to LSB) Reset: 0_B
IGNCONFIG	0	w	**Read Configuration Register IGNConfig** 0_B , no action 1_B , multi read operation executed (order MSB to LSB) Reset: 0_B

MSCReadConfig2 **Offset** **Reset Value**

009_H 00_H

7	6	5	4	3	2	1	0
INCONFIG3	INCONFIG2	INCONFIG1	INCONFIG0	DDCONFIG3	DDCONFIG2	DDCONFIG1	DDCONFIG0
w	w	w	w	w	w	w	w

Field	Bits	Type	Description
INCONFIG3	7	w	**Read Configuration Register InConfig3** 0_B , no action 1_B , multi read operation executed (order MSB to LSB) Reset: 0_B

Field	Bits	Type	Description
INCONFIG2	6	w	**Read Configuration Register InConfig2** 0_B , no action 1_B , multi read operation executed (order MSB to LSB) Reset: 0_B
INCONFIG1	5	w	**Read Configuration Register InConfig1** 0_B , no action 1_B , multi read operation executed (order MSB to LSB) Reset: 0_B
INCONFIG0	4	w	**Read Configuration Register InConfig0** 0_B , no action 1_B , multi read operation executed (order MSB to LSB) Reset: 0_B
DDCONFIG3	3	w	**Read Configuration Register DDConfig3** 0_B , no action 1_B , multi read operation executed (order MSB to LSB) Reset: 0_B
DDCONFIG2	2	w	**Read Configuration Register DDConfig2** 0_B , no action 1_B , multi read operation executed (order MSB to LSB) Reset: 0_B
DDCONFIG1	1	w	**Read Configuration Register DDConfig1** 0_B , no action 1_B , multi read operation executed (order MSB to LSB) Reset: 0_B
DDCONFIG0	0	w	**Read Configuration Register DDConfig0** 0_B , no action 1_B , multi read operation executed (order MSB to LSB) Reset: 0_B

MSCReadOEConfig **Offset** **Reset Value**

$00A_H$ 00_H

7	6	5	4	3	2	1	0
	RES		VRSCONFIG2	OECONFIG3	OECONFIG2	OECONFIG1	OECONFIG0
			w	w	w	w	w

Field	Bits	Type	Description
VRSCONFIG2	4	w	**Read Configuration Register VRSConfig2** 0_B , no action 1_B , multi read operation executed (order MSB to LSB) Reset: 0_B
OECONFIG3	3	w	**Read Configuration Register OEConfig3** 0_B , no action 1_B , multi read operation executed (order MSB to LSB) Reset: 0_B
OECONFIG2	2	w	**Read Configuration Register OEConfig2** 0_B , no action 1_B , multi read operation executed (order MSB to LSB) Reset: 0_B
OECONFIG1	1	w	**Read Configuration Register OEConfig1** 0_B , no action 1_B , multi read operation executed (order MSB to LSB) Reset: 0_B
OECONFIG0	0	w	**Read Configuration Register OEConfig0** 0_B , no action 1_B , multi read operation executed (order MSB to LSB) Reset: 0_B

MSCReadMain **Offset** **Reset Value**

$00B_H$ 00_H

7	6	5	4	3	2	1	0
RES	WWDCONFIG1	TECCONFIG	FWDCONFIG	WDCONFIG1	OPSTAT1	OPSTAT0	DIAG0
	w	w	w	w	w	w	w

Field	Bits	Type	Description
WWDCONFIG1	6	w	**Read Status Register WWDConfig1** 0_B , no action 1_B , multi read operation executed (order MSB to LSB) Reset: 0_B
TECCONFIG	5	w	**Read Status Register TECConfig** 0_B , no action 1_B , multi read operation executed (order MSB to LSB) Reset: 0_B

Field	Bits	Type	Description
FWDCONFIG	4	w	**Read Status Register FWDConfig** 0_B , no action 1_B , multi read operation executed (order MSB to LSB) Reset: 0_B
WDCONFIG1	3	w	**Read Status Register WDConfig1** 0_B , no action 1_B , multi read operation executed (order MSB to LSB) Reset: 0_B
OPSTAT1	2	w	**Read Status Register OpStat1** 0_B , no action 1_B , multi read operation executed (order MSB to LSB) Reset: 0_B
OPSTAT0	1	w	**Read Status Register OpStat0** 0_B , no action 1_B , multi read operation executed (order MSB to LSB) Reset: 0_B
DIAG0	0	w	**Read Diagnosis Register Diag0** 0_B , no action 1_B , multi read operation executed (order MSB to LSB) Reset: 0_B

MSCReadWd1   **Offset**   **Reset Value**

00C$_H$ **00$_H$**

7	6	5	4	3	2	1	0
		RES		WDSTAT1	WDSTAT0	WDHBT1	WDHBT0
				w	w	w	w
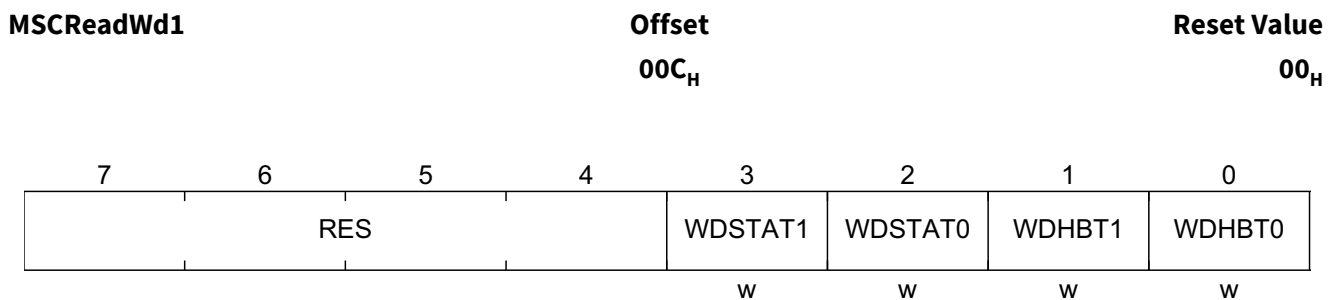
Field	Bits	Type	Description
WDSTAT1	3	w	**Read Status Register WdStat1** 0_B , no action 1_B , multi read operation executed (order MSB to LSB) Reset: 0_B
WDSTAT0	2	w	**Read Status Register WdStat0** 0_B , no action 1_B , multi read operation executed (order MSB to LSB) Reset: 0_B

Field	Bits	Type	Description
WDHBT1	1	w	**Read Status Register WDHBT1** 0_B, no action 1_B, multi read operation executed (order MSB to LSB) Reset: 0_B
WDHBT0	0	w	**Read Status Register WDHBT0** 0_B, no action 1_B, multi read operation executed (order MSB to LSB) Reset: 0_B

WWDServiceCmd　　　　　　　　　　**Offset**　　　　　　　　　　**Reset Value**

　　　　　　　　　　　　　　　　　　　　015_H　　　　　　　　　　　　　　　00_H

7	6	5	4	3	2	1	0
			WWDCWTC			WWDOWTC	
			w			w	
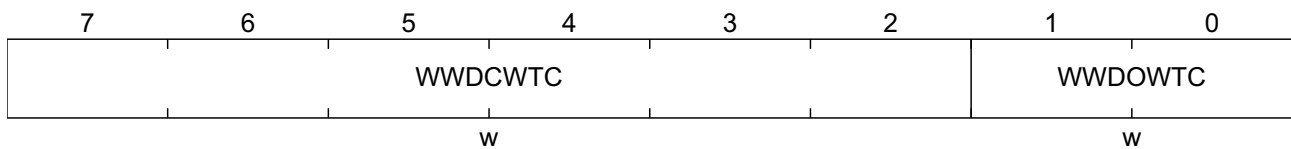
Field	Bits	Type	Description
WWDCWTC	7:2	w	**Window Watchdog Closed Window Time Write Command:** Set WWDCWT in register WWDConfig0 000000_B, no change - old setting used for open and closed window 000001_B, 1,6 ms 111111_B, 100,8 ms Reset: 000000_B
WWDOWTC	1:0	w	**Window Watchdog Open Window Time Write Command:** Set WWDOWT in register WWDConfig0 00_B, 3,2 ms 01_B, 6,4 ms 10_B, 9,6 ms 11_B, 12,8 ms Reset: 00_B

FWDRespCmd　　　　　　　　　　**Offset**　　　　　　　　　　**Reset Value**

　　　　　　　　　　　　　　　　　　　　016_H　　　　　　　　　　　　　　　00_H

7	6	5	4	3	2	1	0
			FWDRESP				

w
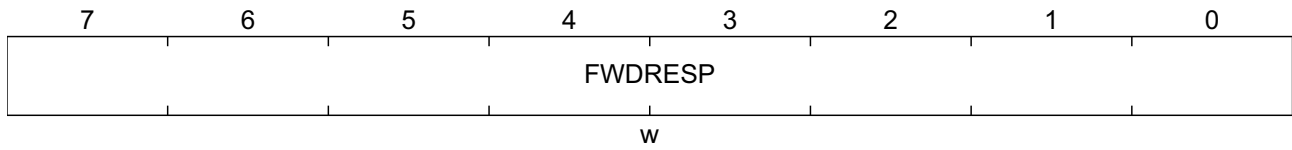
Field	Bits	Type	Description
FWDRESP	7:0	w	**Functional Watchdog Response Byte Write Command** Reset: 00$_H$

FWDRespSyncCmd   **Offset**   **Reset Value**

                                      017$_H$ **00$_H$**

7	6	5	4	3	2	1	0
			FWDRESPS				

w
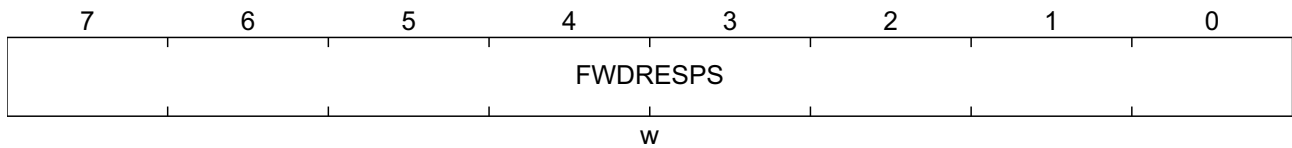
Field	Bits	Type	Description
FWDRESPS	7:0	w	**Functional Watchdog Response Byte Write and Heartbeat Synchronisation Command** Reset: 00$_H$

WDHBTPSyncCmd   **Offset**   **Reset Value**

                                      018$_H$ **00$_H$**

7	6	5	4	3	2	1	0
RES				WDHBTPC			

w
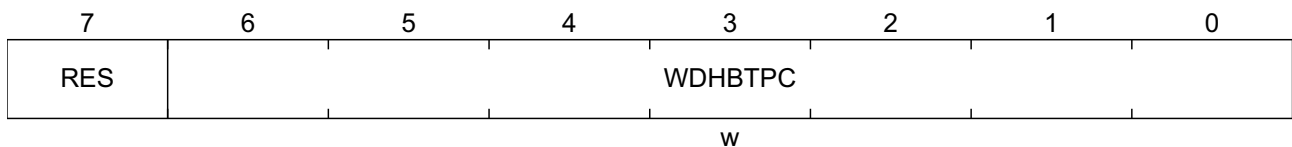
Field	Bits	Type	Description
WDHBTPC	6:0	w	**Heartbeat Timer Period Write and Synchronisation Command:** Set WDHBTP in register WDConfig0 0000000_B, no change 0000001_B, 1,6 ms 0000010_B, 3,2 ms 1111111_B, 203,2 ms Reset: 0000000_B

CmdSR　　　　　　　　　　　　　　　　　**Offset**　　　　　　　　　　　　**Reset Value**

　　　　　　　　　　　　　　　　　　　　　　$01A_H$　　　　　　　　　　　　　　　00_H

7	6	5	4	3	2	1	0
			RES			CMDSR	
						w	
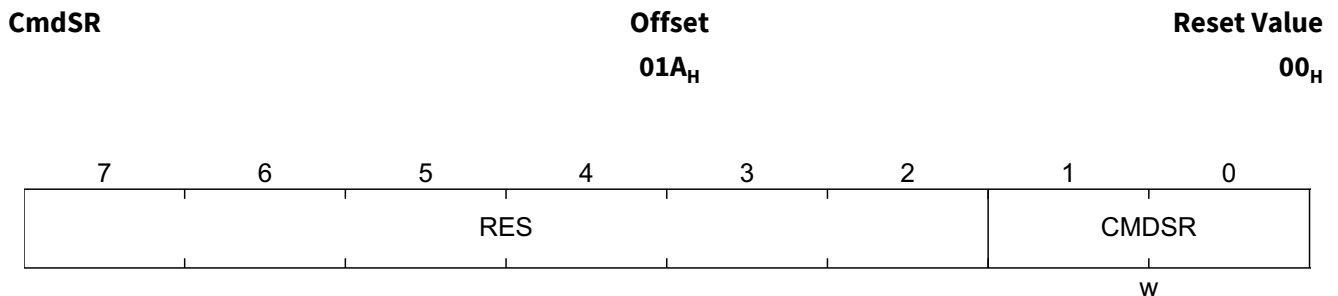
Field	Bits	Type	Description
CMDSR	1:0	w	**Software Reset Command** 00_B , No action 01_B , No action 10_B , No action 11_B , Initiate software reset Reset: 00_B

CmdOE　　　　　　　　　　　　　　　　　**Offset**　　　　　　　　　　　　**Reset Value**

　　　　　　　　　　　　　　　　　　　　　　$01C_H$　　　　　　　　　　　　　　　00_H

7	6	5	4	3	2	1	0
			RES			CMDOE	
						w	
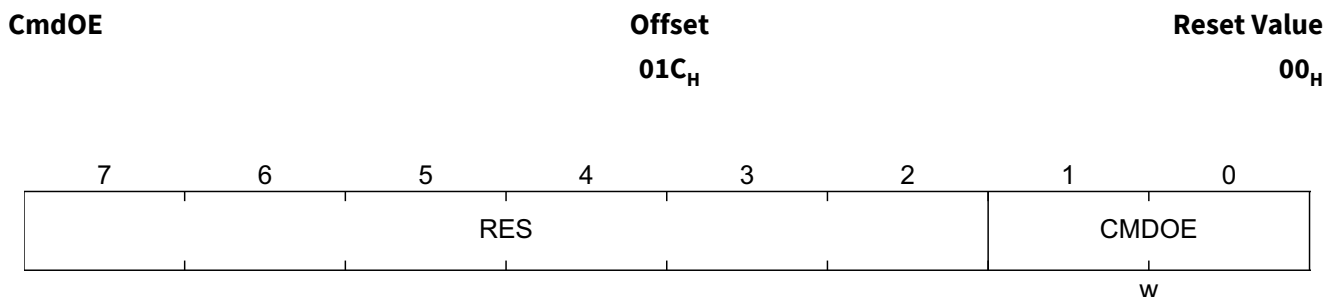
Field	Bits	Type	Description
CMDOE	1:0	w	**Global Output Enable Command** 00_B , No action 01_B , Set Bit OE to 0 10_B , Set Bit OE to 1 11_B , No action Reset: 00_B

CmdLOCK · **Offset** $01E_H$ · **Reset Value** 00_H

7	6	5	4	3	2	1	0
			RES			CMDLOCK	
						w	
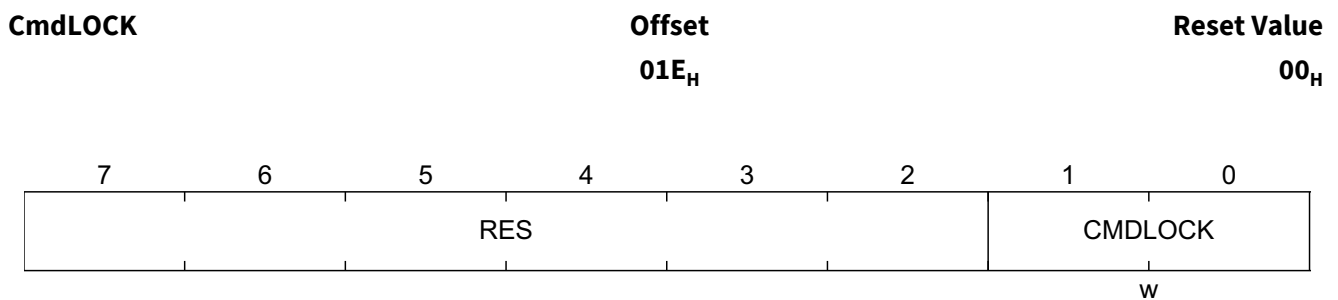
Field	Bits	Type	Description
CMDLOCK	1:0	w	**Configuration Lock Command** 00_B , No action 01_B , Set Bit LOCK to 0 10_B , Set Bit LOCK to 1 11_B , No action Reset: 00_B

14.1.2　Diagnosis Register

Diag0 · **Offset** 020_H · **Reset Value** 00_H

7	6	5	4	3	2	1	0
V6VOV	T2OV	T2UV	T1OV	T1UV	BATOV	CF	COT
r	r	r	r	r	r	r	r
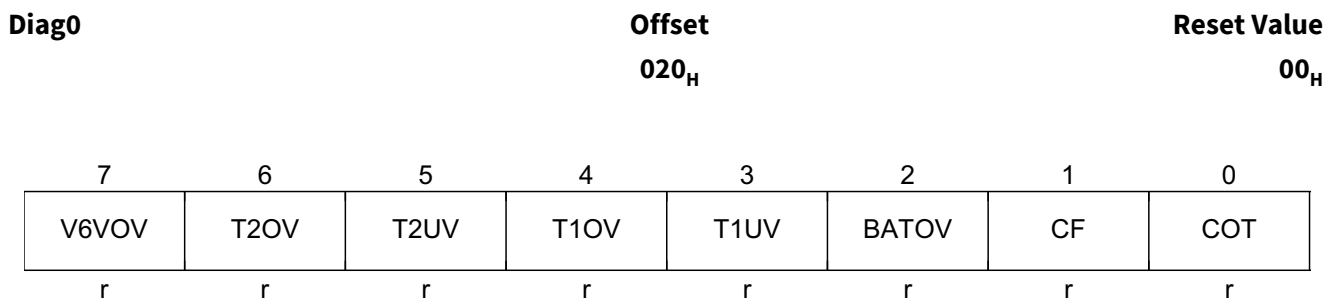
Field	Bits	Type	Description
V6VOV	7	r	**Overvoltage Diagnosis Bit of 6 V Supply V6V:** 0_B , no overvoltage 1_B , overvoltage Reset: 0_B
T2OV	6	r	**Overvoltage Diagnosis Bit of Tracker Output T5V2:** 0_B , no overvoltage 1_B , overvoltage Reset: 0_B
T2UV	5	r	**Undervoltage Diagnosis Bit of Tracker Output T5V2:** 0_B , no undervoltage 1_B , undervoltage Reset: 0_B
T1OV	4	r	**Overvoltage Diagnosis Bit of Tracker Output T5V1:** 0_B , no overvoltage 1_B , overvoltage Reset: 0_B
T1UV	3	r	**Undervoltage Diagnosis Bit of Tracker Output T5V1:** 0_B , no undervoltage 1_B , undervoltage Reset: 0_B
BATOV	2	r	**Battery Overvoltage Diagnosis Bit:** 0_B , no battery overvoltage 1_B , battery overvoltage Reset: 0_B
CF	1	r	**Central Failure Diagnosis Bit:** 0_B , no failure 1_B , failure of minimum one diagnostic detected Reset: 0_B
COT	0	r	**Central Overtemperature Diagnosis Bit:** 0_B , no overtemperature 1_B , overtemperature of minimum one temperature sensor Reset: 0_B

Diag1			**Offset**		**Reset Value**
			021_H		00_H

7	6	5	4	3	2	1	0
		RES			T5VOT	V5VOT	MROT
					r	r	r
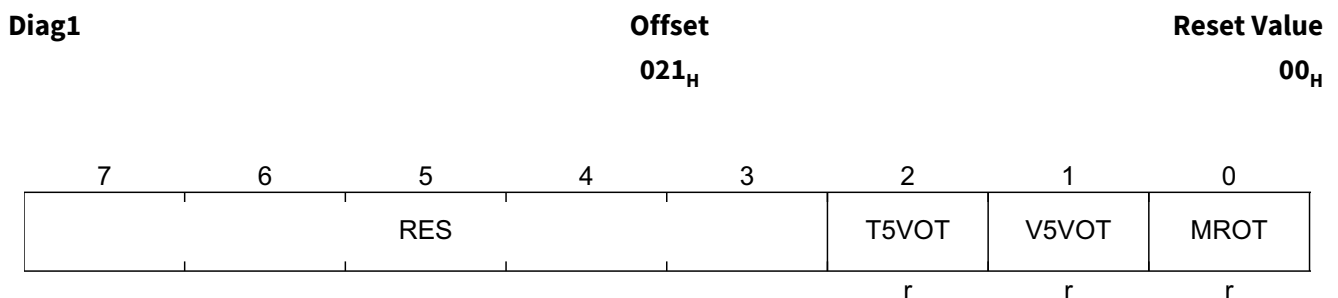
Field	Bits	Type	Description
T5VOT	2	r	**Tracker Overtemperature Diagnosis Bit:** 0_B , no overtemperature 1_B , overtemperature Reset: 0_B
V5VOT	1	r	**V5V Regulator Overtemperature Diagnosis Bit:** 0_B , no overtemperature 1_B , overtemperature Reset: 0_B
MROT	0	r	**Main Relay Overtemperature Diagnosis Bit:** 0_B , no overtemperature 1_B , overtemperature Reset: 0_B

VRSDiag0				**Offset** 022_H			**Reset Value** 00_H

7	6	5	4	3	2	1	0
	RES		VRSDV_OL	VRSDV_SC	VRSOL	VRSB	VRSG
			r	r	r	r	r
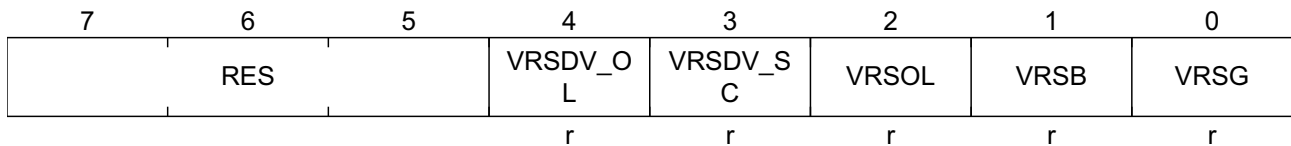
Field	Bits	Type	Description
VRSDV_OL	4	r	**Open Load Measurement Data Valid Bit** 0_B , measurement data not valid 1_B , measurement data valid Reset: 0_B
VRSDV_SC	3	r	**Short to GND/Bat Measurement Data Valid Bit** 0_B , measurement data not valid 1_B , measurement data valid Reset: 0_B
VRSOL	2	r	**VRS Open Load Diagnosis Bit:** 0_B , no open load 1_B , open load Reset: 0_B
VRSB	1	r	**VRS Short to Battery Diagnosis Bit:** 0_B , no short to battery 1_B , short to battery Reset: 0_B

Field	Bits	Type	Description
VRSG	0	r	**VRS Short to GND Diagnosis Bit:** 0_B , no short to GND 1_B , short to GND Reset: 0_B

VRSDiag1   **Offset**   **Reset Value**

                                                 023_H 00_H

7	6	5	4	3	2	1	0
VRSDV_ADC	VRSD						
r	r						
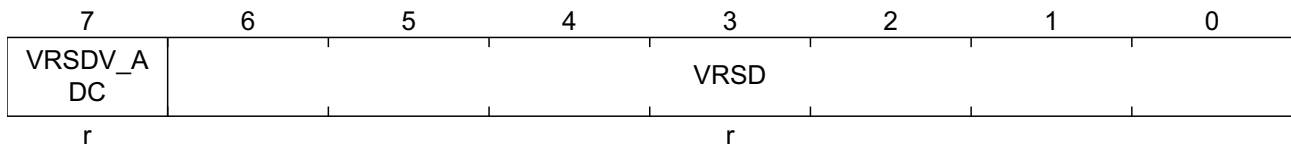
Field	Bits	Type	Description
VRSDV_ADC	7	r	**ADC Measurement Data Valid Bit** 0_B , measurement data not valid 1_B , measurement data valid Reset: 0_B
VRSD	6:0	r	**VRS Diagnosis Measurement Result Register** Reset: 0000000_B

ComDiag   **Offset**   **Reset Value**

                                                 024_H 00_H

7	6	5	4	3	2	1	0
RES		LINOT	CANOT	CANTXTO	CANBDC	COMFE	MSCTO
		r	r	r	r	r	r
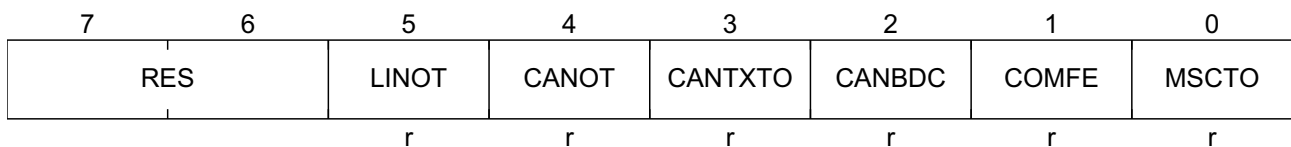
Field	Bits	Type	Description
LINOT	5	r	**LIN Overtemperature Diagnosis Bit:** 0_B , no overtemperature 1_B , overtemperature Reset: 0_B

Field	Bits	Type	Description
CANOT	4	r	**CAN Overtemperature Diagnosis Bit:** 0_B , no overtemperature 1_B , overtemperature Reset: 0_B
CANTXTO	3	r	**CAN TX Dominant Time Out Error Diagnosis Bit:** 0_B , no error 1_B , TX dominant time out error Reset: 0_B
CANBDC	2	r	**CAN Bus Line Dominant Clamp Error Diagnosis Bit:** 0_B , no error 1_B , bus dominant clamp error Reset: 0_B
COMFE	1	r	**Communication Frame Error Diagnosis Bit:** 0_B , no MSC/SPI frame error 1_B , MSC/SPI frame error Reset: 0_B
MSCTO	0	r	**MSC Time Out Failure Diagnosis Bit:** 0_B , no failure 1_B , MSC time out Reset: 0_B

OutDiag0 Offset **Reset Value**

025_H 00_H

7	6	5	4	3	2	1	0
O4DIA		O3DIA		O2DIA		O1DIA	
r		r		r		r	
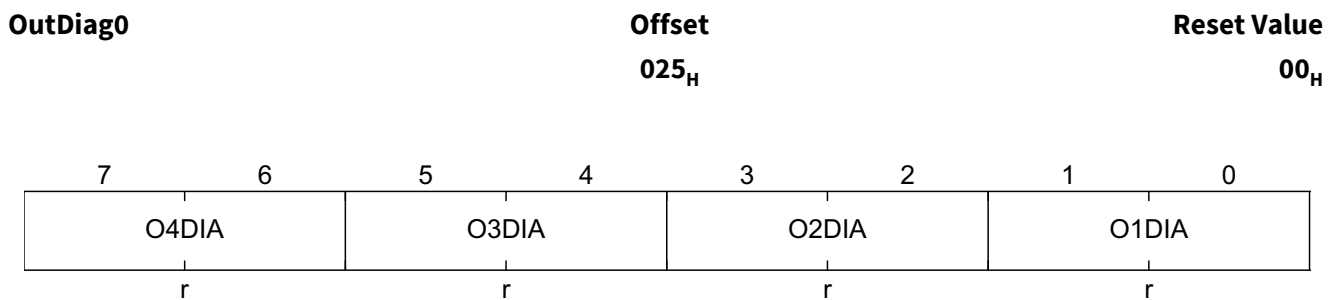
Field	Bits	Type	Description
O4DIA	7:6	r	**Output4 Diagnosis Bits: see below** Reset: 00_B
O3DIA	5:4	r	**Output3 Diagnosis Bits: see below** Reset: 00_B
O2DIA	3:2	r	**Output2 Diagnosis Bits: see below** Reset: 00_B

Field	Bits	Type	Description
O1DIA	1:0	r	**Output1 Diagnosis Bits:** 00_B , no failure 01_B , short circuit to bat (overcurrent) or overtemperature 10_B , open load in off 11_B , short circuit to ground in off Reset: 00_B

OutDiag1   **Offset**   **Reset Value**

                                               026_H   **00_H**

7	6	5	4	3	2	1	0
O8DIA		O7DIA		O6DIA		O5DIA	
r		r		r		r	
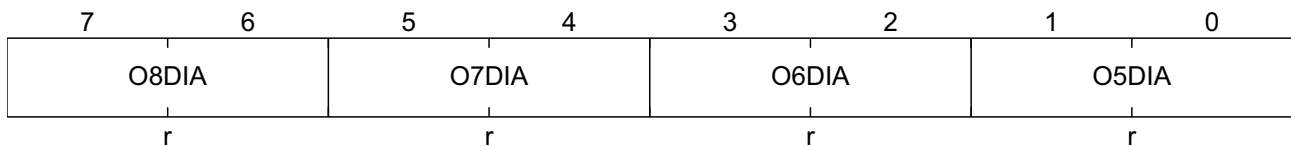
Field	Bits	Type	Description
O8DIA	7:6	r	**Output8 (DFB8) Diagnosis Bit:** 00_B , no failure 01_B , short circuit to bat 10_B , open load in off 11_B , short circuit to ground in off Reset: 00_B
O7DIA	5:4	r	**Output7 Diagnosis Bits: see below** Reset: 00_B
O6DIA	3:2	r	**Output6 Diagnosis Bits: see below** Reset: 00_B
O5DIA	1:0	r	**Output5 Diagnosis Bits:** 00_B , no failure 01_B , short circuit to bat (overcurrent) or overtemperature 10_B , open load in off 11_B , short circuit to ground in off Reset: 00_B

OutDiag2   **Offset**   **Reset Value**

                                               027_H   **00_H**

7	6	5	4	3	2	1	0
O12DIA		O11DIA		O10DIA		O9DIA	
r		r		r		r	
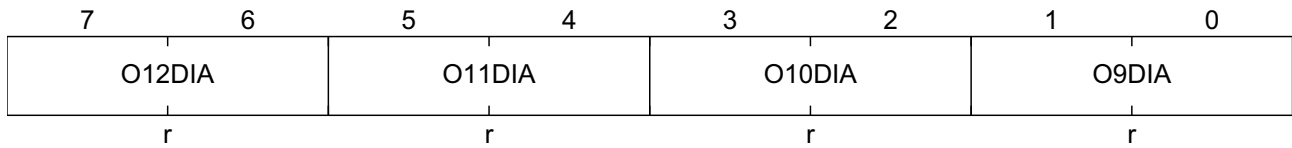
Field	Bits	Type	Description
O12DIA	7:6	r	**Output12 (DFB12) Diagnosis Bit: see below** Reset: 00_B
O11DIA	5:4	r	**Output11 (DFB11) Diagnosis Bit: see below** Reset: 00_B
O10DIA	3:2	r	**Output10 (DFB10) Diagnosis Bit: see below** Reset: 00_B
O9DIA	1:0	r	**Output9 (DFB9) Diagnosis Bit:** 00_B , no failure 01_B , short circuit to bat 10_B , open load in off 11_B , short circuit to ground in off Reset: 00_B

OutDiag3   **Offset**   **Reset Value**
                                        028_H   **00_H**

7	6	5	4	3	2	1	0
O16DIA		O15DIA		O14DIA		O13DIA	
r		r		r		r	
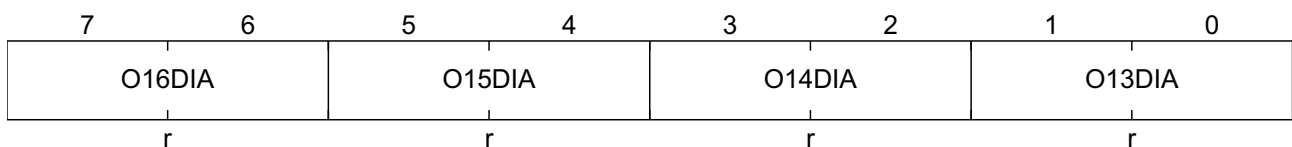
Field	Bits	Type	Description
O16DIA	7:6	r	**Output16 Diagnosis Bit: see below** Reset: 00_B
O15DIA	5:4	r	**Output15 Diagnosis Bit: see below** Reset: 00_B
O14DIA	3:2	r	**Output14 Diagnosis Bit:** 00_B , no failure 01_B , short circuit to bat (overcurrent) or overtemperature 10_B , open load in off 11_B , short circuit to ground in off Reset: 00_B

Field	Bits	Type	Description
O13DIA	1:0	r	**Output13 (DFB13) Diagnosis Bit:** 00_B , no failure 01_B , short circuit to bat 10_B , open load in off 11_B , short circuit to ground in off Reset: 00_B

OutDiag4 Offset **029_H** Reset Value **00_H**

7	6	5	4	3	2	1	0
O20DIA		O19DIA		O18DIA		O17DIA	
r		r		r		r	
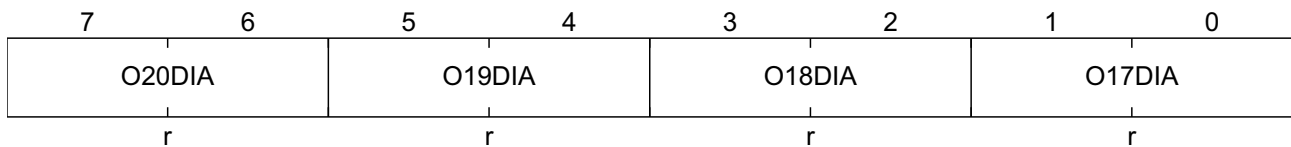
Field	Bits	Type	Description
O20DIA	7:6	r	**Output20 Diagnosis Bits: see below** Reset: 00_B
O19DIA	5:4	r	**Output19 Diagnosis Bits: see below** Reset: 00_B
O18DIA	3:2	r	**Output18 Diagnosis Bits: see below** Reset: 00_B
O17DIA	1:0	r	**Output17 Diagnosis Bits:** 00_B , no failure 01_B , short circuit to bat (overcurrent) or overtemperature 10_B , open load in off 11_B , short circuit to ground in off Reset: 00_B

PPOVDiag Offset **$02A_H$** Reset Value **00_H**

7	6	5	4	3	2	1	0
RES		O13OV	O12OV	O11OV	O10OV	O9OV	O8OV
		r	r	r	r	r	r
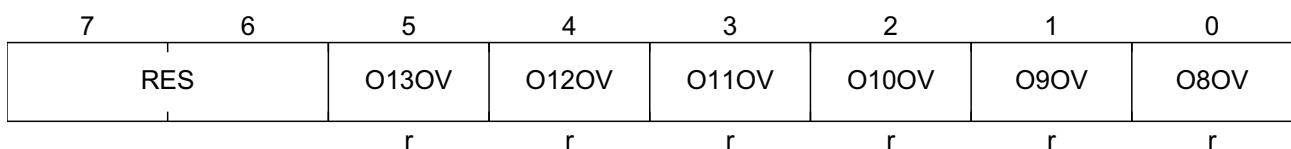
Field	Bits	Type	Description
O13OV	5	r	**Output13 Overvoltage Diagnosis Bit:** 0_B , no overvoltage 1_B , overvoltage Reset: 0_B
O12OV	4	r	**Output12 Overvoltage Diagnosis Bit:** 0_B , no overvoltage 1_B , overvoltage Reset: 0_B
O11OV	3	r	**Output11 Overvoltage Diagnosis Bit:** 0_B , no overvoltage 1_B , overvoltage Reset: 0_B
O10OV	2	r	**Output10 Overvoltage Diagnosis Bit:** 0_B , no overvoltage 1_B , overvoltage Reset: 0_B
O9OV	1	r	**Output9 Overvoltage Diagnosis Bit:** 0_B , no overvoltage 1_B , overvoltage Reset: 0_B
O8OV	0	r	**Output8 Overvoltage Diagnosis Bit:** 0_B , no overvoltage 1_B , overvoltage Reset: 0_B

BriDiag0 **Offset** **Reset Value**

$02B_H$ 00_H

7	6	5	4	3	2	1	0
O24DIA		O23DIA		O22DIA		O21DIA	
r		r		r		r	
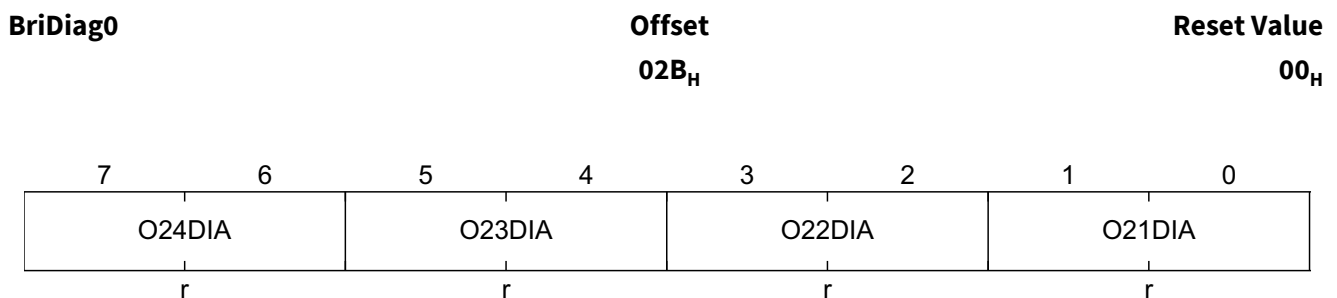
Field	Bits	Type	Description
O24DIA	7:6	r	**Output24 Diagnosis Bits (in off)** Reset: 00_B
O23DIA	5:4	r	**Output23 Diagnosis Bits (in off)** Reset: 00_B

Field	Bits	Type	Description
O22DIA	3:2	r	**Output22 Diagnosis Bits (in off)** Reset: 00_B
O21DIA	1:0	r	**Output21 Diagnosis Bits (in off)** Reset: 00_B

BriDiag1		Offset		Reset Value
		$02C_H$		00_H

7	6	5	4	3	2	1	0
RES		B2OT	B1OT	O24OC	O23OC	O22OC	O21OC
		r	r	r	r	r	r
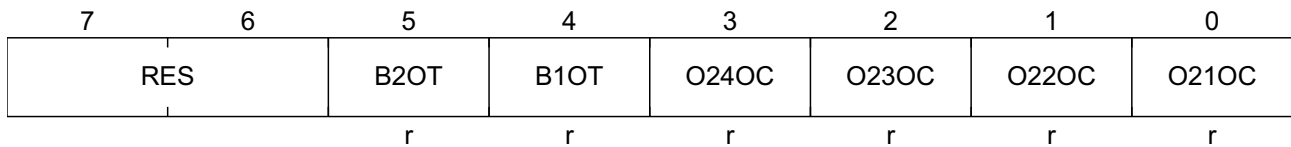
Field	Bits	Type	Description
B2OT	5	r	**Output23,24 Overtemperature Diagnosis Bit** 0_B , no overtemperature 1_B , overtemperature Reset: 0_B
B1OT	4	r	**Output21,22 Overtemperature Diagnosis Bit** 0_B , no overtemperature 1_B , overtemperature Reset: 0_B
O24OC	3	r	**Output24 Overcurrent Diagnosis Bit** 0_B , no overcurrent 1_B , overcurrent Reset: 0_B
O23OC	2	r	**Output23 Overcurrent Diagnosis Bit** 0_B , no overcurrent 1_B , overcurrent Reset: 0_B
O22OC	1	r	**Output22 Overcurrent Diagnosis Bit** 0_B , no overcurrent 1_B , overcurrent Reset: 0_B
O21OC	0	r	**Output21 Overcurrent Diagnosis Bit** 0_B , no overcurrent 1_B , overcurrent Reset: 0_B

IgnDiag **Offset** **Reset Value**

02D$_H$ **00**$_H$

7	6	5	4	3	2	1	0
IGN4DIA		IGN3DIA		IGN2DIA		IGN1DIA	
r		r		r		r	
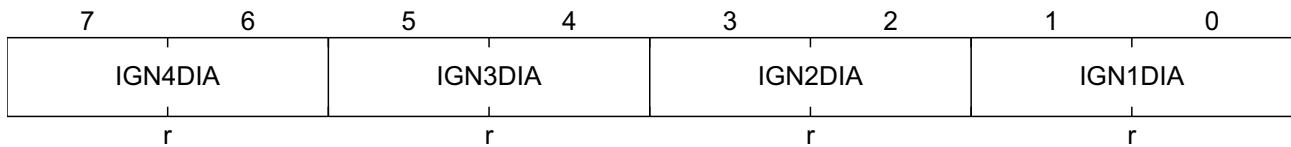
Field	Bits	Type	Description
IGN4DIA	7:6	r	**Ignition 4 Output Diagnosis Bits: see below** Reset: 00_B
IGN3DIA	5:4	r	**Ignition 3 Output Diagnosis Bits: see below** Reset: 00_B
IGN2DIA	3:2	r	**Ignition 2 Output Diagnosis Bits: see below** Reset: 00_B
IGN1DIA	1:0	r	**Ignition 1 Output Diagnosis Bits:** 00_B , no failure 01_B , short circuit to bat or overtemperature 10_B , open load 11_B , short circuit to ground in on Reset: 00_B

WdDiag **Offset** **Reset Value**

02E$_H$ **00**$_H$

7	6	5	4	3	2	1	0
RES	TECRES	FWDRES	WWDRES	FWDREA	FWDREL	WWDSCE	WWDTO
	r	r	r	r	r	r	r
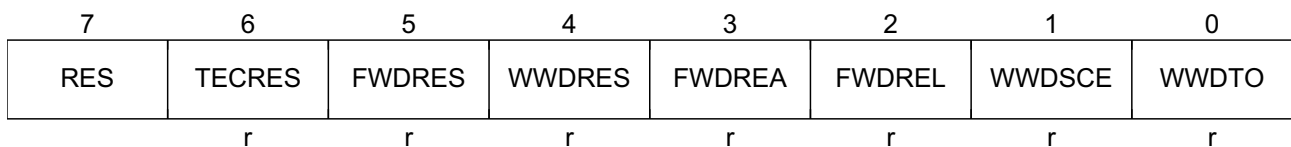
Field	Bits	Type	Description
TECRES	6	r	**Reset caused by TEC:** 0_B , no reset (caused by TEC) happened 1_B , reset (caused by TEC) happened Reset: 0_B

Field	Bits	Type	Description
FWDRES	5	r	**Reset caused by Functional Watchdog:** 0_B , no functional watchdog reset happened 1_B , functional watchdog reset happened Reset: 0_B
WWDRES	4	r	**Reset caused by Window Watchdog:** 0_B , no window watchdog reset happened 1_B , window watchdog reset happened Reset: 0_B
FWDREA	3	r	**Functional Watchdog Response Error of Actual Running Sequence Diagnosis Bit:** 0_B , no error 1_B , error Reset: 0_B
FWDREL	2	r	**Functional Watchdog Response Error of Last Sequence Diagnosis Bit:** 0_B , no error 1_B , error Reset: 0_B
WWDSCE	1	r	**Window Watchdog Service Command too Early Diagnosis Bit:** 0_B , service command in time 1_B , service command too early Reset: 0_B
WWDTO	0	r	**Window Watchdog Time Out Diagnosis Bit:** 0_B , no time out 1_B , time out Reset: 0_B

14.1.3 Status Register

EOTStat0	Offset	Reset Value
	031_H	00_H

7	6	5	4	3	2	1	0
			EOTC0				
			r				
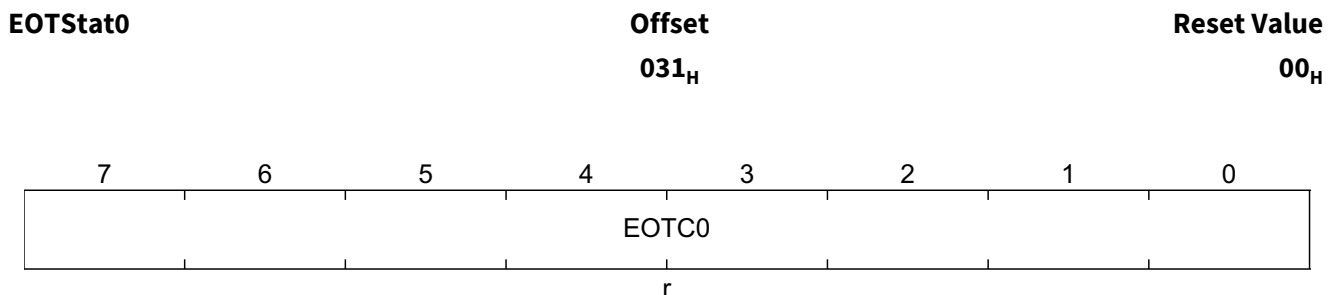
Field	Bits	Type	Description
EOTC0	7:0	r	**Engine Off Timer Counter Value Bits: (Bit 7 - 0)** Reset: 00_H

EOTStat1 　　　　　　　　　　　　　**Offset** 　　　　　　　　　　　　　**Reset Value**

　　　　　　　　　　　　　　　　　　　032_H 　　　　　　　　　　　　　　　　**00_H**

7	6	5	4	3	2	1	0
			EOTC1				

r
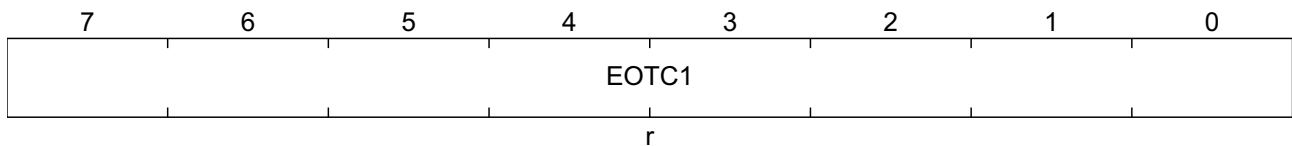
Field	Bits	Type	Description
EOTC1	7:0	r	**Engine Off Timer Counter Value Bits: (Bit 15 - 8)** Reset: 00_H

EOTStat2 　　　　　　　　　　　　　**Offset** 　　　　　　　　　　　　　**Reset Value**

　　　　　　　　　　　　　　　　　　　033_H 　　　　　　　　　　　　　　　　**00_H**

7	6	5	4	3	2	1	0
			EOTC2				

r
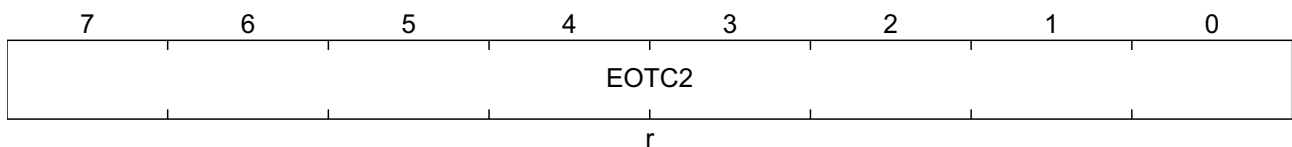
Field	Bits	Type	Description
EOTC2	7:0	r	**Engine Off Timer Counter Value Bits: (Bit 23 - 16)** Reset: 00_H

OpStat0 　　　　　　　　　　　　　**Offset** 　　　　　　　　　　　　　**Reset Value**

　　　　　　　　　　　　　　　　　　　034_H 　　　　　　　　　　　　　　　　**00_H**

7	6	5	4	3	2	1	0
EOTWK	CANWK	WKINT	MON	MR	OM	WK	KEY
r	r	r	r	r	r	r	r

Field	Bits	Type	Description
EOTWK	7	r	**Status of internal EOTWK signal:** 0_B, EOTWK is inactive 1_B, EOTWK is active Reset: 0_B
CANWK	6	r	**Status of internal CANWK signal:** 0_B, CANWK is inactive 1_B, CANWK is active Reset: 0_B
WKINT	5	r	**Status of internal WKINT signal:** 0_B, WKINT is inactive 1_B, WKINT is active Reset: 0_B
MON	4	r	**MON Pin Status Bit:** 0_B, active (low) 1_B, inactive (high) Reset: 0_B
MR	3	r	**Main Relay Switch On Status Bit:** 0_B, off 1_B, on Reset: 0_B
OM	2	r	**Operation Mode Bit:** 0_B, normal operation 1_B, afterrun mode Reset: 0_B
WK	1	r	**WK Status Bit (filtered):** 0_B, WK = 0 1_B, WK = 1 Reset: 0_B
KEY	0	r	**KEY Status Bit (filtered):** 0_B, KEY = 0 1_B, KEY = 1 Reset: 0_B

OpStat1 **Offset** **Reset Value**

035_H 00_H

7	6	5	4	3	2	1	0
LOCK	OE	EOTRES	RSTR	V5VOVR	V5VUVR	WDRES	ARES
r	r	r	r	r	r	r	r

Field	Bits	Type	Description
LOCK	7	r	**Configuration Lock Status Bit:** 0_B , Configuration registers unlocked 1_B , Configuration registers locked Reset: 0_B
OE	6	r	**Global Output Enable Status Bit:** 0_B , outputs disabled and control register are reset 1_B , outputs enabled Reset: 0_B
EOTRES	5	r	**Engine Off Timer Reset Status Bit:** 0_B , no EOT reset happened 1_B , EOT reset happened Reset: 0_B
RSTR	4	r	**Reset caused by external RST Reset: (only valid if no internal power on reset occurs)** 0_B , no external RST reset happened 1_B , external RST reset happened Reset: 0_B
V5VOVR	3	r	**Reset caused by V5V Overvoltage Reset: (only valid if no internal power on reset occurs)** 0_B , no V5V overvoltage reset happened 1_B , V5V overvoltage reset happened Reset: 0_B
V5VUVR	2	r	**Reset caused by V5V Undervoltage Reset: (only valid if no internal power on reset occurs)** 0_B , no V5V undervoltage reset happened 1_B , V5V undervoltage reset happened Reset: 0_B
WDRES	1	r	**Reset caused by Watchdog Reset: (only valid if no internal power on reset occurs)** 0_B , no watchdog reset happened 1_B , watchdog reset happened Reset: 0_B
ARES	0	r	**Reset caused by Afterrun Reset: (only valid if no internal power on reset occurs)** 0_B , no afterrun reset happened 1_B , afterrun reset happened Reset: 0_B

WWDStat   **Offset**   **Reset Value**

                                          036$_H$ **30**$_H$

7	6	5	4	3	2	1	0
RES		WWDEC					
				r			
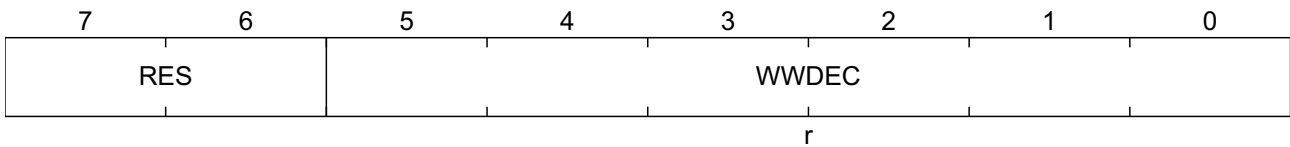
Field	Bits	Type	Description
WWDEC	5:0	r	**Window Watchdog Error Counter Value** Reset: 110000$_B$

FWDStat0   **Offset**   **Reset Value**

                                          037$_H$ **30**$_H$

7	6	5	4	3	2	1	0
RES		FWDPC					
				r			

Field	Bits	Type	Description
FWDPC	5:0	r	**Functional Watchdog Pass Counter Value** Reset: 110000$_B$

FWDStat1   **Offset**   **Reset Value**

                                          038$_H$ **30**$_H$

7	6	5	4	3	2	1	0
RES		FWDRESPC		FWDQUEST			
		r		r			
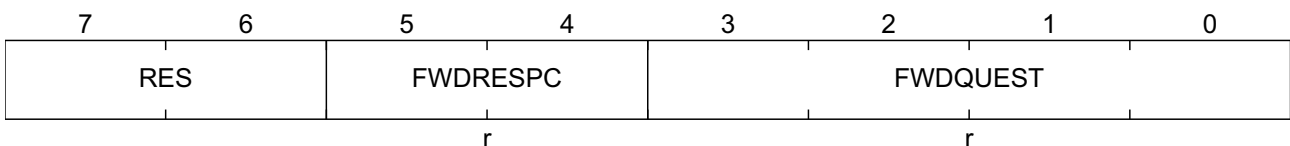
Field	Bits	Type	Description
FWDRESPC	5:4	r	**Functional Watchdog Response Counter Value** Reset: 11_B
FWDQUEST	3:0	r	**Functional Watchdog Question** Reset: 0000_B

TECStat Offset Reset Value

039_H 30_H

7	6	5	4	3	2	1	0
\multicolumn{2}{	c	}{RES}	\multicolumn{6}{c	}{TEC}

7	6	5	4	3	2	1	0
RES		TEC					
		r					
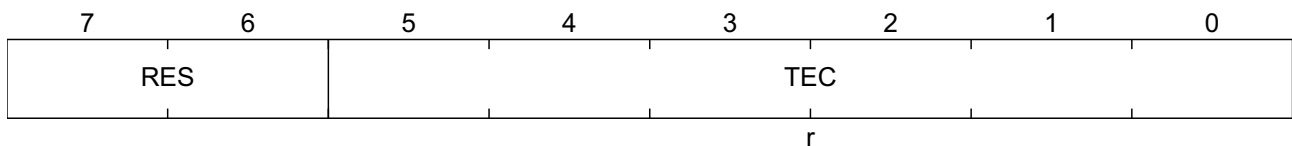
Field	Bits	Type	Description
TEC	5:0	r	**Total Error Counter Value** Reset: 110000_B

WdStat0 Offset Reset Value

$03A_H$ 00_H

7	6	5	4	3	2	1	0
WWDSCR	SSOTS	WWDPDC			RESC		
r	r	r			r		
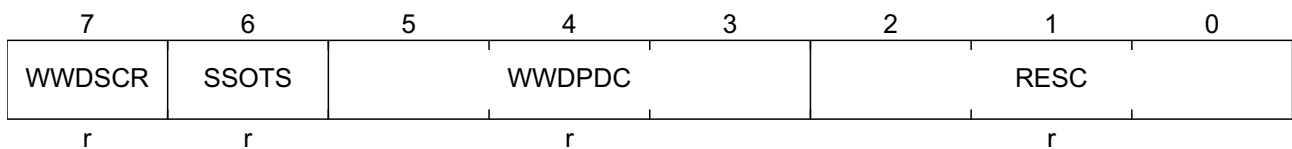
Field	Bits	Type	Description
WWDSCR	7	r	**Window Watchdog Service Command received** 0_B , No Service Command received 1_B , Service Command received Reset: 0_B
SSOTS	6	r	**Secure Shut Off Timer Start Status Bit:** 0_B , timer reset 1_B , timer started Reset: 0_B

Field	Bits	Type	Description
WWDPDC	5:3	r	**Window Watchdog Power-Down Counter Value** Reset: 000$_B$
RESC	2:0	r	**Reset Counter Value** Reset: 000$_B$

WdStat1 **Offset** **Reset Value**

03B$_H$ **00$_H$**

7	6	5	4	3	2	1	0
RES		TECPDC			FWDPDC		
		r			r		
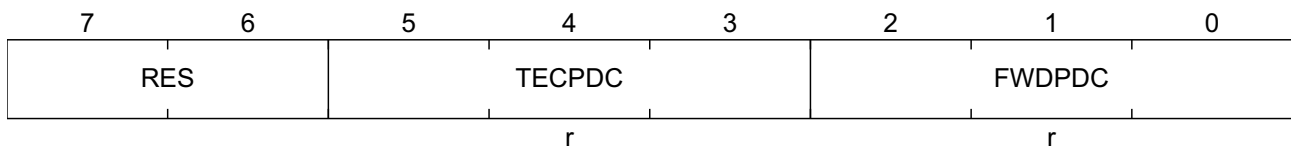
Field	Bits	Type	Description
TECPDC	5:3	r	**Total Error Power-Down Counter Value** Reset: 000$_B$
FWDPDC	2:0	r	**Functional Watchdog Power-Down Counter Value** Reset: 000$_B$

WDHBT0 **Offset** **Reset Value**

03C$_H$ **00$_H$**

7	6	5	4	3	2	1	0
RES				WDHBTPRE			
				r			
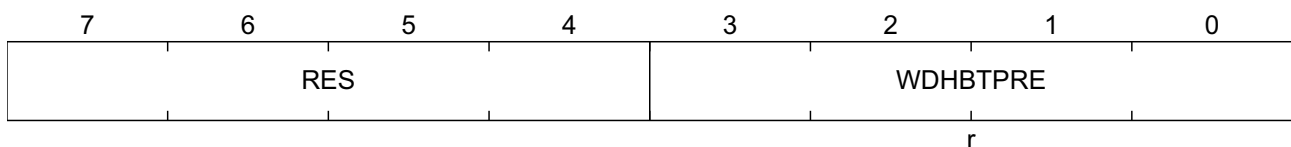
Field	Bits	Type	Description
WDHBTPRE	3:0	r	**Sampled Watchdog Heartbeat Timer Predivider Value** Reset: 0000$_B$

WDHBT1   **Offset**   **Reset Value**

03D$_H$ 00$_H$

7	6	5	4	3	2	1	0
RES	WDHBT						
	r						
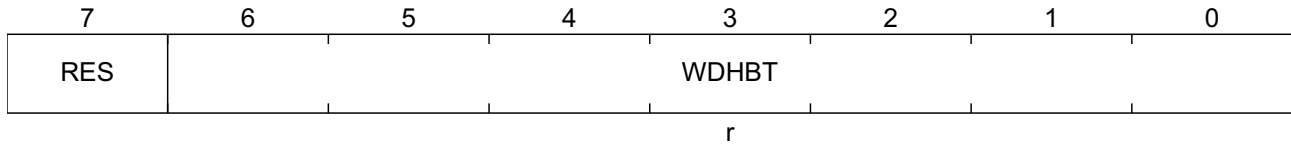
Field	Bits	Type	Description
WDHBT	6:0	r	**Sampled Watchdog Heartbeat Timer Value** Reset: 0000000$_B$

14.1.4   Configuration Register

OutConfig0 locked with LOCK = 1

OutConfig0   **Offset**   **Reset Value**

040$_H$ FF$_H$

7	6	5	4	3	2	1	0
O4OL	O4OC	O3OL	O3OC	O2OL	O2OC	O1OL	O1OC
rw	rw	rw	rw	rw	rw	rw	rw
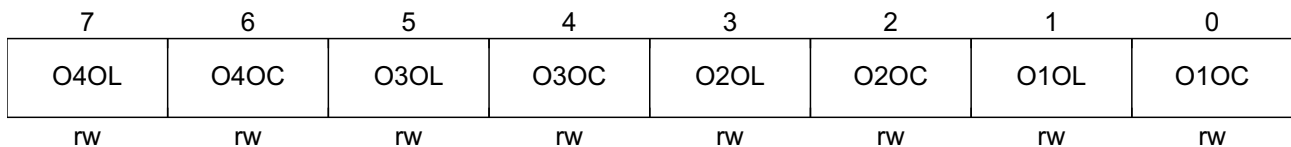
Field	Bits	Type	Description
O4OL	7	rw	**Output4 Open Load Set Up:** 0$_B$, pull down current deactivated 1$_B$, fully functional Reset: 1$_B$
O4OC	6	rw	**Output4 Overcurrent Protection Set Up:** 0$_B$, current limitation in case of overcurrent 1$_B$, switch off in case of overcurrent Reset: 1$_B$
O3OL	5	rw	**Output3 Open Load Set Up:** 0$_B$, pull down current deactivated 1$_B$, fully functional Reset: 1$_B$

Field	Bits	Type	Description
O3OC	4	rw	**Output3 Overcurrent Protection Set Up:** 0_B , current limitation in case of overcurrent 1_B , switch off in case of overcurrent Reset: 1_B
O2OL	3	rw	**Output2 Open Load Set Up:** 0_B , pull down current deactivated 1_B , fully functional Reset: 1_B
O2OC	2	rw	**Output2 Overcurrent Protection Set Up:** 0_B , current limitation in case of overcurrent 1_B , switch off in case of overcurrent Reset: 1_B
O1OL	1	rw	**Output1 Open Load Set Up:** 0_B , pull down current deactivated 1_B , fully functional Reset: 1_B
O1OC	0	rw	**Output1 Overcurrent Protection Set Up:** 0_B , current limitation in case of overcurrent 1_B , switch off in case of overcurrent Reset: 1_B

OutConfig1 locked with LOCK = 1

OutConfig1 **Offset** **Reset Value**

041_H $3F_H$

7	6	5	4	3	2	1	0
RES		O7OL	O7OC	O6OL	O6OC	O5OL	O5OC
		rw	rw	rw	rw	rw	rw

Field	Bits	Type	Description
O7OL	5	rw	**Output7 Open Load Set Up:** 0_B , pull down current deactivated 1_B , fully functional Reset: 1_B
O7OC	4	rw	**Output7 Overcurrent Protection Set Up:** 0_B , current limitation in case of overcurrent 1_B , switch off in case of overcurrent Reset: 1_B

Field	Bits	Type	Description
O6OL	3	rw	**Output6 Open Load Set Up:** 0_B , pull down current deactivated 1_B , fully functional Reset: 1_B
O6OC	2	rw	**Output6 Overcurrent Protection Set Up:** 0_B , current limitation in case of overcurrent 1_B , switch off in case of overcurrent Reset: 1_B
O5OL	1	rw	**Output5 Open Load Set Up:** 0_B , pull down current deactivated 1_B , fully functional Reset: 1_B
O5OC	0	rw	**Output5 Overcurrent Protection Set Up:** 0_B , current limitation in case of overcurrent 1_B , switch off in case of overcurrent Reset: 1_B

OutConfig2 locked with LOCK = 1

OutConfig2		**Offset** 042_H					**Reset Value** $3F_H$

7	6	5	4	3	2	1	0
PP0D		O13OL	O12OL	O11OL	O10OL	O9OL	O8OL
rw		rw	rw	rw	rw	rw	rw

Field	Bits	Type	Description
PP0D	7:6	rw	**Diagnosis in On Set Up for OUT8 and OUT9:** 00_B , typ. 125 mV short to bat in on threshold 01_B , typ. 225 mV short to bat in on threshold 10_B , typ. 400 mV short to bat in on threshold 11_B , typ. 0.8 V short to bat in on threshold Reset: 00_B
O13OL	5	rw	**Output13 Open Load Set Up:** 0_B , pull down current deactivated 1_B , fully functional Reset: 1_B
O12OL	4	rw	**Output12 Open Load Set Up:** 0_B , pull down current deactivated 1_B , fully functional Reset: 1_B

Field	Bits	Type	Description
O11OL	3	rw	**Output11 Open Load Set Up:** 0_B , pull down current deactivated 1_B , fully functional Reset: 1_B
O10OL	2	rw	**Output10 Open Load Set Up:** 0_B , pull down current deactivated 1_B , fully functional Reset: 1_B
O9OL	1	rw	**Output9 Open Load Set Up:** 0_B , pull down current deactivated 1_B , fully functional Reset: 1_B
O8OL	0	rw	**Output8 Open Load Set Up:** 0_B , pull down current deactivated 1_B , fully functional Reset: 1_B

OutConfig3 locked with LOCK = 1

OutConfig3   **Offset**   **Reset Value**

                                       043_H 30_H

7	6	5	4	3	2	1	0
RES		O14OL	O14OC	PP2D		PP1D	
		rw	rw	rw		rw	

Field	Bits	Type	Description
O14OL	5	rw	**Output14 Open Load Set Up:** 0_B , pull down current deactivated 1_B , fully functional Reset: 1_B
O14OC	4	rw	**Output14 Overcurrent Protection Set Up:** 0_B , current limitation in case of overcurrent 1_B , switch off in case of overcurrent Reset: 1_B
PP2D	3:2	rw	**Diagnosis in On Set Up for OUT12 and OUT13:** 00_B , typ. 125 mV short to bat in on threshold 01_B , typ. 225 mV short to bat in on threshold 10_B , typ. 400 mV short to bat in on threshold 11_B , typ. 0.8 V short to bat in on threshold Reset: 00_B

Field	Bits	Type	Description
PP1D	1:0	rw	**Diagnosis in On Set Up for OUT10 and OUT11:** 00_B , typ. 125 mV short to bat in on threshold 01_B , typ. 225 mV short to bat in on threshold 10_B , typ. 400 mV short to bat in on threshold 11_B , typ. 0.8 V short to bat in on threshold Reset: 00_B

OutConfig4 locked with LOCK = 1

OutConfig4   **Offset**   **Reset Value**

044_H $3F_H$

7	6	5	4	3	2	1	0
RES	O17D	O17OL	O17OC	O16OL	O16OC	O15OL	O15OC
	rw	rw	rw	rw	rw	rw	rw

Field	Bits	Type	Description
O17D	6	rw	**Output17 Delayed Off Set Up:** 0_B , no delayed off function 1_B , delayed off function activated Reset: 0_B
O17OL	5	rw	**Output17 Open Load Set Up:** 0_B , pull down current deactivated 1_B , fully functional Reset: 1_B
O17OC	4	rw	**Output17 Overcurrent Protection Set Up:** 0_B , current limitation in case of overcurrent 1_B , switch off in case of overcurrent Reset: 1_B
O16OL	3	rw	**Output16 Open Load Set Up:** 0_B , pull down current deactivated 1_B , fully functional Reset: 1_B
O16OC	2	rw	**Output16 Overcurrent Protection Set Up:** 0_B , current limitation in case of overcurrent 1_B , switch off in case of overcurrent Reset: 1_B
O15OL	1	rw	**Output15 Open Load Set Up:** 0_B , pull down current deactivated 1_B , fully functional Reset: 1_B

Field	Bits	Type	Description
O15OC	0	rw	**Output15 Overcurrent Protection Set Up:** 0_B , current limitation in case of overcurrent 1_B , switch off in case of overcurrent Reset: 1_B

OutConfig5 locked with LOCK = 1

OutConfig5 **Offset** **Reset Value**

045$_H$ **3F$_H$**

7	6	5	4	3	2	1	0
RES		O20OL	O20OC	O19OL	O19OC	O18OL	O18OC
		rw	rw	rw	rw	rw	rw
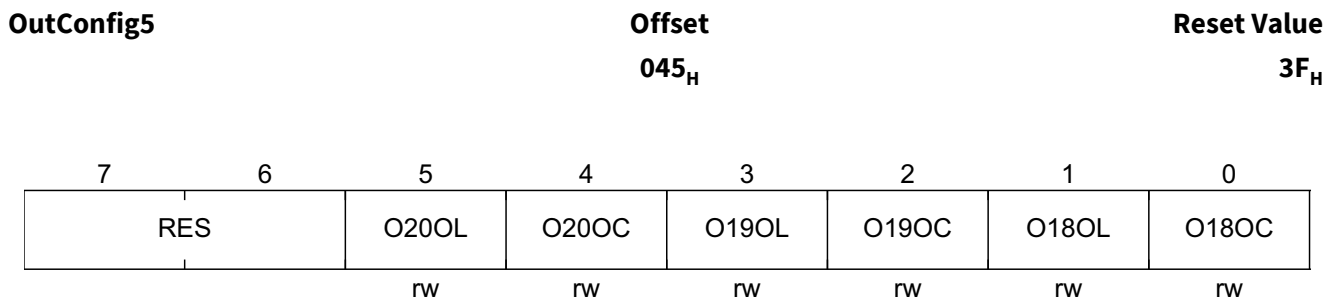
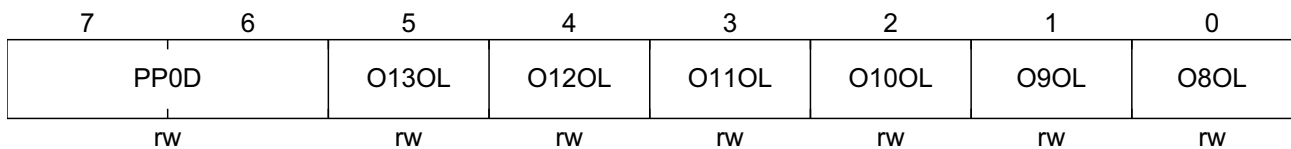| Field	Bits	Type	Description
O20OL	5	rw	**Output20 Open Load Set Up:** 0_B , pull down and pull up current deactivated 1_B , fully functional Reset: 1_B
O20OC	4	rw	**Output20 Overcurrent Protection Set Up:** 0_B , current limitation in case of overcurrent 1_B , switch off in case of overcurrent Reset: 1_B
O19OL	3	rw	**Output19 Open Load Set Up:** 0_B , pull down and pull up current deactivated 1_B , fully functional Reset: 1_B
O19OC	2	rw	**Output19 Overcurrent Protection Set Up:** 0_B , current limitation in case of overcurrent 1_B , switch off in case of overcurrent Reset: 1_B
O18OL	1	rw	**Output18 Open Load Set Up:** 0_B , pull down and pull up current deactivated 1_B , fully functional Reset: 1_B
O18OC	0	rw	**Output18 Overcurrent Protection Set Up:** 0_B , current limitation in case of overcurrent 1_B , switch off in case of overcurrent Reset: 1_B

BriConfig0 locked with LOCK = 1

BriConfig0	Offset	Reset Value
	046_H	00_H

7	6	5	4	3	2	1	0
O24F	O24M	O23F	O23M	O22F	O22M	O21F	O21M
rw	rw	rw	rw	rw	rw	rw	rw

Field	Bits	Type	Description
O24F	7	rw	**Output24 Freewheeling Mode Set Up:** 0_B , passive freewheeling mode 1_B , active freewheeling mode Reset: 0_B
O24M	6	rw	**Output24 Mode Set Up:** 0_B , low-side switch mode 1_B , high-side switch mode Reset: 0_B
O23F	5	rw	**Output23 Freewheeling Mode Set Up:** 0_B , passive freewheeling mode 1_B , active freewheeling mode Reset: 0_B
O23M	4	rw	**Output23 Mode Set Up:** 0_B , low-side switch mode 1_B , high-side switch mode Reset: 0_B
O22F	3	rw	**Output22 Freewheeling Mode Set Up:** 0_B , passive freewheeling mode 1_B , active freewheeling mode Reset: 0_B
O22M	2	rw	**Output22 Mode Set Up:** 0_B , low-side switch mode 1_B , high-side switch mode Reset: 0_B
O21F	1	rw	**Output21 Freewheeling Mode Set Up:** 0_B , passive freewheeling mode 1_B , active freewheeling mode Reset: 0_B
O21M	0	rw	**Output21 Mode Set Up:** 0_B , low-side switch mode 1_B , high-side switch mode Reset: 0_B

BriConfig1 locked with LOCK = 1

BriConfig1   **Offset**   **Reset Value**
                                             047$_H$ **00**$_H$

7	6	5	4	3	2	1	0
		RES			FB2E	FB1E	O21D
					rw	rw	rw
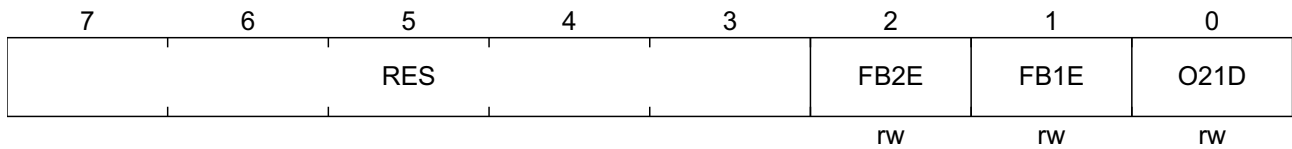
Field	Bits	Type	Description
FB2E	2	rw	**Full Bridge 2 Enable Bit:** 0_B , Output 23 and 24 are not used in full bridge configuration 1_B , Output 23 and 24 are used in full bridge configuration Reset: 0_B
FB1E	1	rw	**Full Bridge 1 Enable Bit:** 0_B , Output 21 and 22 are not used in full bridge configuration 1_B , Output 21 and 22 are used in full bridge configuration Reset: 0_B
O21D	0	rw	**Output21 Delayed Off Set Up:** 0_B , no delayed off function 1_B , delayed off function activated Reset: 0_B

IGNConfig locked with LOCK = 1

IGNConfig   **Offset**   **Reset Value**
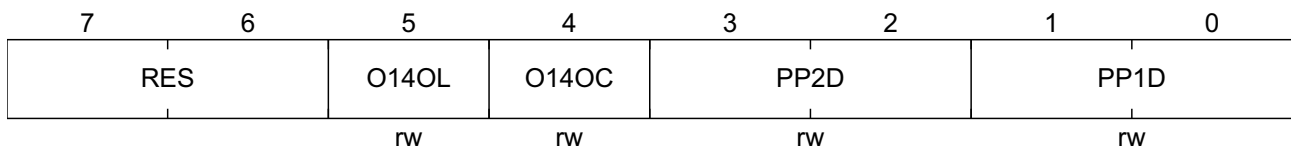   **048**$_H$ **00**$_H$

7	6	5	4	3	2	1	0
	RES		IOLT		IOLI		IOLA
			rw		rw		rw
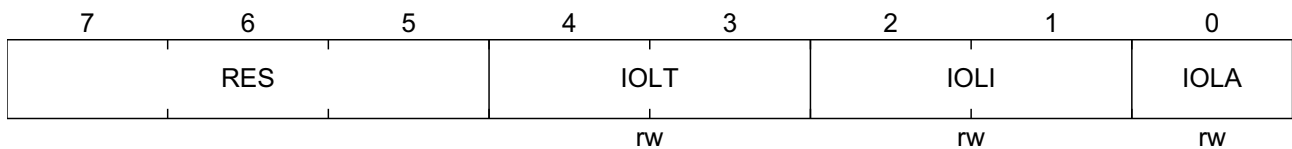
Field	Bits	Type	Description
IOLT	4:3	rw	**Ignition Time Setting for Open Load Detection:** 00_B , 64 µs 01_B , 256 µs 10_B , 512 µs 11_B , 768 µs Reset: 00_B
IOLI	2:1	rw	**Ignition Current Setting for Open Load Detection:** 00_B , -100 µA 01_B , -400 µA 10_B , -1 mA 11_B , -4 mA Reset: 00_B
IOLA	0	rw	**Ignition Open Load Detection Activation:** 0_B , no open load detection 1_B , open load detection active Reset: 0_B

VRSConfig0 **Offset** **Reset Value**

049$_H$ **00$_H$**

7	6	5	4	3	2	1	0
VRSPV		RES			VRSF		VRSPT
rw					rw		rw
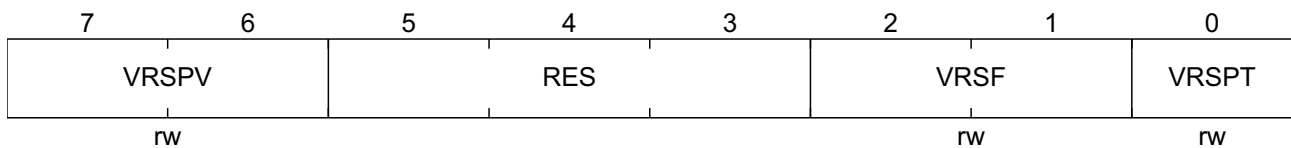
Field	Bits	Type	Description
VRSPV	7:6	rw	**VRS Peak Voltage Detection Set Up:** 00_B , 50 mV 01_B , 150 mV 10_B , 350 mV 11_B , 550 mV Reset: 00_B
VRSF	2:1	rw	**VRS Output Filter Time Set Up:** 00_B , 1 µs, reset value 01_B , 5 µs 10_B , 10 µs 11_B , 20 µs Reset: 00_B

Field	Bits	Type	Description
VRSPT	0	rw	**VRS Peak Time Set Up:** 0_B , 10 µs, reset value 1_B , 250 µs Reset: 0_B

VRSConfig1 locked with LOCK = 1

VRSConfig1   **Offset**   **Reset Value**

                                                  04A$_H$ **00$_H$**

7	6	5	4	3	2	1	0
		VRSI_SC			VRSM		VRSDIAGM
		rw			rw		rw

Field	Bits	Type	Description
VRSI_SC	7:4	rw	**Current setting for short to GND/Bat measurement** 0000_B, 10 µA 0001_B, 20 µA 0010_B, 30 µA 0011_B, 40 µA 0100_B, 50 µA 0101_B, 60 µA 0110_B, 70 µA 0111_B, 80 µA 1000_B, 100 µA 1001_B, 120 µA 1010_B, 140 µA 1011_B, 160 µA 1100_B, to full scale (0b1111) 160 µA Reset: 0000_B
VRSM	3:2	rw	**VRS/Hall Sensor Mode Set Up:** 00_B , auto detection mode for VR sensor signals (reset value) 01_B , semi auto detection mode for VR sensor signals 10_B , manuel detection mode for VR sensor signals 11_B , Hall sensor mode Reset: 00_B
VRSDIAGM	1:0	rw	**VRS Diagnosis Mode Set Up:** 00_B , normal detection mode 01_B , short to GND/Bat diagnosis mode 10_B , open load diagnosis mode 11_B , ADC diagnosis mode Reset: 00_B

VRSConfig2 locked with LOCK = 1

VRSConfig2   **Offset**   **Reset Value**
                                                  04B$_H$ **00**$_H$

7	6	5	4	3	2	1	0
VRSI_ADC				VRSI_OL			
rw				rw			

Field	Bits	Type	Description
VRSI_ADC	7:4	rw	**Current setting for ADC measurement** 0000$_B$, 10 µA 0001$_B$, 20 µA 0010$_B$, 30 µA 0011$_B$, 40 µA 0100$_B$, 50 µA 0101$_B$, 60 µA 0110$_B$, 70 µA 0111$_B$, 80 µA 1000$_B$, 100 µA 1001$_B$, 120 µA 1010$_B$, 140 µA 1011$_B$, 160 µA 1100$_B$, to full scale (0b1111) 160 µA Reset: 0000$_B$
VRSI_OL	3:0	rw	**Current setting for open load measurement** 0000$_B$, 10 µA 0001$_B$, 20 µA 0010$_B$, 30 µA 0011$_B$, 40 µA 0100$_B$, 50 µA 0101$_B$, 60 µA 0110$_B$, 70 µA 0111$_B$, 80 µA 1000$_B$, 100 µA 1001$_B$, 120 µA 1010$_B$, 140 µA 1011$_B$, 160 µA 1100$_B$, to full scale (0b1111) 160 µA Reset: 0000$_B$

OpConfig0 locked with LOCK = 1

OpConfig0   **Offset**   **Reset Value**

                                                        04E$_H$ 09$_H$

7	6	5	4	3	2	1	0
RES	KOD		EOTCONF	AR	AE	PDT	
	rw		rw	rw	rw	rw	
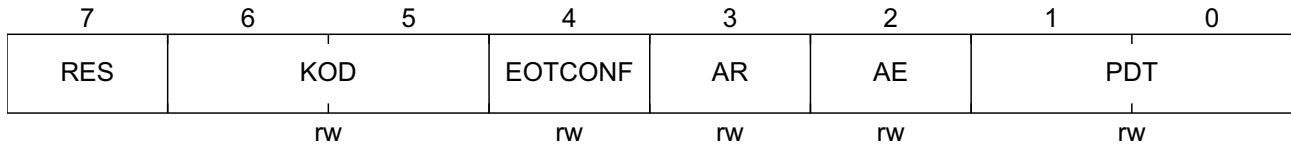
Field	Bits	Type	Description
KOD	6:5	rw	**Key Off Delay Set Up:** 00$_B$, 100 ms 01$_B$, 200 ms 10$_B$, 400 ms 11$_B$, 800 ms Reset: 00$_B$
EOTCONF	4	rw	**Engine Off Timer Configuration:** 0$_B$, timer start with negative edge of KEY signal 1$_B$, timer start with command EOTS in register Cmd0 Reset: 0$_B$
AR	3	rw	**Afterrun Reset Behavior Set Up:** 0$_B$, no afterrun reset 1$_B$, afterrun reset Reset: 1$_B$
AE	2	rw	**Afterrun Enable:** 0$_B$, no afterrun mode 1$_B$, afterrun mode Reset: 0$_B$
PDT	1:0	rw	**Power-Down Time Set Up:** 00$_B$, 100 ms 01$_B$, 200 ms 10$_B$, 300 ms 11$_B$, 400 ms Reset: 01$_B$

ComConfig0 locked with LOCK = 1

**ComConfig0**   **Offset**   **Reset Value**

                                                        04F$_H$ A4$_H$

7	6	5	4	3	2	1	0
MSCF			MSCO	MSCAD	MSCP	MSCUF	
rw			rw	rw	rw	rw	

Field	Bits	Type	Description
MSCF	7:5	rw	**MSC Upstream Frequency Divider Set Up:** 000_B , Division by 64 001_B , Division by 4 010_B , Division by 8 011_B , Division by 16 100_B , Division by 32 101_B , Division by 64 110_B , Division by 128 111_B , Division by 256 Reset: 101_B
MSCO	4	rw	**MSC SDO Definition:** 0_B , open drain 1_B , push pull Reset: 0_B
MSCAD	3	rw	**MSC Address Definition A0 to A3:** 0_B , value of A2 to A3 are incremented with each read command 1_B , A0 to A3 values are fixed to the values of MSCA[3:0] Reset: 0_B
MSCP	2	rw	**MSC Upstream Parity Format Set Up:** 0_B , odd parity 1_B , even parity Reset: 1_B
MSCUF	1:0	rw	**MSC Upstream Address Format Setup:** 00_B , upstream format without address 01_B , upstream format with address 10_B , upstream format with address 11_B , upstream format with address Reset: 00_B

ComConfig1 locked with LOCK = 1

ComConfig1	Offset	Reset Value
	050_H	$0D_H$

7	6	5	4	3	2	1	0
		MSCA		LINTOE	LIN		CAN
		rw		rw	rw		rw
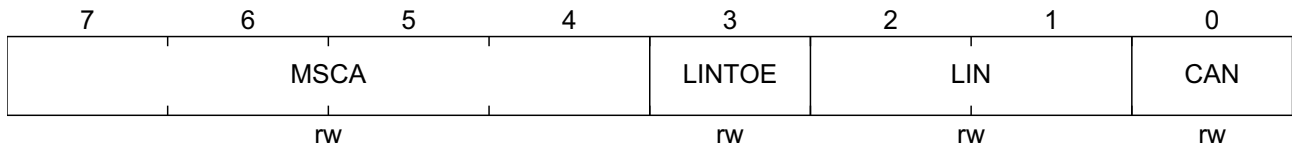
Field	Bits	Type	Description
MSCA	7:4	rw	**MSC Upstream Address for MSCAD = 1** Reset: 0000_B
LINTOE	3	rw	**LIN TX Time OUT Function Enable:** 0_B , TX time out function disabled 1_B , TX time out function enabled Reset: 1_B
LIN	2:1	rw	**Operation Mode:** 00_B , receive only mode 01_B , LIN/K-line operation 10_B , flash mode 11_B , receive only mode Reset: 10_B
CAN	0	rw	**CAN Operation Mode:** 0_B , receive only mode 1_B , high speed CAN mode Reset: 1_B

EOTConfig0 locked with LOCK = 1

EOTConfig0   **Offset**   **Reset Value**
                                  051_H   **00_H**

7	6	5	4	3	2	1	0
			EOTTH0				
			rw				
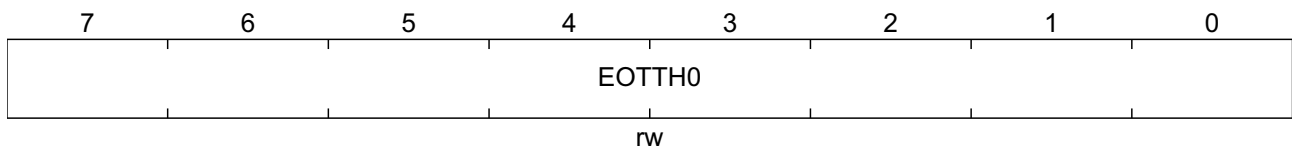
Field	Bits	Type	Description
EOTTH0	7:0	rw	**Engine Off Timer Comparator Threshold: (Bit 7 - 0)** Reset: 00_H

EOTConfig1 locked with LOCK = 1

EOTConfig1   **Offset**   **Reset Value**
                                  052$_H$ **00$_H$**

7	6	5	4	3	2	1	0
			EOTTH1				

rw
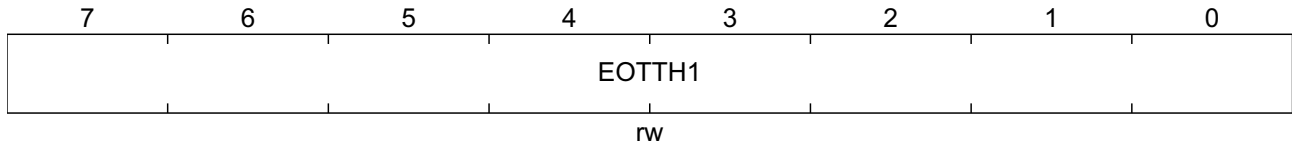
Field	Bits	Type	Description
EOTTH1	7:0	rw	**Engine Off Timer Comparator Threshold: (Bit 15 - 8)** Reset: 00$_H$

InConfig0 locked with LOCK = 1

InConfig0   **Offset**   **Reset Value**
                                 053$_H$ **00$_H$**

7	6	5	4	3	2	1	0
	RES				IN9O		

rw
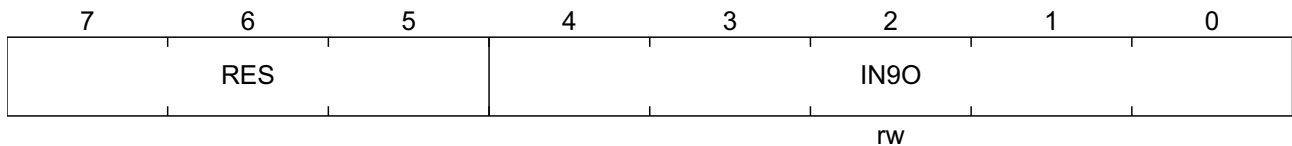
Field	Bits	Type	Description
IN9O	4:0	rw	**Direct control Input9 Assignment:** See **Table 51** Reset: 00000$_B$

Additional Table with Constants

This table describes more than 16 constants.

Table 51   Constant Values

Name and Description	Value
output5	00000$_B$
output6	00001$_B$
output7	00010$_B$
output8	00011$_B$

Table 51   Constant Values (cont'd)

Name and Description	Value
output9	00100_B
output10	00101_B
output11	00110_B
output12	00111_B
output13	01000_B
output14	01001_B
output15	01010_B
output16	01011_B
output17	01100_B
output18	01101_B
output19	01110_B
output20	01111_B
output21	10000_B
output22	10001_B
output23	10010_B
output24	10011_B

InConfig1 locked with LOCK = 1

InConfig1	Offset	Reset Value
	054_H	00_H

7	6	5	4	3	2	1	0
	RES				IN10O		

rw
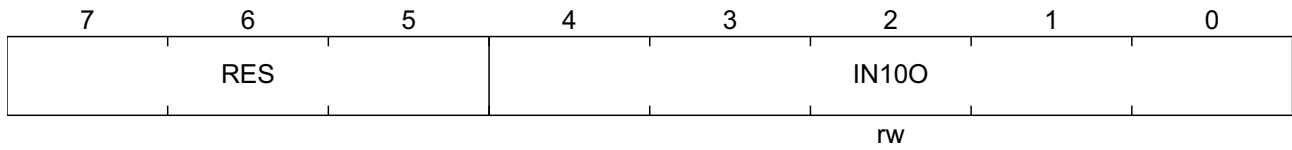
Field	Bits	Type	Description
IN10O	4:0	rw	**Direct control Input10 Assignment:** See **Table 52** Reset: 00000_B

Additional Table with Constants

This table describes more than 16 constants.

Table 52   Constant Values

Name and Description	Value
output5	00000_B
output6	00001_B
output7	00010_B
output8	00011_B
output9	00100_B
output10	00101_B
output11	00110_B
output12	00111_B
output13	01000_B
output14	01001_B
output15	01010_B
output16	01011_B
output17	01100_B
output18	01101_B

Table 52   Constant Values (cont'd)

Name and Description	Value
output19	01110_B
output20	01111_B
output21	10000_B
output22	10001_B
output23	10010_B
output24	10011_B

InConfig2 locked with LOCK = 1

InConfig2	**Offset**	**Reset Value**
	055$_H$	**00$_H$**

7	6	5	4	3	2	1	0
	RES				IN11O		
					rw		
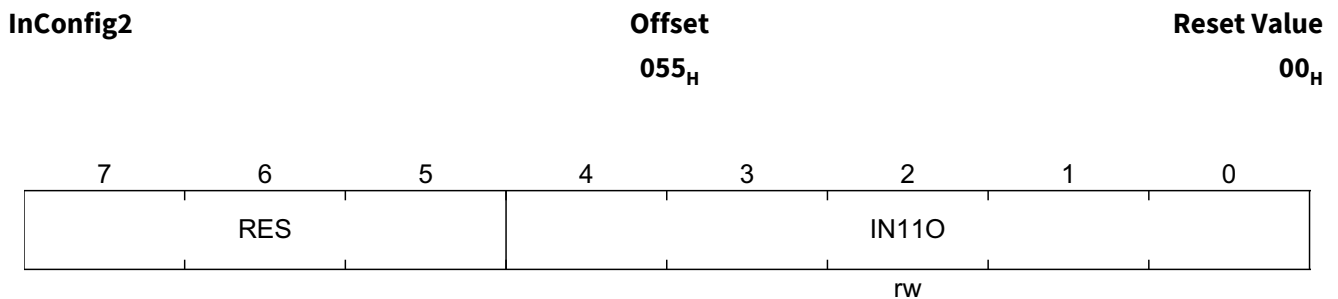
Field	Bits	Type	Description
IN11O	4:0	rw	**Direct control Input11 Assignment:** See **Table 53** Reset: 00000_B

Additional Table with Constants

This table describes more than 16 constants.

Table 53   Constant Values

Name and Description	Value
output5	00000_B
output6	00001_B
output7	00010_B

Table 53   Constant Values (cont'd)

Name and Description	Value
output8	00011_B
output9	00100_B
output10	00101_B
output11	00110_B
output12	00111_B
output13	01000_B
output14	01001_B
output15	01010_B
output16	01011_B
output17	01100_B
output18	01101_B
output19	01110_B
output20	01111_B
output21	10000_B
output22	10001_B
output23	10010_B
output24	10011_B

InConfig3 locked with LOCK = 1

InConfig3	**Offset**	**Reset Value**
	056_H	00_H

7	6	5	4	3	2	1	0
	RES				IN12O		

rw
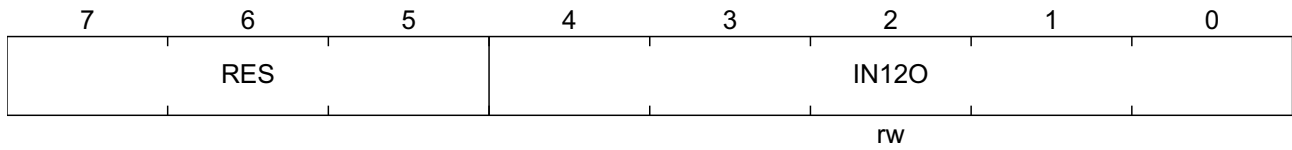
Field	Bits	Type	Description
IN12O	4:0	rw	**Direct control Input12 Assignment:** See **Table 54** Reset: 00000_B

Additional Table with Constants

This table describes more than 16 constants.

Table 54   Constant Values

Name and Description	Value
output5	00000_B
output6	00001_B
output7	00010_B
output8	00011_B
output9	00100_B
output10	00101_B
output11	00110_B
output12	00111_B
output13	01000_B
output14	01001_B
output15	01010_B
output16	01011_B
output17	01100_B
output18	01101_B

Table 54   Constant Values (cont'd)

Name and Description	Value
output19	01110_B
output20	01111_B
output21	10000_B
output22	10001_B
output23	10010_B
output24	10011_B

DDConfig0 locked with LOCK = 1

DDConfig0	**Offset**	**Reset Value**
	057_H	00_H

7	6	5	4	3	2	1	0
O8DD	O7DD	O6DD	O5DD	O4DD	O3DD	O2DD	O1DD
rw	rw	rw	rw	rw	rw	rw	rw

Field	Bits	Type	Description
O8DD	7	rw	**Output8 Direct Drive Control: see below** Reset: 0_B
O7DD	6	rw	**Output7 Direct Drive Control: see below** Reset: 0_B
O6DD	5	rw	**Output6 Direct Drive Control: see below** Reset: 0_B
O5DD	4	rw	**Output5 Direct Drive Control: see below** Reset: 0_B
O4DD	3	rw	**Output4 Direct Drive Control: see below** Reset: 0_B
O3DD	2	rw	**Output3 Direct Drive Control: see below** Reset: 0_B
O2DD	1	rw	**Output2 Direct Drive Control: see below** Reset: 0_B

Field	Bits	Type	Description
O1DD	0	rw	**Output1 Direct Drive Control:** 0_B , controlled by MSC/SPI interface 1_B , controlled by Direct Drive Input Reset: 0_B

DDConfig1 locked with LOCK = 1

DDConfig1 **Offset** **Reset Value**

 058$_H$ **00$_H$**

7	6	5	4	3	2	1	0
O16DD	O15DD	O14DD	O13DD	O12DD	O11DD	O10DD	O9DD
rw	rw	rw	rw	rw	rw	rw	rw

Field	Bits	Type	Description
O16DD	7	rw	**Output16 Direct Drive Control: see below** Reset: 0_B
O15DD	6	rw	**Output15 Direct Drive Control: see below** Reset: 0_B
O14DD	5	rw	**Output14 Direct Drive Control: see below** Reset: 0_B
O13DD	4	rw	**Output13 Direct Drive Control: see below** Reset: 0_B
O12DD	3	rw	**Output12 Direct Drive Control: see below** Reset: 0_B
O11DD	2	rw	**Output11 Direct Drive Control: see below** Reset: 0_B
O10DD	1	rw	**Output10 Direct Drive Control: see below** Reset: 0_B
O9DD	0	rw	**Output9 Direct Drive Control:** 0_B , controlled by MSC/SPI interface 1_B , controlled by Direct Drive Input Reset: 0_B

DDConfig2 locked with LOCK = 1

DDConfig2 **Offset** **Reset Value**

 059$_H$ **00$_H$**

7	6	5	4	3	2	1	0
O24DD	O23DD	O22DD	O21DD	O20DD	O19DD	O18DD	O17DD
rw	rw	rw	rw	rw	rw	rw	rw

Field	Bits	Type	Description
O24DD	7	rw	**Output24 Direct Drive Control: see below** Reset: 0_B
O23DD	6	rw	**Output23 Direct Drive Control: see below** Reset: 0_B
O22DD	5	rw	**Output22 Direct Drive Control: see below** Reset: 0_B
O21DD	4	rw	**Output21 Direct Drive Control: see below** Reset: 0_B
O20DD	3	rw	**Output20 Direct Drive Control: see below** Reset: 0_B
O19DD	2	rw	**Output19 Direct Drive Control: see below** Reset: 0_B
O18DD	1	rw	**Output18 Direct Drive Control: see below** Reset: 0_B
O17DD	0	rw	**Output17 Direct Drive Control:** 0_B , controlled by MSC/SPI interface 1_B , controlled by Direct Drive Input Reset: 0_B

DDConfig3 locked with LOCK = 1

DDConfig3	**Offset**	**Reset Value**
	$05A_H$	**00_H**

7	6	5	4	3	2	1	0
RES				IGN4DD	IGN3DD	IGN2DD	IGN1DD
				rw	rw	rw	rw
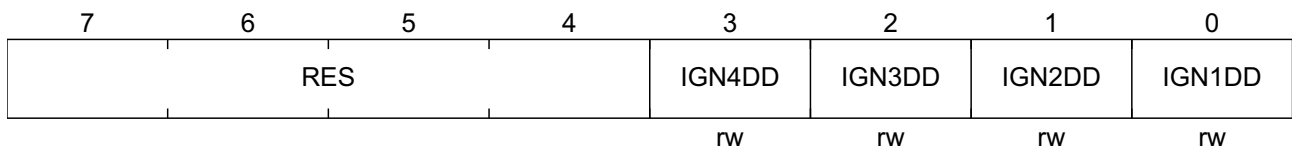
Field	Bits	Type	Description
IGN4DD	3	rw	**Ignition Output4 Direct Drive Control: see below** Reset: 0_B
IGN3DD	2	rw	**Ignition Output3 Direct Drive Control: see below** Reset: 0_B

Field	Bits	Type	Description
IGN2DD	1	rw	**Ignition Output2 Direct Drive Control: see below** Reset: 0_B
IGN1DD	0	rw	**Ignition Output1 Direct Drive Control:** 0_B , controlled by MSC/SPI interface 1_B , controlled by Direct Drive Input Reset: 0_B

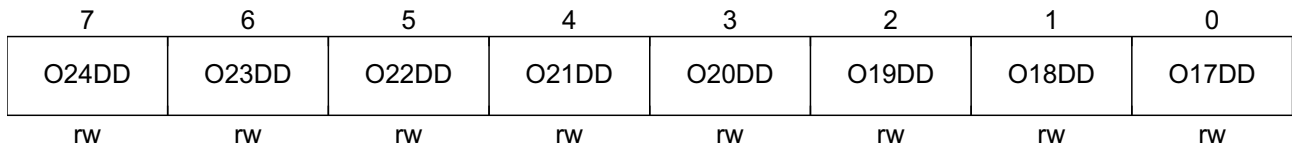**OEConfig0**   **Offset**   **Reset Value**

                         05B$_H$ **00$_H$**

7	6	5	4	3	2	1	0
O8E	O7E	O6E	O5E	O4E	O3E	O2E	O1E
rw	rw	rw	rw	rw	rw	rw	rw

Field	Bits	Type	Description
O8E	7	rw	**Output8 Enable Bit:** 0_B , output disabled 1_B , output enabled Reset: 0_B
O7E	6	rw	**Output7 Enable Bit:** 0_B , output disabled 1_B , output enabled Reset: 0_B
O6E	5	rw	**Output6 Enable Bit:** 0_B , output disabled 1_B , output enabled Reset: 0_B
O5E	4	rw	**Output5 Enable Bit:** 0_B , output disabled 1_B , output enabled Reset: 0_B
O4E	3	rw	**Output4 Enable Bit:** 0_B , output disabled 1_B , output enabled Reset: 0_B
O3E	2	rw	**Output3 Enable Bit:** 0_B , output disabled 1_B , output enabled Reset: 0_B

Field	Bits	Type	Description
O2E	1	rw	**Output2 Enable Bit:** 0_B , output disabled 1_B , output enabled Reset: 0_B
O1E	0	rw	**Output1 Enable Bit:** 0_B , output disabled 1_B , output enabled Reset: 0_B

OEConfig1   **Offset**   **Reset Value**

                                        05C$_H$ **00$_H$**

7	6	5	4	3	2	1	0
O16E	O15E	O14E	O13E	O12E	O11E	O10E	O9E
rw	rw	rw	rw	rw	rw	rw	rw
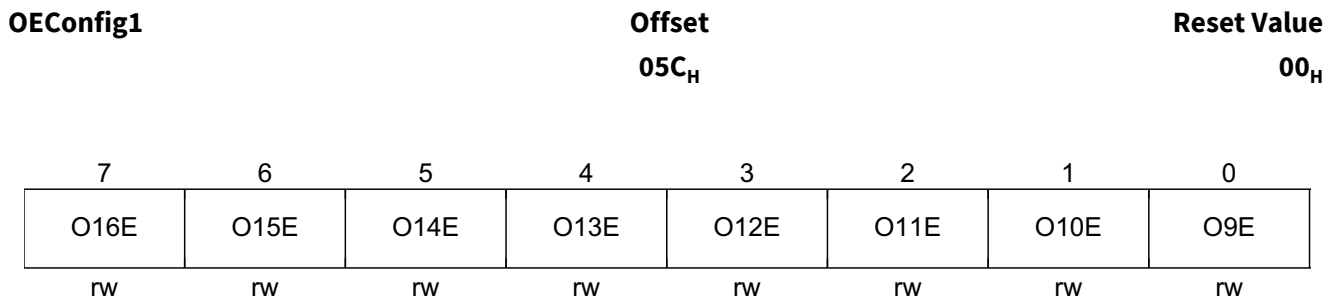
Field	Bits	Type	Description
O16E	7	rw	**Output16 Enable Bit:** 0_B , output disabled 1_B , output enabled Reset: 0_B
O15E	6	rw	**Output15 Enable Bit:** 0_B , output disabled 1_B , output enabled Reset: 0_B
O14E	5	rw	**Output14 Enable Bit:** 0_B , output disabled 1_B , output enabled Reset: 0_B
O13E	4	rw	**Output13 Enable Bit:** 0_B , output disabled 1_B , output enabled Reset: 0_B
O12E	3	rw	**Output12 Enable Bit:** 0_B , output disabled 1_B , output enabled Reset: 0_B

Field	Bits	Type	Description
O11E	2	rw	**Output11 Enable Bit:** 0_B , output disabled 1_B , output enabled Reset: 0_B
O10E	1	rw	**Output10 Enable Bit:** 0_B , output disabled 1_B , output enabled Reset: 0_B
O9E	0	rw	**Output9 Enable Bit:** 0_B , output disabled 1_B , output enabled Reset: 0_B

OEConfig2 Offset Reset Value

$05D_H$ 00_H

7	6	5	4	3	2	1	0
O24E	O23E	O22E	O21E	O20E	O19E	O18E	O17E
rw	rw	rw	rw	rw	rw	rw	rw

Field	Bits	Type	Description
O24E	7	rw	**Output24 Enable Bit:** 0_B , output disabled 1_B , output enabled Reset: 0_B
O23E	6	rw	**Output23 Enable Bit:** 0_B , output disabled 1_B , output enabled Reset: 0_B
O22E	5	rw	**Output22 Enable Bit:** 0_B , output disabled 1_B , output enabled Reset: 0_B
O21E	4	rw	**Output21 Enable Bit:** 0_B , output disabled 1_B , output enabled Reset: 0_B

Field	Bits	Type	Description
O20E	3	rw	**Output20 Enable Bit:** 0_B , output disabled 1_B , output enabled Reset: 0_B
O19E	2	rw	**Output19 Enable Bit:** 0_B , output disabled 1_B , output enabled Reset: 0_B
O18E	1	rw	**Output18 Enable Bit:** 0_B , output disabled 1_B , output enabled Reset: 0_B
O17E	0	rw	**Output17 Enable Bit:** 0_B , output disabled 1_B , output enabled Reset: 0_B

OEConfig3 Offset **05E$_H$** Reset Value **00$_H$**

7	6	5	4	3	2	1	0
		RES		IGN4E	IGN3E	IGN2E	IGN1E
				rw	rw	rw	rw

Field	Bits	Type	Description
IGN4E	3	rw	**Ignition 4 Output Enable Bit:** 0_B , output disabled 1_B , output enabled Reset: 0_B
IGN3E	2	rw	**Ignition 3 Output Enable Bit:** 0_B , output disabled 1_B , output enabled Reset: 0_B
IGN2E	1	rw	**Ignition 2 Output Enable Bit:** 0_B , output disabled 1_B , output enabled Reset: 0_B

Field	Bits	Type	Description
IGN1E	0	rw	**Ignition 1 Output Enable Bit:** 0_B , output disabled 1_B , output enabled Reset: 0_B

WWDConfig0 **Offset** **Reset Value**

$05F_H$ FF_H

7	6	5	4	3	2	1	0
			WWDCWT			WWDOWT	
			rw			rw	
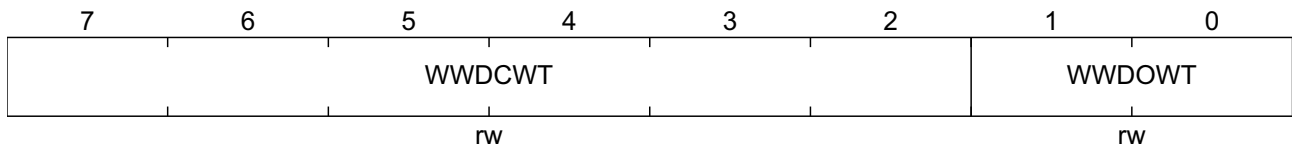
Field	Bits	Type	Description
WWDCWT	7:2	rw	**Window Watchdog Closed Window Time:** 000000_B, no change - old setting used for open and closed window 000001_B, 1,6 ms 111111_B, 100,8 ms Reset: 111111_B
WWDOWT	1:0	rw	**Window Watchdog Open Window Time:** 00_B , 3,2 ms 01_B , 6,4 ms 10_B , 9,6 ms 11_B , 12,8 ms Reset: 11_B

WWDConfig1 **Offset** **Reset Value**

060_H 77_H

7	6	5	4	3	2	1	0
	WWDECD				WWDECI		
	rw				rw		
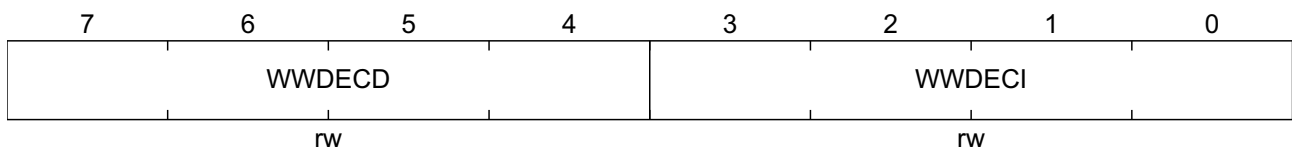
Field	Bits	Type	Description
WWDECD	7:4	rw	**Window Watchdog Error Counter Decrement:** 0000_B, -1 0001_B, -2 1111_B, -16 Reset: 0111_B
WWDECI	3:0	rw	**Window Watchdog Error Counter Increment:** 0000_B, +1 0001_B, +2 1111_B, +16 Reset: 0111_B

FWDConfig   **Offset**   **Reset Value**

061_H $F7_H$

7	6	5	4	3	2	1	0
	FWDPCD				FWDPCI		
	rw				rw		
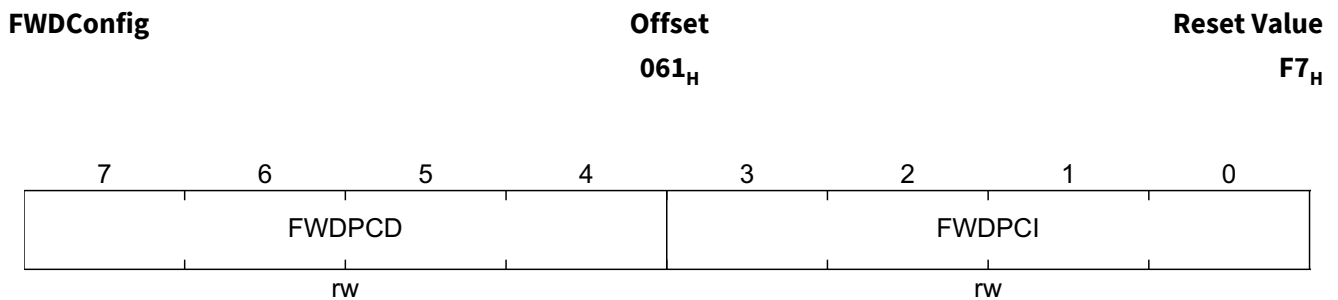
Field	Bits	Type	Description
FWDPCD	7:4	rw	**Functional Watchdog Pass Counter Decrement:** 0000_B, -1 0001_B, -2 1111_B, -16 Reset: 1111_B
FWDPCI	3:0	rw	**Functional Watchdog Pass Counter Increment:** 0000_B, +1 0001_B, +2 1111_B, +16 Reset: 0111_B

TECConfig   **Offset**   **Reset Value**

062_H 77_H

7	6	5	4	3	2	1	0
		TECD				TECI	
		rw				rw	
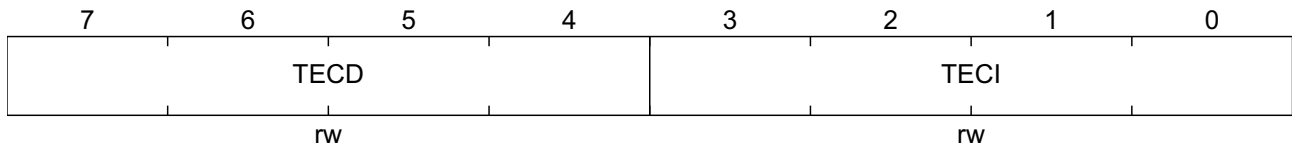
Field	Bits	Type	Description
TECD	7:4	rw	**Total Error Counter Decrement:** 0000_B, -1 0001_B, -2 1111_B, -16 Reset: 0111_B
TECI	3:0	rw	**Total Error Counter Increment:** 0000_B, +1 0001_B, +2 1111_B, +16 Reset: 0111_B

WDConfig0   **Offset**   **Reset Value**

                                       063_H   **47_H**

7	6	5	4	3	2	1	0
RES				WDHBTP			
				rw			
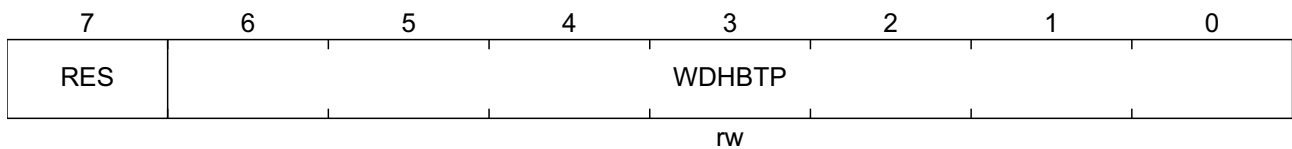
Field	Bits	Type	Description
WDHBTP	6:0	rw	**Watchdog Heartbeat Timer Period:** 0000000_B, no change 0000001_B, 1,6 ms 0000010_B, 3,2 ms 1111111_B, 203,2 ms Reset: 1000111_B

WDConfig1 locked with LOCK = 1

WDConfig1   **Offset**   **Reset Value**

                                       064_H   **03_H**

7	6	5	4	3	2	1	0
	RES		FWDKQ	FWDQG	WDREN	LINWE	CANWE
			rw	rw	rw	rw	rw

Field	Bits	Type	Description
FWDKQ	4	rw	**Functional Watchdog Keep Question Setup:** 0_B , No influence to question generation in case of window watchdog error 1_B , Keep question in case of window watchdog error Reset: 0_B
FWDQG	3	rw	**Functional Watchdog Question Generation:** 0_B , Question period 16 1_B , Question period 256 Reset: 0_B
WDREN	2	rw	**Watchdog Reset Enable Bit:** 0_B , reset disabled 1_B , reset enabled Reset: 0_B
LINWE	1	rw	**LIN Operation Mode during Watchdog Error Setup:** 0_B , receive only mode 1_B , according ComConfig1.LIN Reset: 1_B
CANWE	0	rw	**CAN Operation Mode during Watchdog Error Setup:** 0_B , receive only mode 1_B , according ComConfig1.CAN Reset: 1_B

14.1.5 Control Register

Cont0		Offset		Reset Value
		$07B_H$		00_H

7	6	5	4	3	2	1	0
O8ON	O7ON	O6ON	O5ON	O4ON	O3ON	O2ON	O1ON
rw	rw	rw	rw	rw	rw	rw	rw

Field	Bits	Type	Description
O8ON	7	rw	**Output8 Switch on Control Bit:** 0_B , off 1_B , on Reset: 0_B
O7ON	6	rw	**Output7 Switch on Control Bit:** 0_B , off 1_B , on Reset: 0_B
O6ON	5	rw	**Output6 Switch on Control Bit:** 0_B , off 1_B , on Reset: 0_B
O5ON	4	rw	**Output5 Switch on Control Bit:** 0_B , off 1_B , on Reset: 0_B
O4ON	3	rw	**Output4 Switch on Control Bit:** 0_B , off 1_B , on Reset: 0_B
O3ON	2	rw	**Output3 Switch on Control Bit:** 0_B , off 1_B , on Reset: 0_B
O2ON	1	rw	**Output2 Switch on Control Bit:** 0_B , off 1_B , on Reset: 0_B
O1ON	0	rw	**Output1 Switch on Control Bit:** 0_B , off 1_B , on Reset: 0_B

Cont1			**Offset** $07C_H$			**Reset Value** 00_H	
7	6	5	4	3	2	1	0
O16ON	O15ON	O14ON	O13ON	O12ON	O11ON	O10ON	O9ON
rw	rw	rw	rw	rw	rw	rw	rw

Field	Bits	Type	Description
O16ON	7	rw	**Output16 Switch on Control Bit:** 0_B , off 1_B , on Reset: 0_B
O15ON	6	rw	**Output15 Switch on Control Bit:** 0_B , off 1_B , on Reset: 0_B
O14ON	5	rw	**Output14 Switch on Control Bit:** 0_B , off 1_B , on Reset: 0_B
O13ON	4	rw	**Output13 Switch on Control Bit:** 0_B , off 1_B , on Reset: 0_B
O12ON	3	rw	**Output12 Switch on Control Bit:** 0_B , off 1_B , on Reset: 0_B
O11ON	2	rw	**Output11 Switch on Control Bit:** 0_B , off 1_B , on Reset: 0_B
O10ON	1	rw	**Output10 Switch on Control Bit:** 0_B , off 1_B , on Reset: 0_B
O9ON	0	rw	**Output9 Switch on Control Bit:** 0_B , off 1_B , on Reset: 0_B

Cont2				**Offset** **$07D_H$**			**Reset Value** **00_H**

7	6	5	4	3	2	1	0
O24ON	O23ON	O22ON	O21ON	O20ON	O19ON	O18ON	O17ON
rw	rw	rw	rw	rw	rw	rw	rw
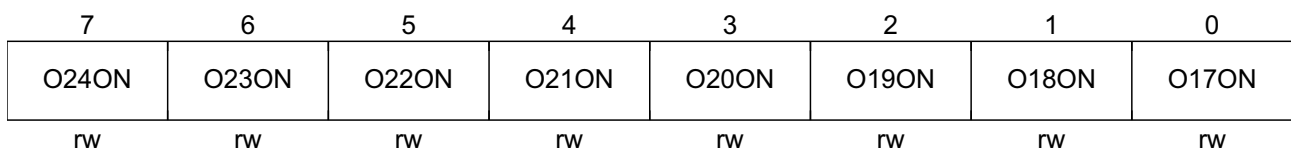
Field	Bits	Type	Description
O24ON	7	rw	**Output24 Switch on Control Bit:** 0_B , off 1_B , on Reset: 0_B
O23ON	6	rw	**Output23 Switch on Control Bit:** 0_B , off 1_B , on Reset: 0_B
O22ON	5	rw	**Output22 Switch on Control Bit:** 0_B , off 1_B , on Reset: 0_B
O21ON	4	rw	**Output21 Switch on Control Bit:** 0_B , off 1_B , on Reset: 0_B
O20ON	3	rw	**Output20 Switch on Control Bit:** 0_B , off 1_B , on Reset: 0_B
O19ON	2	rw	**Output19 Switch on Control Bit:** 0_B , off 1_B , on Reset: 0_B
O18ON	1	rw	**Output18 Switch on Control Bit:** 0_B , off 1_B , on Reset: 0_B
O17ON	0	rw	**Output17 Switch on Control Bit:** 0_B , off 1_B , on Reset: 0_B

Cont3   **Offset**   **Reset Value**

$07E_H$ **00_H**

7	6	5	4	3	2	1	0
		RES		IGN4ON	IGN3ON	IGN2ON	IGN1ON
				rw	rw	rw	rw
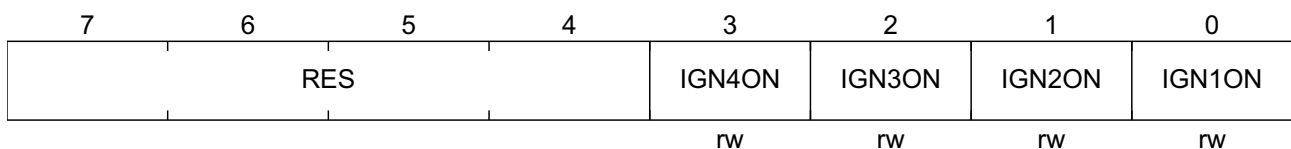
Field	Bits	Type	Description
IGN4ON	3	rw	**Ignition Output4 Switch on Control Bit:** 0_B , off 1_B , on Reset: 0_B
IGN3ON	2	rw	**Ignition Output3 Switch on Control Bit:** 0_B , off 1_B , on Reset: 0_B
IGN2ON	1	rw	**Ignition Output2 Switch on Control Bit:** 0_B , off 1_B , on Reset: 0_B
IGN1ON	0	rw	**Ignition Output1 Switch on Control Bit:** 0_B , off 1_B , on Reset: 0_B

15 SPI

Alternatively to the MSC communication interface a SPI interface is available. It uses the pins *SIP*, *SDO*, *CSN* and *FCLP*. The configuration is done via the pins *FCLN* and *SIN*. *FCLN* must be connected to *VDDIO* and *SIN* must be connected to *AGND*. In SPI mode the output stage of the pin *SDO* is set to push pull operation (definition and description see **Chapter 13.2** and **Chapter 13.4**).

The definition of the registers is the same as for the MSC communication (see **Chapter 14**), only the frame is SPI specific (see **Figure 67** and **Chapter 15.1**). Multiple read commands are not allowed.

There is no monitoring of valid transmissions implemented (like MSC monitoring, see **Chapter 13.1.1**).
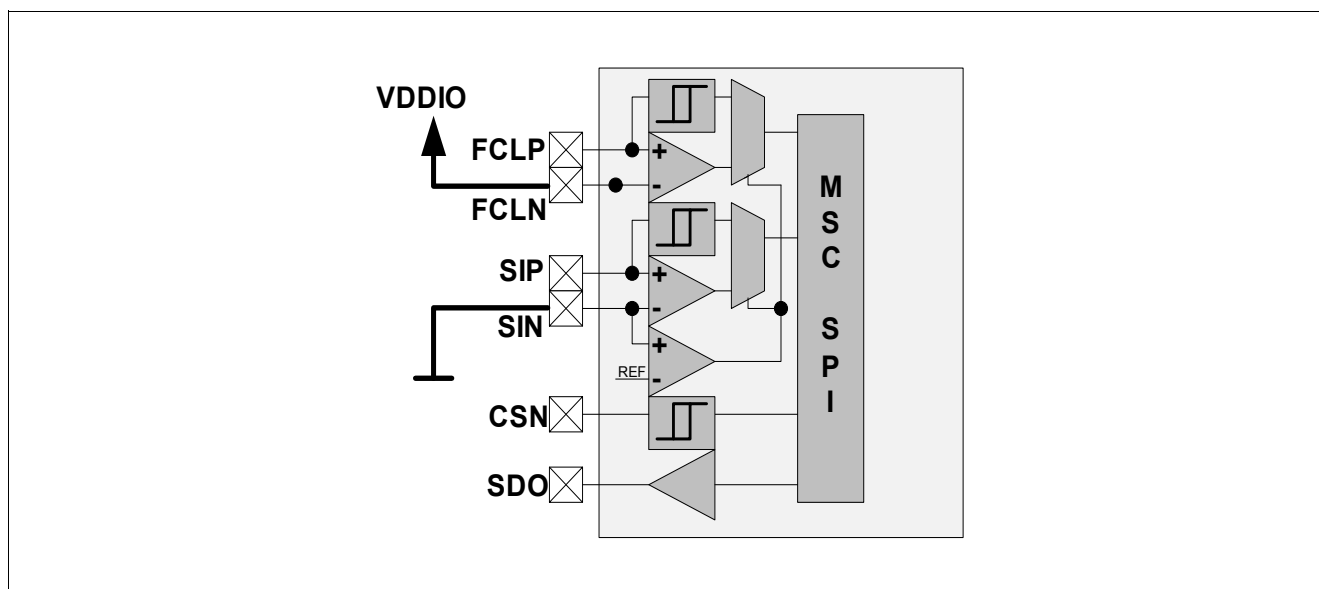
Figure 66   Block diagram of the SPI interface

15.1 SPI Protocol

The principle of the SPI communication is shown in **Figure 67**. The message from the microcontroller must be sent LSB first. The data from the *SDO* pin is sent LSB first. The TLE8888-1QK samples data from the *SIP* pin on the falling edge of *FCLP* and shifts data out of the *SDO* pin on the rising edge of *FCLP*. Each access must be terminated by a rising edge of *CSN*.

All SPI messages must be exactly 16 bits long, otherwise the SPI message is discarded and the bit **COMFE** in diagnosis register **ComDiag** is set to "1".

There is one message delay in the response to each message (i.e. the response for message N will be returned during message N+1).

There are two valid access possible:

*   Write access to registers with write permission: the answer is 1 for the R/W bit, the address and the content of the register
*   Read access to register with read permission: the answer is 0 for the R/W bit, the address and the content of the register

Everything else is not executed.

Write access to multiple read commands are also not valid in SPI mode.

SPI

Status Flag Indication: after the falling edge of *CSN* and before the first rising edge of *FCLP* the level of the *SDO* indicates an OR combination of the status of the central failure bit **CF** and the central overtemperature bit **COT** of the diagnosis register **Diag0**.

With this feature during every SPI communication a check of the diagnosis status can be done without additional read access of the diagnosis register.
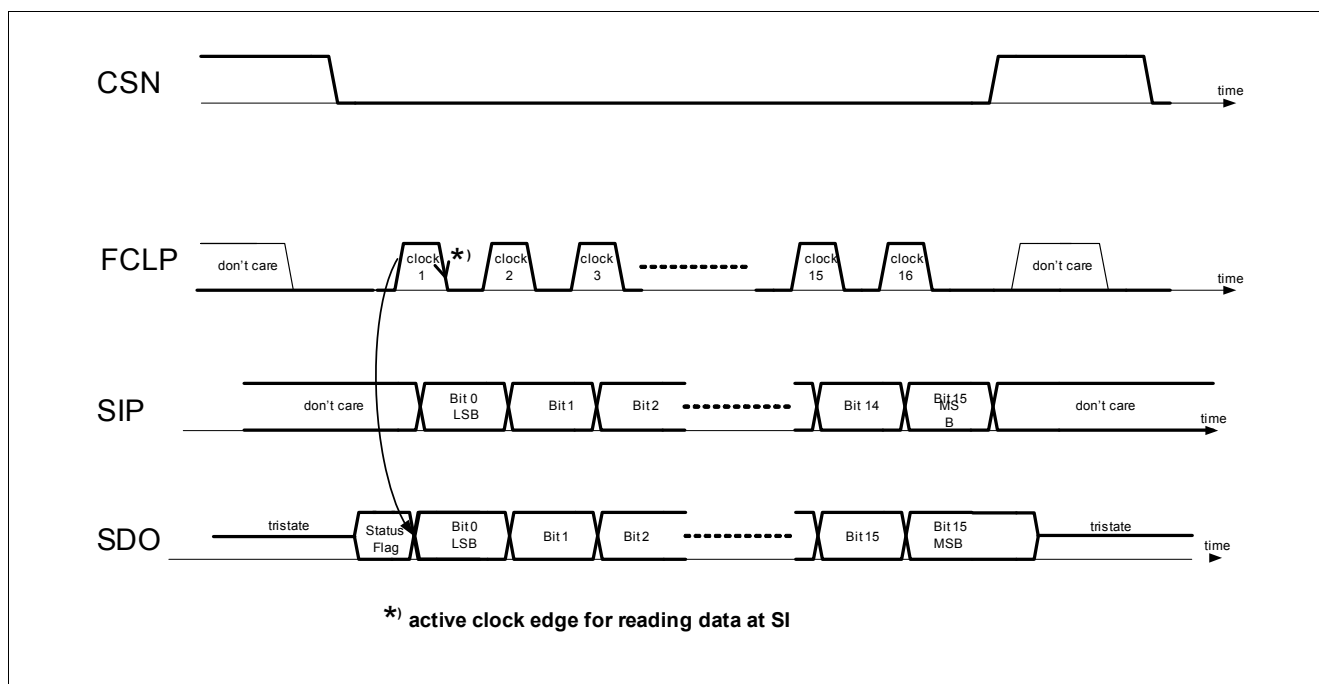

Figure 67   SPI Protocol

SPI Answers:

- during power on reset: SPI commands are ignored, *SDO* is always tristate
- after power on reset: the address and the content of the status register **OpStat0** is transmitted with the next SPI transmission
- during watchdog reset: SPI commands are ignored, *SDO* has the value of the status flag
- after watchdog reset: the address and the content of the diagnosis register **FWDStat1** is transmitted with the first SPI transmission after the low to high transition of *RST*
- after a read or write command: the address and content of the selected register is transmitted with the next SPI transmission (for not existing addresses or wrong access mode the data is always "0")
- after an invalid communication frame: the address and the content of the diagnosis register **Diag0** is transmitted with the next SPI transmission and the bit **COMFE** in diagnosis register **ComDiag** is set to "1"

15.2 SPI Frame Definition

Overview SPI Frame

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
CD7	CD6	CD5	CD4	CD3	CD2	CD1	CD0	C7	C6	C5	C4	C3	C2	C1	C0

Field	Bits	Type	Description
C0	0		**R/W Bit: defines the access to the register**
C[7:1]	[7:1]		**Address Bits, definition see Chapter 14**
CD[7:0]	[15:8]		**Data Bits, definition see Chapter 14**

15.3 Electrical Characteristics SPI

Table 55 Electrical Characteristics Communication

V_S = 13.5 V, V_{VSV} = 5 V, T_j = -40°C to +150°C, all voltages with respect to GND, positive current flowing into pin, (unless otherwise specified)

Parameter	Symbol	Values			Unit	Note or Test Condition	Number
		Min.	Typ.	Max.			
SPI detection threshold for *SIN*	VFCLN_SPI	0.3	–	0.7	V		P_15.1
Single ended mode detection threshold for *FCLN*	VFCLN_single	2	–	3	V		P_15.2
SDO						see **Chapter 13.4**	P_15.3
Input low level (*SIP*, *FCLP*, *CSN*)	VINn_L	-0.3	–	0.8	V		P_15.4
Input high level (*SIP*, *FCLP*, *CSN*)	VINn_H	1.6	–	5.5	V		P_15.5
Input hysteresis (*SIP*, *FCLP*, *CSN*)	VINn_Hys	0.1	–	0.5	V		P_15.6
Clock frequency	fSPI	–	–	5	MHz		P_15.7

16 EMC Requirements

16.1 ISO Pulse Tests

Definitions for all ISO pulse test on application including the TLE8888-1QK are regarding standard ISO 7637-2:2011. The following amplitude definitions for the tests are required:

• Pulse 3a: VS = -140 V, all outputs available on ECU connector

• Pulse 3b: VS = 140 V, all outputs available on ECU connector

• Pulse 5: VS = +38.5 V (clamped), td = 400 ms (ECU reset is permitted under this test, outputs will be switched off)

The tests are performed only on application level.

17 Application Information

Note: The information in this chapter is given as a hint for the implementation of the device only and shall not be regarded as a description or warranty of a certain functionality, condition or quality of the device.

Note: These are very simplified examples of application circuits. The functions must be verified in the real application.
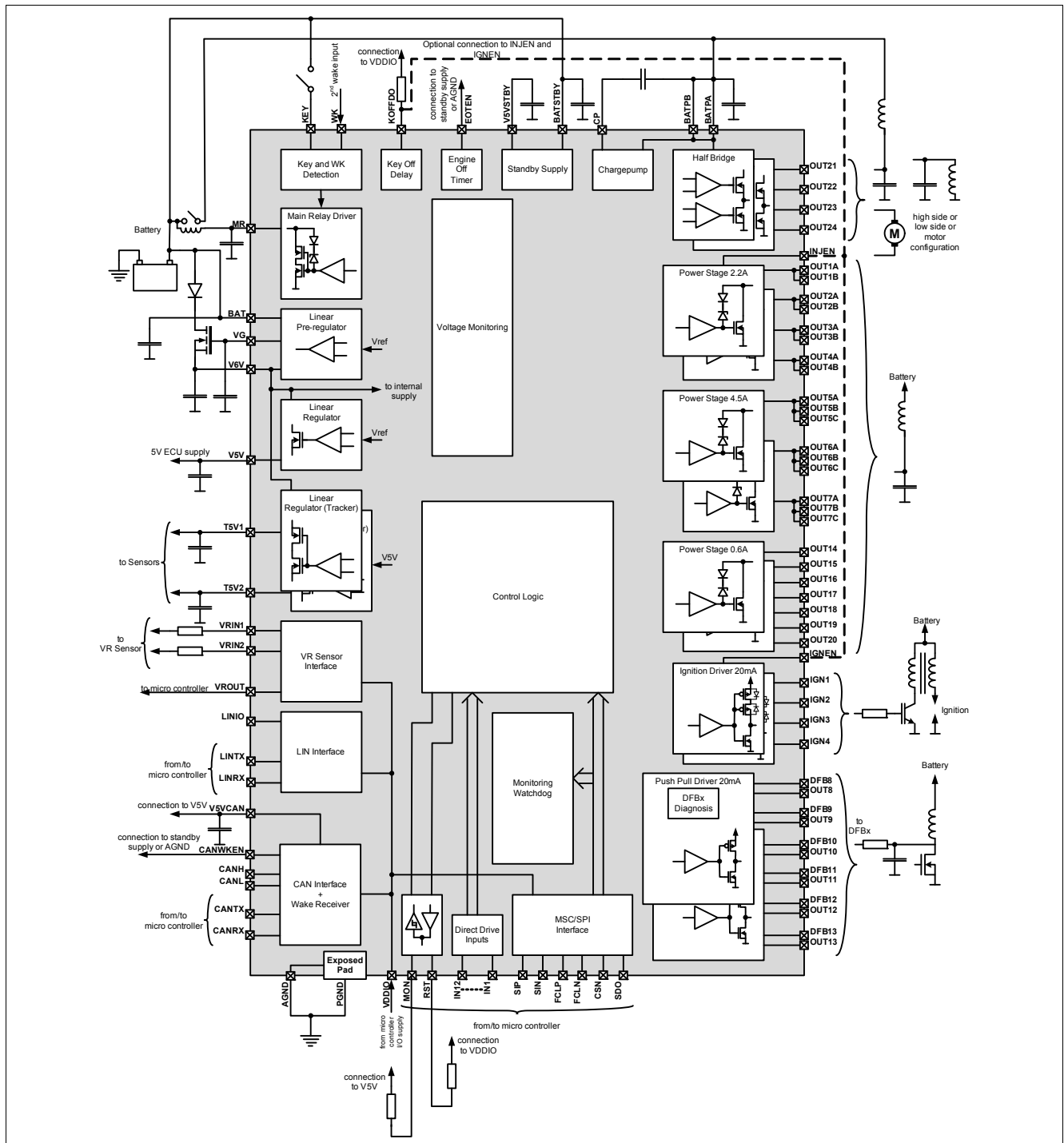
Figure 68   Application Diagram
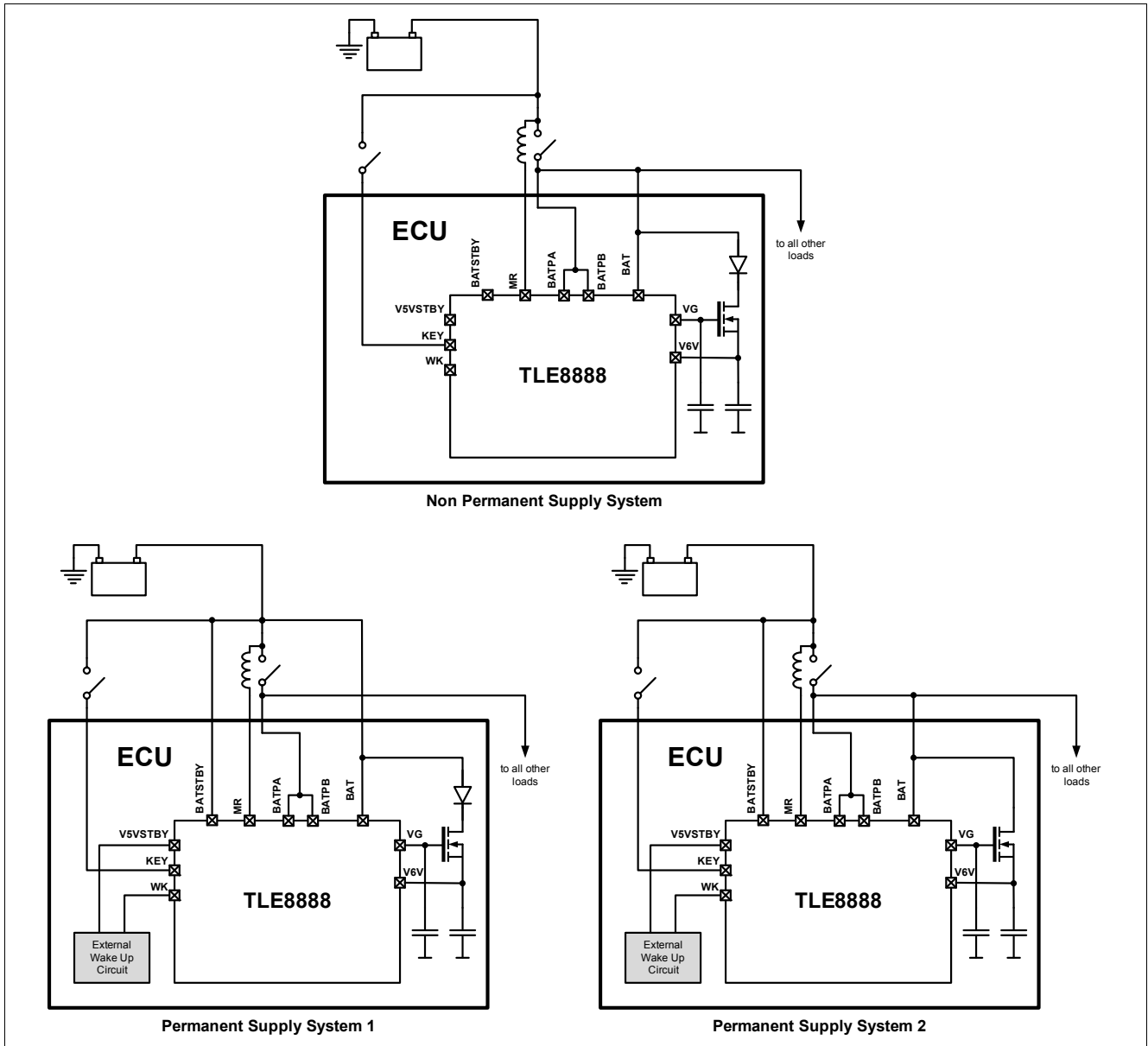
17.1 Supply Systems

Figure 69   Application Diagram Supply Systems

In **Figure 69** three setups for connecting the battery supply to the TLE8888-1QK are shown. With non permanent battery supply there is no standby supply available and all functions related to this supply (e.g. engine off timer) are not active. Wake-up could be done by a signal at the pins *KEY* and *WK*.

In a permanent supply system the standby supply is permanently connected to the battery and all functions related to this supply can be enabled (e.g. CAN remote wake-up). The pins *BATPA* and *BATPB* must be connected to the switched battery supply because there is no special mode to reduce the current consumption in standby mode. The pin *BAT* and the external MOSFET of the pre regulator are allowed to be connected permanently to the battery.

17.2 VR Sensor Interface

For Hall sensor signal detection in **Figure 70** and **Figure 71** different proposals for the external devices are shown. For the description of the set ups see **Chapter 10**.
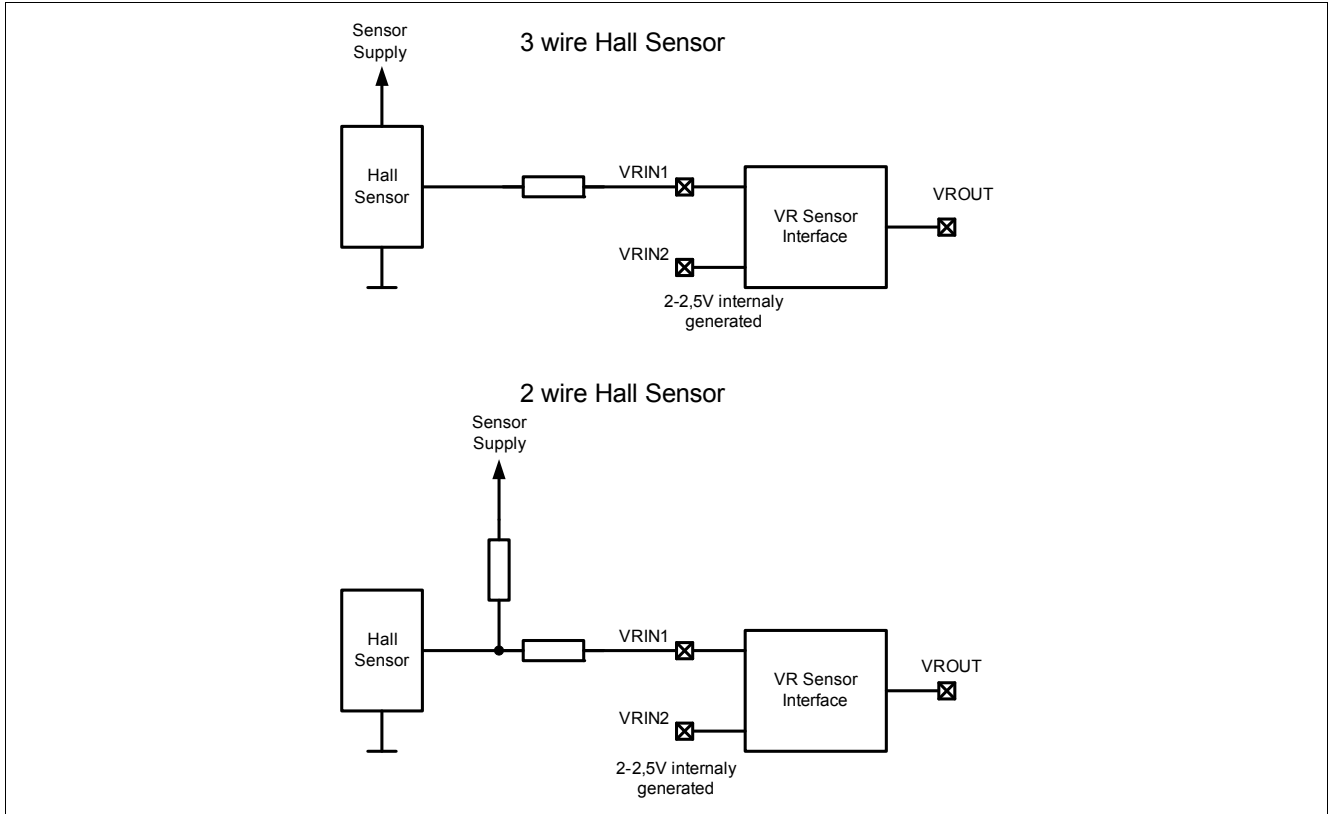

Figure 70   Application Circuit for VR Sensor Interface used for Hall Sensor in Hall Mode Set Up
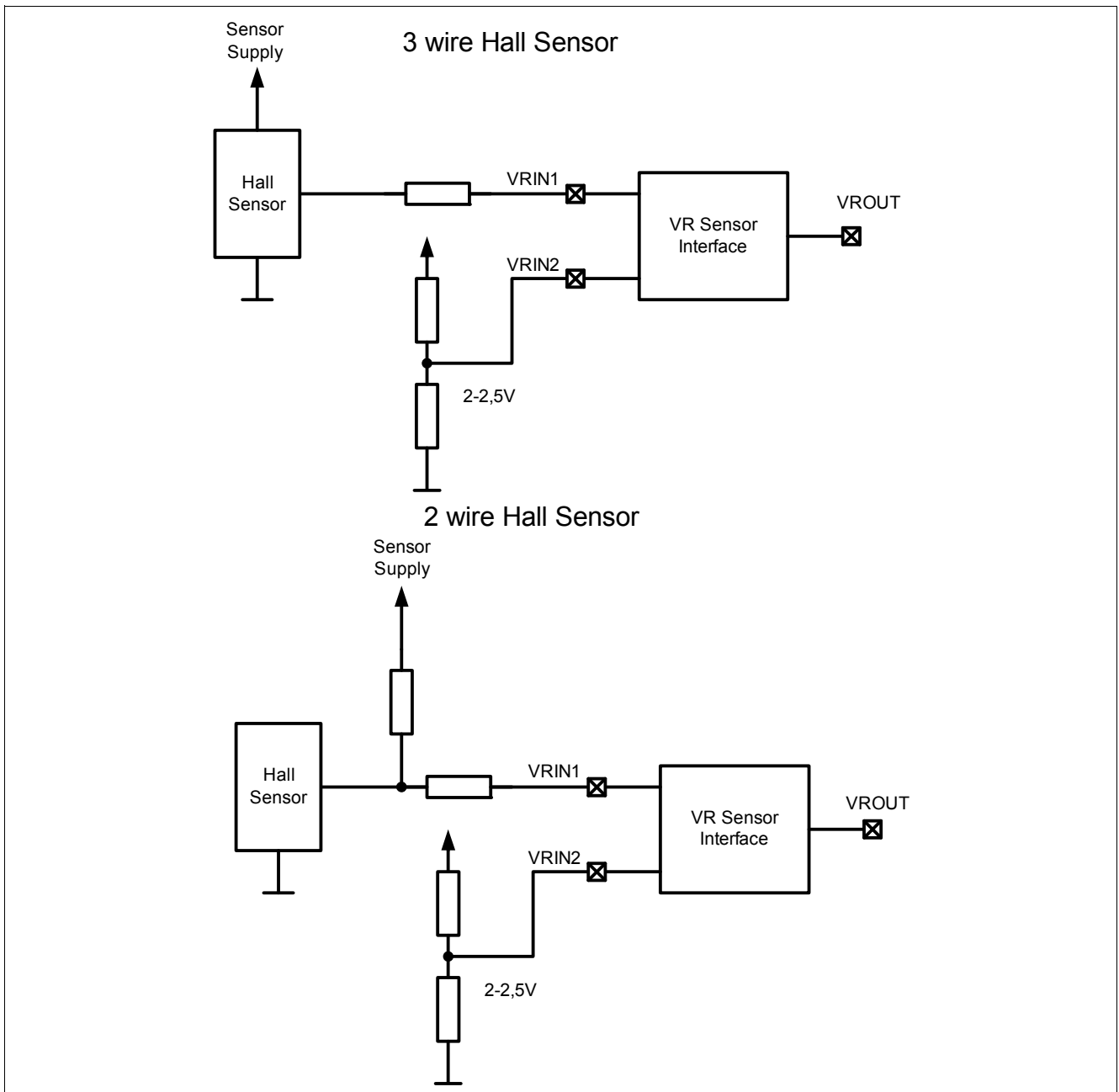
Application Information

Figure 71   Application Circuit for VR Sensor Interface used for Hall Sensor in Auto, Semi Auto and Manual Detection Mode Set Up
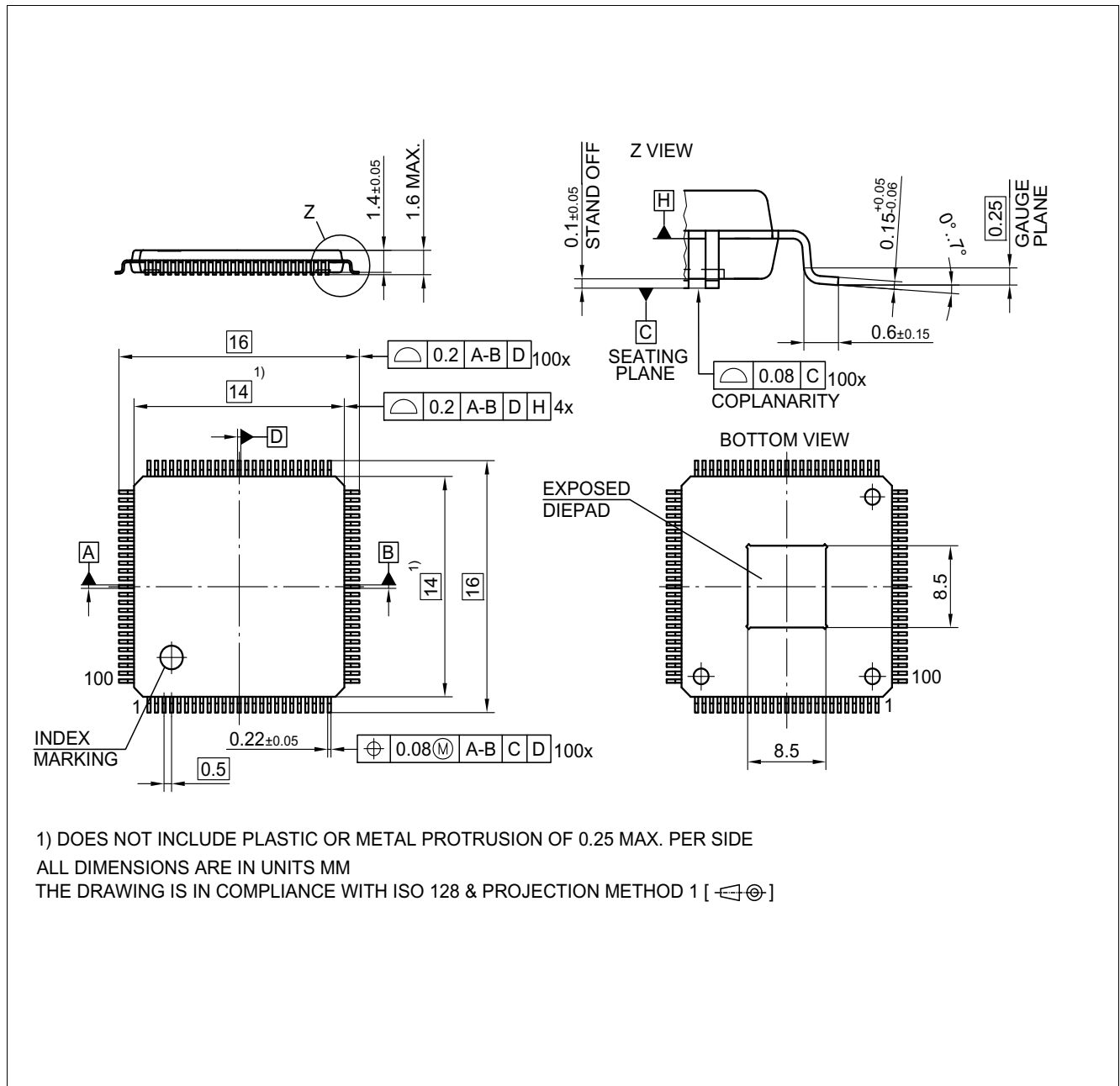
18 Package Outlines

Figure 72   LQFP-100

Green Product (RoHS compliant)

To meet the world-wide customer requirements for environmentally friendly products and to be compliant with government regulations the device is available as a green product. Green products are RoHS-Compliant (i.e Pb-free finish on leads and suitable for Pb-free soldering according to IPC/JEDEC J-STD-020).

19 Revision History

Revision	Date	Changes	
V1.2	2017-02-10	updated to new layout, package picture (page 5) and package outline picture (page 206) updated, paragraph below package outline picture removed	
V1.1	2014-08-20	on all pages: general name changed to "TLE8888-1QK" and date and revision	
V1.1	2014-08-20	page 5 and 6: 2 device types added	
V1.1	2014-08-20	page 29: parameter P_5.3.24 min/max changed	
V1.1	2014-08-20	page 52: parameter P_7.5.2 and P_7.5.11 max defined	
V1.1	2014-08-20	page 57: parameter P_8.8.38, P_8.8.39, P_8.8.40, P_8.8.42, P_8.8.43 and P_8.8.44 definition improved	
V1.1	2014-08-20	page 58: parameter P_8.8.45 definition improved	
V1.1	2014-08-20	page 62: table 25 corrected	
V1.1	2014-08-20	page 100: PGND reference pin changed	
V1.1	2014-08-20	page 2, 9, 10, 11, 17, 18, 20, 21, 22, 26, 38, 39, 43, 44, 45, 48, 49, 52, 56, 58, 196: missing variable names added	
V1.0	2014-03-13	Data Sheet	

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